

8		7		6		5		4		3		2		1		
SCHEM,MLB_BAFFIN,X363G												REV	ECN	DESCRIPTION OF REVISION	CK APPD DATE	
												10	0006897289	ENGINEERING RELEASED	2016-08-24	
D	PAGE CSA		CONTENTS		SYNC		DATE		PAGE CSA		CONTENTS		SYNC		DATE	
	1	1	MLB_BAFFIN				61	65	AUDIO Speaker Amps & Conn		X363_AUDIO	01/25/2016				
	2	2	BOM Configuration		J80_MLB	07/07/2015	62	66	AUDIO JACK CONNECTOR		J80_MLB	11/06/2015				
	3	3	BOM Configuration		J80_MLB_BAFFIN_CLEAN	12/02/2015	63	69	DC-In & Battery Connectors		J80_MLB	11/06/2015				
	4	4	PD Parts		J80_MLB	11/16/2015	64	70	PBUS Supply & Battery Charger		J80_MLB	11/06/2015				
	5	5	CPU DMI/PEG/FDI/RSVD		X363_AGGTFT1	01/21/2016	65	71	CORE & SA IMVP IC		J80_OTTUMAN_MLB_BAFFIN	12/10/2015				
	6	6	CPU Clock/Misc/JTAG/CFG		J80_MLB	11/06/2015	66	72	CORE IMVP POWER BLOCK		J80_OTTUMAN_MLB_BAFFIN	09/03/2015				
	7	7	CPU DDR3 Interfaces		J80_MLB	11/06/2015	67	73	SA IMVP IC		J80_OTTUMAN_MLB_BAFFIN	11/18/2015				
	8	8	CPU Power		J80_MLB	08/16/2015	68	74	GT & GTX IMVP POWER BLOCK		J80_OTTUMAN_MLB_BAFFIN	09/03/2015				
	9	9	CPU Ground		J80_MLB	08/17/2015	69	76	Power - 5V 3.3V Supply		J80_OTTUMAN_MLB_BAFFIN	12/09/2015				
C	10	10	CPU Decoupling 1 [10]		J80_OTTUMAN_MLB_BAFFIN	11/22/2015	70	78	PMIC-1 & Power Control		J80_MLB	12/08/2015				
	11	11	CPU Decoupling 2 [11]		X363_SEAN	02/01/2016	71	79	PMIC-1 1.2V 0.6V VCCIO		J80_MLB	11/06/2015				
	12	12	PCH RTC/HDA/JTAG/SATA/CLK		X363_SAKKOC	04/14/2016	72	80	PMIC-1 1V 1.8V VCCPCH		X363_ZIFENGSHEN	04/14/2016				
	13	13	PCH DMI/FDI/PM/GFX/PCI		J80_MLB	11/06/2015	73	81	PMIC-1 Aliases & TPs		J80_SILUCHEN_MLB_BAFFIN	12/08/2015				
	14	14	PCH PCI-E/USB		X363_SAKKOC	04/14/2016	74	82	Power FETs		J80_SAKKOC_MLB_BAFFIN	12/11/2015				
	15	15	PCH GPIO/MISC/NCTF		X363_SAKKOC	04/29/2016	75	84	LCD Backlight Driver		J80_OTTUMAN_MLB_BAFFIN	12/03/2015				
	16	16	PCH Power		X363_SAKKOC	01/25/2016	76	85	eDP Display Connector		J80_ZIFENGSHEN_MLB_BAFFIN	12/03/2015				
	17	17	PCH DECOUPLING		J80_MLB	11/06/2015	77	86	POLARIS_CONTROLLER		X363_JSAMUELS	04/01/2016				
	18	18	CPU/PCH Merged XDP		X363_SAKKOC	01/25/2016	78	87	POLARIS POWER		X363_JSAMUELS	05/18/2016				
	19	19	Chipset Support 1		X363_SAKKOC	04/29/2016	79	88	POLARIS GND		X363_JSAMUELS	04/01/2016				
B	20	20	Chipset Support 2		X363_SAKKOC	01/14/2016	80	89	Connector		X363_JSAMUELS	04/01/2016				
	21	22	LPDDR3 VREF MARGINING		J80_MLB	11/06/2015	81	90	TEMP SENSORS		J80_MLB	11/06/2015				
	22	23	LPDDR3 DRAM Channel A (0-31)		J80_MLB	11/06/2015	82	91	NAND 1/2		X363_JSAMUELS	08/09/2016				
	23	24	LPDDR3 DRAM Channel A (32-63)		J80_MLB	11/06/2015	83	92	NAND 2/2		X363_JSAMUELS	08/09/2016				
	24	25	LPDDR3 DRAM Channel B (0-31)		J80_MLB	11/06/2015	84	93	POLARIS PMIC		X363_JSAMUELS	08/09/2016				
	25	26	LPDDR3 DRAM Channel B (32-63)		J80_MLB	11/06/2015	85	94	SSD NAND VR		X363_JSAMUELS	04/01/2016				
	26	27	LPDDR3 DRAM Termination		J80_MLB	11/06/2015	86	95	SSD SUPPORT		X363_ZIFENGSHEN	04/15/2016				
	27	28	USB-C HIGH SPEED 1		J80_MLB	11/06/2015	87	96	Lifeboat		X363_BBABADI	01/20/2016				
	28	29	USB-C HIGH SPEED 2		J80_MLB	11/06/2015	88	97	Constraints		Constraints	05/18/2016				
	29	30	USB-C Support		X363_AGGTFT1	08/08/2016	89	98	eDP Mux		dpmux	08/22/2015				
A	30	31	USB-C PORT CONTROLLER A		X362_DKGO	08/08/2016	90	99	GPU PCC		X363_SEAN	01/27/2016				
	31	32	USB-C PORT CONTROLLER B		J80_MLB	11/06/2015	91	100	BAFFIN PCI-E		X363_SEAN	01/27/2016				
	32	33	USB-C CONNECTOR A		X362_MLB	03/30/2016	92	101	Baffin CORE/FB POWER		X363_SEAN	02/01/2016				
	33	34	USB-C CONNECTOR B		X362_MLB	03/29/2016	93	102	Baffin FRAME BUFFER I/F		J80_SEAN	04/29/2015				
	34	35	TBT 5V REGULATOR		J80_ZIFENGSHEN_MLB_BAFFIN	12/04/2015	94	103	Baffin 1V05 GPU / 1V35 FB Power Supply		J80_OTTUMAN_MLB_BAFFIN	12/08/2015				
	35	37	WIFI/BT: MODULE 1		X363_SAKKOC	04/29/2016	95	104	GDDR5 Frame Buffer A		J80_SEAN	04/29/2015				
	36	38	WIFI/BT: MODULE 2		J80_MLB	11/06/2015	96	105	GDDR5 Frame Buffer B		J80_SEAN	04/29/2015				
	37	39	Camera/DFR 1		X363_SAKKOC	04/29/2016	97	106	GFX IMVP VCore Regulator [106]		J80_OTTUMAN_MLB_BAFFIN	12/08/2015				
	38	40	Camera/DFR 2		X362_T208	03/22/2016	98	107	Baffin GPIOs,CLK & Straps		X363_SEAN	01/28/2016				
	39	41	Camera/DFR 3		X362_T208	04/25/2016	99	108	Baffin DP/GPIO		X363_SEAN	01/27/2016				
DRAWING												DRAWING TITLE				
TITLE=MLB_BAFFIN ABBREV=ABBREV LAST MODIFIED=Wed Aug 24 09:57:44 2016												SCHEM,MLB-BAFFIN,X363				
Schematic / PCB #'s												Apple Inc.				
PART NUMBER QTY DESCRIPTION REFERENCE DES CRITICAL BOM OPTION												DRAWING NUMBER 051-00647 SIZE D				
051-00647 1 SCHEM,MLB-BAFFIN,X363G SCH CRITICAL												REVISION 10.0.0				
820-00281 1 PCB,MLB-BAFFIN,X363G PCB CRITICAL												BRANCH dvt-fab10				
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BOM Variants															
BOM NUMBER		BOM NAME				BOM OPTIONS									
685-00076		COMMON PARTS,MLB-BAFFIN,X363				X363_COMMON									
985-00126		DEV,MLB-BAFFIN,X363				X363_DEVEL:PVT									
985-00232		DEV,MLB-BAFFIN,PVT,X363				X363_DEVEL:PVT									
639 BOMs have been moved to the end of the schematic															
X363 BOM Groups															
BOM GROUP		BOM OPTIONS													
X363_COMMON		ALTERNATE,COMMON,X363_COMMON1,X363_COMMON2,X363_COMMON3,X363_COMMON4,X363_PROGPARTS													
X363_COMMON1		SOC:HYNIX,SE:PROD,SKIP_5V3V3:AUDIBLE,DIPLEXER:MURATA,T208_PROG:REV5,BOARD_ID:17,VCHDA:S0													
X363_COMMON2		XDP:YES,SAMCONN,SOC_BOOT:SPI,DPMUX_XTAL:NO,GPUCLK:OSC,BAFFIN_AP_TEMP,VCCPLLLOC:S3,WIFI_SAK:NO													
X363_COMMON3		CPUTHRM:ALRT,TBTTHRM:ALRT,LOADRC:NO,OTHERRC:YES,DDRRC:YES,TBTRC:YES,TPADRC:YES,LID_FEATURE_ON													
X363_COMMON4		EDP:YES,CPUPEG:X8X4X4,TBTTHRM_SNS,GPUTHRM_SNS,S3_STATE:YES,GPU_ROM:YES,SVID_PU:CORE													
X363_PROGPARTS		BOOTROM_PROG:DVT,BT_PROG:DVT,WIFI_PROG:DVT,UPCROM_PROG:DVT,SMC_PROG:PVT,DPMUXMCU:PROG,PCC:NO													
X363_DEVEL:ENG		ALTERNATE,ENGISNS,DBGLED,XDP_CONN,USBC_DBG,DBG_BTN,DBG_FAN,DBG_XTAL,DPMUX_DEBUG,WIFI_DBG,SSD_DEBUG,GPUROM:BLANK,PCC:YES													
X363_DEVEL:DVT		ALTERNATE,ENGISNS,DBGLED,XDP_CONN,USBC_DBG,DBG_BTN,DBG_FAN,DBG_XTAL,DPMUX_DEBUG,WIFI_DBG,SSD_DEBUG													
X363_DEVEL:PVT		ALTERNATE,XDP_CONN,USBC_DBG													
ENGISNS		TBTISNS,LOADISNS,TPADISNS,DDRISNS,OTHERISNS													
Module Parts															
PART NUMBER		QTY	DESCRIPTION				REFERENCE DES		CRITICAL		BOM OPTION				
337S00227		1	CPU,SKY,SR2FT,R1,PRQ,4/2,2.9,BGA1440				U0500		CRITICAL		CPU_SKL:2.9				
337S00228		1	CPU,SKY,SR2FU,R1,PRQ,4/2,2.7,BGA1440				U0500		CRITICAL		CPU_SKL:2.7				
337S00229		1	CPU,SKY,SR2FQ,R1,PRQ,4/2,2.6,BGA1440				U0500		CRITICAL		CPU_SKL:2.6				
998-04701		1	INTERPOSER,INTEL,BGA1440,MM940989				U0500		CRITICAL		CPU_SKL:SOCKET				
337S00258		1	IC,SKL_PCH-H,SFF,SR2NH,PRQ,DL,BGA939				U1100		CRITICAL						
353S00961		4	IC,CD3215,ACR,C0,USB_PWR_SW,BLANK,BGA96				U3100,U3200,UB300,UB400		CRITICAL						
338S00254		2	IC,TBT,ALPINE_RIDGE_DP,QT55,QS,C1,BGA337				U2800,UB000		CRITICAL						
353S01016		1	IC,ISL9239HIZ,PMU,TUBA,WCSF40,2.1X3.3MM				U7000		CRITICAL						
338S00221		1	IC,PMU,P650839,7X7MM,BGA168				U7800		CRITICAL						
338S00142		1	IC,CODEC,CLIFDEN,CS421A3A,B0,MICSP49				U6300		CRITICAL						
337S00330		1	IC,GPU,BAFFIN,ULA,A1,PS,BGA769				UA000		CRITICAL		BAFFIN_ULA				
337S00331		1	IC,GPU,BAFFIN,PROA,A1,PS,BGA769				UA000		CRITICAL		BAFFIN_PROA				
337S00332		1	IC,GPU,BAFFIN,LEA,A1,PS,BGA769				UA000		CRITICAL		BAFFIN_LEA				
998-04866		1	INTERPOSER,AMD,C989,BGA769,VDDCI/MVDD				UA000		CRITICAL		STARDUST:VDDCI_MVDD				
998-04867		1	INTERPOSER,AMD,C988,BGA769,VDDC				UA000		CRITICAL		STARDUST:VDDC				
677-04532		2	SUBASSY (T&R) PCB,A,AMR,INTERPOSER,X363				J5250,J5260		CRITICAL						
Development/Base BOMs															
PART NUMBER		QTY	DESCRIPTION				REFERENCE DES		CRITICAL		BOM OPTION				
685-00076		1	COMMON PARTS,MLB-BAF,X363				BASE		CRITICAL		BASE_BOM				
985-00126		1	DEV,MLB-BAF,X363				DEVEL		CRITICAL		DEVEL_BOM				
WIFI/BT Diplexers															
PART NUMBER		QTY	DESCRIPTION				REFERENCE DES		CRITICAL		BOM OPTION				
155S0979		3	FLTR,DIPLEXER,2.45/5.54GHZ,0805				U3810,U3820,U3830		CRITICAL		DIPLEXER:MURATA				
GPU Options															
BOM GROUP		BOM OPTIONS													
2GB_MC_BAFFIN		FB_2GB_MICRON,VRAM:GRP1													
2GB_HY_BAFFIN		FB_2GB_HYNIX,VRAM:GRP1													
2GB_SM_BAFFIN		FB_2GB_SAMSUNG,VRAM:GRP2													
4GB_SM_BAFFIN		FB_4GB_SAMSUNG,VRAM:GRP1													
4GB_MC_BAFFIN		FB_4GB_MICRON,VRAM:GRP1													
FB VDRAM Parts															
PART NUMBER		QTY	DESCRIPTION				REFERENCE DES		CRITICAL		BOM OPTION				
333S00044		4	IC,GDDR5,4Gb,7Gbps,1.5V,25NM,A,170 BGA				UA400,UA450,UA500,UA550		CRITICAL		FB_2GB_MICRON				
333S00043		4	IC,GDDR5,4Gb,7Gbps,1.5V,25NM,A,170 BGA				UA400,UA450,UA500,UA550		CRITICAL		FB_2GB_HYNIX				
333S00078		4	IC,GDDR5,8Gb,7Gbps,1.5V,25NM,B,170 BGA				UA400,UA450,UA500,UA550		CRITICAL		FB_2GB_SAMSUNG				
333S00074		4	IC,GDDR5,8Gb,7Gbps,1.5V,25NM,B,170 BGA				UA400,UA450,UA500,UA550		CRITICAL		FB_4GB_SAMSUNG				
333S00075		4	IC,GDDR5,8Gb,7Gbps,1.5V,25NM,A,170 BGA				UA400,UA450,UA500,UA550		CRITICAL		FB_4GB_MICRON				
Sub-BOM DIPLEXER															
BOM NUMBER		BOM NAME				BOM OPTIONS									
685-00085		DIPLEXERS,MURATA,X363G				DIPLEXER:MURATA									
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BOM Configuration

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Strategic Silicon

PART#	STRATEGIC VALUE	COMMENT
337S00227	08	CPU
337S00228	08	CPU
337S00229	08	CPU
333S00050	07	MAIN MEMORY
333S00070	07	MAIN MEMORY
335S00149	02	SSD NAND
335S00204	02	SSD NAND
335S00205	02	SSD NAND
335S00219	02	SSD NAND
339S00154	02	SSD CONTROLLER
339S00155	02	SSD CONTROLLER
338S00166	02	SSD PMIC
337S00225	08	GPU
337S00285	08	GPU
337S00286	08	GPU
333S00044	07	VIDEO MEMORY
333S00043	07	VIDEO MEMORY
333S00078	07	VIDEO MEMORY
333S00074	07	VIDEO MEMORY
333S00075	07	VIDEO MEMORY
343S00135	10	T208
343S00136	10	T208
343S00137	10	T208
338S00138	10	T208
338S00193	09	BERKELIUM
353S3978	02	MOJAVE
338S00097	02	SECURE ELEMENT
338S00254	08	ALPINE RIDGE
353S00961	09	ACE
338S00142	09	CLIFDEN
353S00604	07	AUDIO AMP
353S4316	08	BAYSIDE
338S00221	08	BANJO
353S00853	09	TUBA
339S00056	05	ICEBOOK
359S00006	08	GREEN CLOCK
353S00795	09	DEBUG MUX

BOM Configuration

SYNC_MASTER=J80_MLB		SYNC_DATE=07/07/2015	
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D	Programmable Parts															D
	PART NUMBER	QTY	DESCRIPTION	REFERENCE DES	CRITICAL	BOM OPTION										
	338S1231	1	IC,SMC12,40MHZ/50MHIPS MCU,7X7,1688GA	U5000	CRITICAL	SMC_PROG:BLANK	Blank									
	341S00701	1	IC,SMC-B1,EXT (v2.37P7) PVT,X363G	U5000	CRITICAL	SMC_PROG:PVT	TI									
	335S00013	1	IC,SPI SERIAL FLASH,64M BITS,3V,RP 801C,Q8=1	U6100	CRITICAL	BOOTROM_PROG:BLANK	Blank									
	341S00699	1	IC,EFI ROM (V0193), DVT, X363G	U6100	CRITICAL	BOOTROM_PROG:DVT	Macronix/Winbond									
	353S00926	2	IC,CD3215,ACE,B03,BLANK,BGA96	U2890,UB090	CRITICAL	UPCROM_PROG:BLANK	Blank									
	341S00707	1	T29,AR1 (V10.5) PVT, X363G	U2890	CRITICAL	UPCROM_PROG:DVT	Winbond									
	341S00708	1	T29,AR2 (V10.5) PVT, X363G	UB090	CRITICAL	UPCROM_PROG:DVT	Winbond									
	335S00024	1	IC,SERIAL-FLASH,2MBIT,4V,8-USON,2x3x,6MM	U3750	CRITICAL	BT_PROG:BLANK	Blank									
	341S00695	1	IC,BT ROM (V28), DVT, X362/X363	U3750	CRITICAL	BT_PROG:DVT	Macronix/Winbond									
	341S00709	1	WIFI ROM (P107) DVT,NEW,MM1,X362/X363	U3710	CRITICAL	WIFI_PROG:DVT	Rohm/On Semi									
	341S3565	1	IC, EDP MUX-95C, (RENESAS) V3.2.8,DVB,D2	U9800	CRITICAL	DEMUXMCU:PROG										
	335S0724	1	IC,1Mbit SERIAL FLASH 2X3X0.6MM UFDFPN8 PKG	UA701	CRITICAL	GPUROM:BLANK	Blank									
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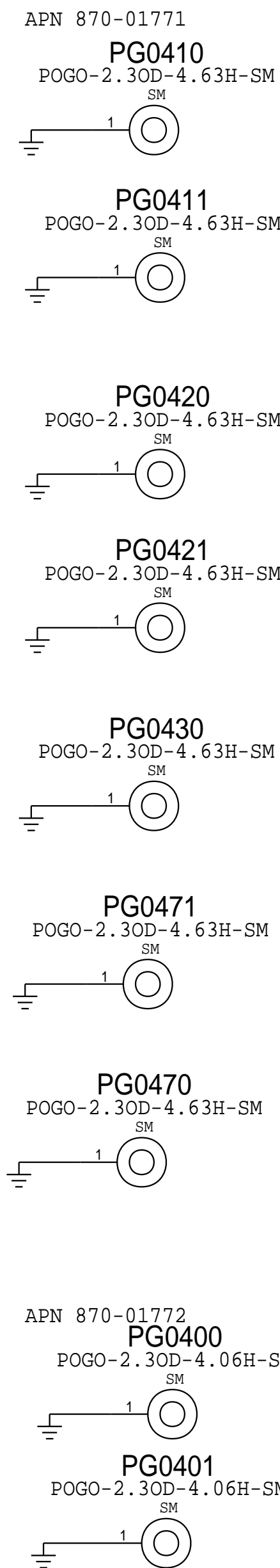
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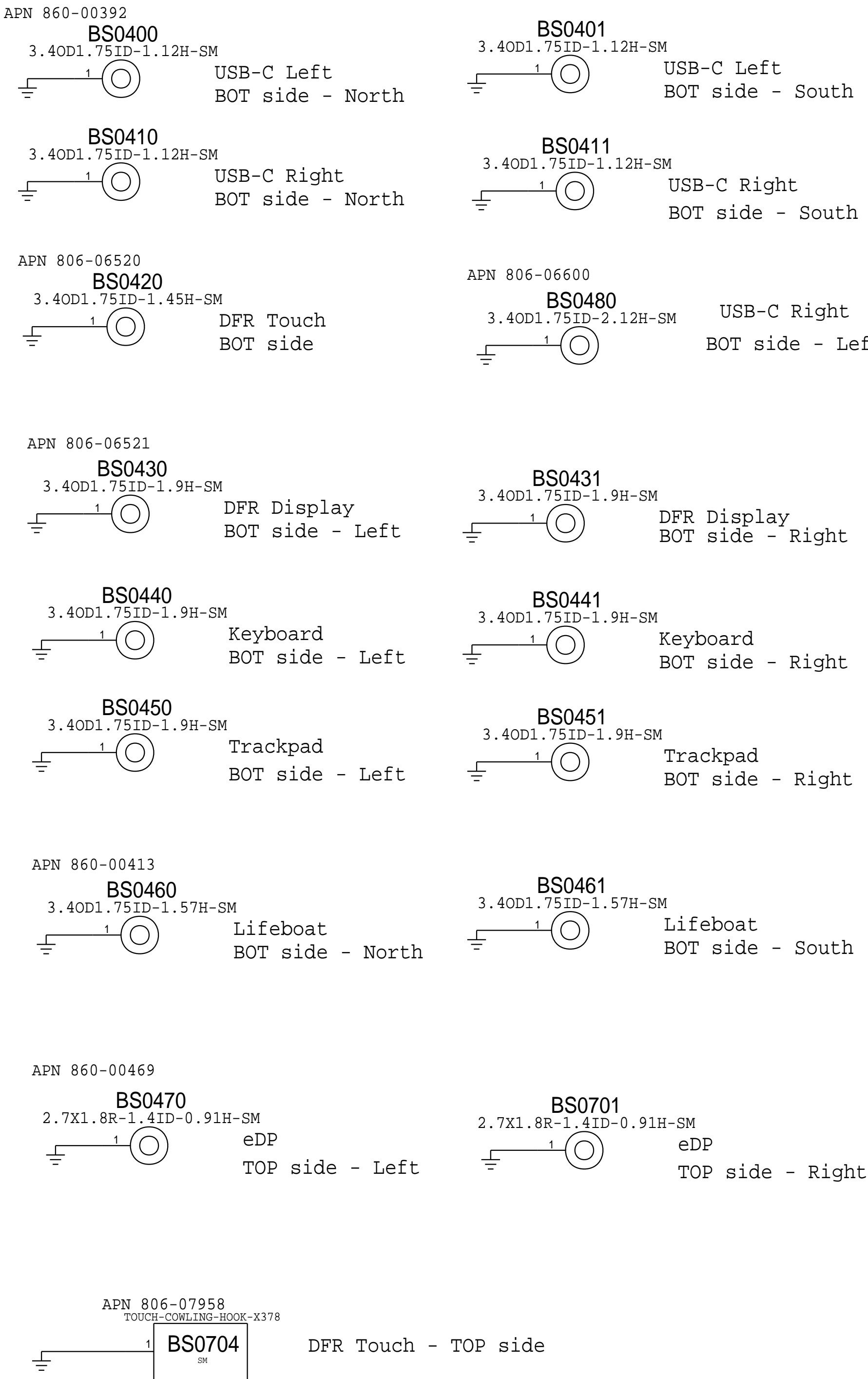
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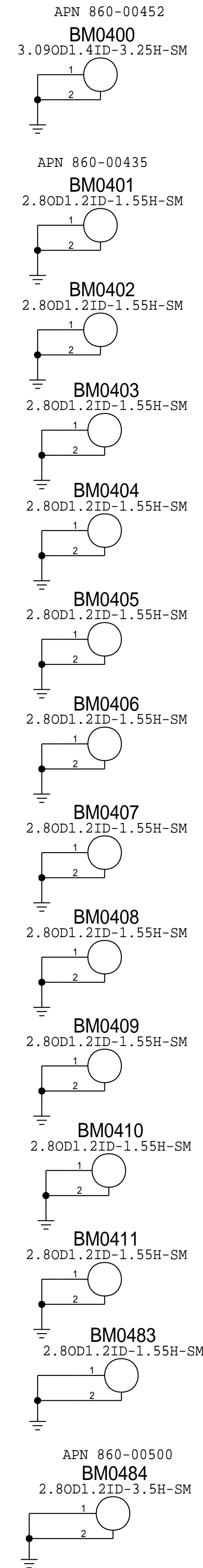
Pogo Pins



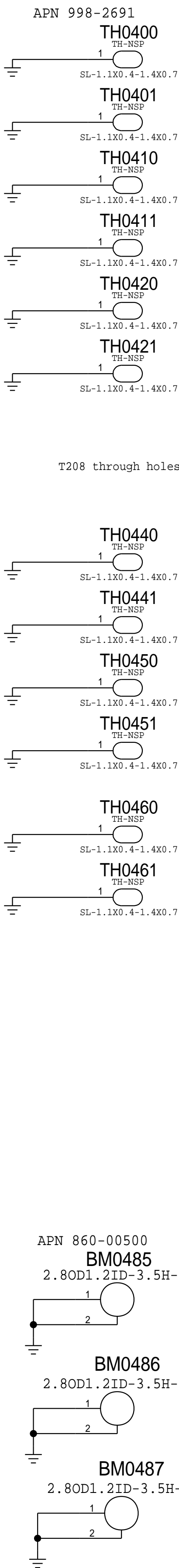
SMT Bosses



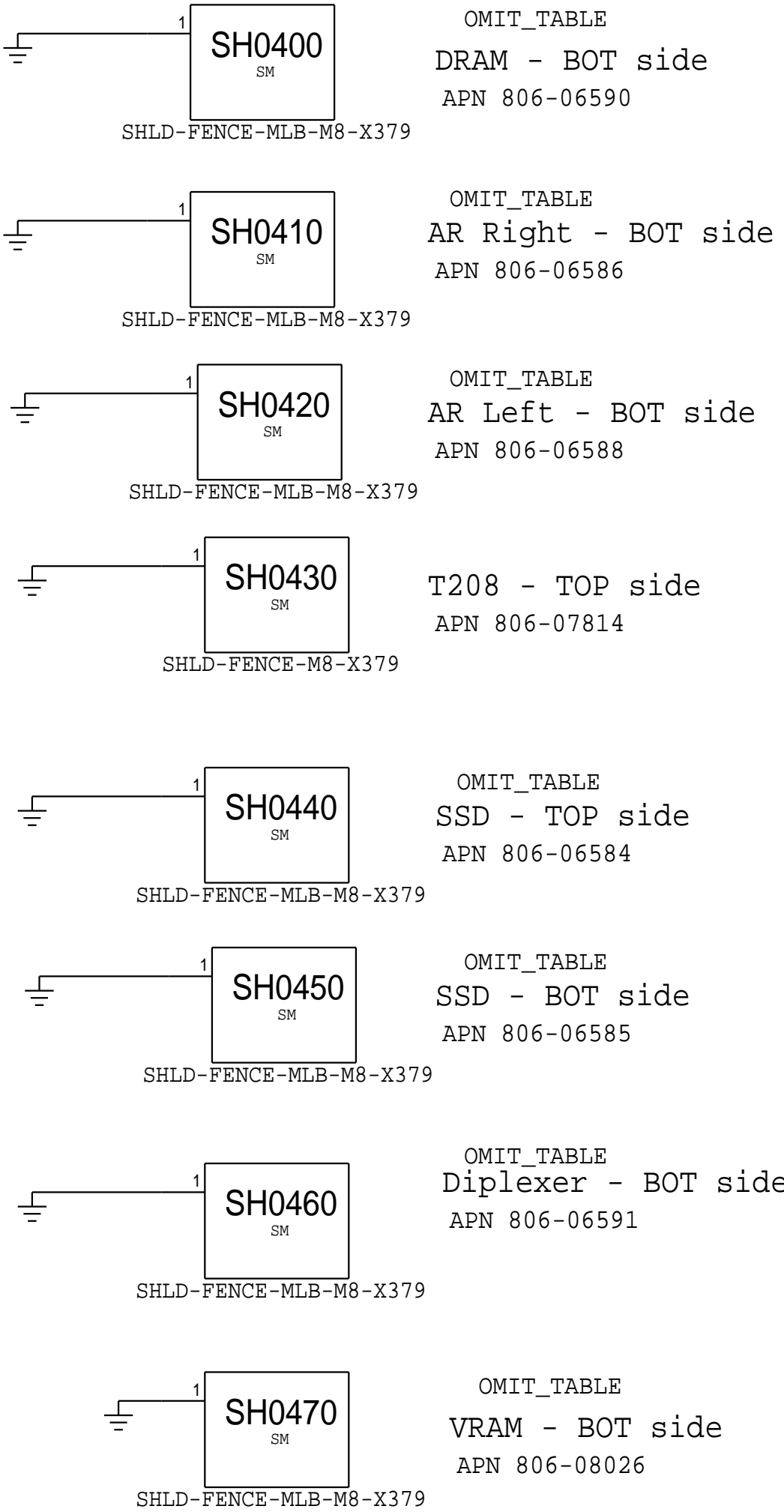
Rubber Mount Standoffs



Shield Can TH




Shield Can Fence

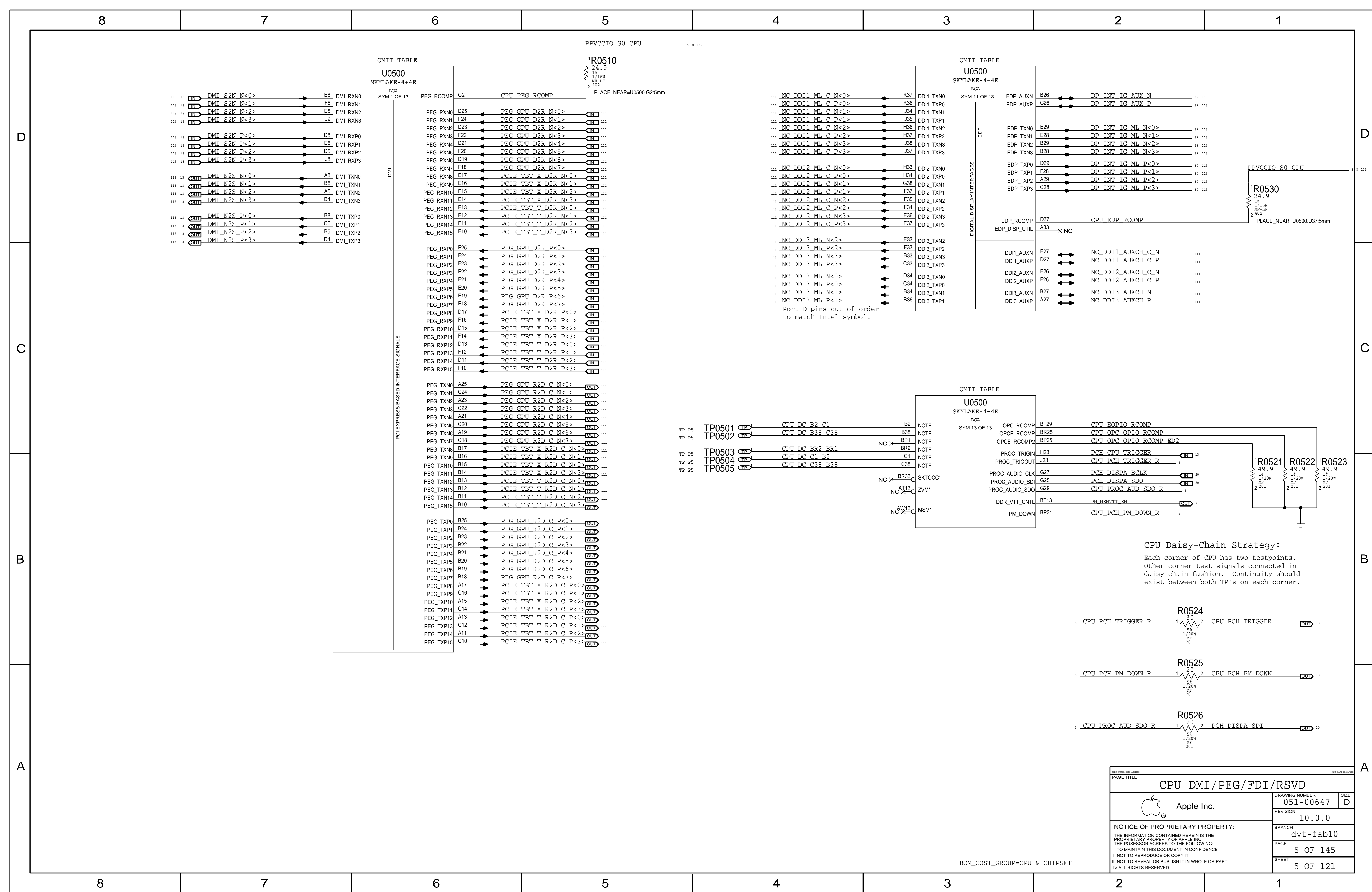


Shield Can Omit Table

PART NUMBER	QTY	DESCRIPTION	REFERENCE DES	CRITICAL	BOM OPTION
806-08023	1	SHIELD,FENCE,DRAM,X378	SH0400	CRITICAL	
806-08019	1	SHIELD,FENCE,ALPINE RIDGE,RIGHT,X378	SH0410	CRITICAL	
806-08021	1	SHIELD,FENCE,ALPINE RIDGE,LEFT,X378	SH0420	CRITICAL	
806-07918	1	SHIELD,NAND,TOP,ALT,X363	SH0440	CRITICAL	
806-07917	1	SHIELD,NAND,BOTTOM,ALT,X363	SH0450	CRITICAL	
806-08024	1	SHIELD,DIPLEX,EG,X378	SH0460	CRITICAL	
806-08026	1	FENCE,VRAM,EG,X378	SH0470	CRITICAL	

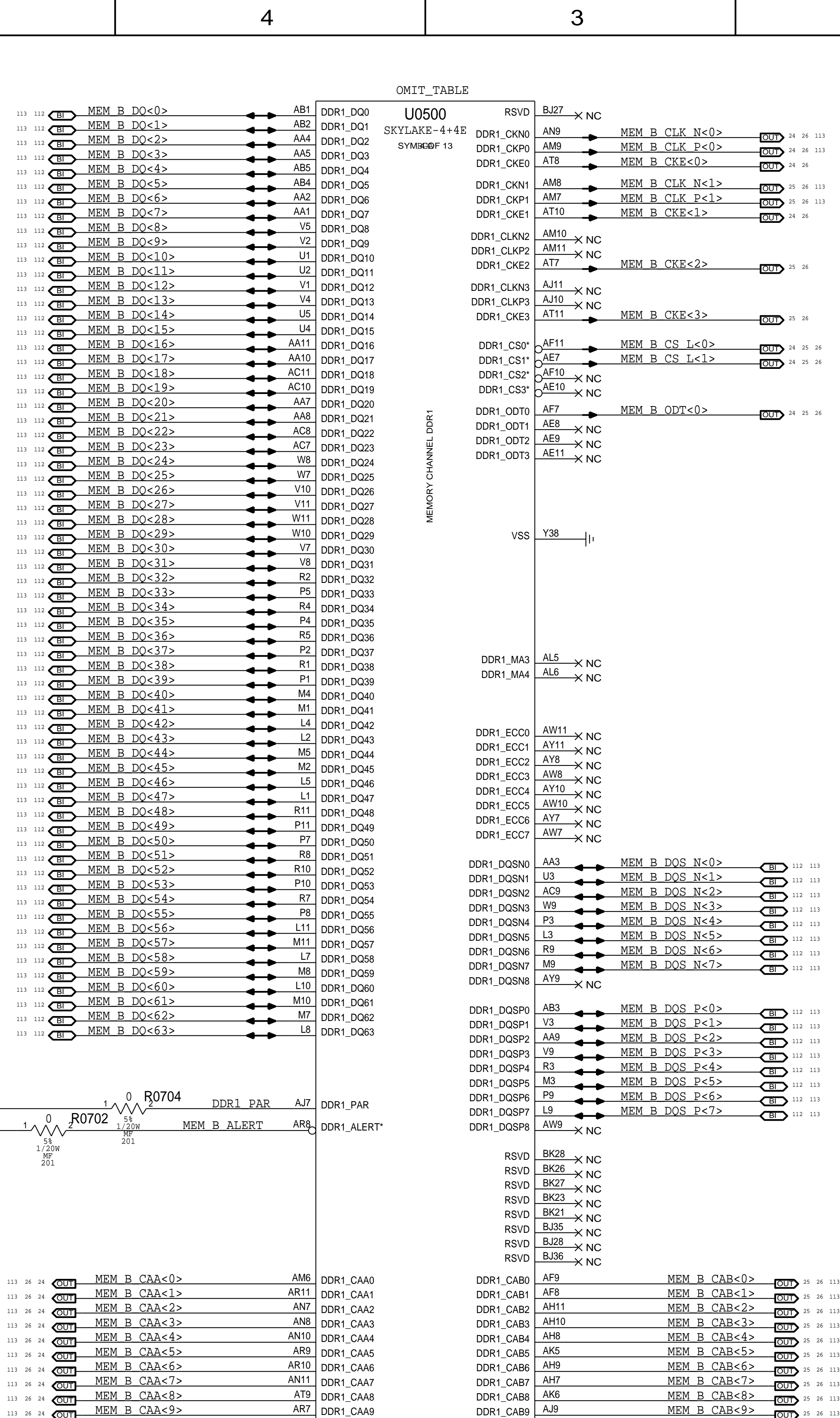
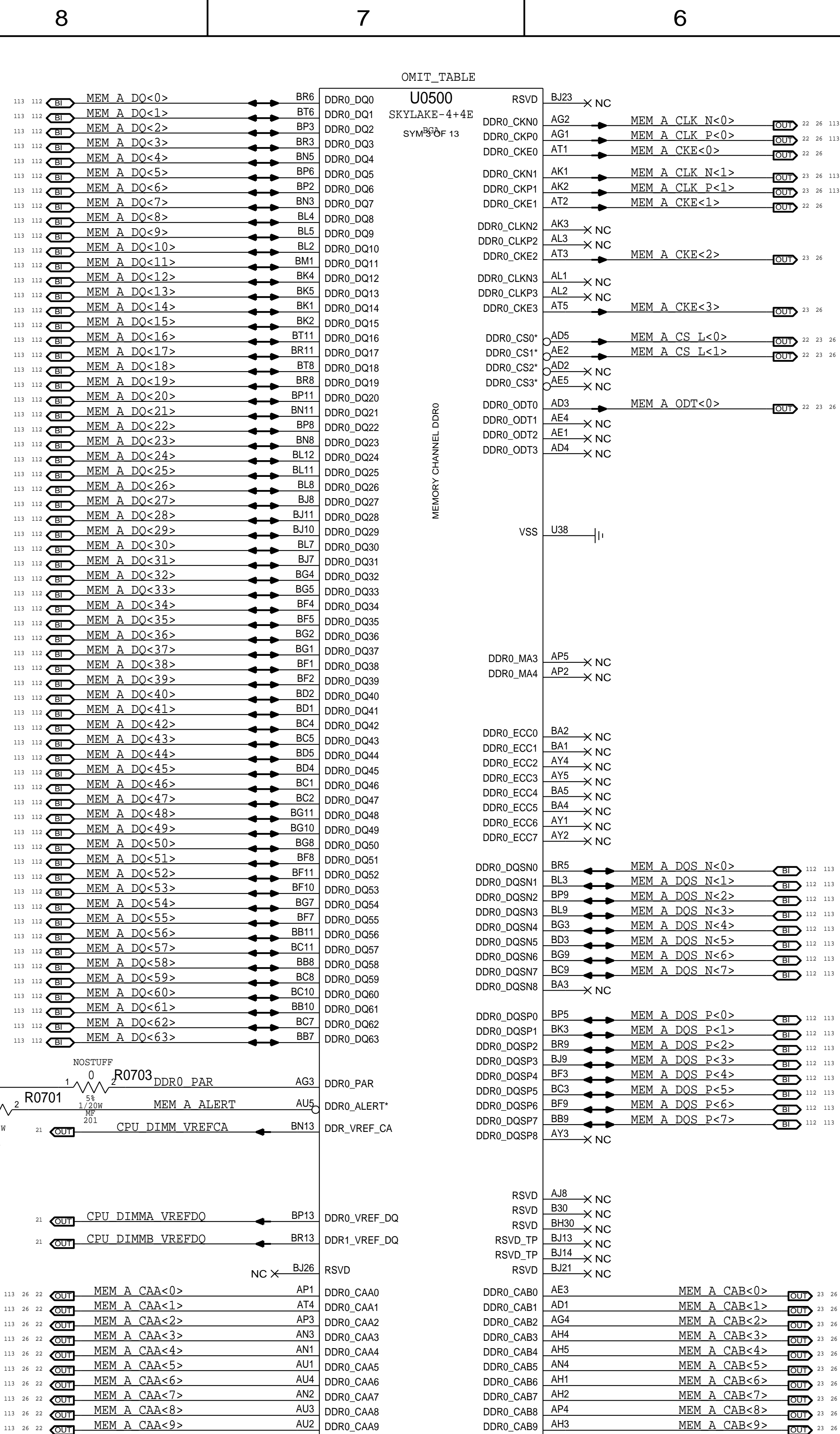
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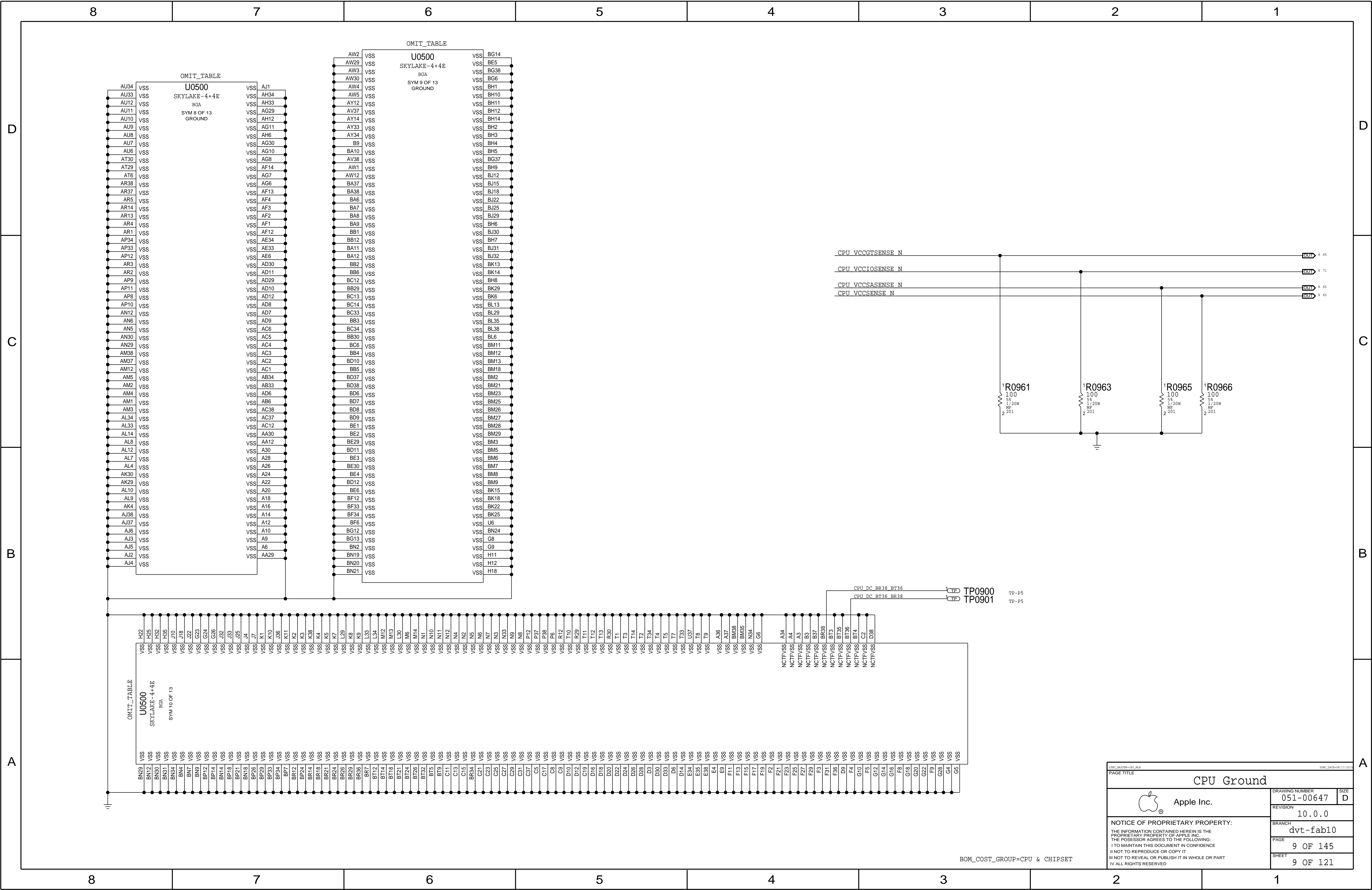










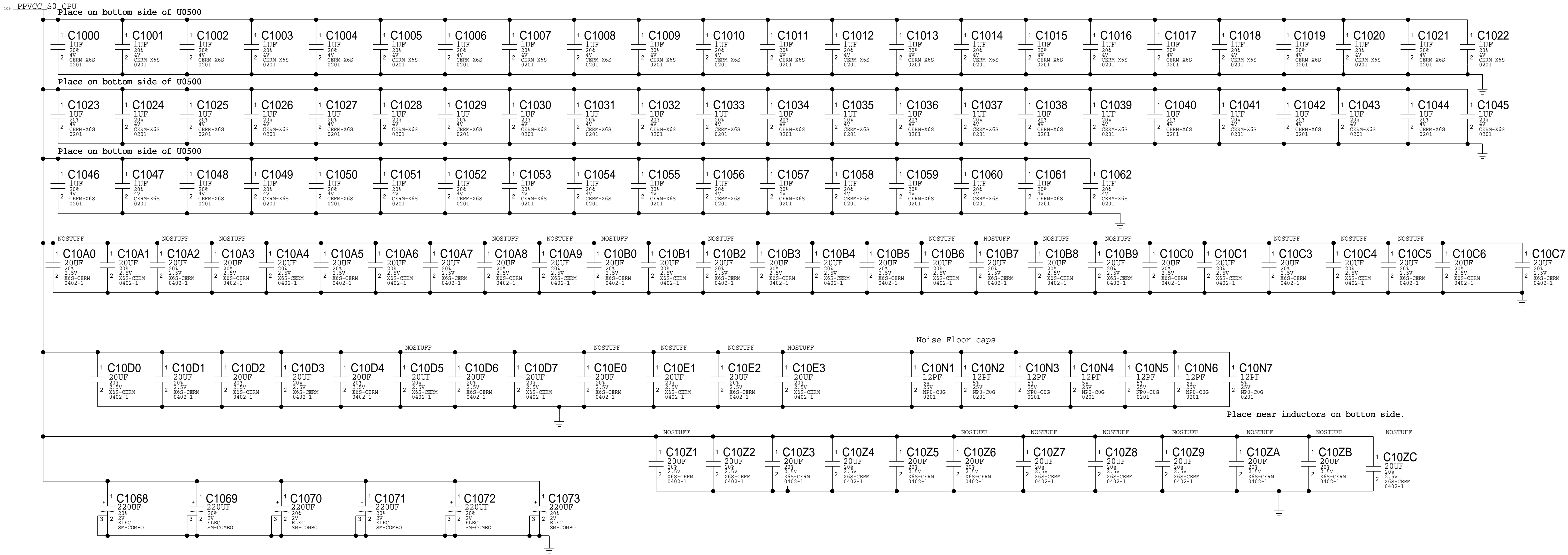


CPU VCORE Decoupling

Intel recommendation: 5x 220uF ESR 5m ohms ESL 1.9nH each,4x 47uF 0805 8x22uF 0603, 28x 10uF 0402, 3x 10uF 0402, 69x 1uF 0201  
Apple Implementation:

Vcc CPU Core Decoupling from 20140905 BOM

Board Edge: 2x 220uF, 4x 47uF rest on the back side



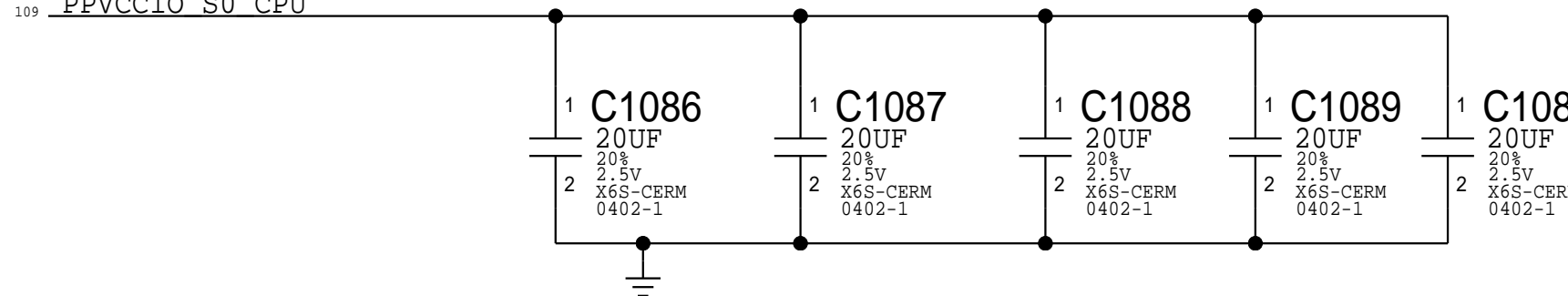
CPU VDDQ Decoupling

Intel recommendation: 10x 10uF 0402, 4x 22uF 0602  
Apple Implementation:

CPU VCCIO Decoupling


Intel recommendation: 3x 10uF 0402 (opposite CPU)  
Apple Implementation:

Place near U0580 on bottom side of U0500



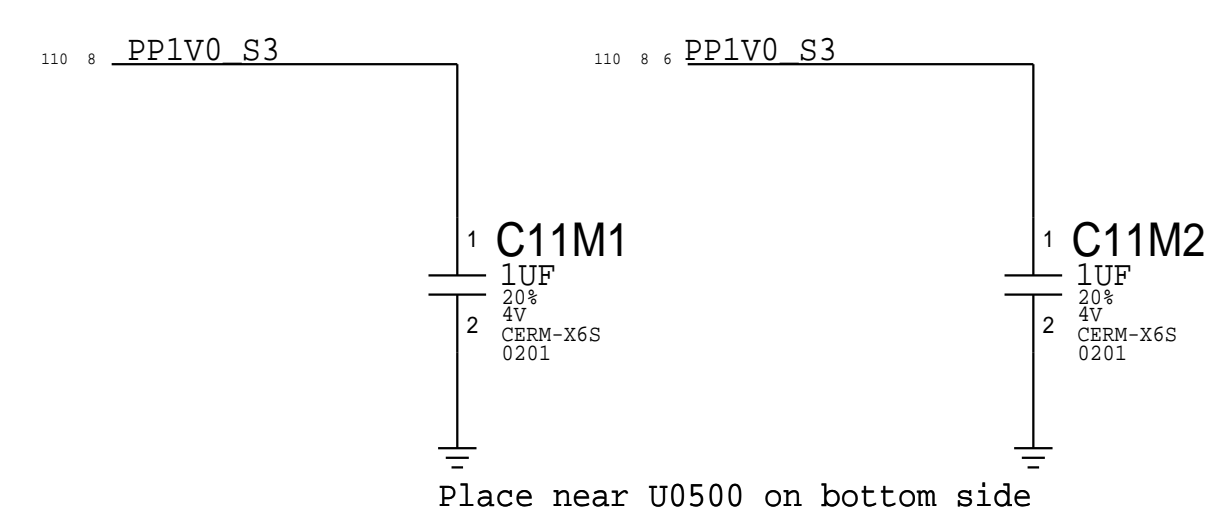
NOTE: Intel decoupling recommendations from CBR schematics for Skylake H doc#557227 and PDG section 48.1 (document# 546884)

BOM\_COST\_GROUP=CPU & CHIPSET

PAGE TITLE			
CPU Decoupling 1 [10]			
 Apple Inc.	DRAWING NUMBER	051-00647	SIZE
	REVISION	10.0.0	D
	BRANCH	dvt-fab10	
	PAGE	10 OF 145	
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Board Edge: 4x220uF, 7x 47uF rest on back side

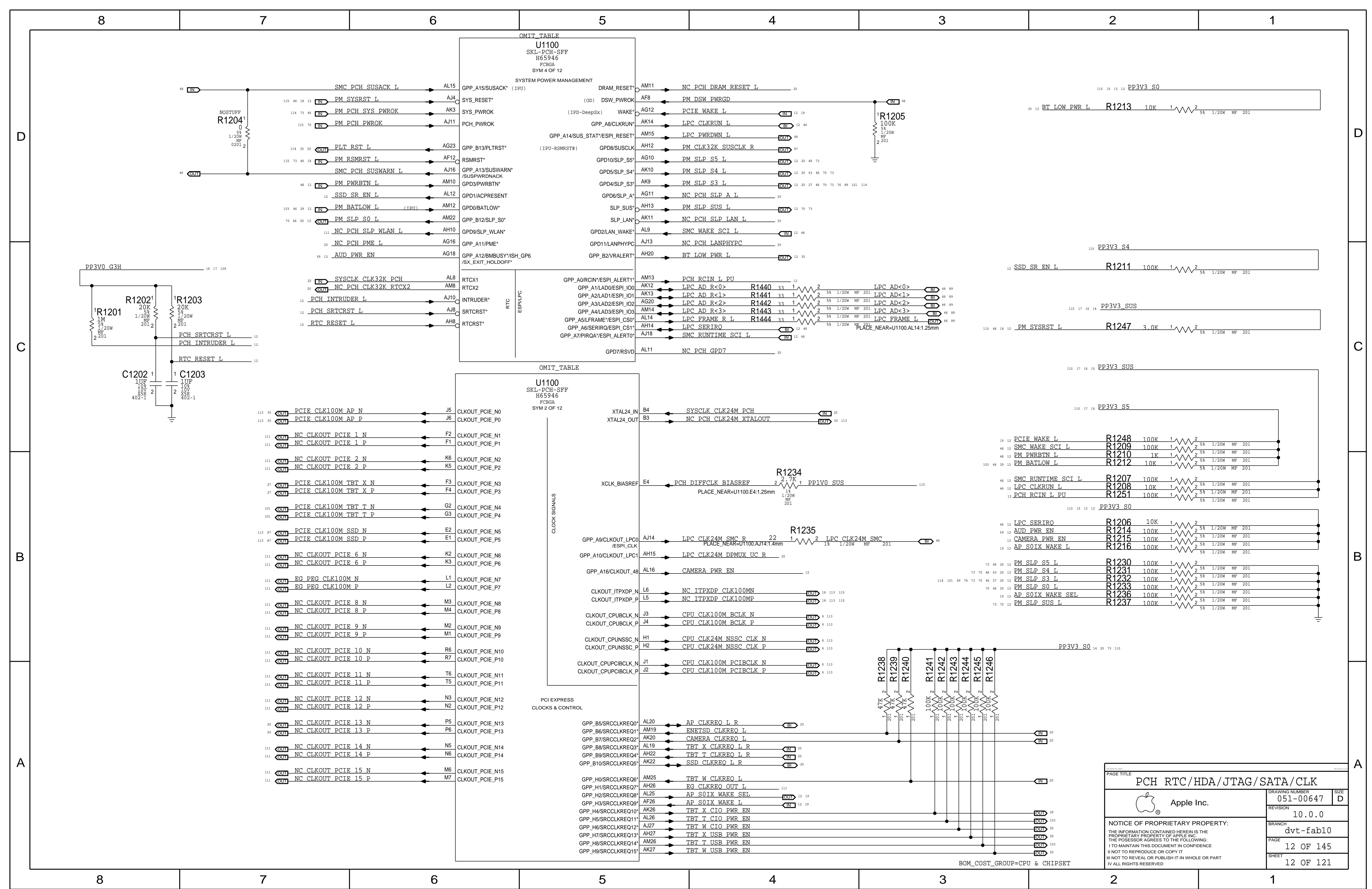


Intel recommendation: 2x 220uF, 1x 47uF 0805, 1x 22uF, 7x 10uF 0402, 3x 1uF 0201\_  
2x 220uF, 1x 22uF on board edge, everything else on back side

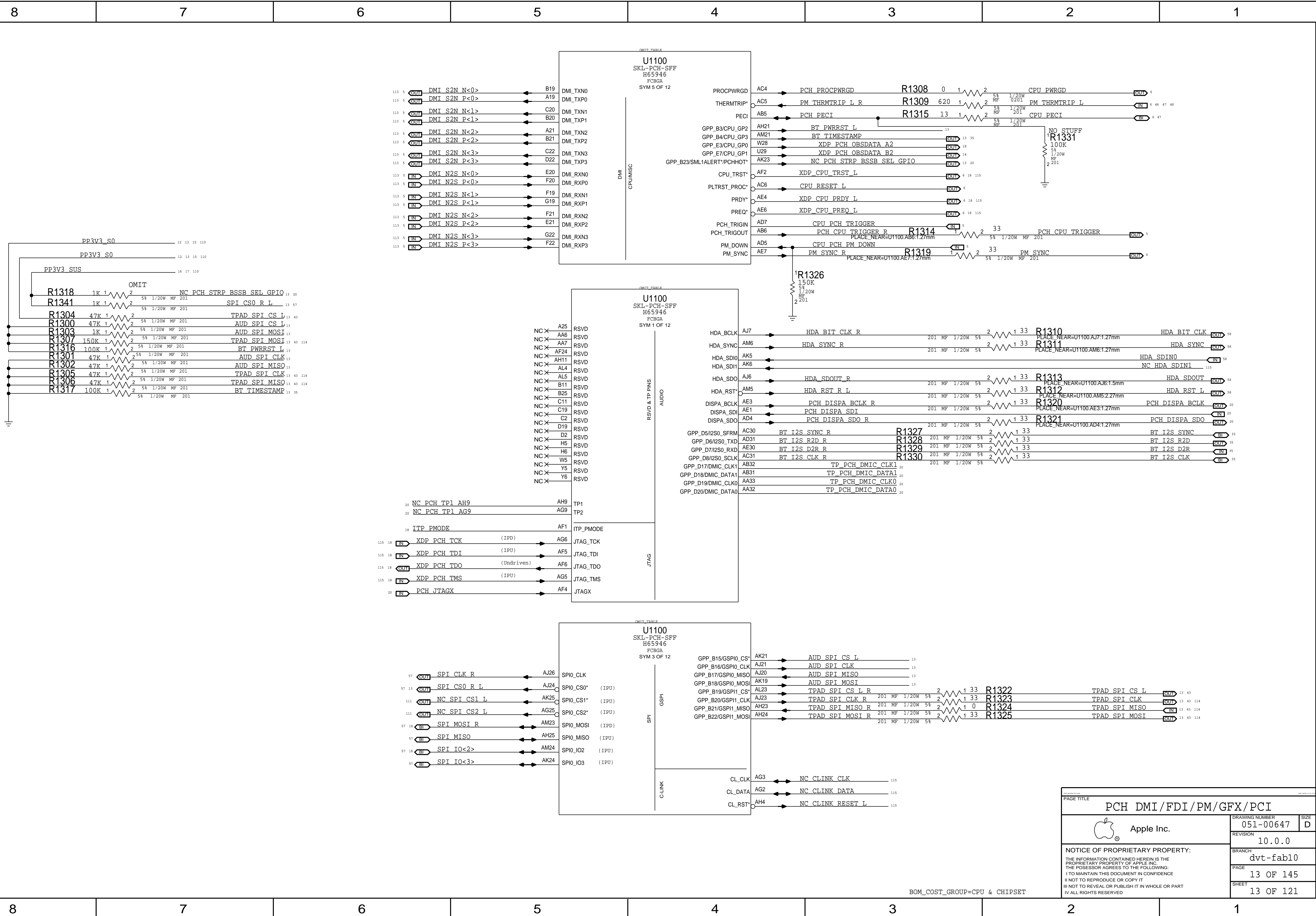
Apple Implementation:

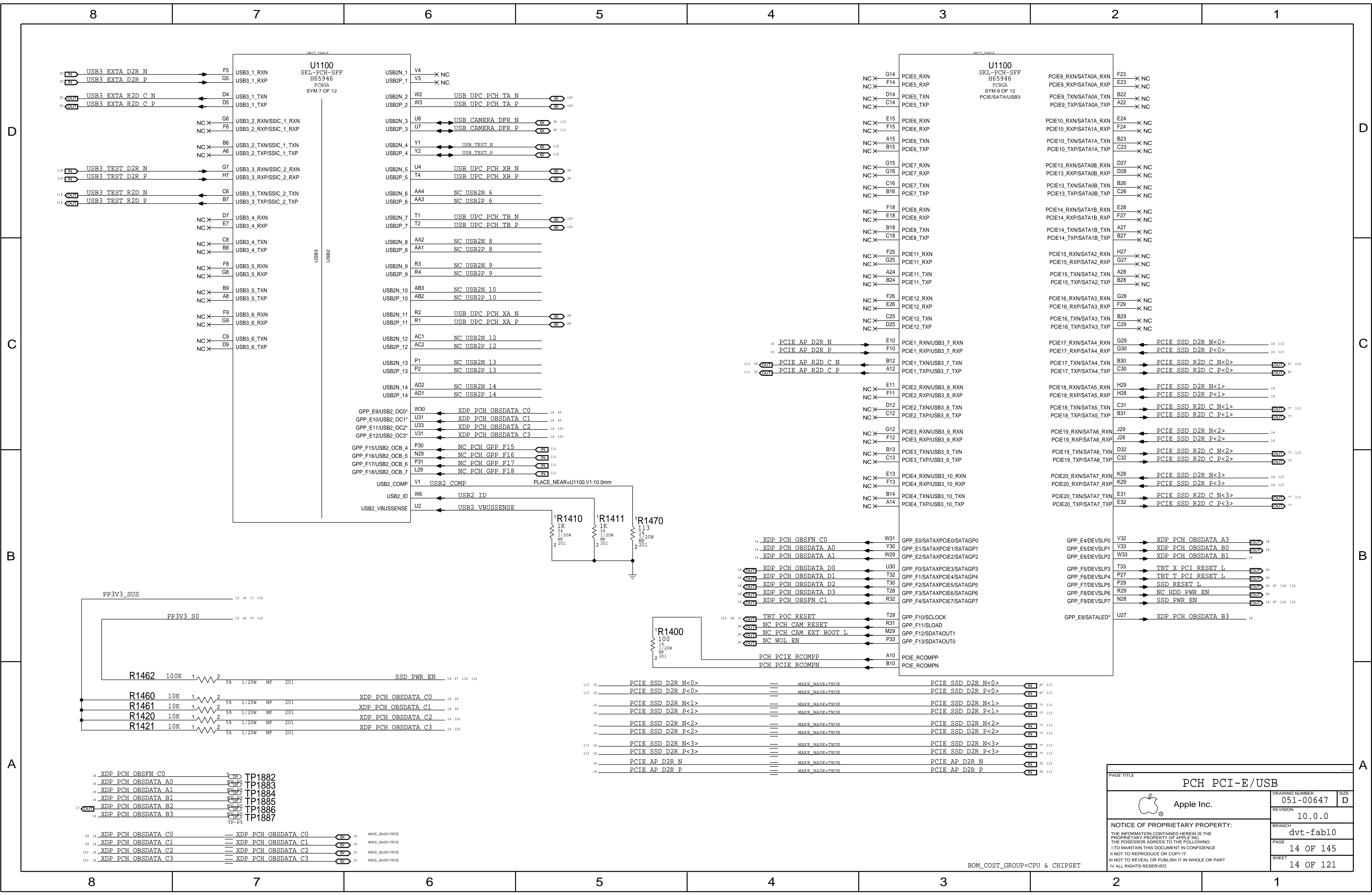
BOM\_COST\_GROUP=CPU & CHIPSET

PAGE TITLE		DRAWING NUMBER		SIZE
CPU Decoupling 2 [11]		051-00647		D
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		BRANCH		
		dvt-fab10		
		PAGE		
		11 OF 145		
		SHEET		
		11 OF 121		



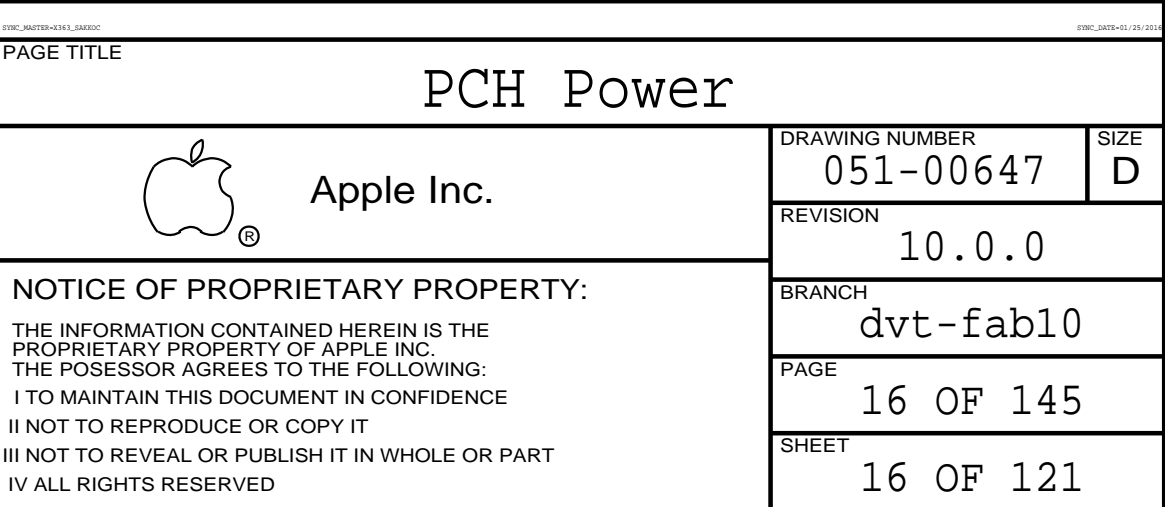




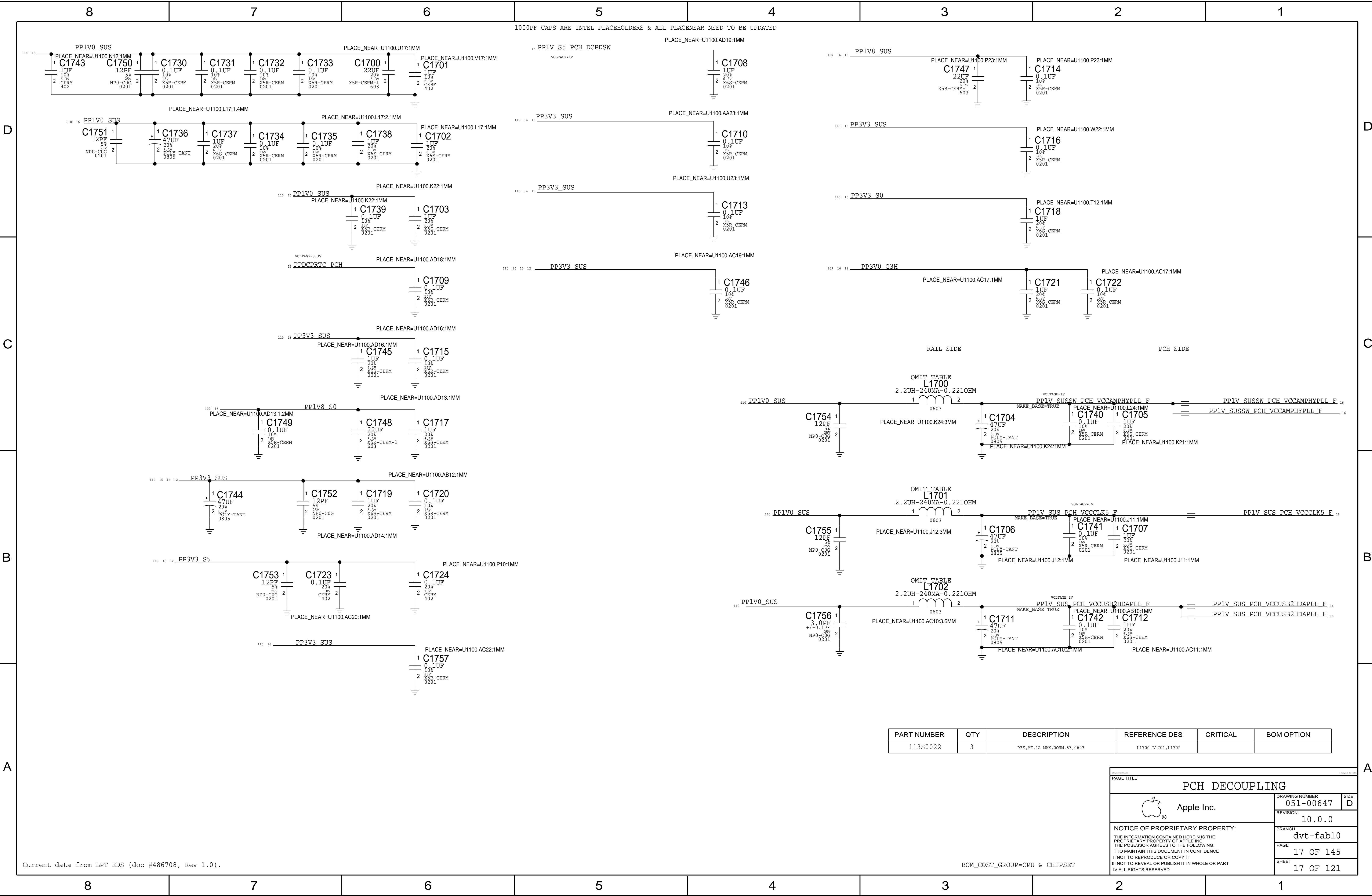











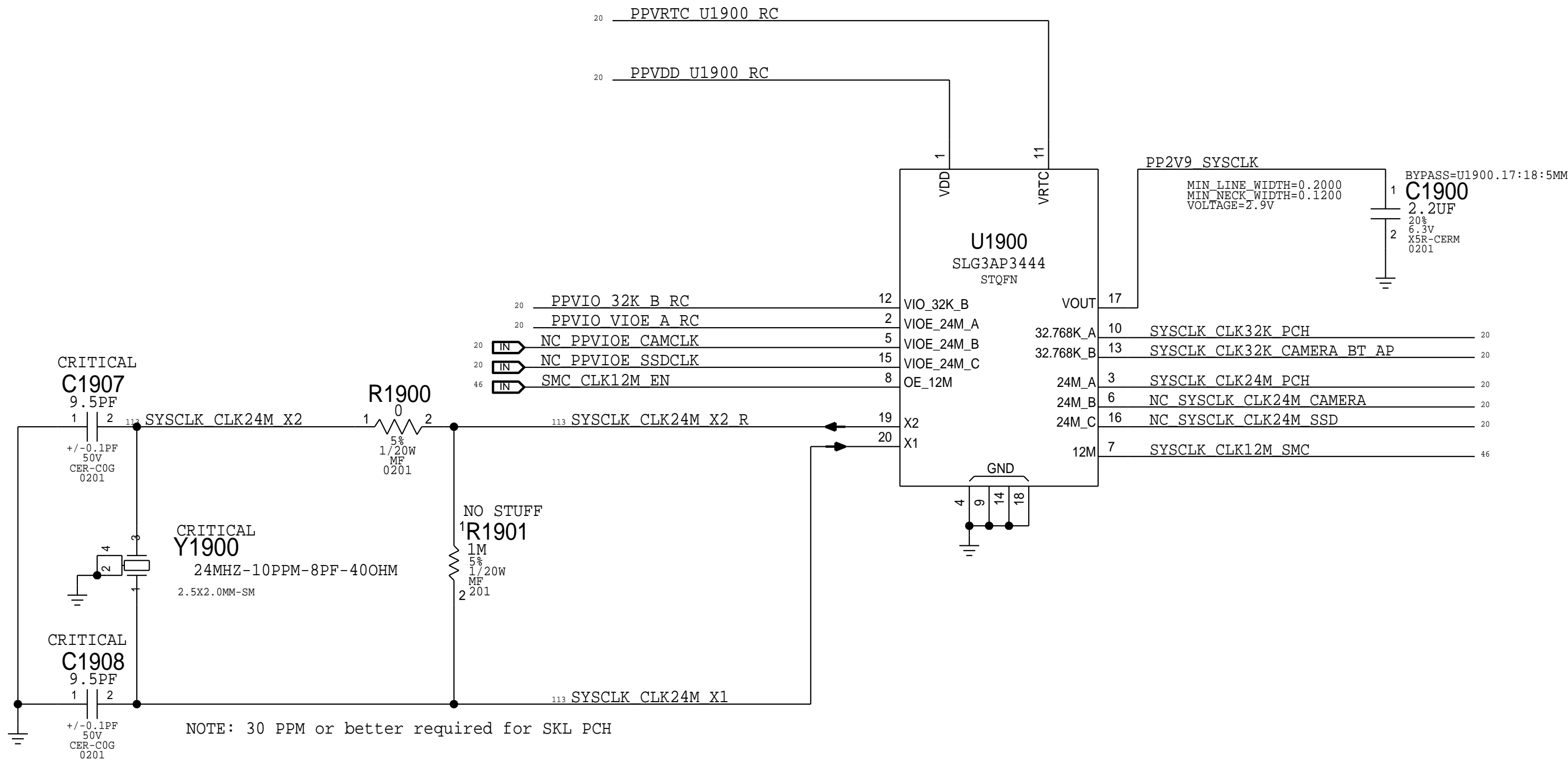


PART NUMBER	QTY	DESCRIPTION	REFERENCE DES	CRITICAL	BOM OPTION
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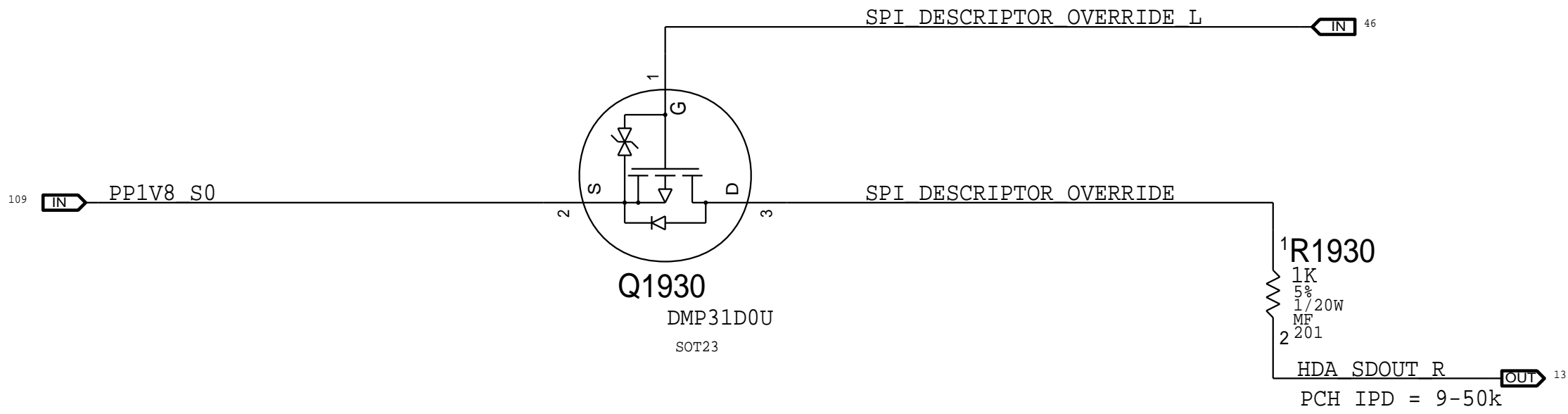
PAGE TITLE		DRAWING NUMBER		SIZE
PCH DECOUPLING		051-00647		D
 Apple Inc.		REVISION		
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		PAGE		
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System 32kHz / 12MHz / 24MHz Clock Generator

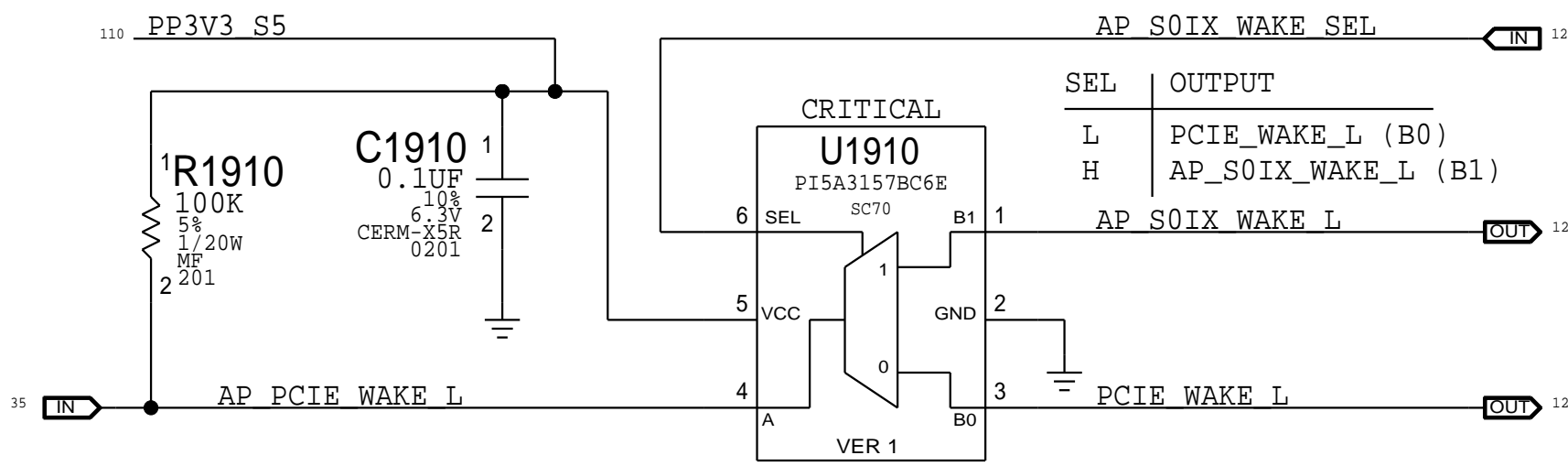


PCH ME Disable Strap



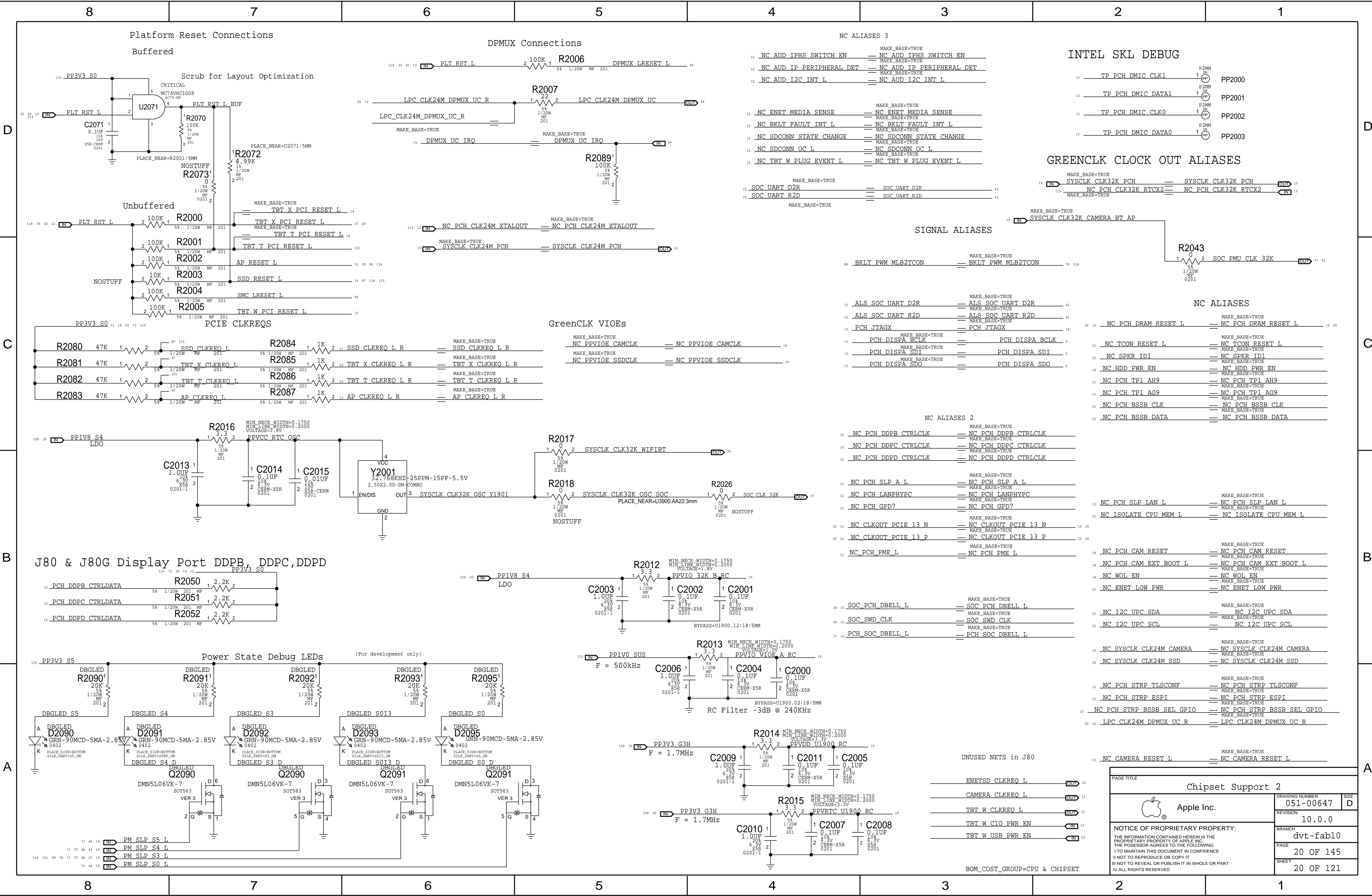
PCH uses HDA\_SDO as a power-up strap. If low, ME functions normally. If high, ME is disabled. This allows for full re-flashing of SPI ROM. SMC controls strap enable to allow in-field control of strap setting. \*\*\*\*\* Circuit does not support HDA voltage >3.3V.

PCIe Wake Muxing



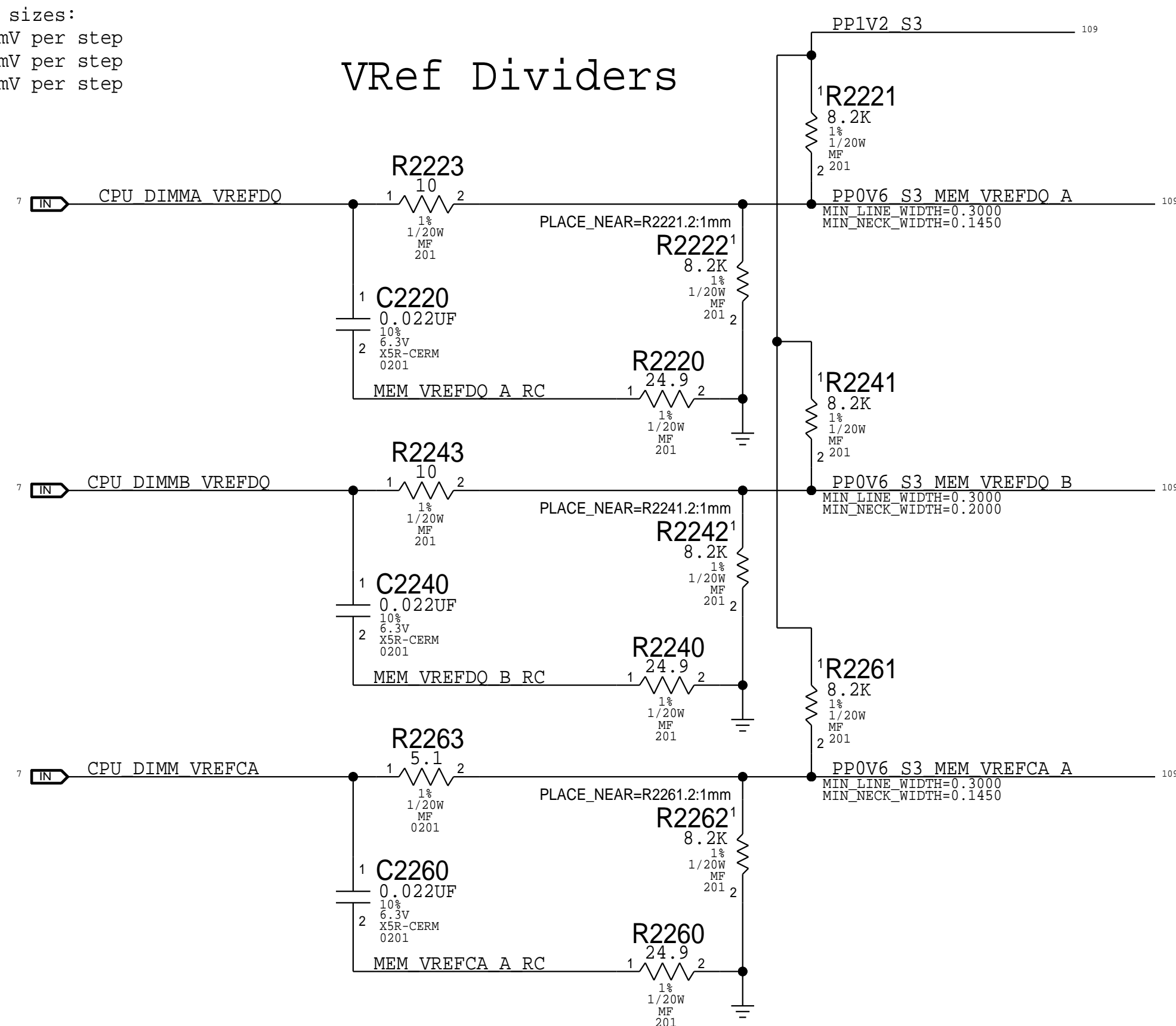
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	REVISION	10.0.0	
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```
NOTE: CPU DAC output step sizes:
      DDR3   (1.5V)  7.70mV per step
      DDR3L  (1.35V) 6.99mV per step
      LPDDR3 (1.2V)  ???mV per step
```



BOM COST GROUP=DRAM

SYNC_MASTER=J80_MLB		SYNC_DATE=11/06/2015	
PAGE TITLE			
LPDDR3 VREF MARGINING			
 Apple Inc.	DRAWING NUMBER		SIZE
	051-00647		D
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	BRANCH		
	dvt-fab10		
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	SHEET	21 OF 121	

## D

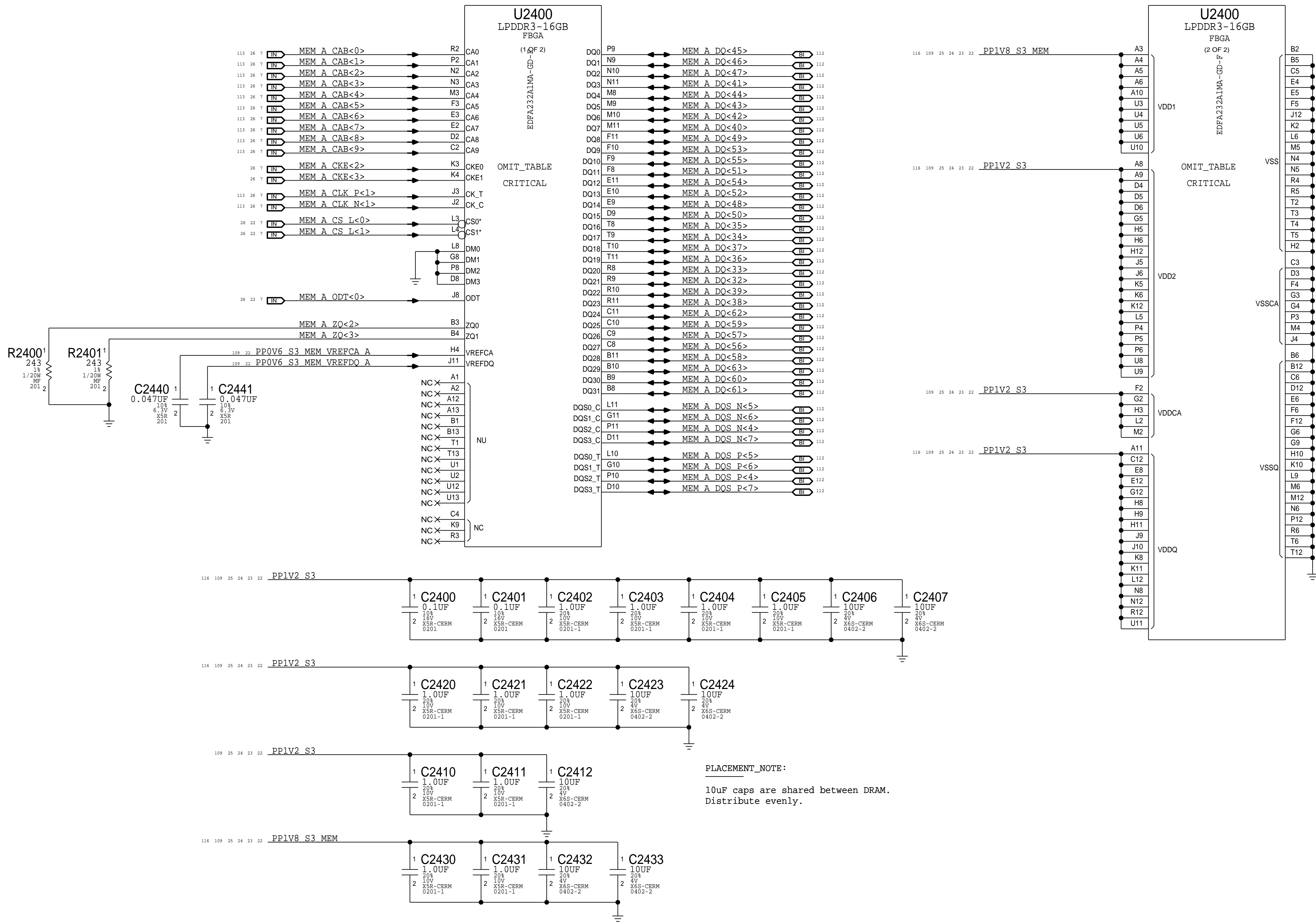
D


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B

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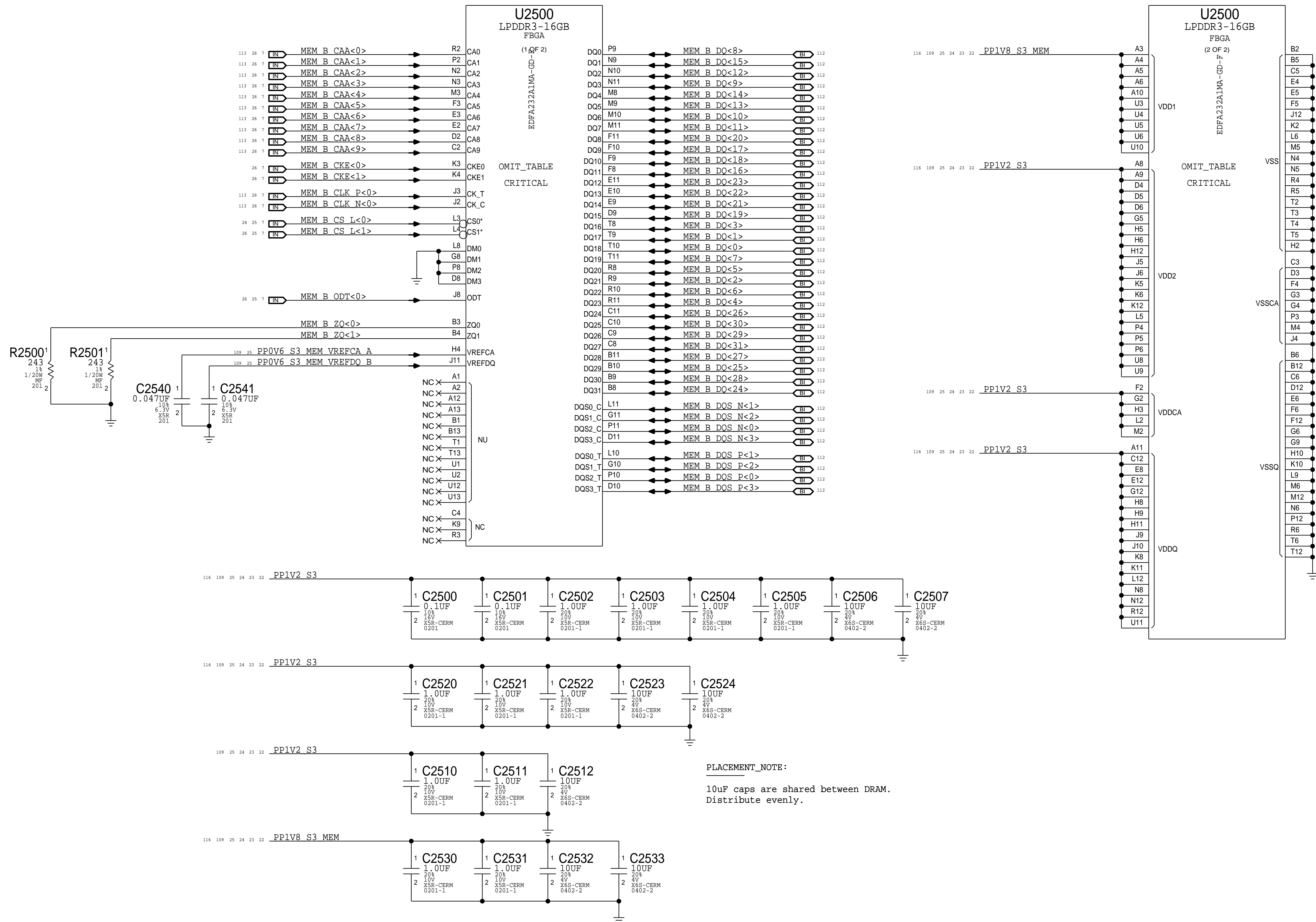
LPDDR3 CHANNEL A (32-63)




SYNC_MASTER=J80_MLB		SYNC_DATE=11/06/2015	
PAGE TITLE			
LPDDR3 DRAM Channel A (32-63)			
 Apple Inc.	DRAWING NUMBER	051-00647	SIZE
	REVISION	10.0.0	
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	PAGE	24 OF 145	
	SHEET	23 OF 121	

BOM\_COST\_GROUP=DRAM

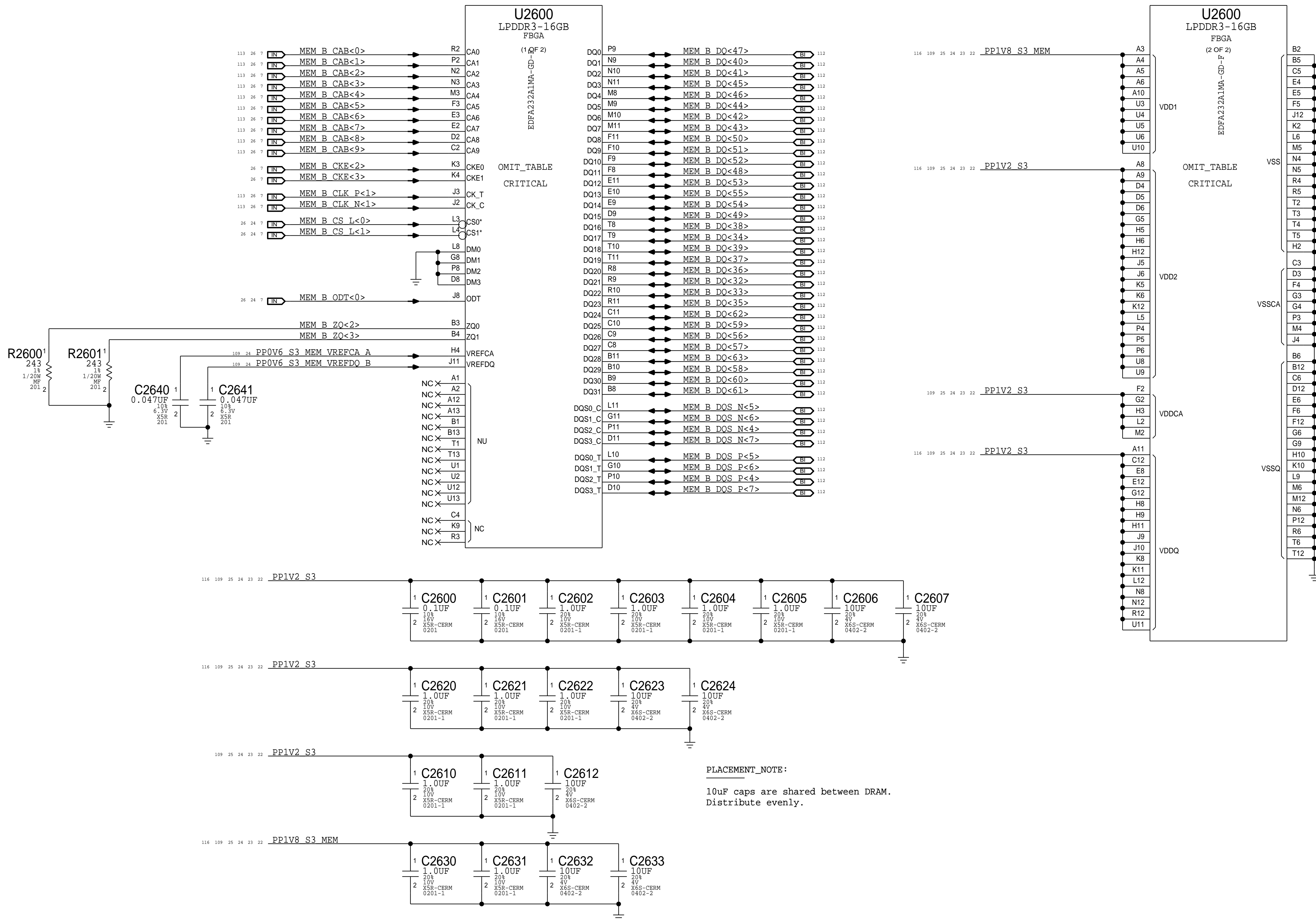
# LPDDR3 CHANNEL B (0-31)




SYNC_MASTER=J80_MLB		SYNC_DATE=11/06/2015	
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LPDDR3 DRAM Channel B (0-31)			
	Apple Inc.	DRAWING NUMBER	051-00647
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		PAGE	25 OF 145
		SHEET	24 OF 121

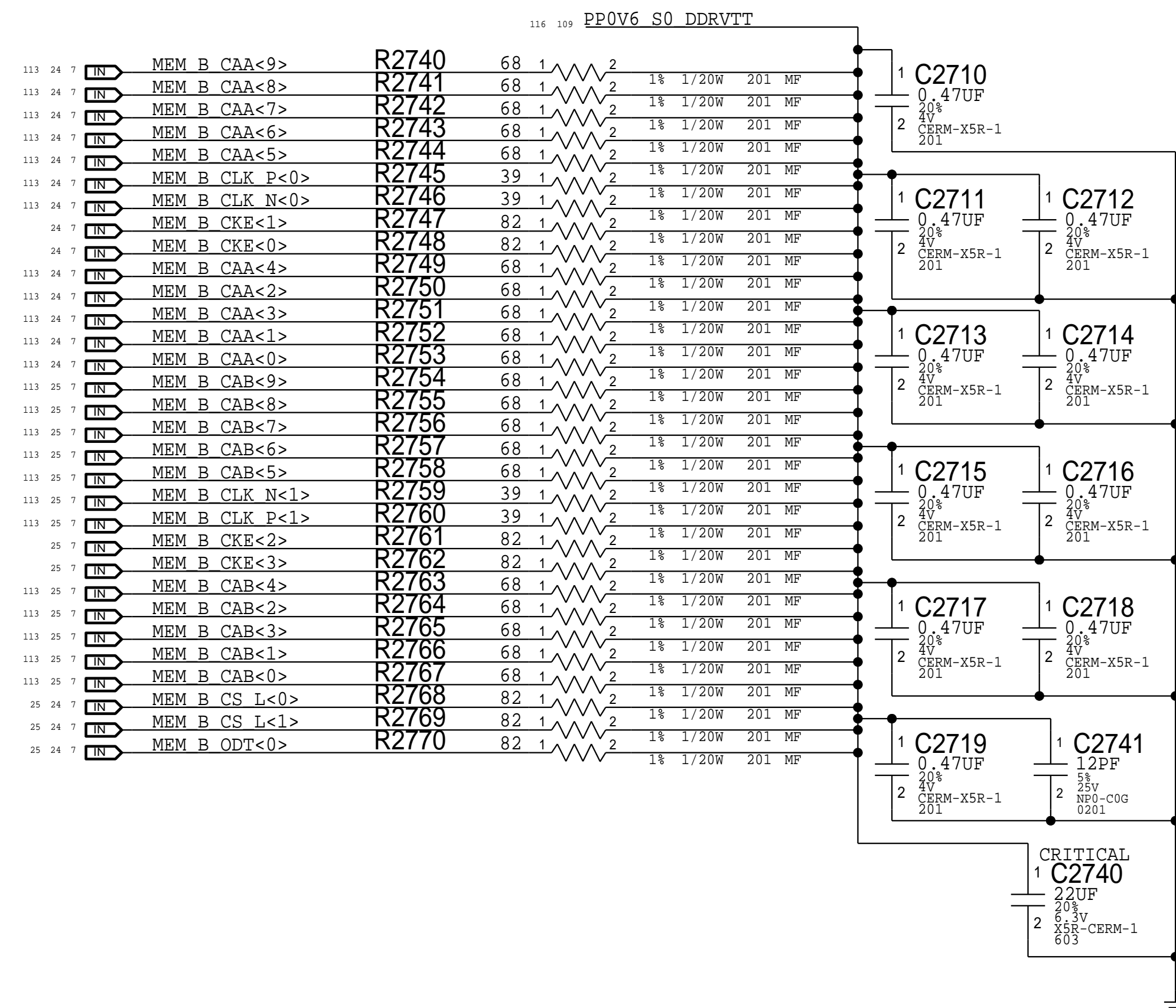
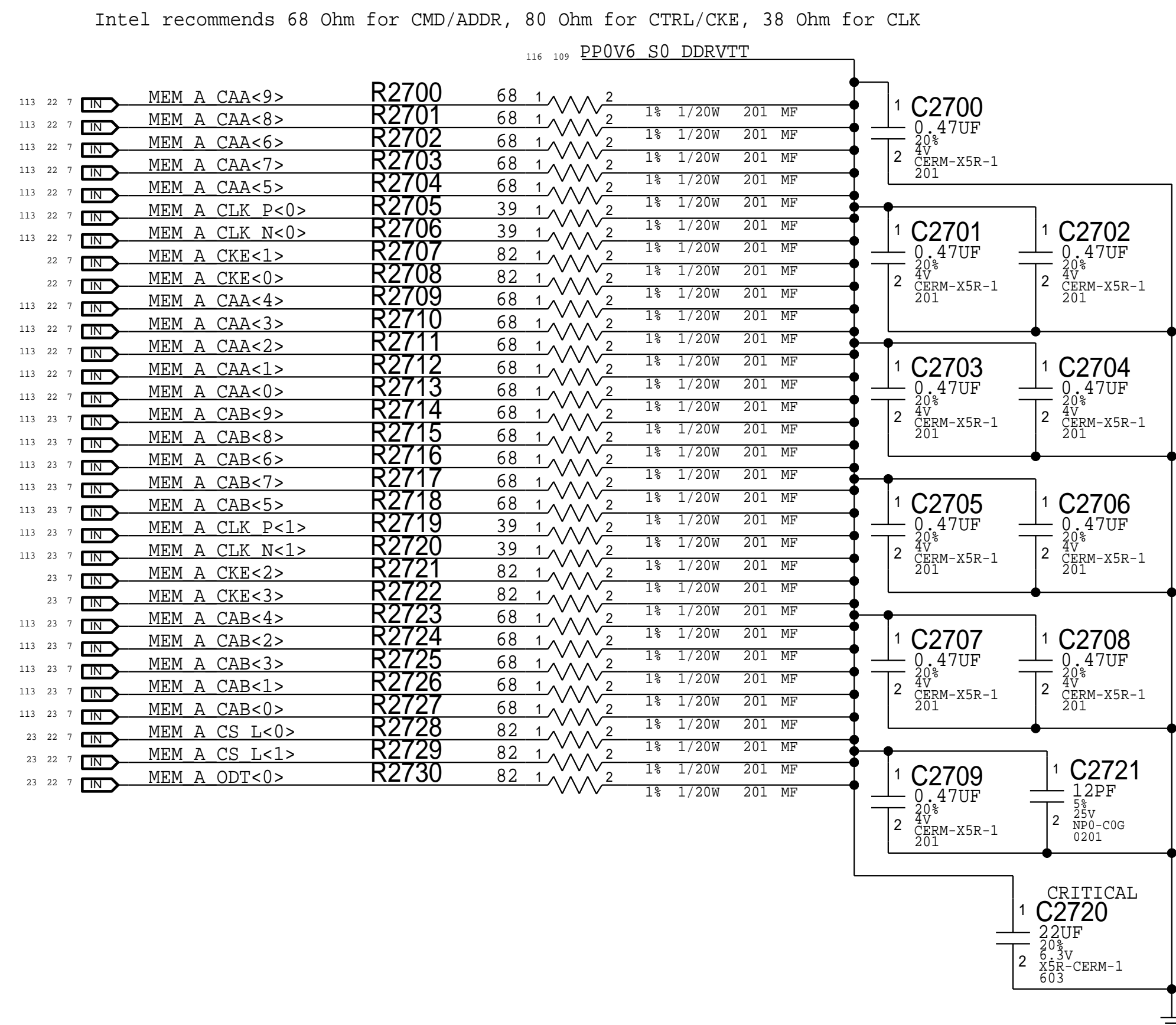


# LPDDR3 CHANNEL B (32-63)

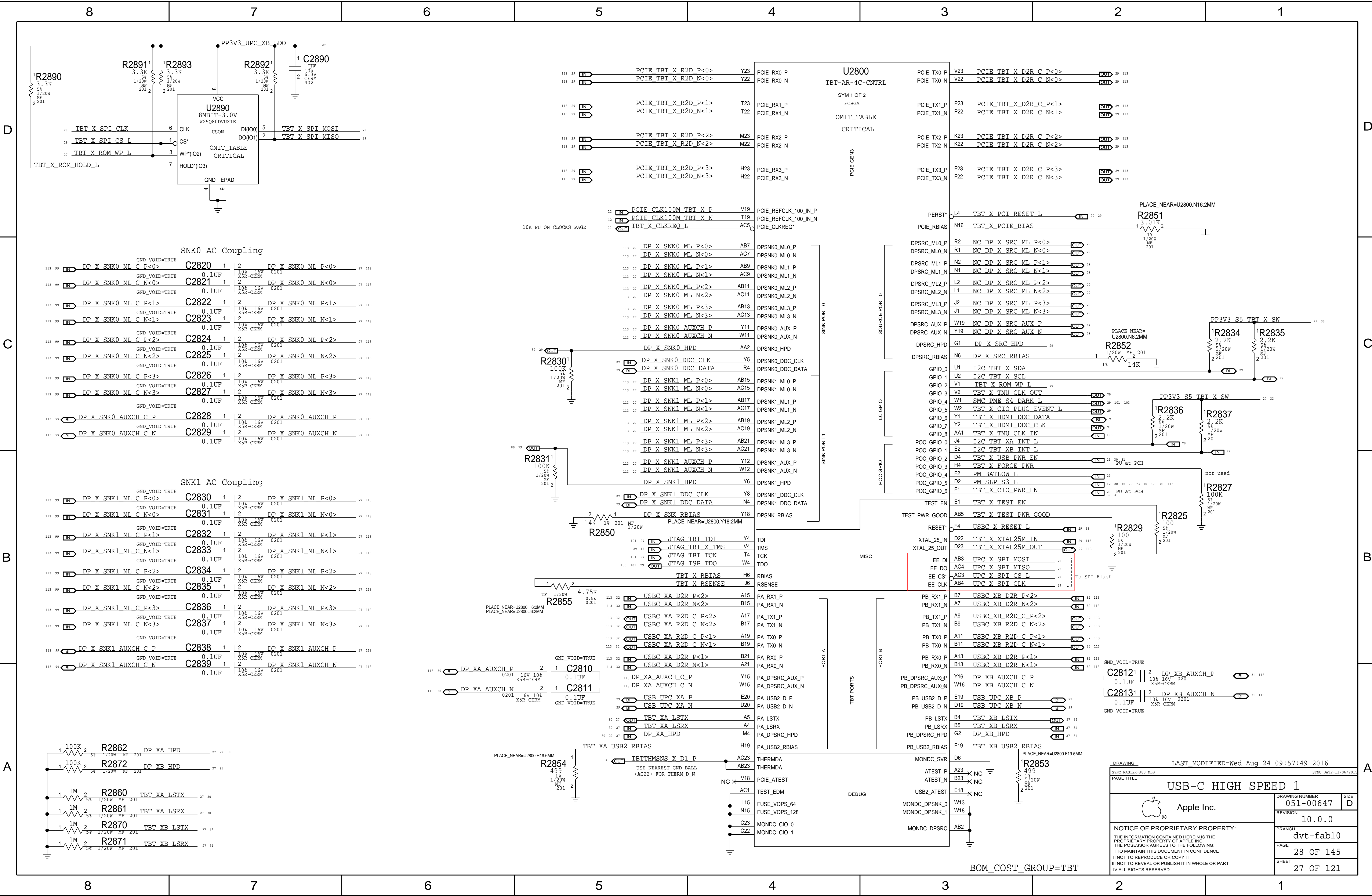


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LPDDR3 DRAM Channel B (32-63)				
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		SHEET	25 OF 121	

BOM\_COST\_GROUP=DRAM







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LAST\_MODIFIED=Wed Aug 24 09:57:49 2016

SYNC\_MASTER=780\_MLB

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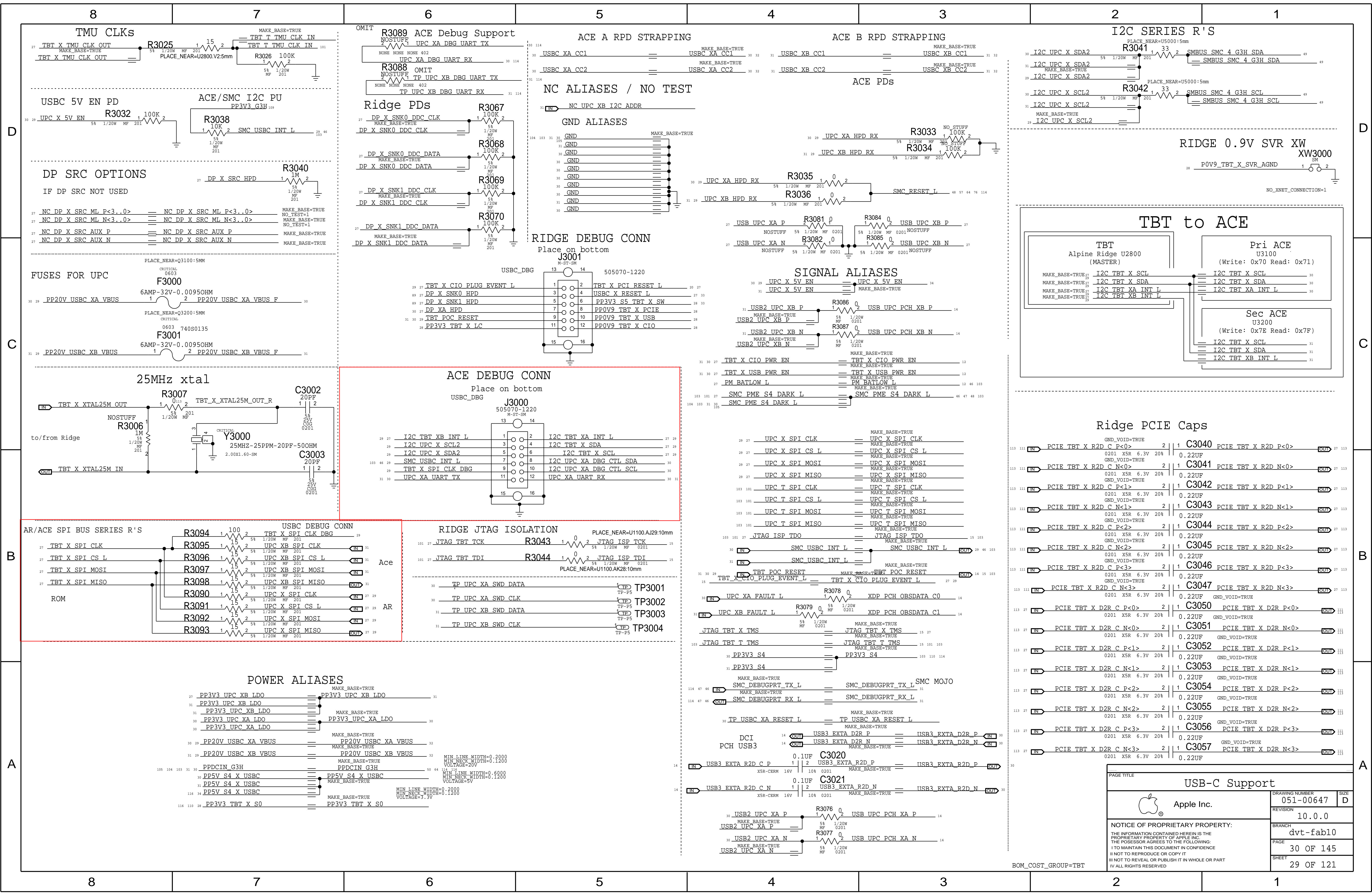
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27 OF 121

BOM\_COST\_GROUP=TBT

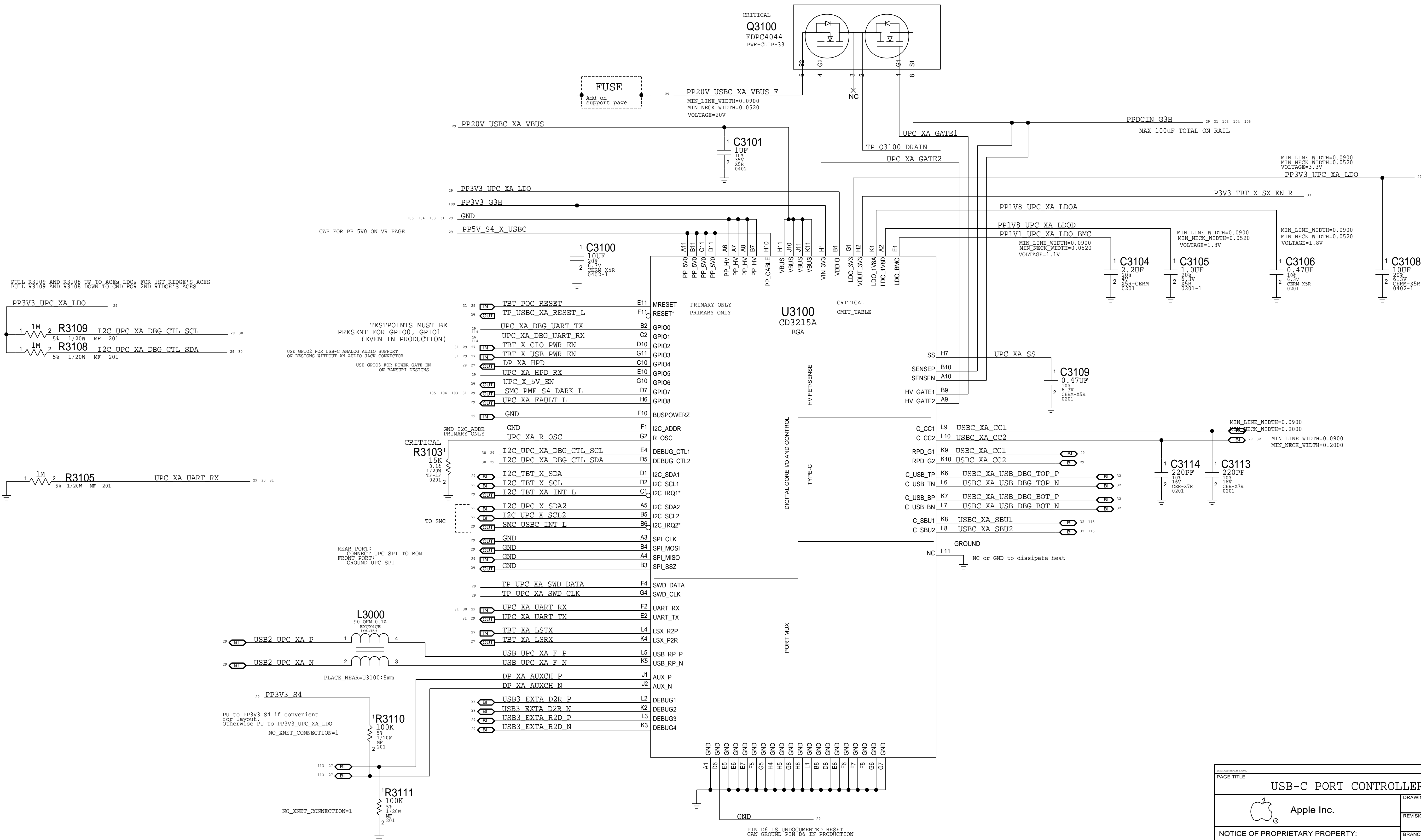








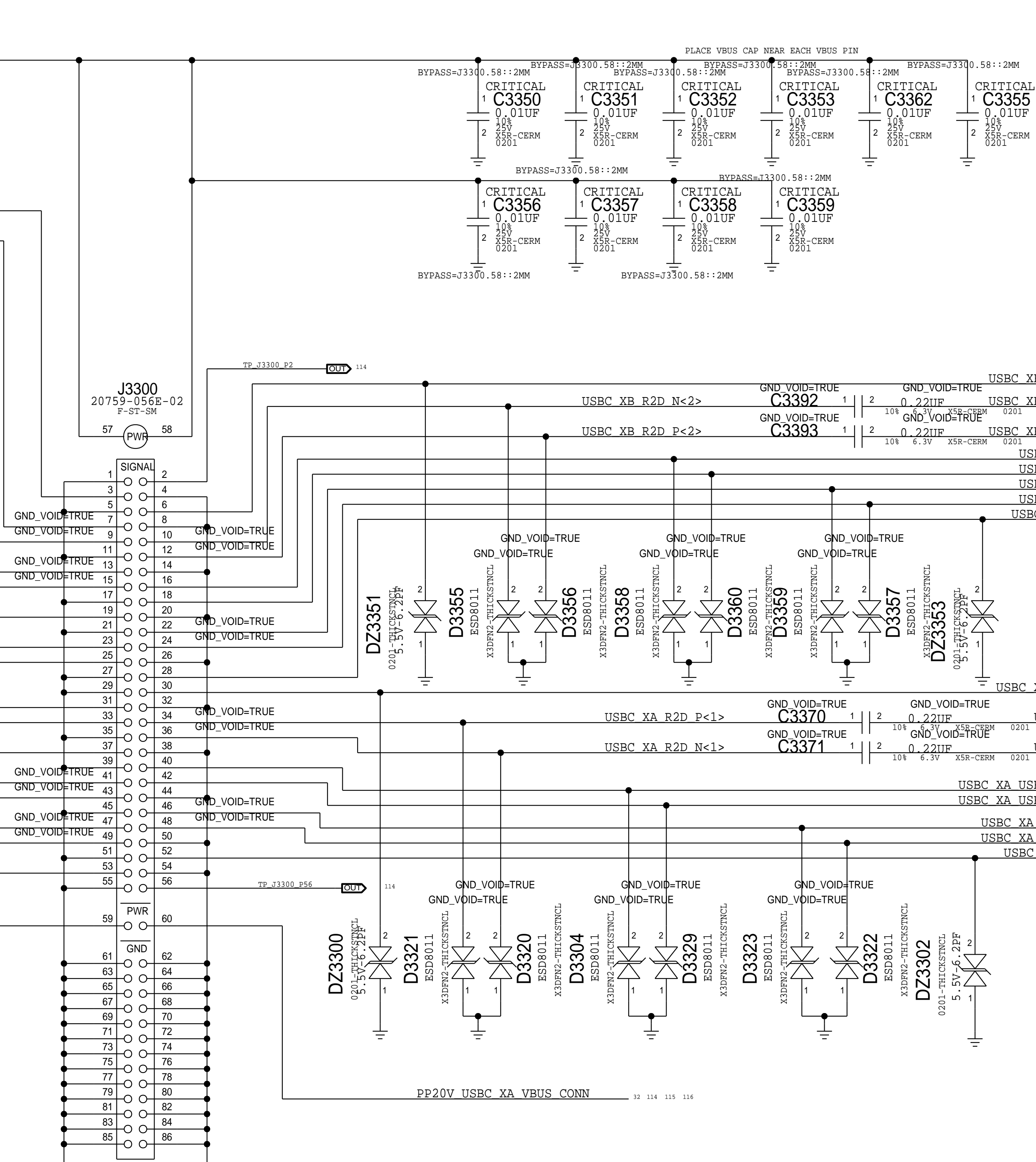
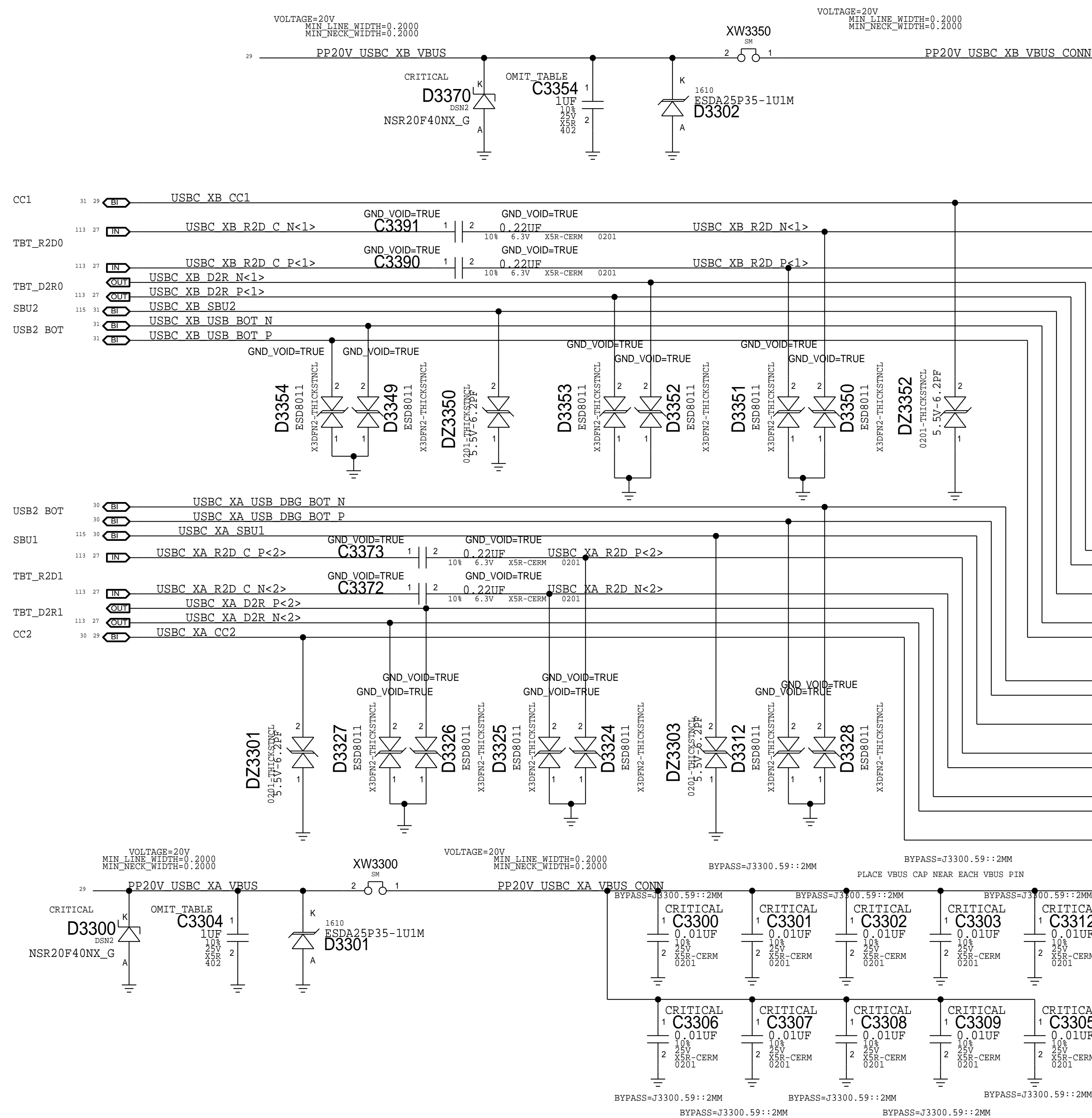
PRIMARY ACE USB-C PORT CONTROLLER (UPC)




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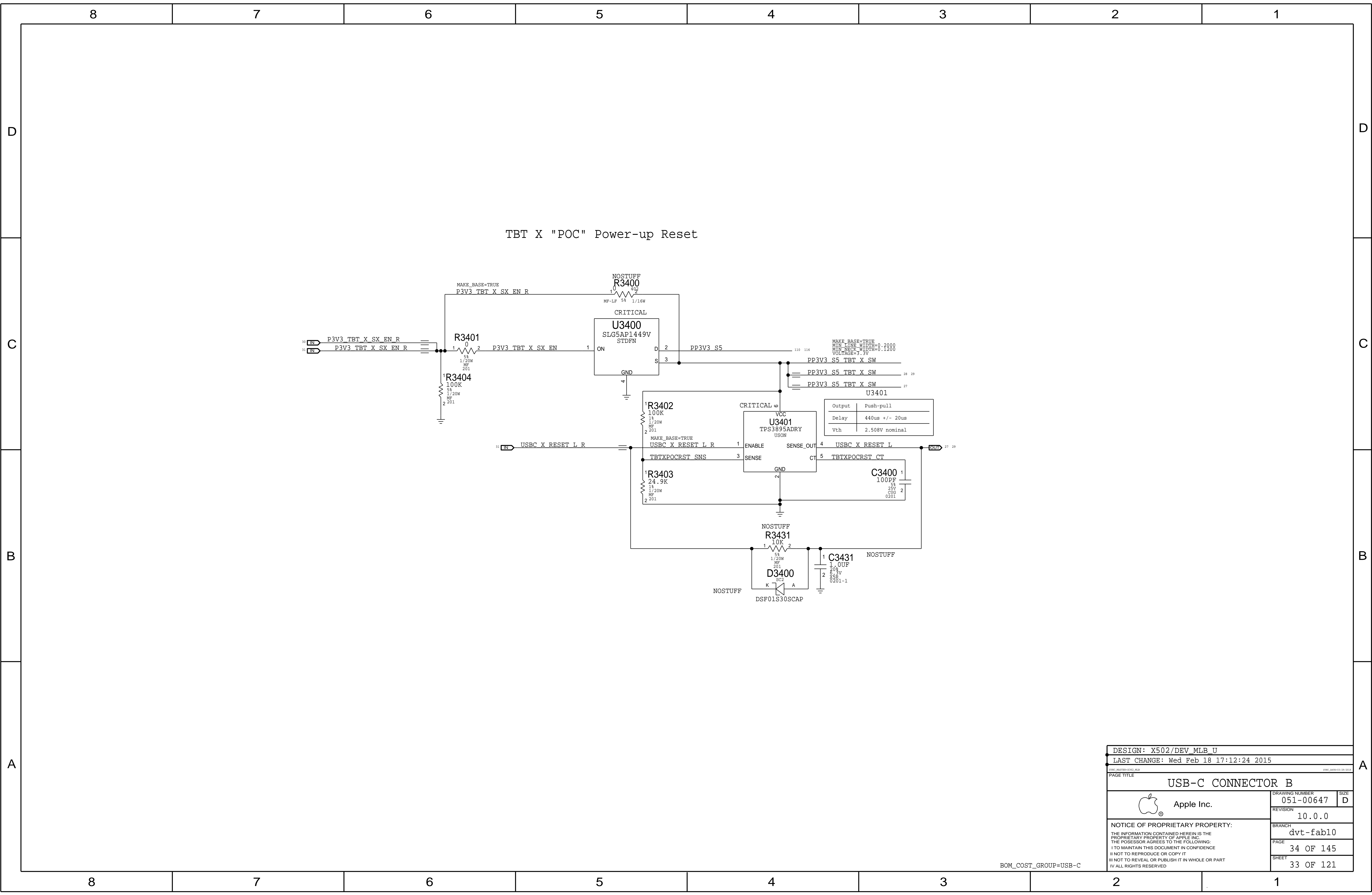
PAGE TITLE			PAGE TITLE		
USB-C PORT CONTROLLER A			DRAWING NUMBER		
			051-00647		SIZE
			10.0.0		D
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			PAGE		31 OF 145
			SHEET		30 OF 121





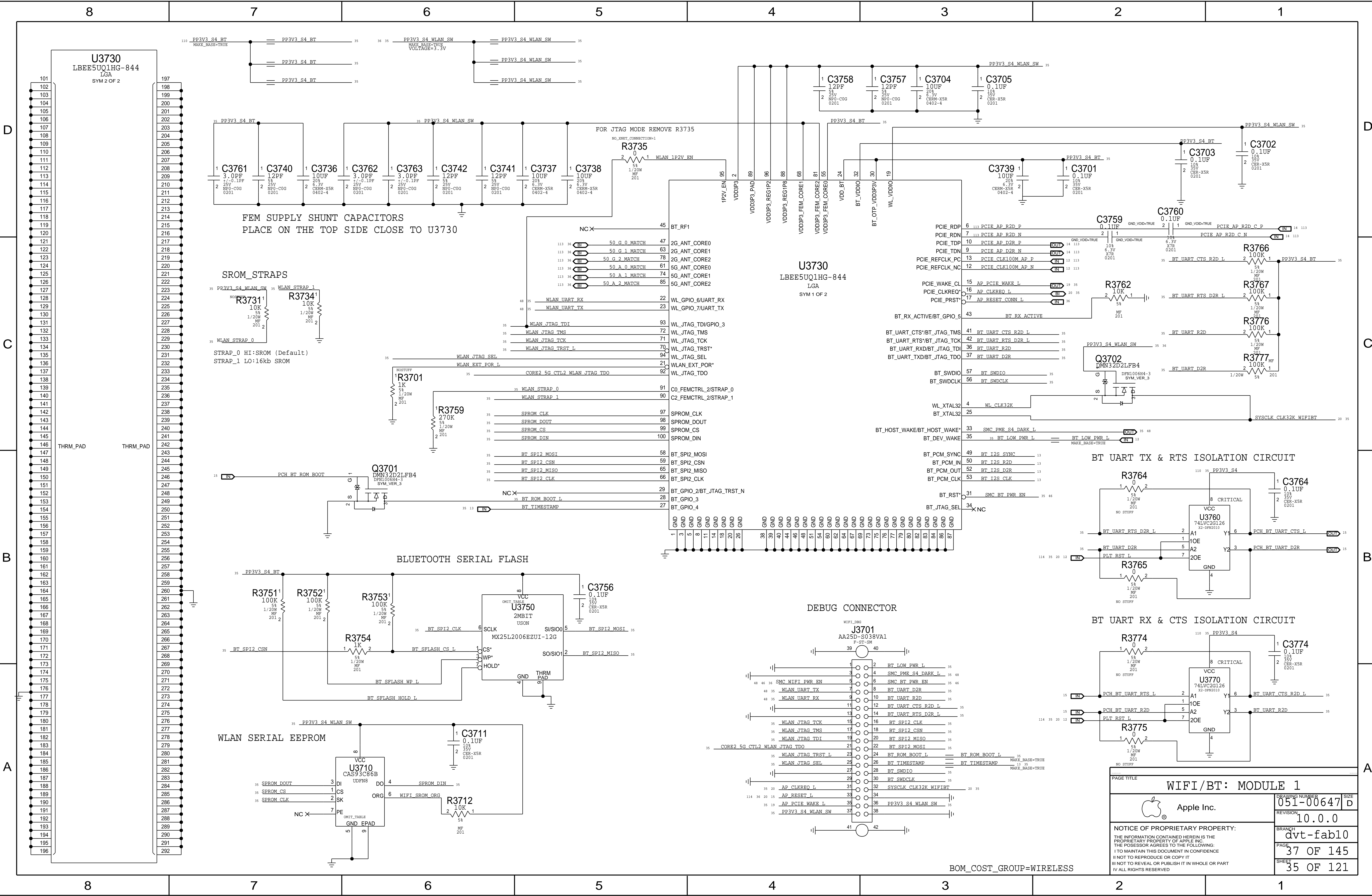
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138S0683	2	CAP,CER,XSR,10F,10\$,25V,0402	C3304, C3354	CRITICAL	NOSTUFF

LAST CHANGE: Wed Apr 1 22:57:37 2015			
PAGE TITLE			
USB-C CONNECTOR A			
 Apple Inc.	DRAWING NUMBER		SIZE
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D

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A

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C

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PAGE TITLE			
WIFI/BT: MODULE 1			
 Apple Inc.	DRAWING NUMBER	051-00647	SIZE
	REVISION	10.0.0	D
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		PAGE	37 OF 145
		SHEET	35 OF 121

BOM\_COST\_GROUP=WIRELESS

D

C

B

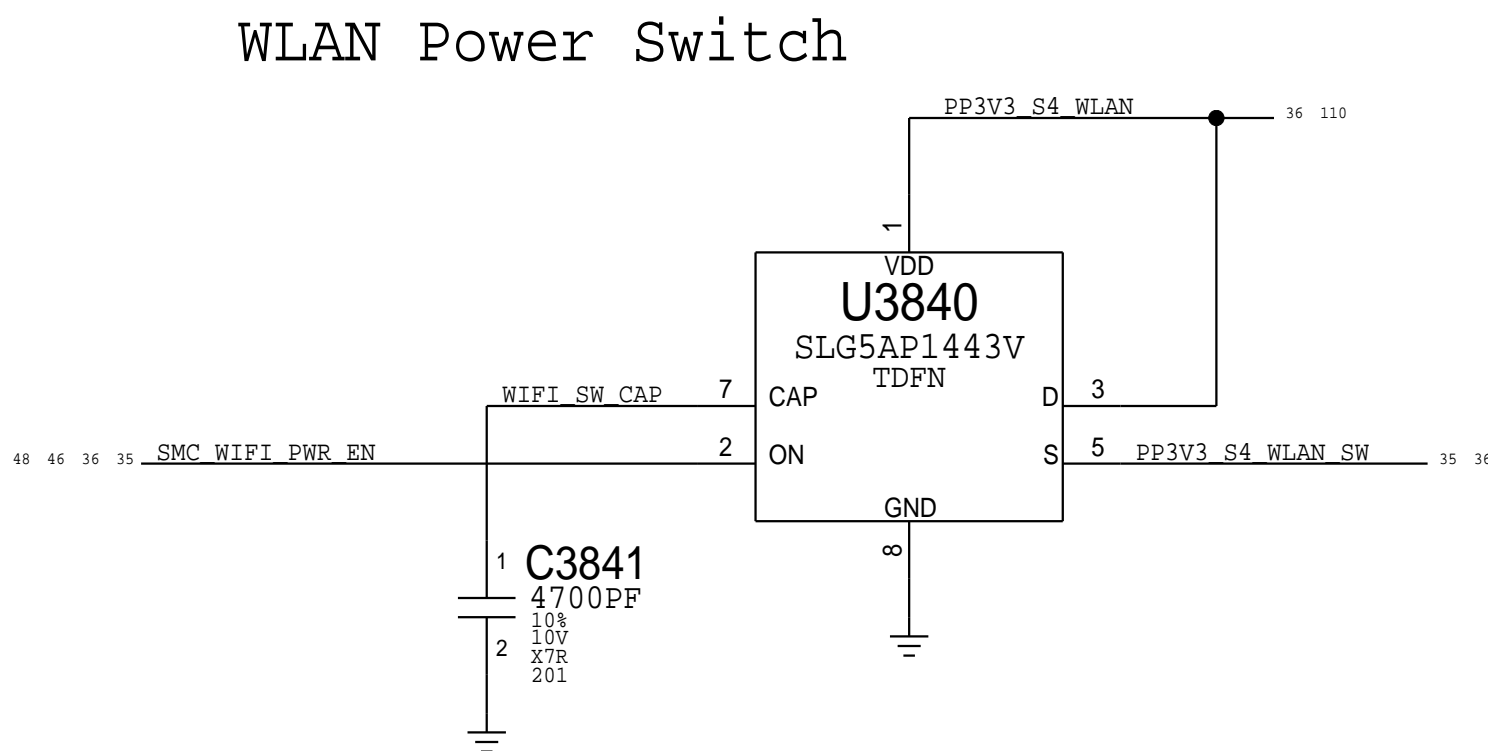
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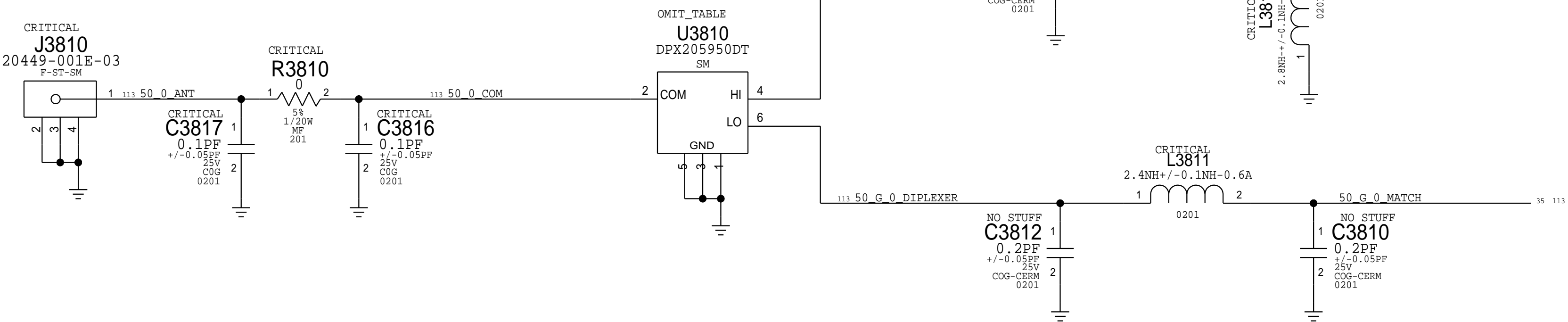
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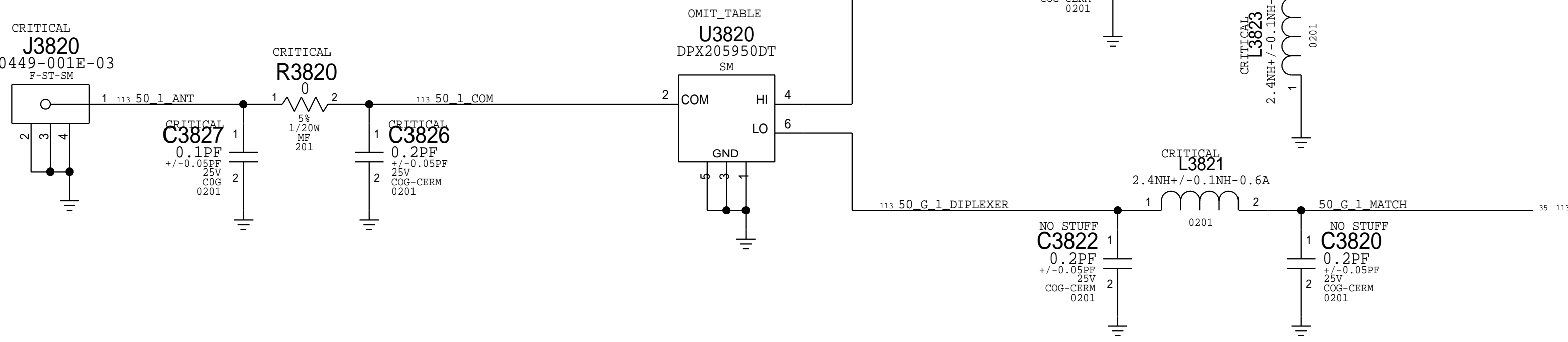
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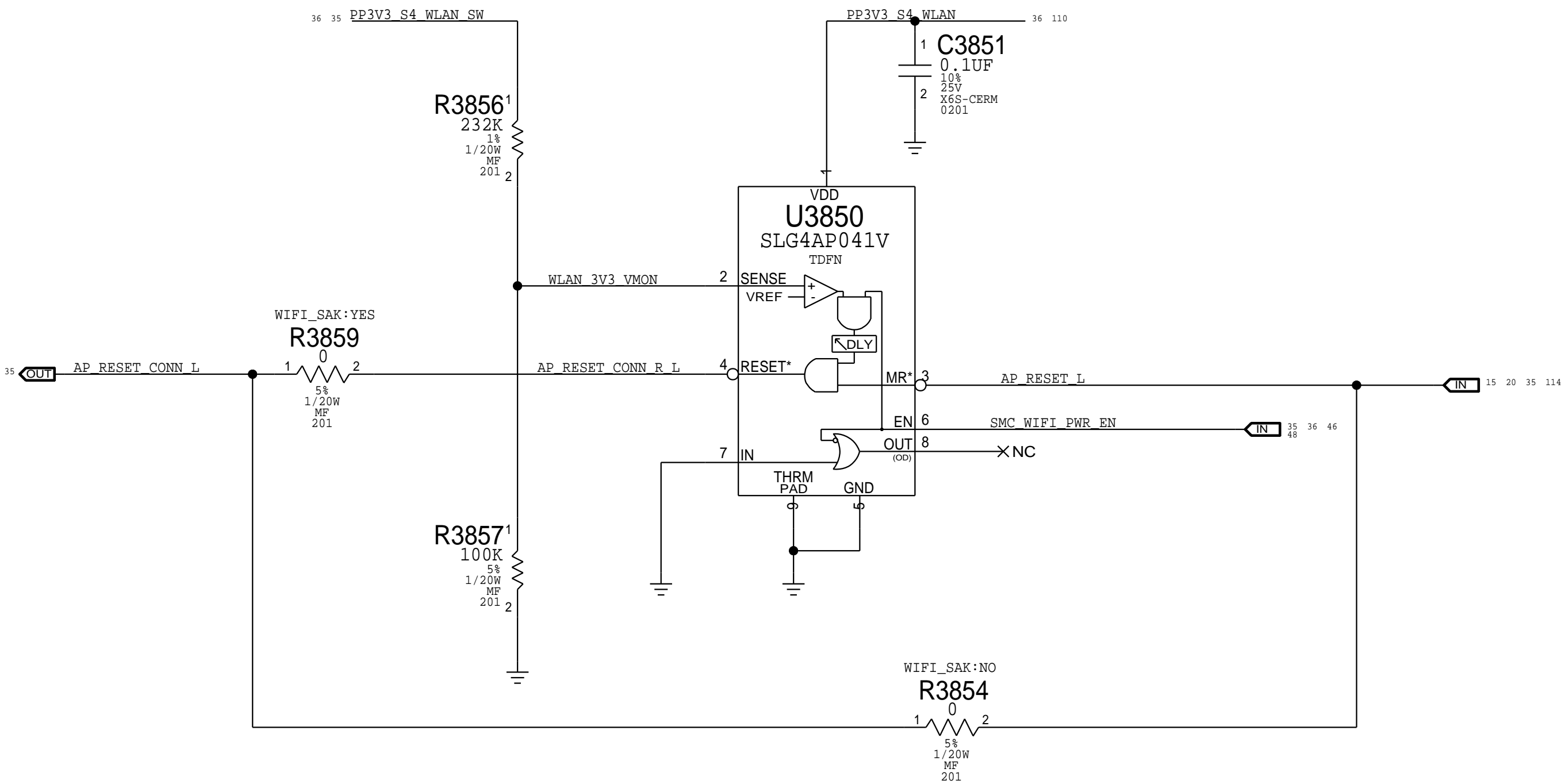
CORE0 DIPLEXER AND MATCHING



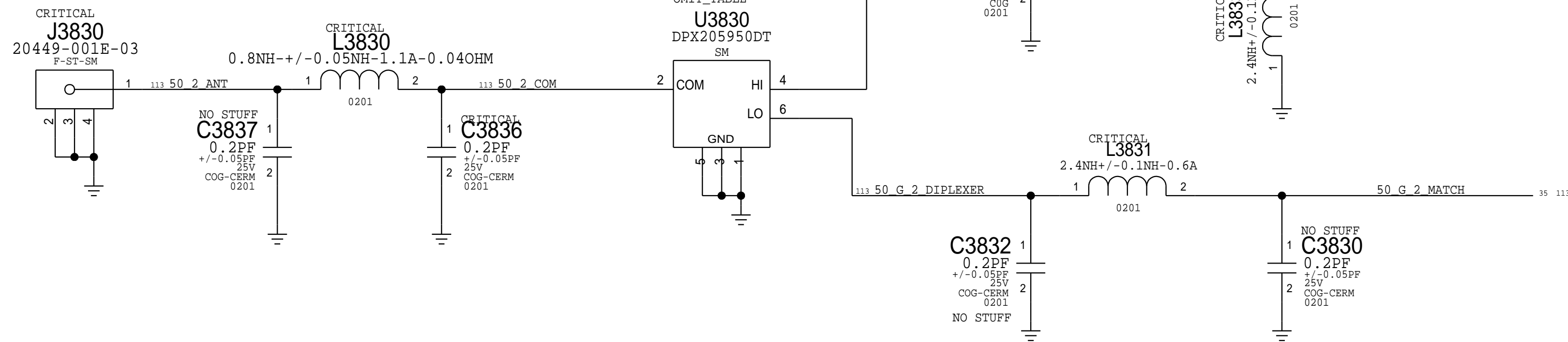
CORE1 DIPLEXER AND MATCHING




Supervisor & CLKREQ# Isolation  
Delay = 130ms +/- 20%



CORE2 DIPLEXER AND MATCHING



BOM\_COST\_GROUP=WIRELESS

SYNC_MASTER=J80_MLB		SYNC_DATE=11/06/2015	
PAGE TITLE			
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 Apple Inc.		DRAWING NUMBER	051-00647
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		PAGE	38 OF 145
		SHEET	36 OF 121

PART NUMBER	QTY	DESCRIPTION	REFERENCE DES	CRITICAL	BOM OPTION
343S00136	1	IC,M8+512MB 208M DDR,A12,S,8CK,BGA700	U3900	CRITICAL	SOC:HYNIX

PART NUMBER	QTY	DESCRIPTION	REFERENCE DES	CRITICAL	BOM OPTION
338S00147	1	IC,RTM2,DEV,PN549A1,P61D0	U3905	CRITICAL	SE:DEV
338S00097	1	IC,RTM2,MP,PN549A1,P61D0	U3905	CRITICAL	SE:PROD

T208

D

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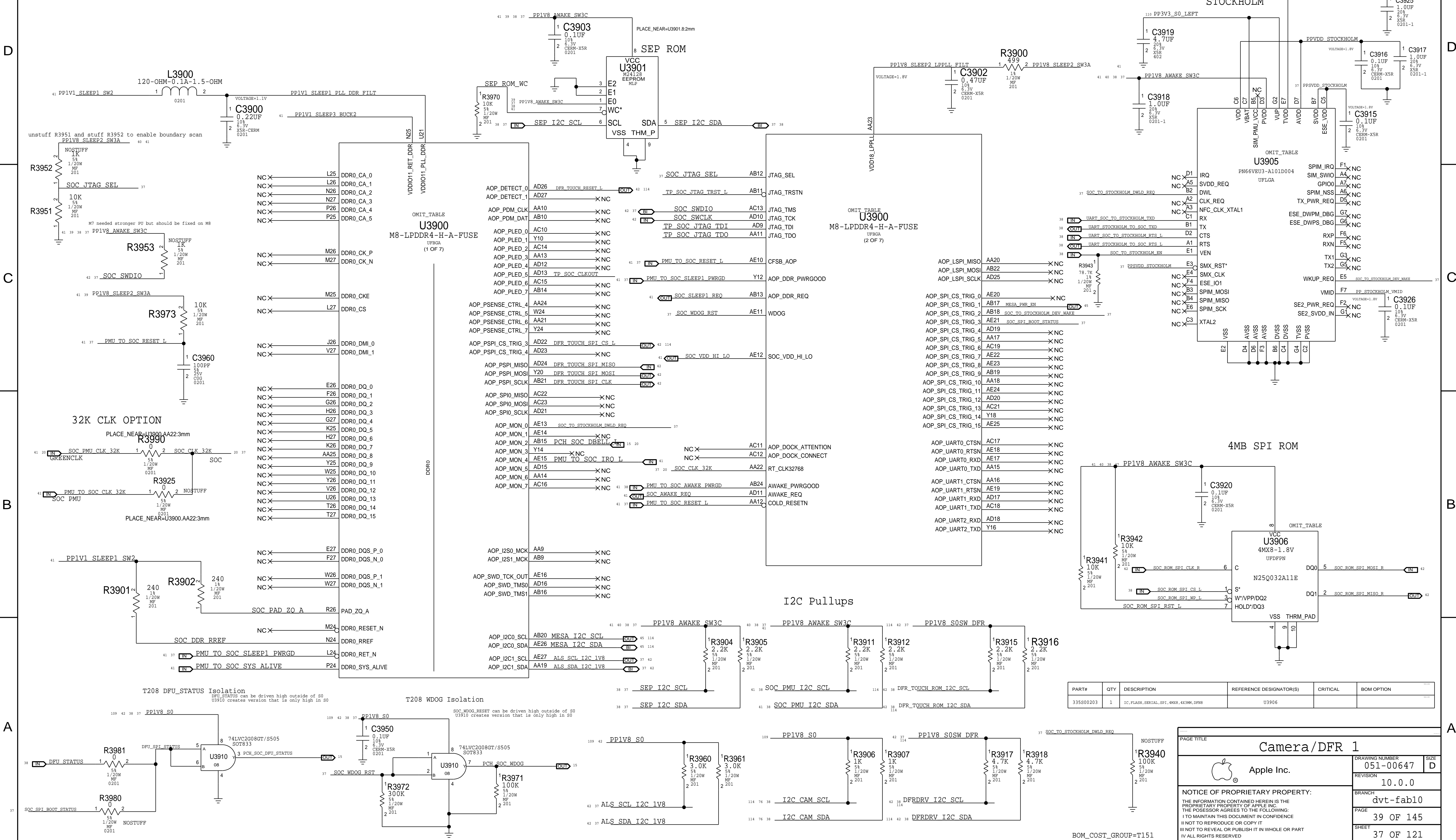
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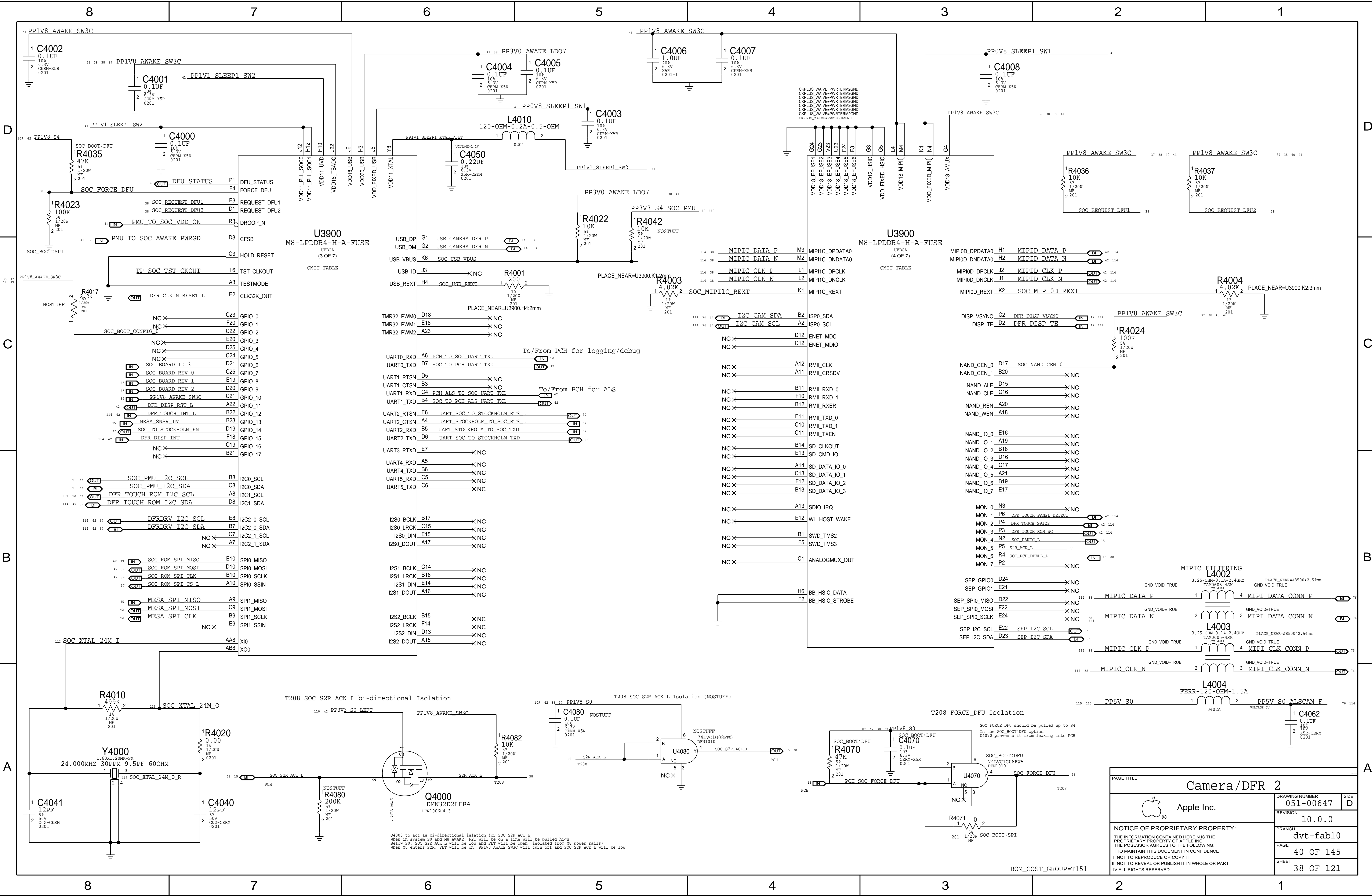
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PART#	QTY	DESCRIPTION	REFERENCE DESIGNATOR(S)	CRITICAL	BOM OPTION
335S00203	1	IC,FLASH,SERIAL,SPI,4MX8,4KX36M,DFNR	U3906		

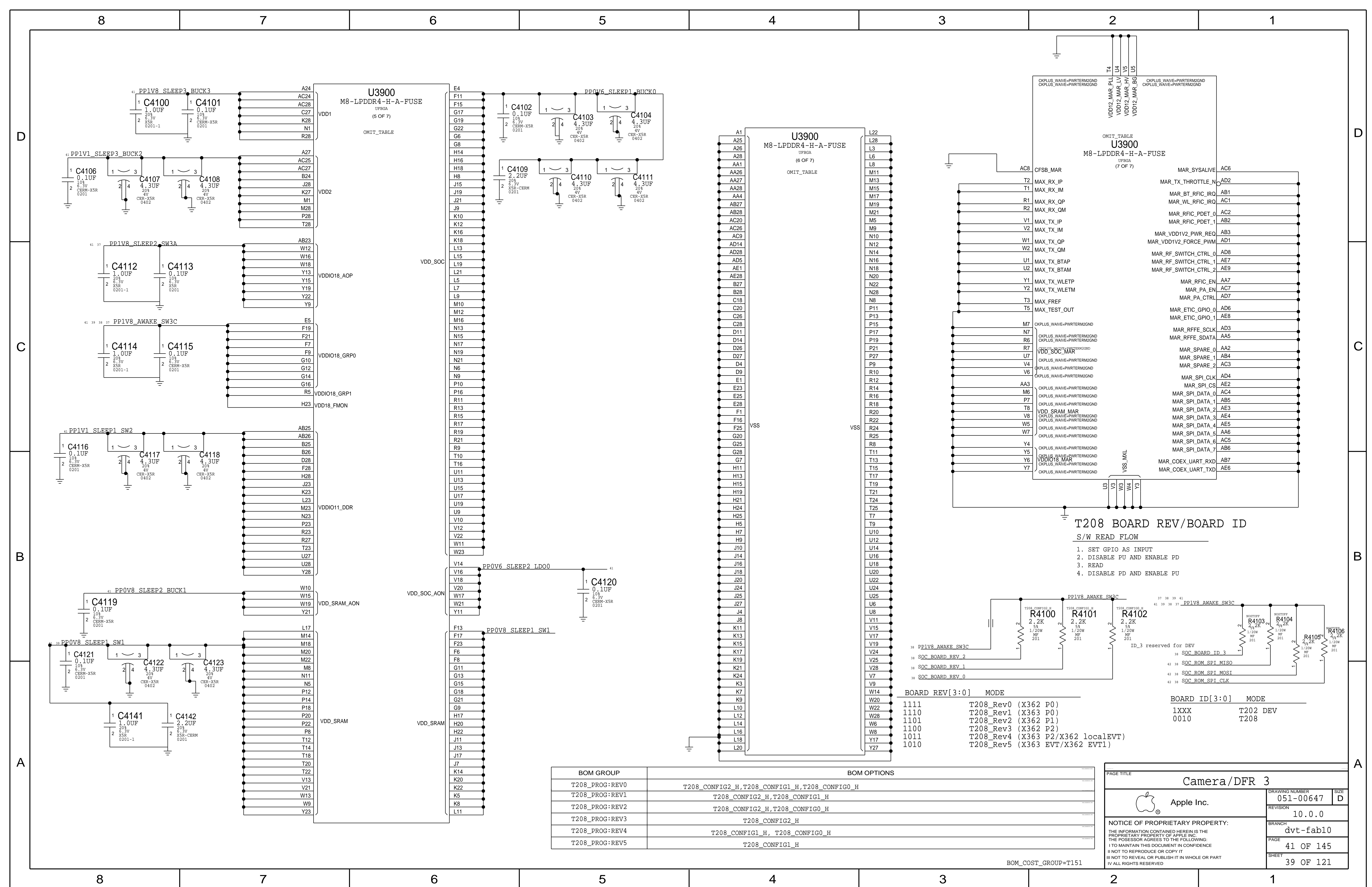
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BRANCH dvt-fab10	SHEET 37 OF 121



PAGE TITLE		Camera/DFR 2	
DRAWING NUMBER		051-00647	SIZE
REVISION		10.0.0	D
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PAGE		40 OF 145	
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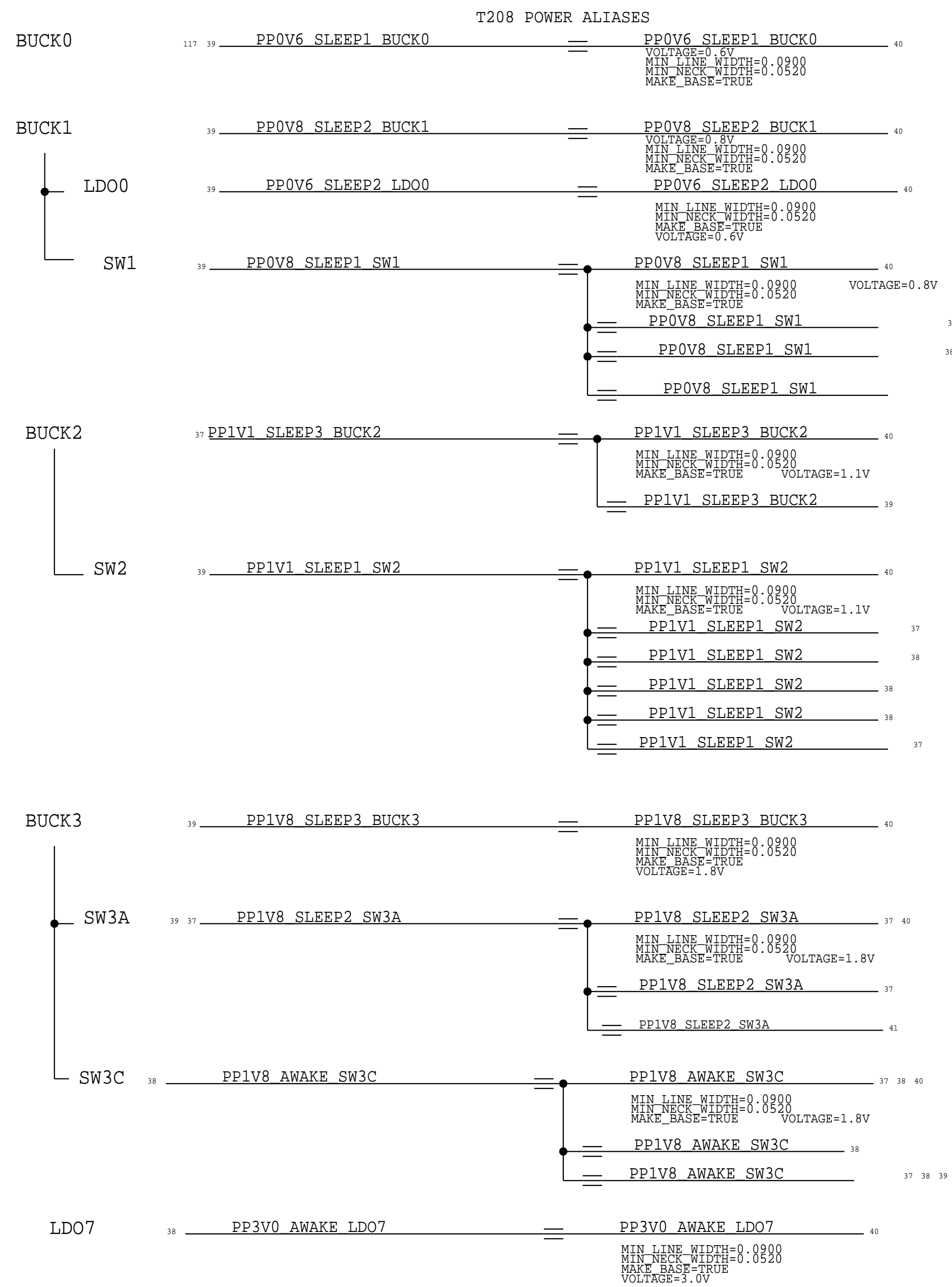
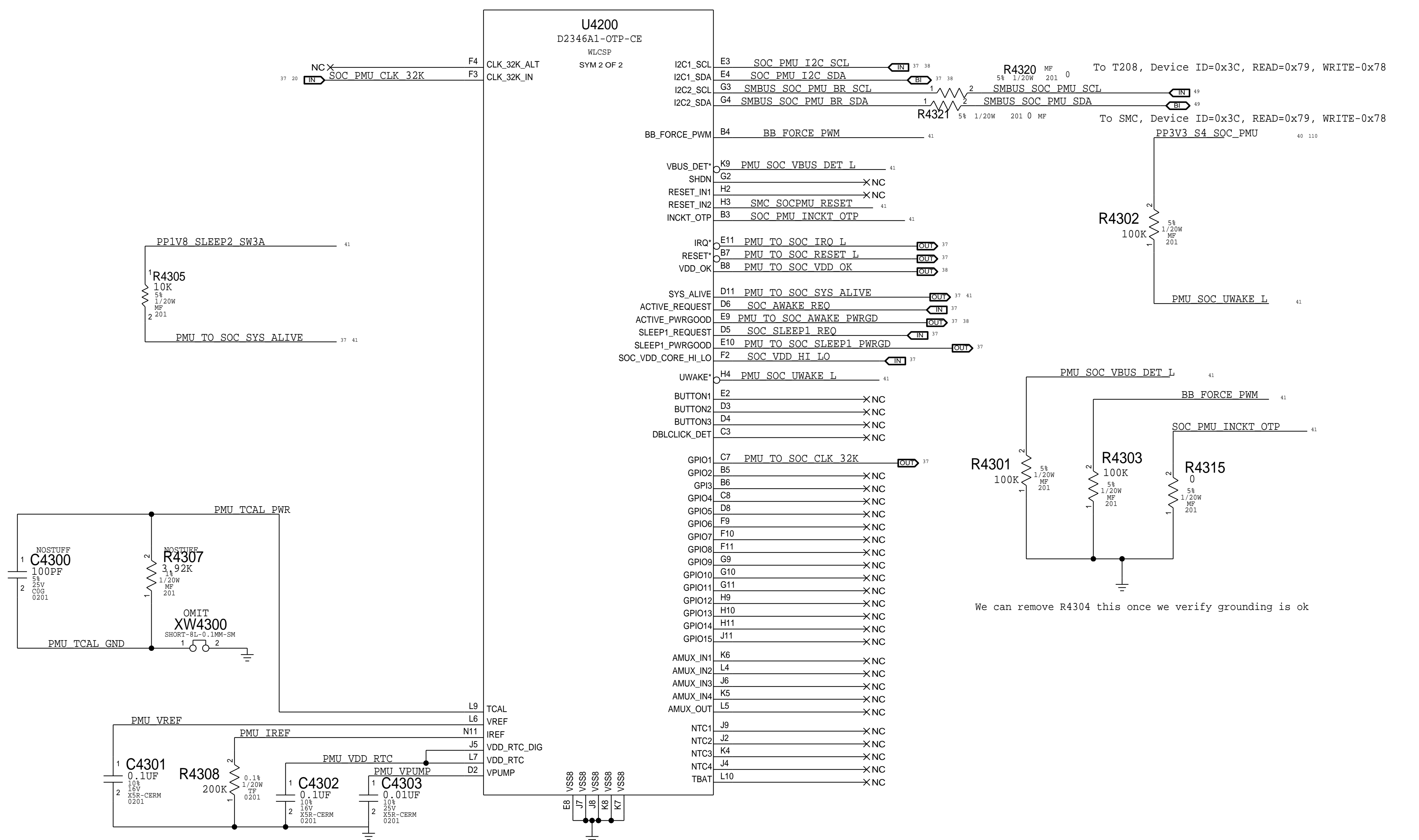









Berkelium - 2



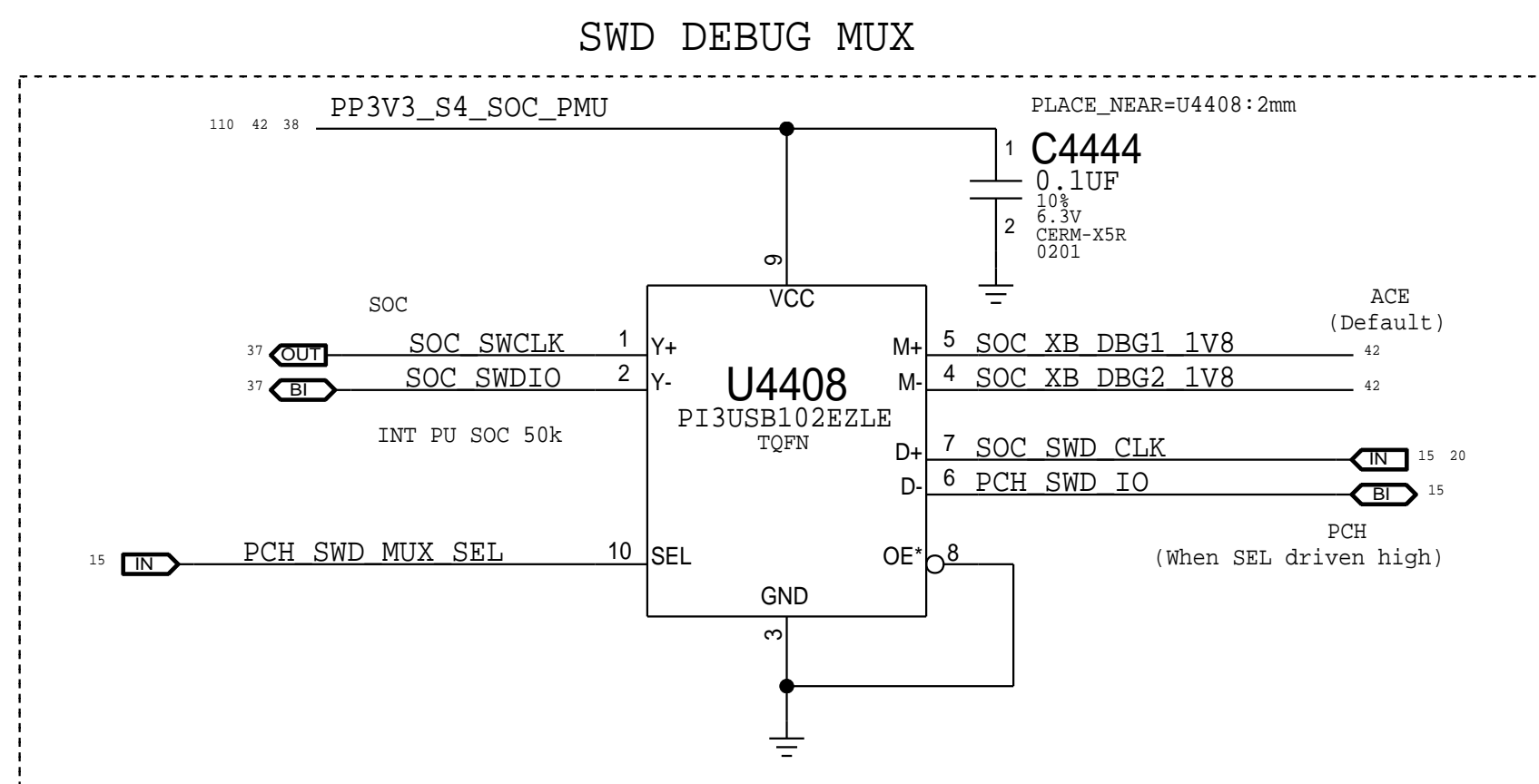
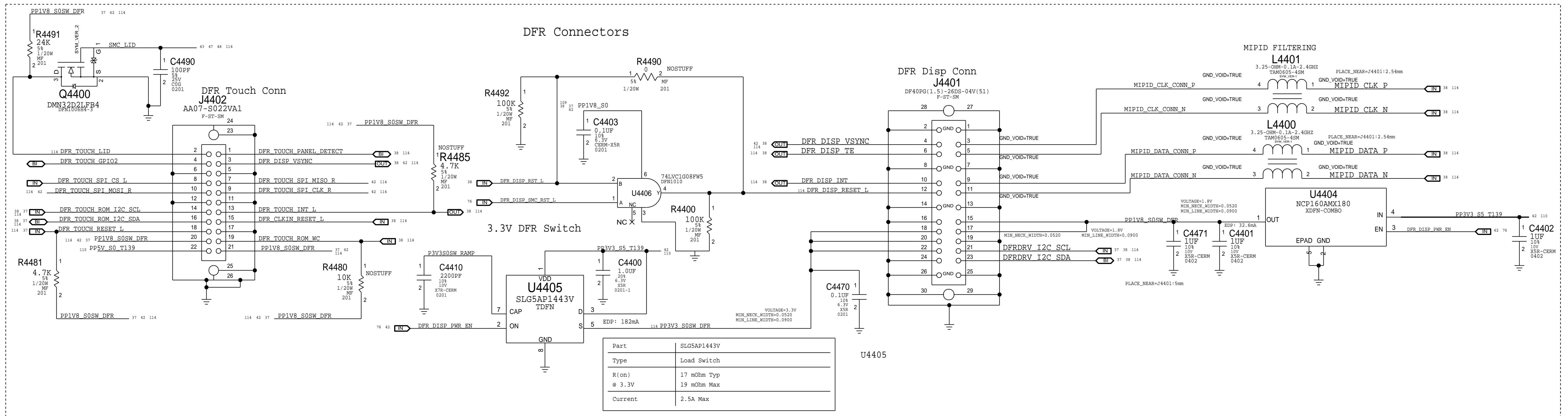
SMC SOCPMU RESET == SMC SOCPMU RESET MAKE\_BASE=TRUE

Signal Aliases

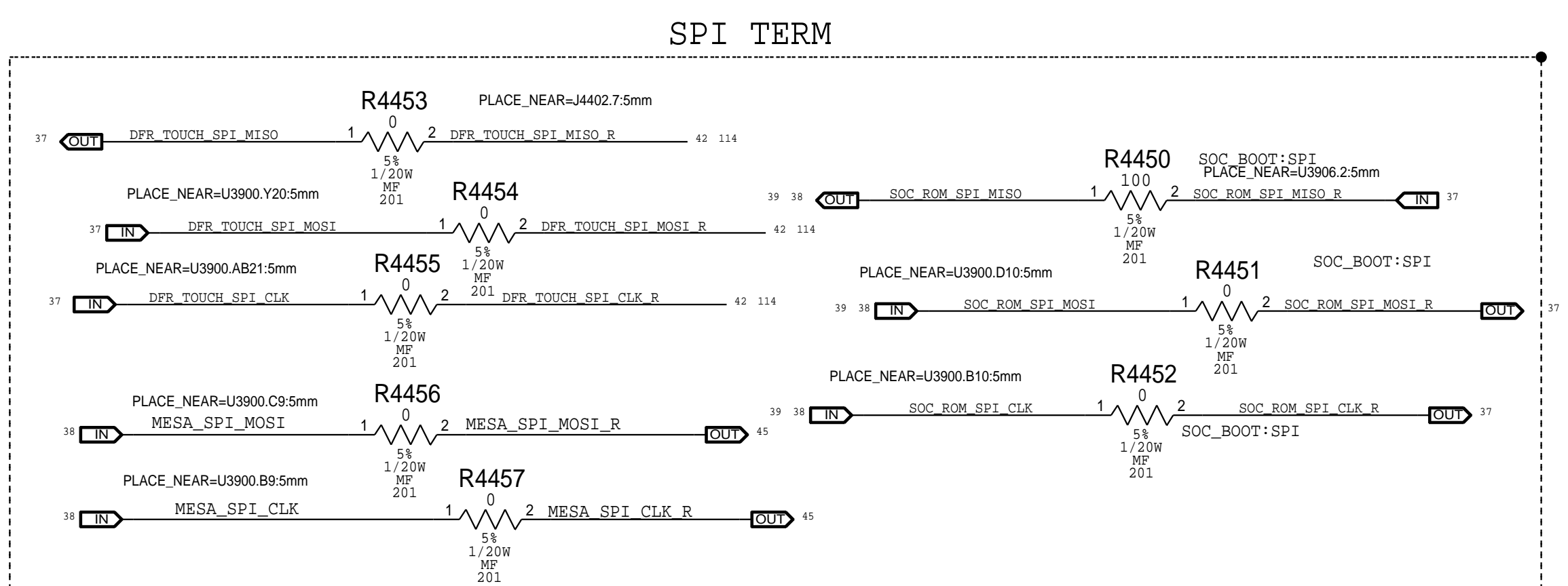
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Berkelium - 2			
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		PAGE	43 OF 145
		SHEET	41 OF 121

BOM\_COST\_GROUP=T151

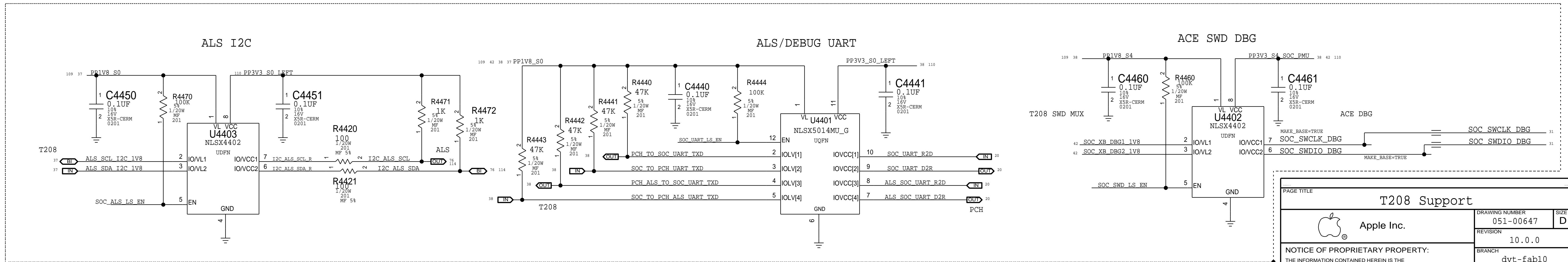
# T208 Support




Bus	Device	7-bit Address	8-bit Address	
			Read	Write
AP0	PMU	0011110 (0x3C)	0x79	0x78
AP1	Touch EEPROM	1010000 (0x50)	0xA1	0xA0
AP2_0	Tesla	1010100 (0x4C)	0x99	0x98
AOP0	Mesa EEPROM	101000x (0x50/0x51)	0xA1/A3	0xA0/A2
AOP1	ALS	0111001 (0x39)	0x73	0x72
SEP	M34128 EEPROM	1010001 (0x51)	0xA3	0xA2



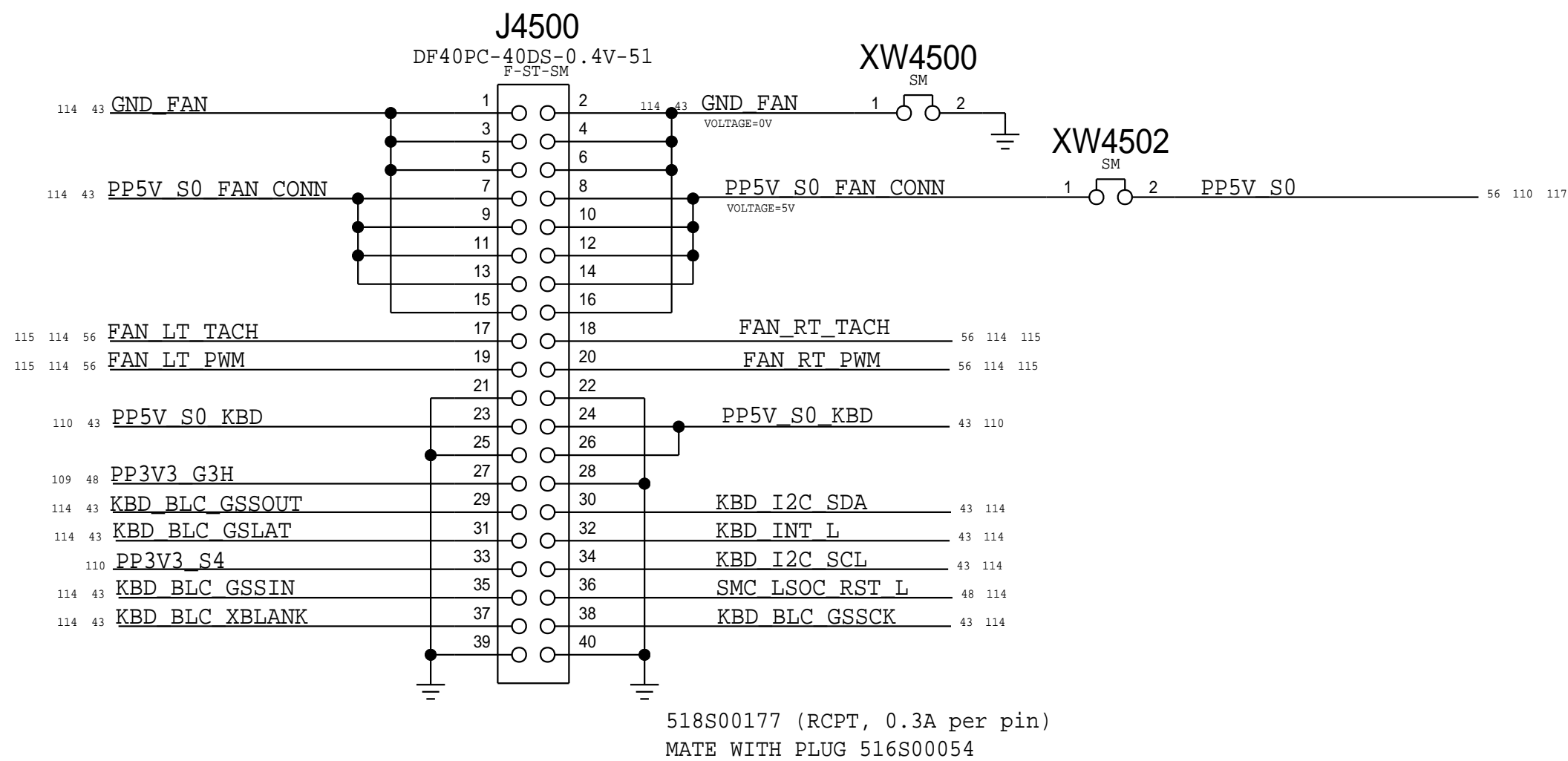
## T208 LEVEL SHIFTING



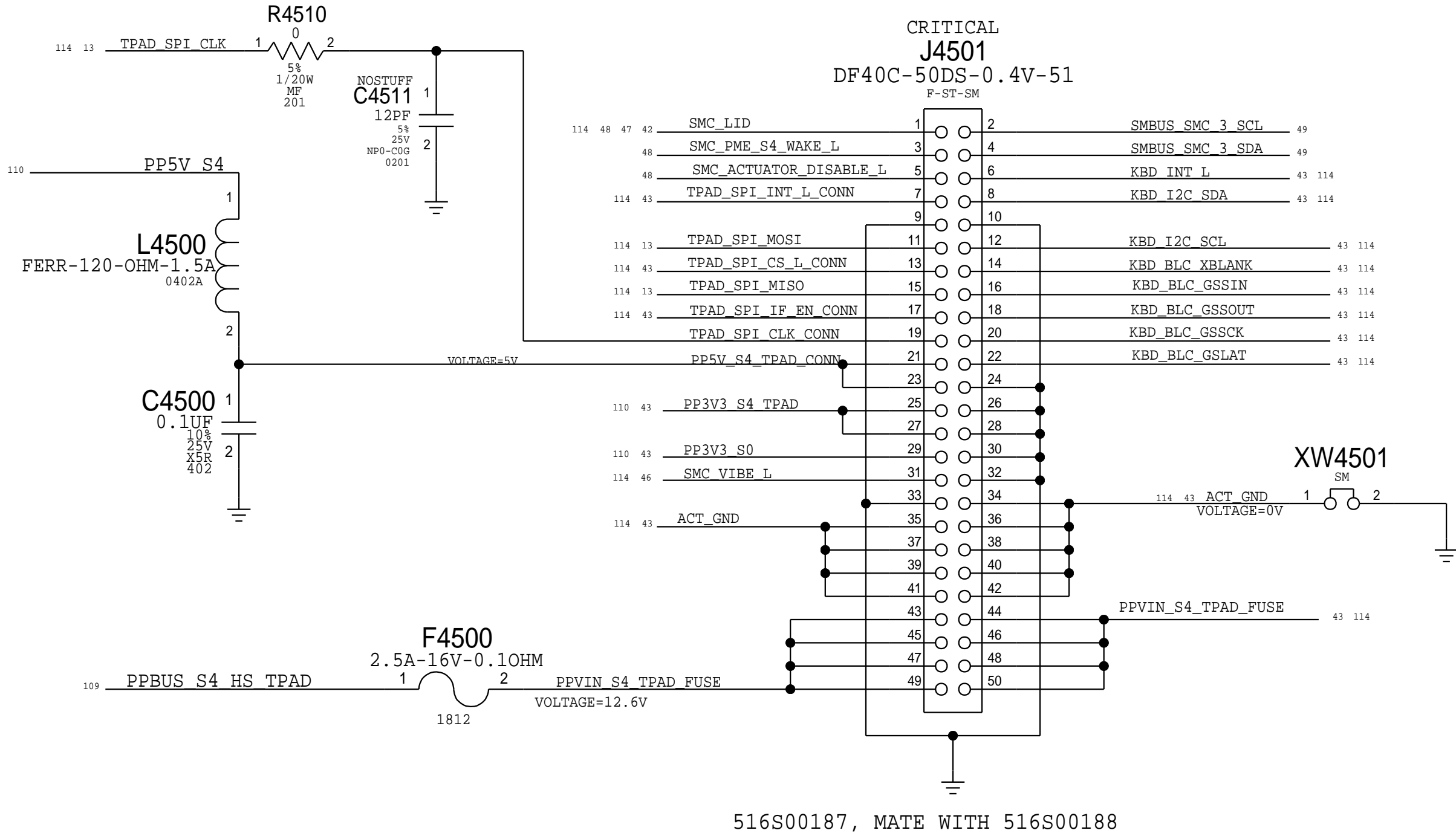
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 Apple Inc.	DRAWING NUMBER	051-00647	
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		SHEET	42 OF 121

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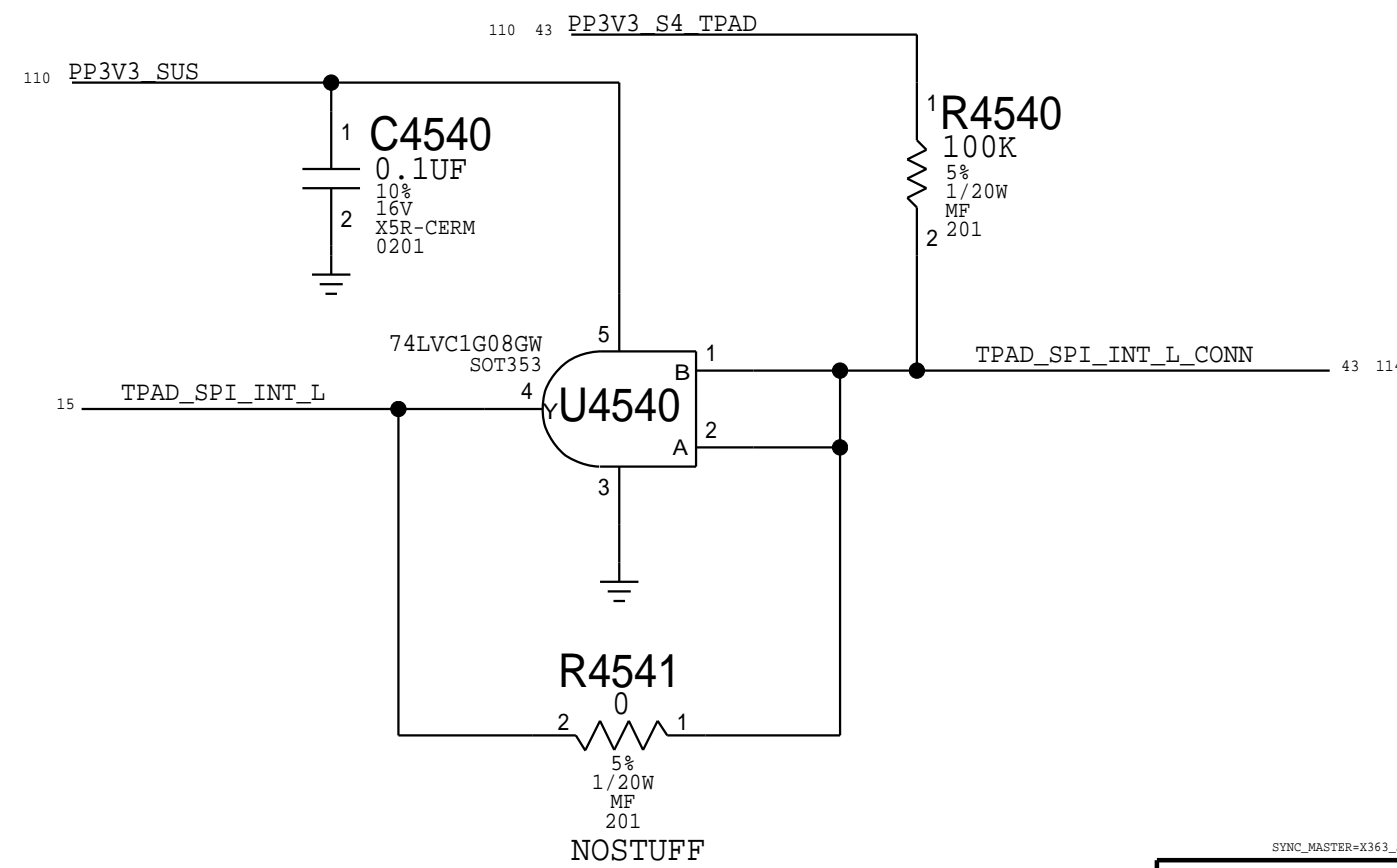
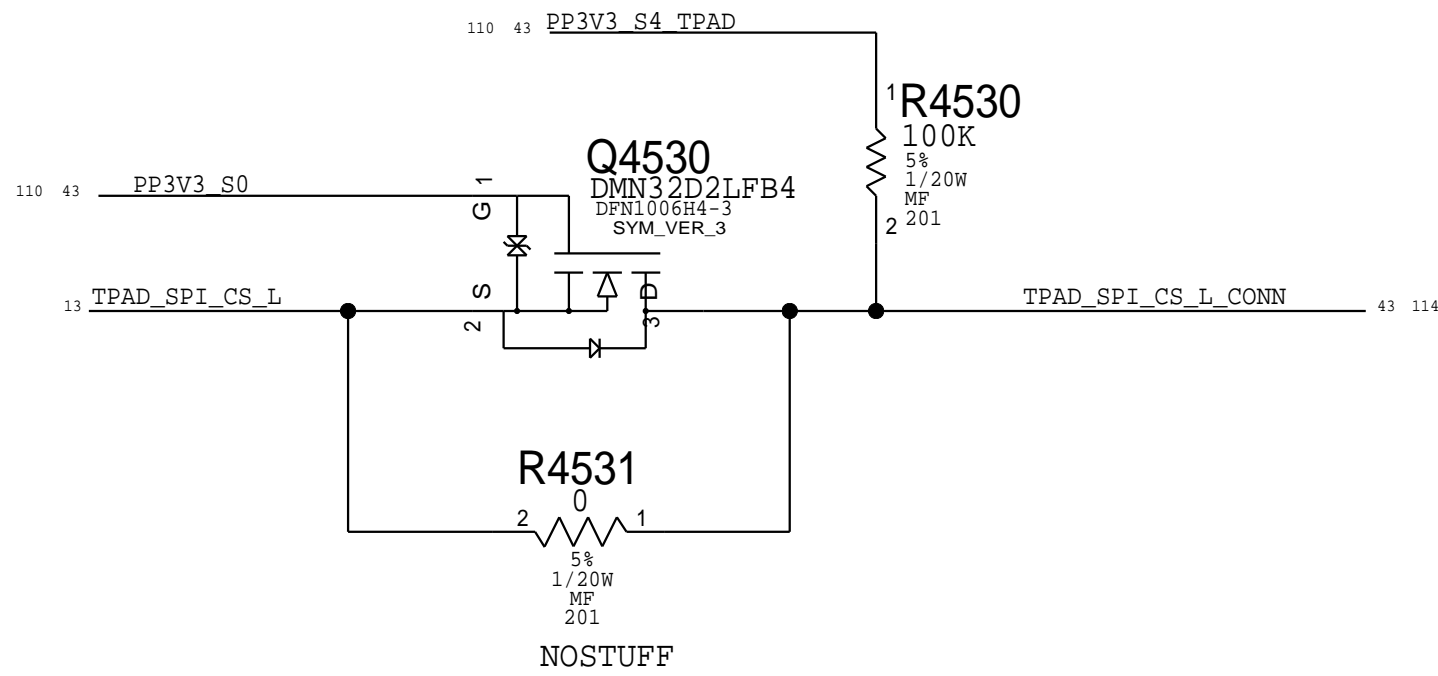
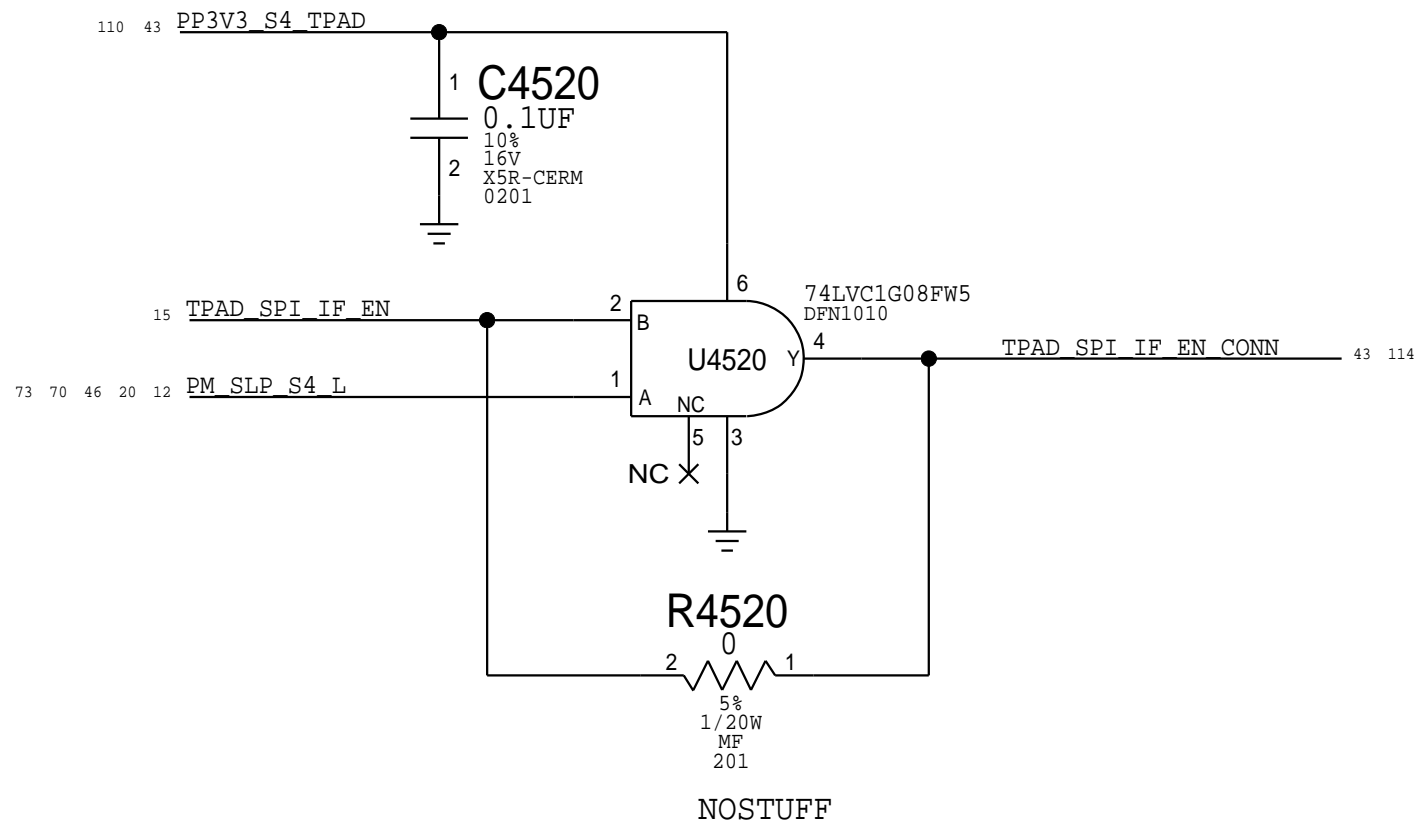
KBD CONNECTOR



TPAD CONNECTOR



TRACKPAD ISOLATION GATES/FET



PAGE TITLE			
Connectors&ESD			
	DRAWING NUMBER	051-00647	SIZE
	REVISION	10.0.0	D
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BOM\_COST\_GROUP=KEYBOARD

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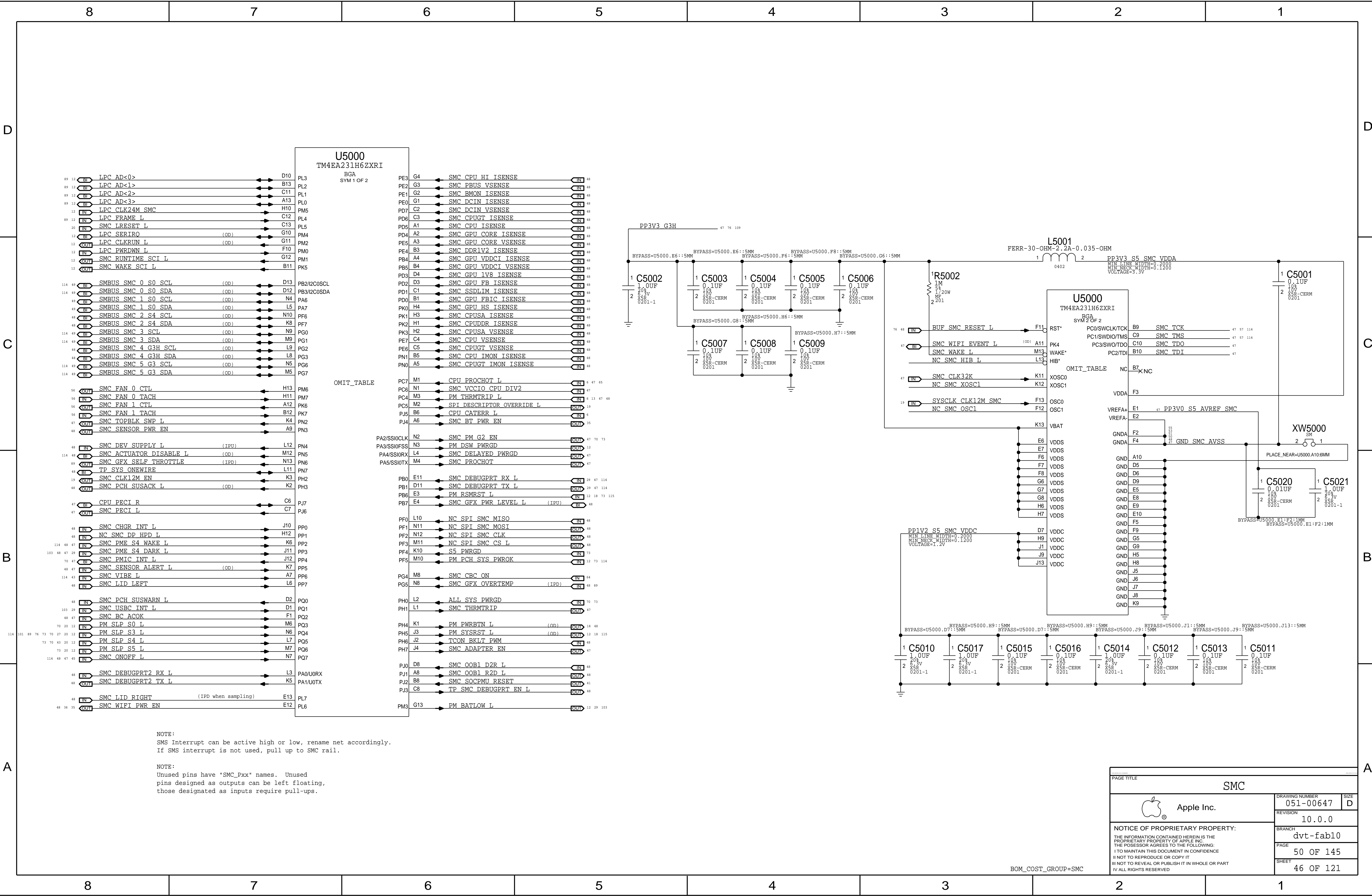
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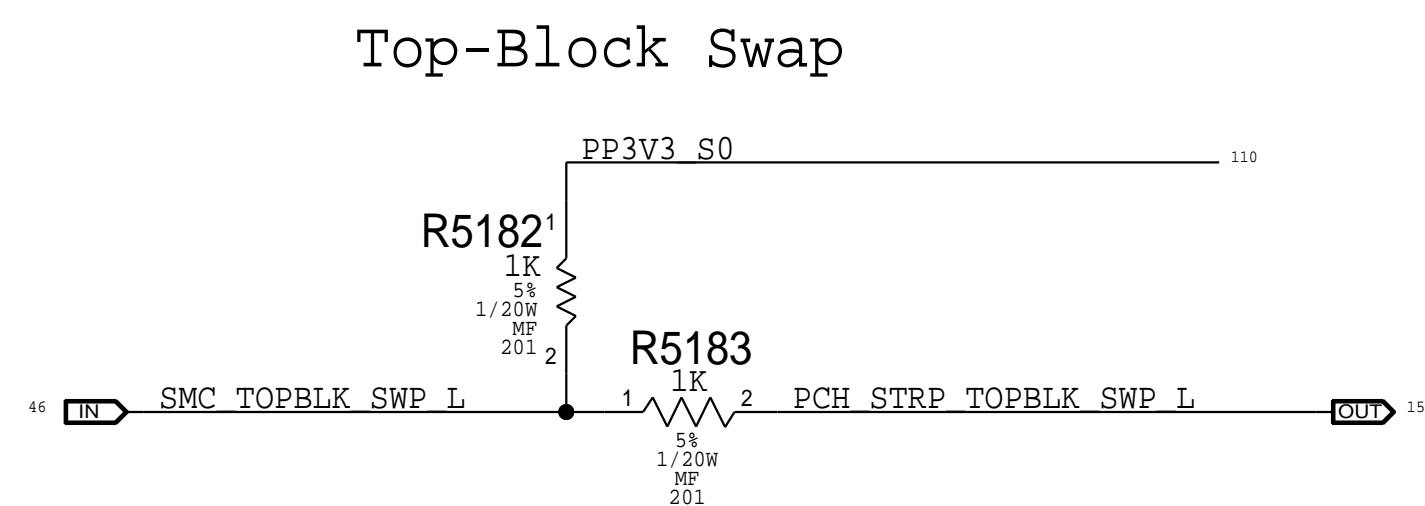
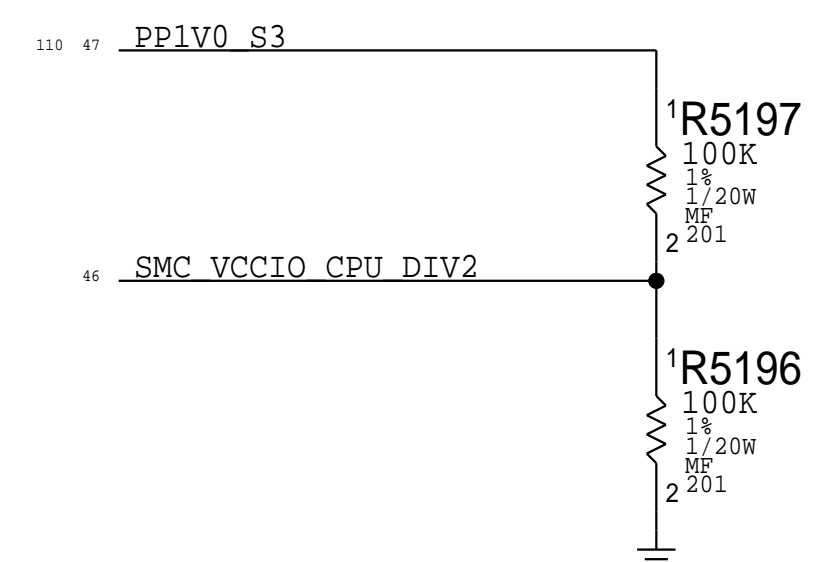
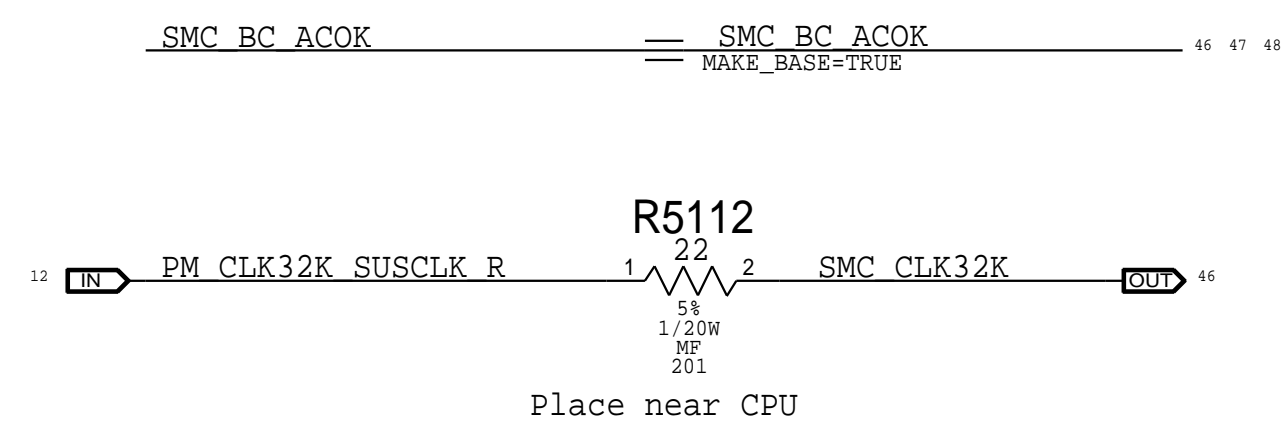
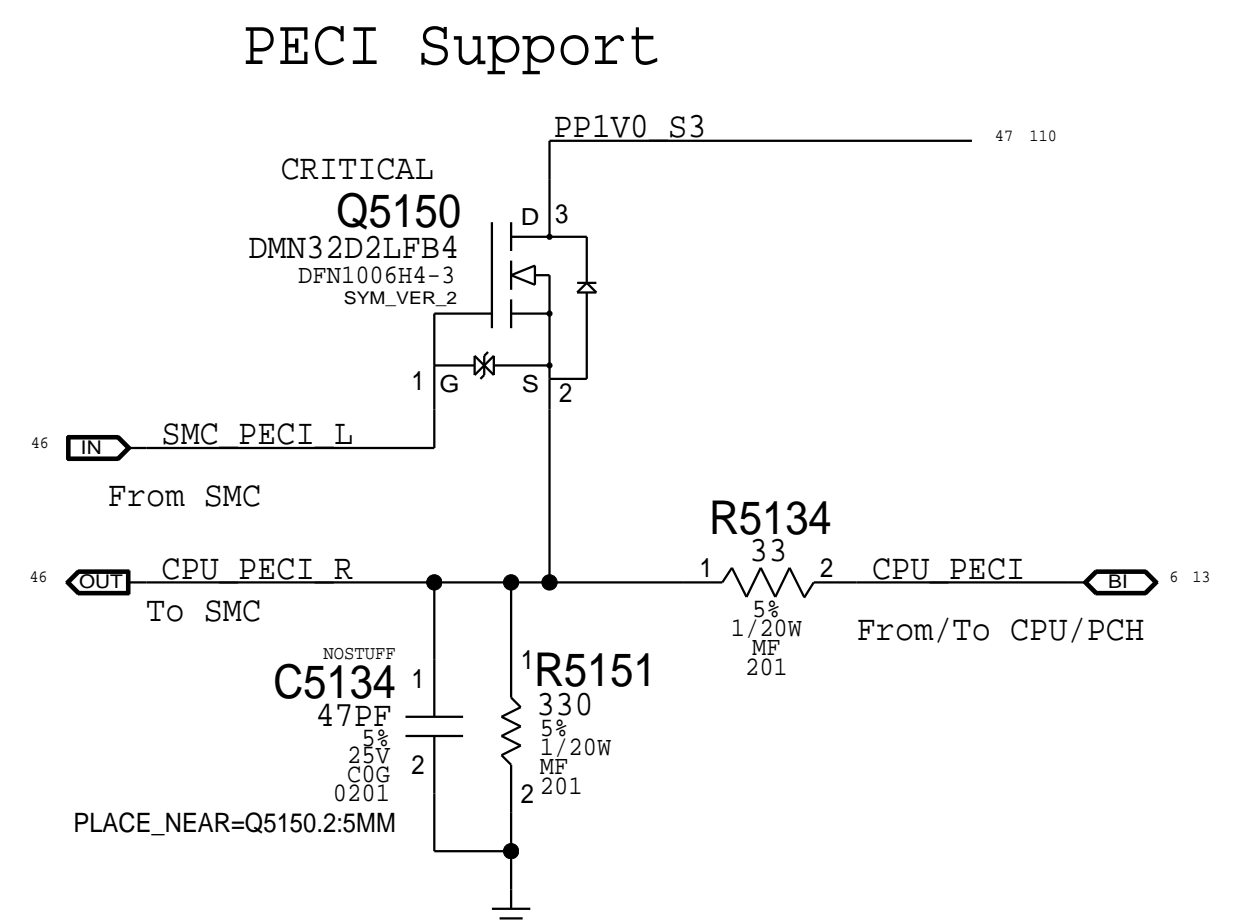
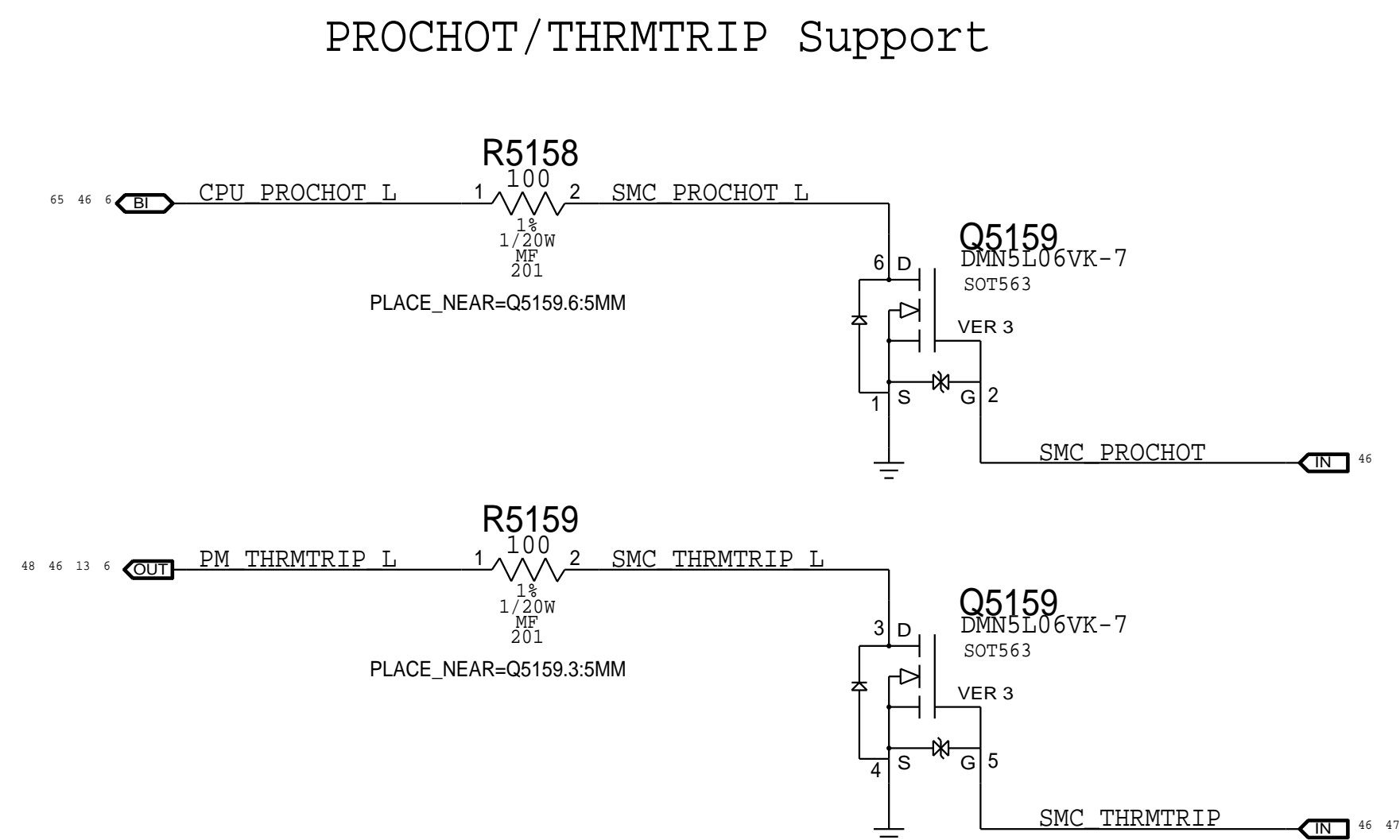
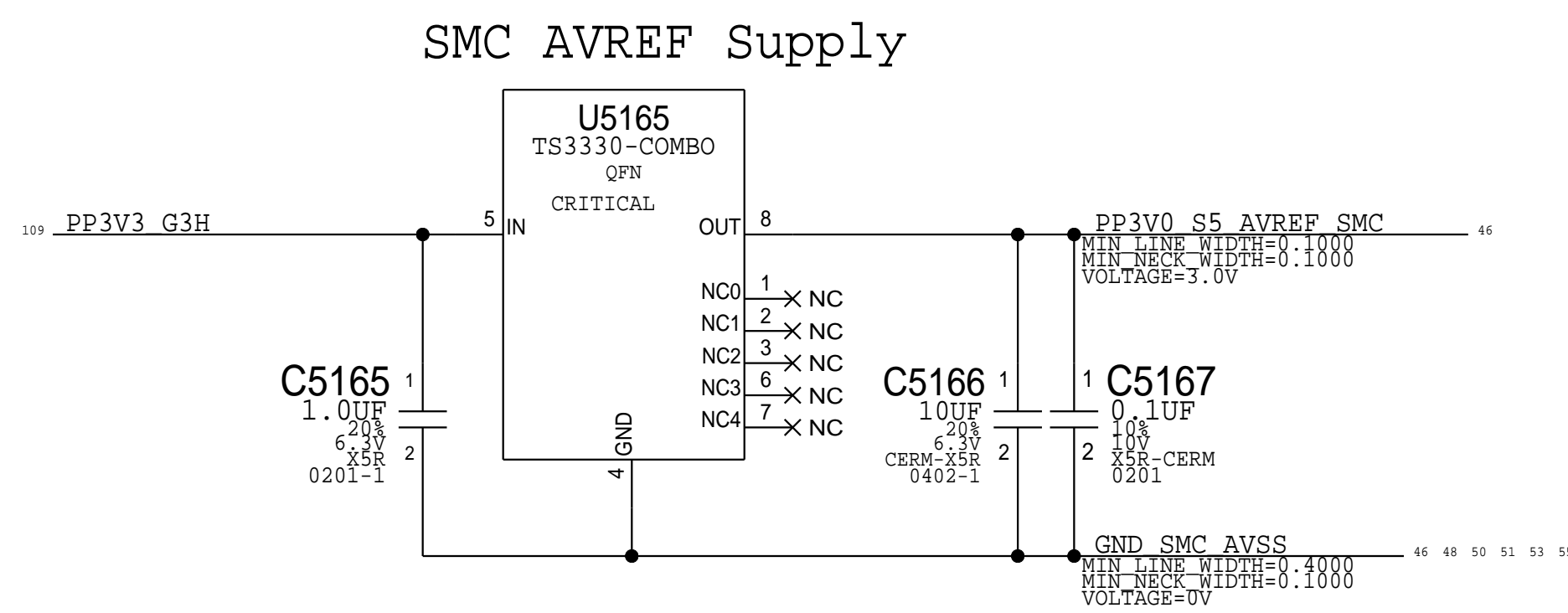
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		BRANCH  <b>dvt-fab10</b>	
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		SHEET  <b>44 OF 121</b>	


BOM\_COST\_GROUP=DEBUG







[illegible]

SYMC_MASTER=780_21F0ENR0N_MCA_BAFFIN		SYMC_DATE=11/19/2013	
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	051-00647		D
	REVISION		
	10.0.0		
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BOM\_COST\_GROUP=SMC

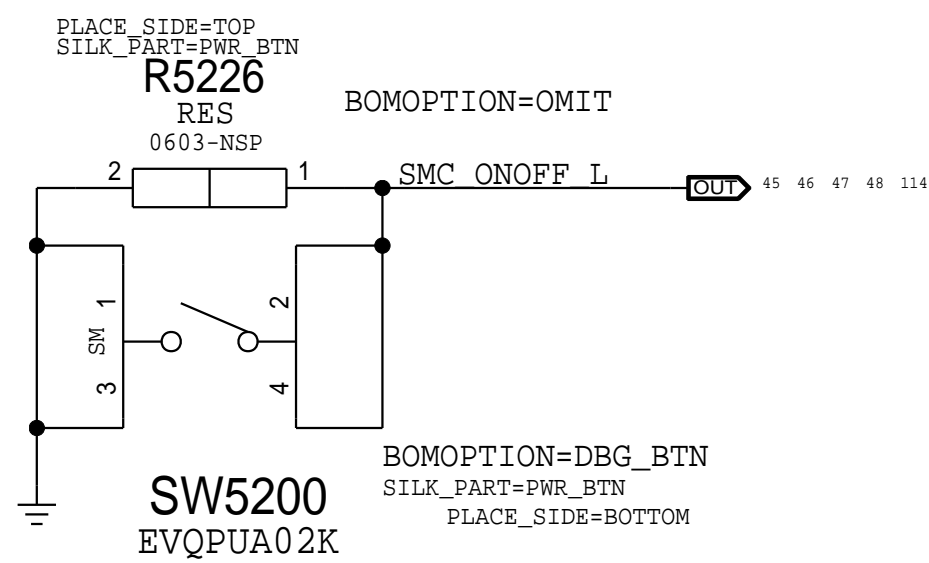
## SMC12 ADC Assignments

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OUT	SMC PBUS VSENSE	=	MAKE_BASE=TRUE SMC PBUS VSENSE	IN	50
OUT	SMC BMON ISENSE	=	MAKE_BASE=TRUE SMC BMON ISENSE	IN	50
OUT	SMC DCIN ISENSE	=	MAKE_BASE=TRUE SMC DCIN ISENSE	IN	50
OUT	SMC DCIN VSENSE	=	MAKE_BASE=TRUE SMC DCIN VSENSE	IN	50
OUT	SMC CPUTG ISENSE	=	MAKE_BASE=TRUE SMC CPUTG ISENSE	IN	53
OUT	SMC CPU ISENSE	=	MAKE_BASE=TRUE SMC CPU ISENSE	IN	51
OUT	SMC GPU CORE ISENSE	=	MAKE_BASE=TRUE SMC GPU CORE ISENSE	IN	55
OUT	SMC GPU CORE VSENSE	=	MAKE_BASE=TRUE SMC GPU CORE VSENSE	IN	55
OUT	SMC DDRIV2 ISENSE	=	MAKE_BASE=TRUE SMC DDRIV2 ISENSE	IN	51
OUT	SMC GPU VDDCI ISENSE	=	MAKE_BASE=TRUE SMC GPU VDDCI ISENSE	IN	55
OUT	SMC GPU VDDCI VSENSE	=	MAKE_BASE=TRUE SMC GPU VDDCI VSENSE	IN	55
OUT	SMC GPU IV8 ISENSE	=	MAKE_BASE=TRUE SMC GPU IV8 ISENSE	IN	55
OUT	SMC GPU FB ISENSE	=	MAKE_BASE=TRUE SMC GPU FB ISENSE	IN	53
OUT	SMC SSDLIM ISENSE	=	MAKE_BASE=TRUE SMC SSDLIM ISENSE	IN	53
OUT	SMC GPU FBIC ISENSE	=	MAKE_BASE=TRUE SMC GPU FBIC ISENSE	IN	55
OUT	SMC GPU HS ISENSE	=	MAKE_BASE=TRUE SMC GPU HS ISENSE	IN	55
OUT	SMC CPUSA ISENSE	=	MAKE_BASE=TRUE SMC CPUSA ISENSE	IN	53
OUT	SMC CPUDDR ISENSE	=	MAKE_BASE=TRUE SMC CPUDDR ISENSE	IN	51
OUT	SMC CPUSA VSENSE	=	MAKE_BASE=TRUE SMC CPU VSENSE	IN	55
OUT	SMC CPUTG VSENSE	=	MAKE_BASE=TRUE SMC CPUTG VSENSE	IN	55
OUT	SMC CPU IMON ISENSE	=	MAKE_BASE=TRUE SMC CPU IMON ISENSE	IN	51 55
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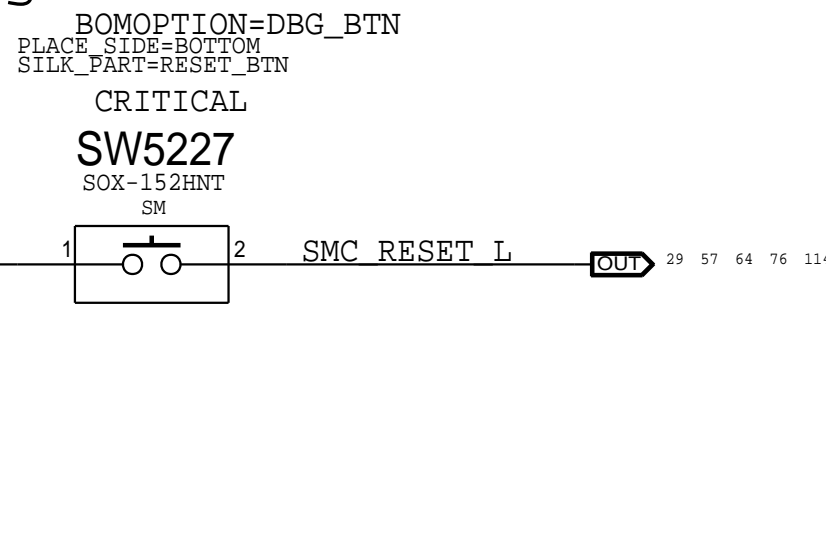
## SMC12 Pin Assignments

SMC GFX PWR LEVEL L	=	SMC GFX PWR LEVEL L	89
TP SYS ONEWIRE	=	MAKE_BASE=TRUE TP SYS ONEWIRE	
TP SMC DEBUGPRT EN L	=	MAKE_BASE=TRUE TP SMC DEBUGPRT EN L	
NC_SMC_DP_HPD L	=	MAKE_BASE=TRUE NC_SMC_DP_HPD L	

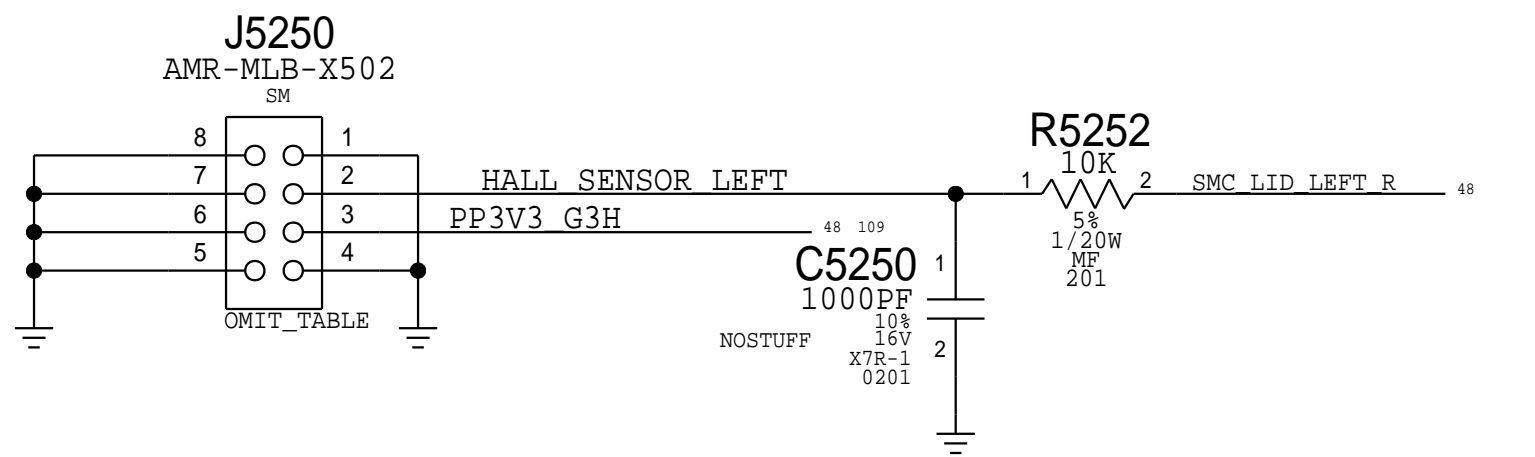
## Debug Power "Buttons"



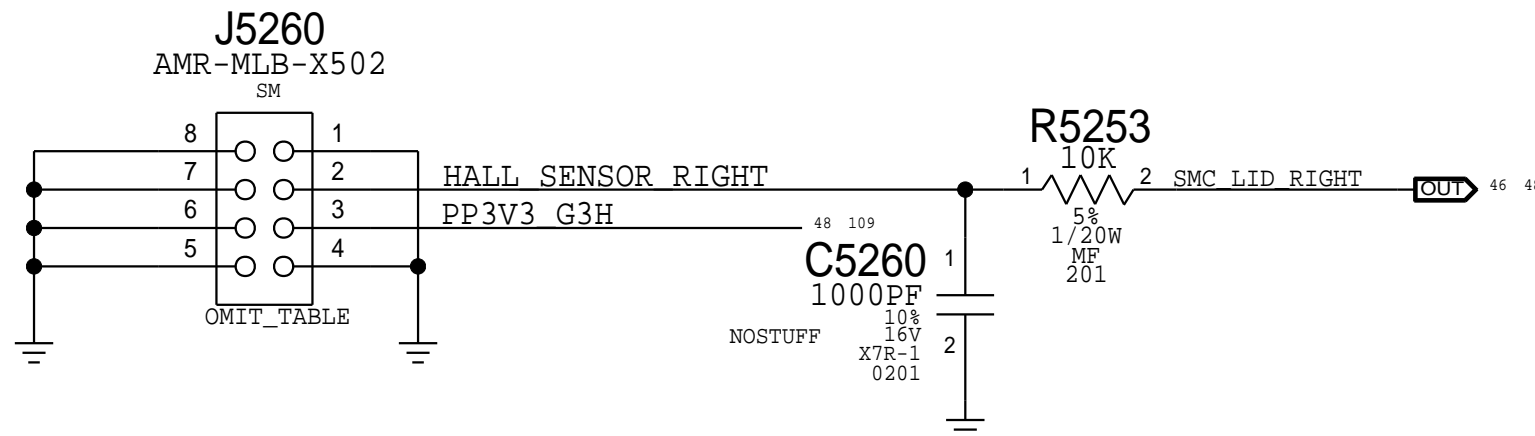
## Debug RESET "Buttons"



## Hall Effect Pads - Left



## Hall Effect Pads - Right



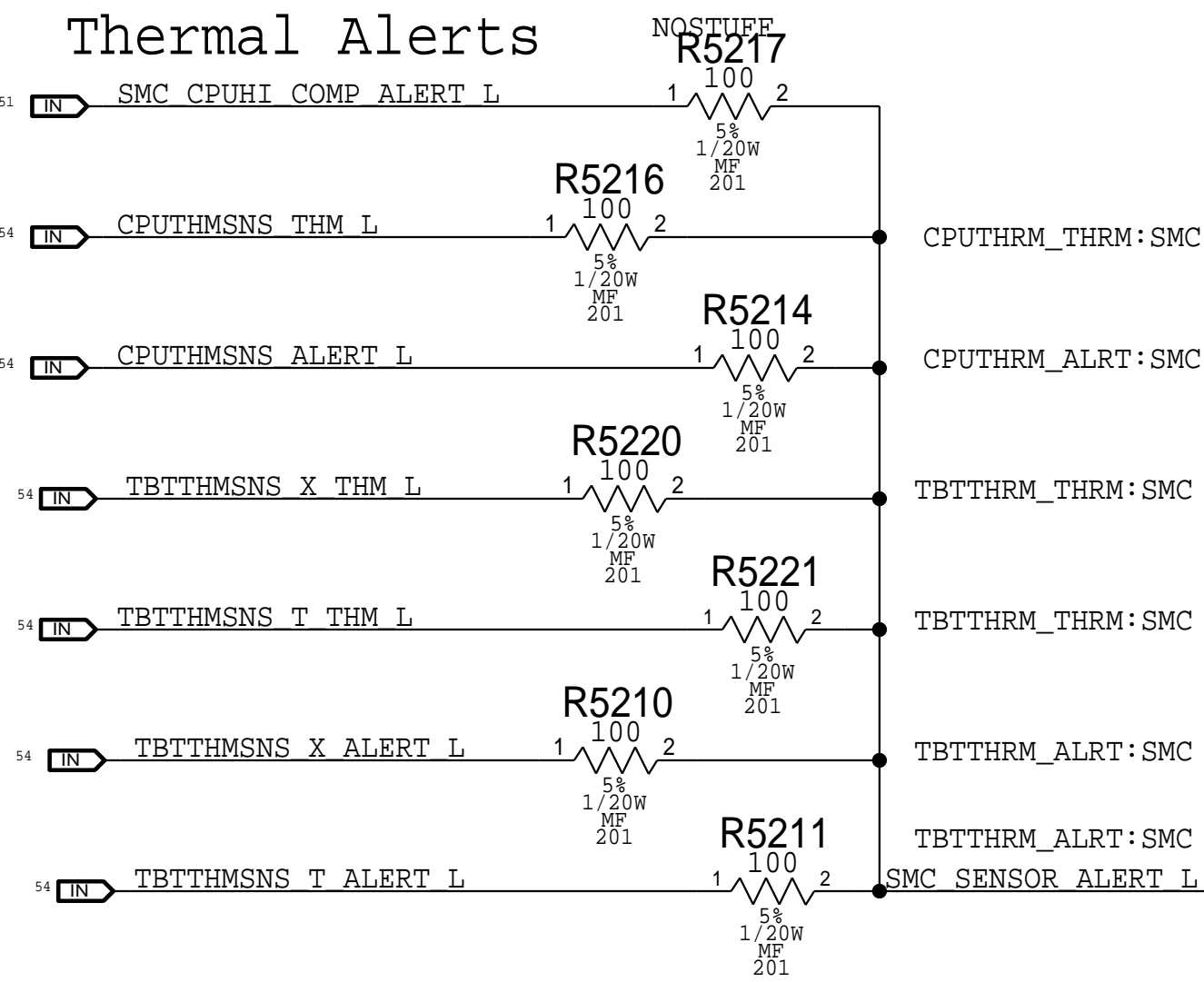
Specify one of these BOM GROUPS.

BOM GROUP	BOM OPTIONS
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CPUTHRM:THRM	CPUTHRM_THRM:SMC
CPUTHRM:ALRT	CPUTHRM_ALRT:SMC

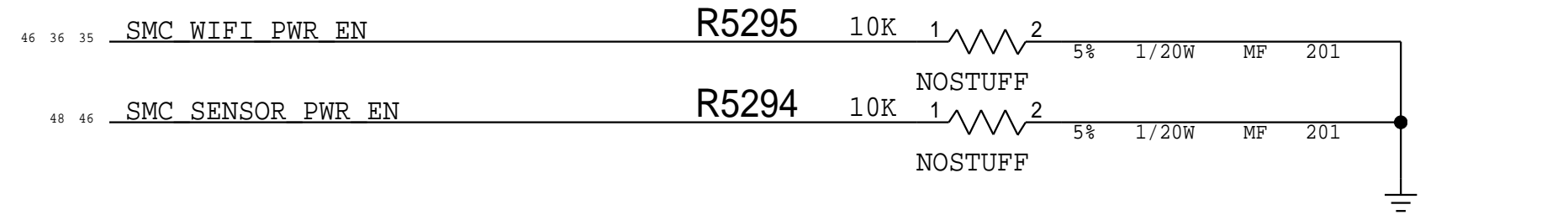
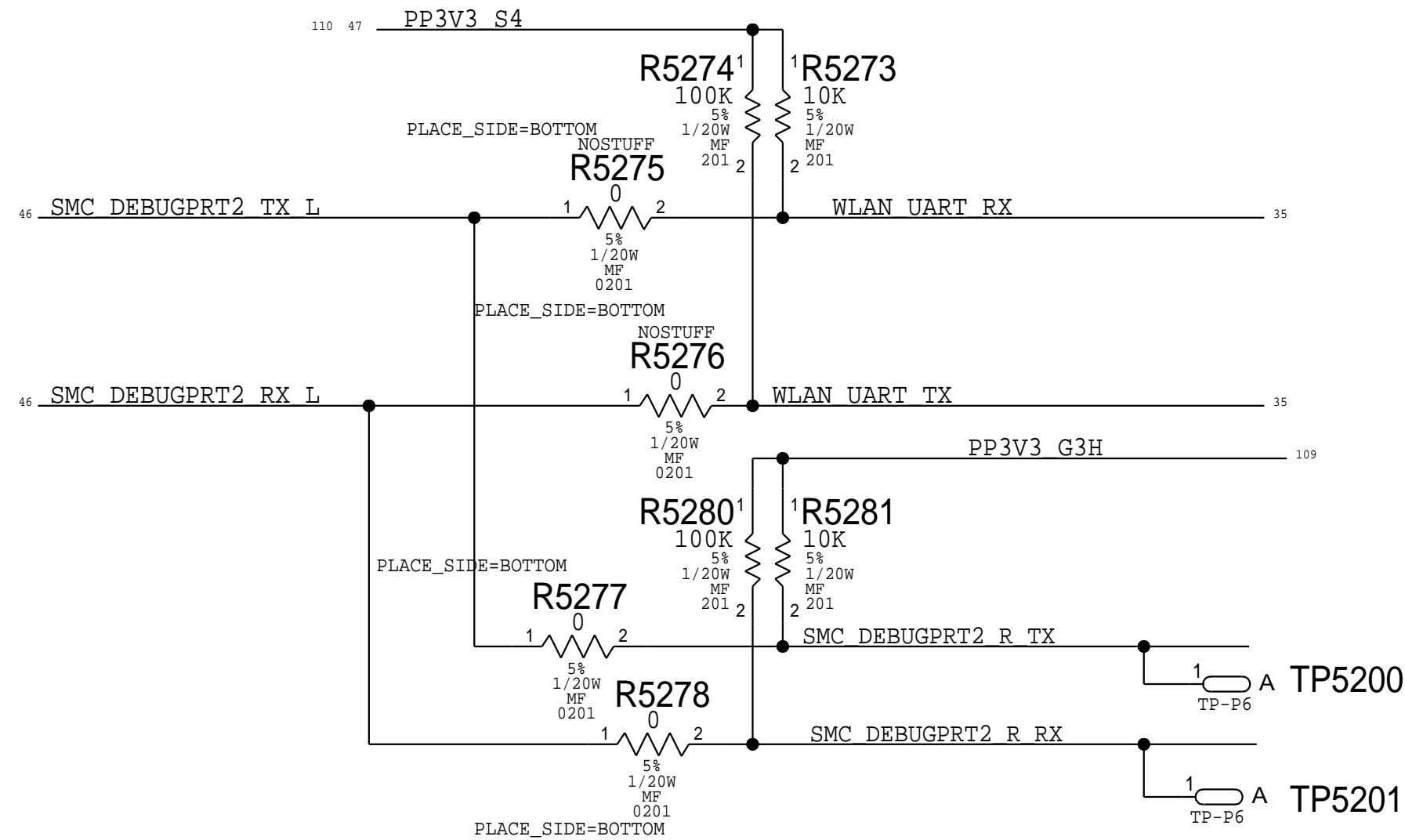
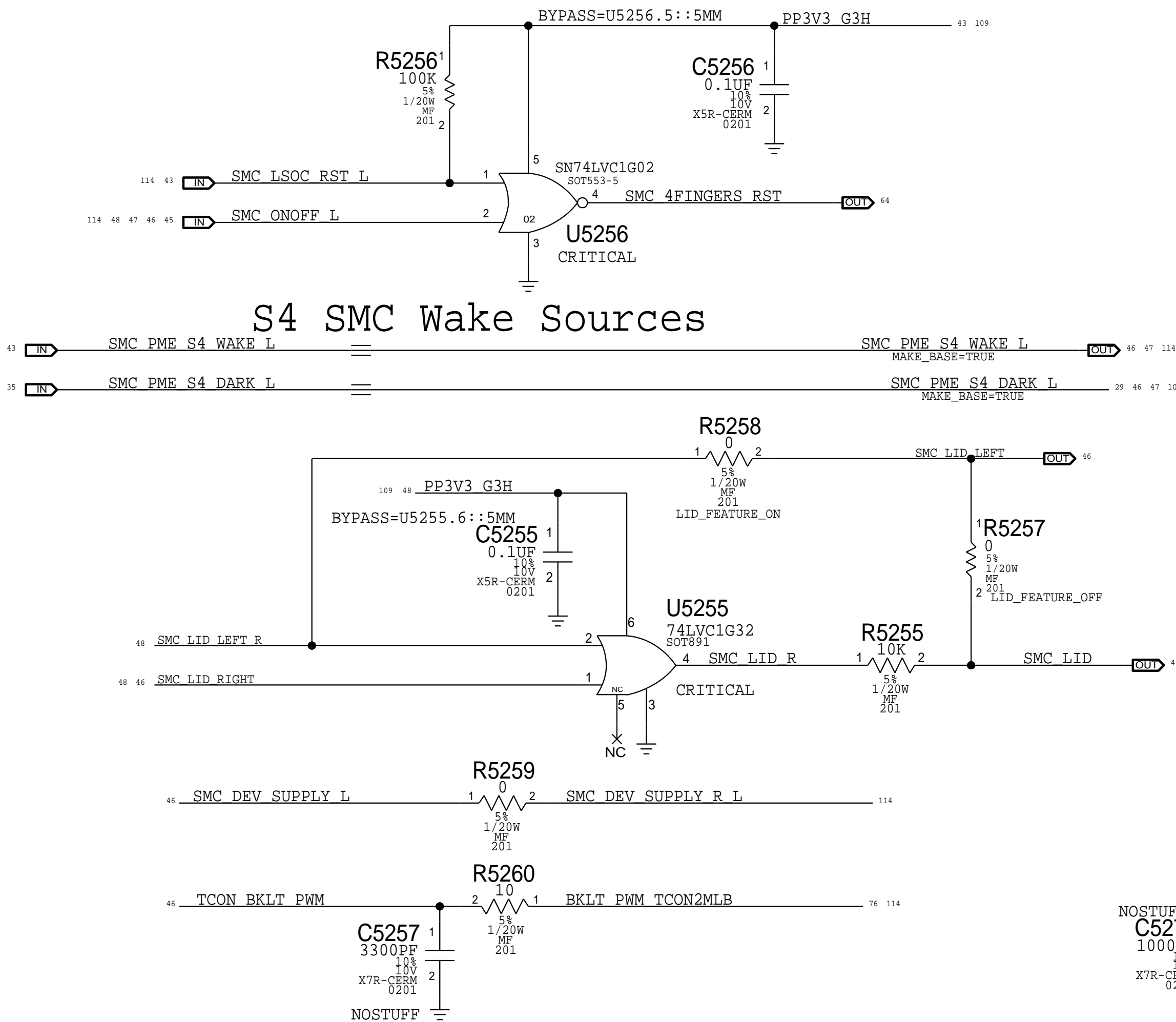
Specify one of these BOM GROUPS.

BOM GROUP	BOM OPTIONS
TBTTHRM:BOTH	TBTTHRM_THRM:SMC,TBTTHRM_ALRT:SMC
TBTTHRM:THRM	TBTTHRM_THRM:SMC,TBTTHRM_ALRT:PU
TBTTHRM:ALRT	TBTTHRM_THRM:PU,TBTTHRM_ALRT:SMC
TBTTHRM:NONE	TBTTHRM_THRM:PU,TBTTHRM_ALRT:PU

## Thermal Alerts

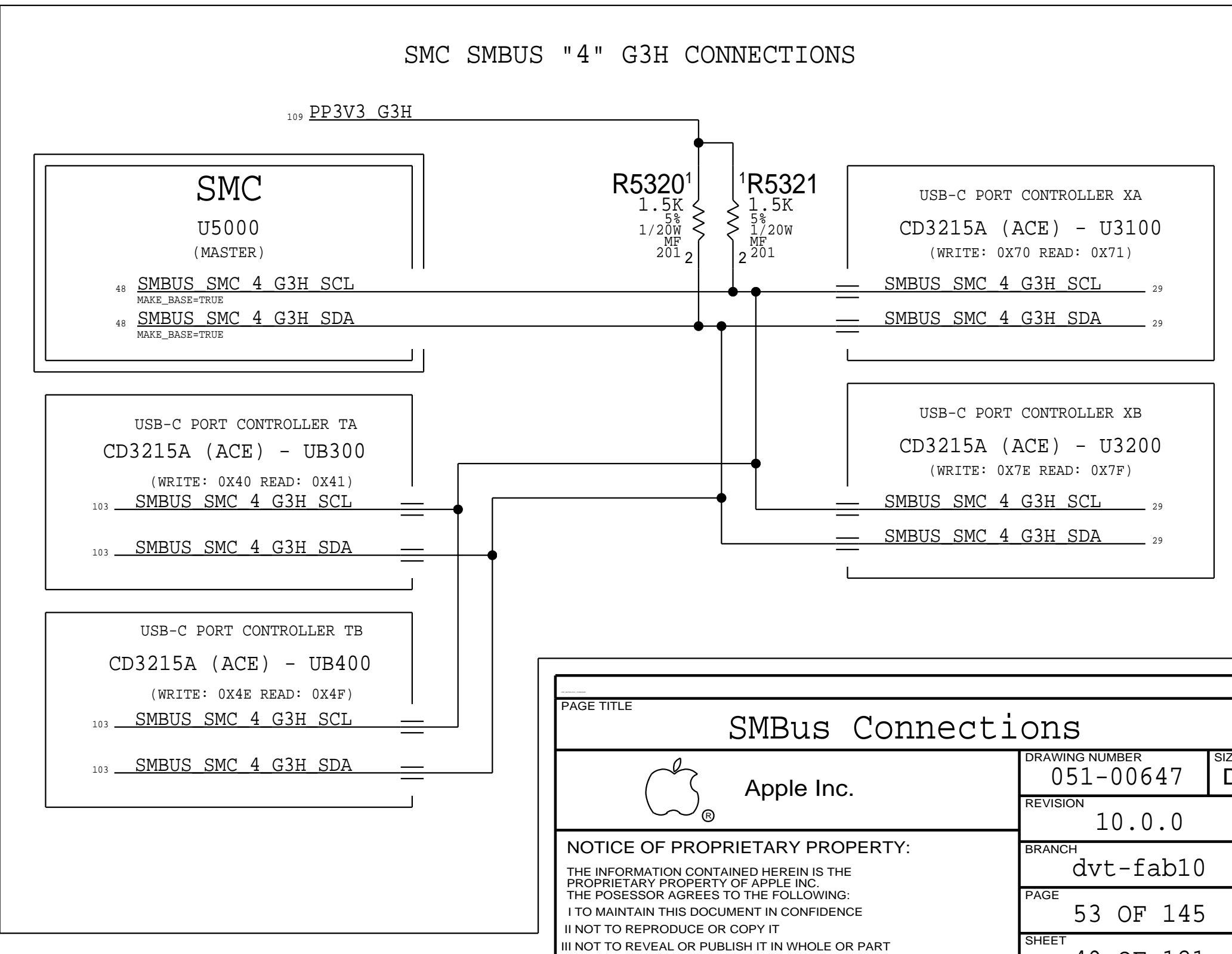
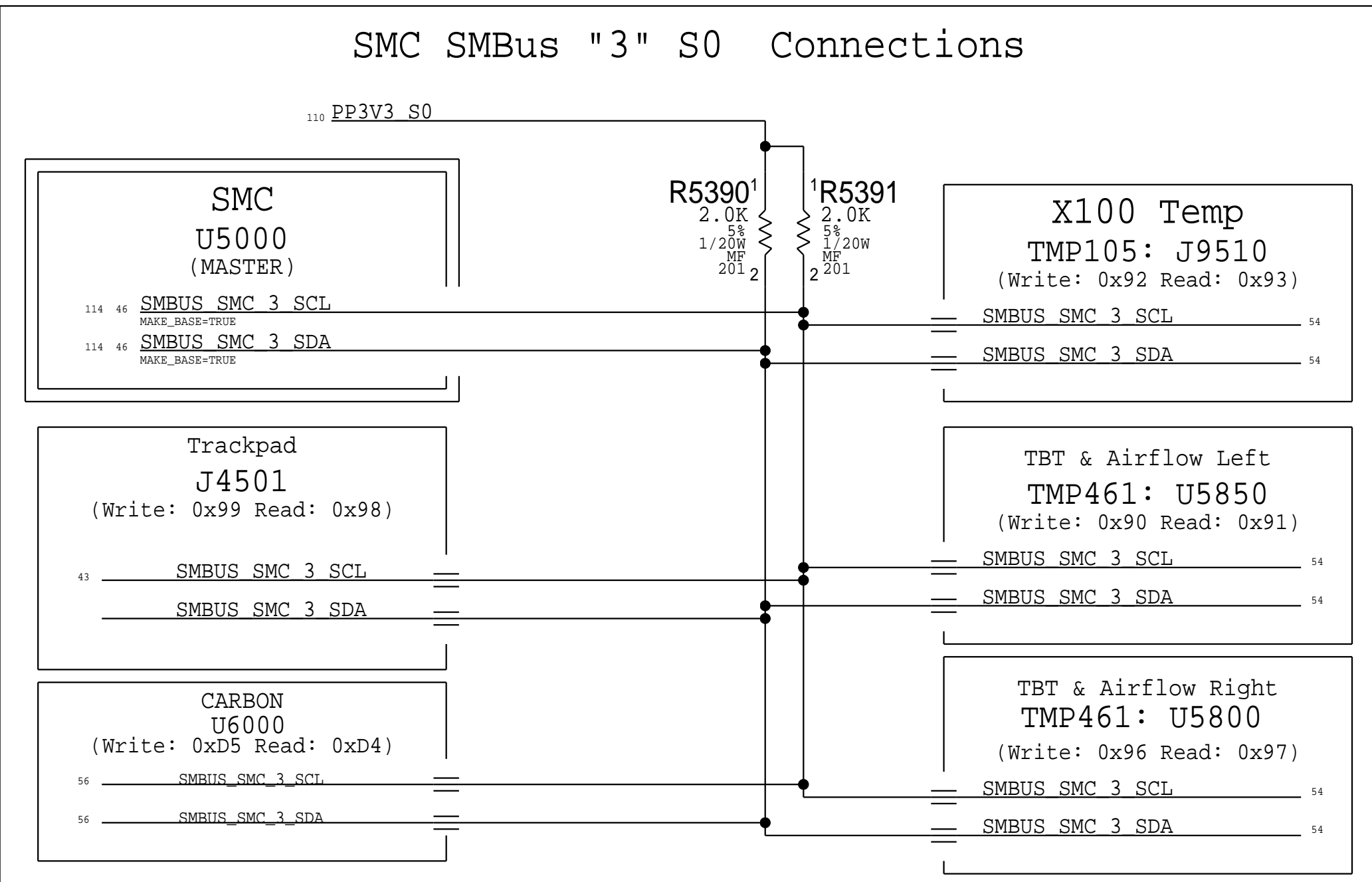
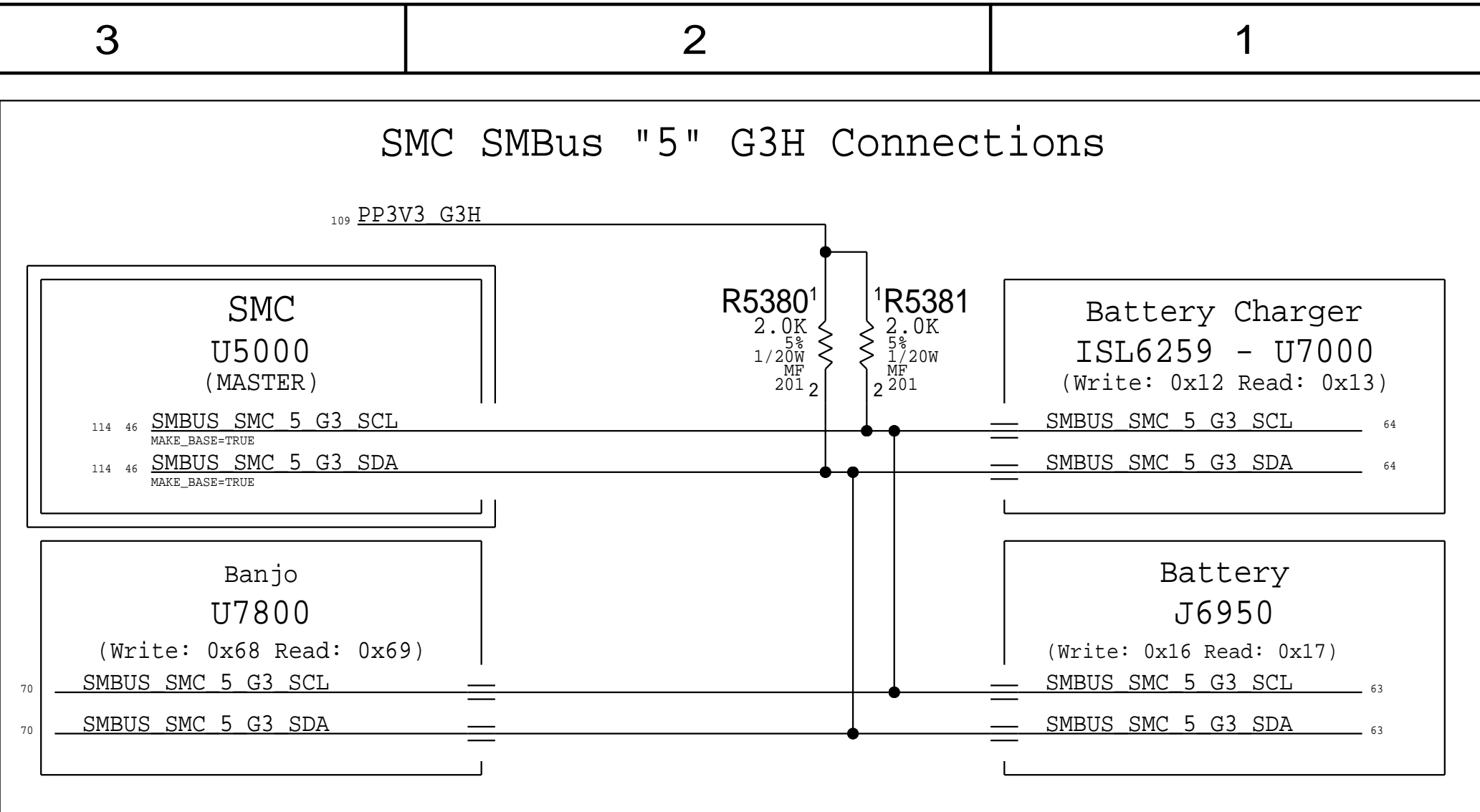
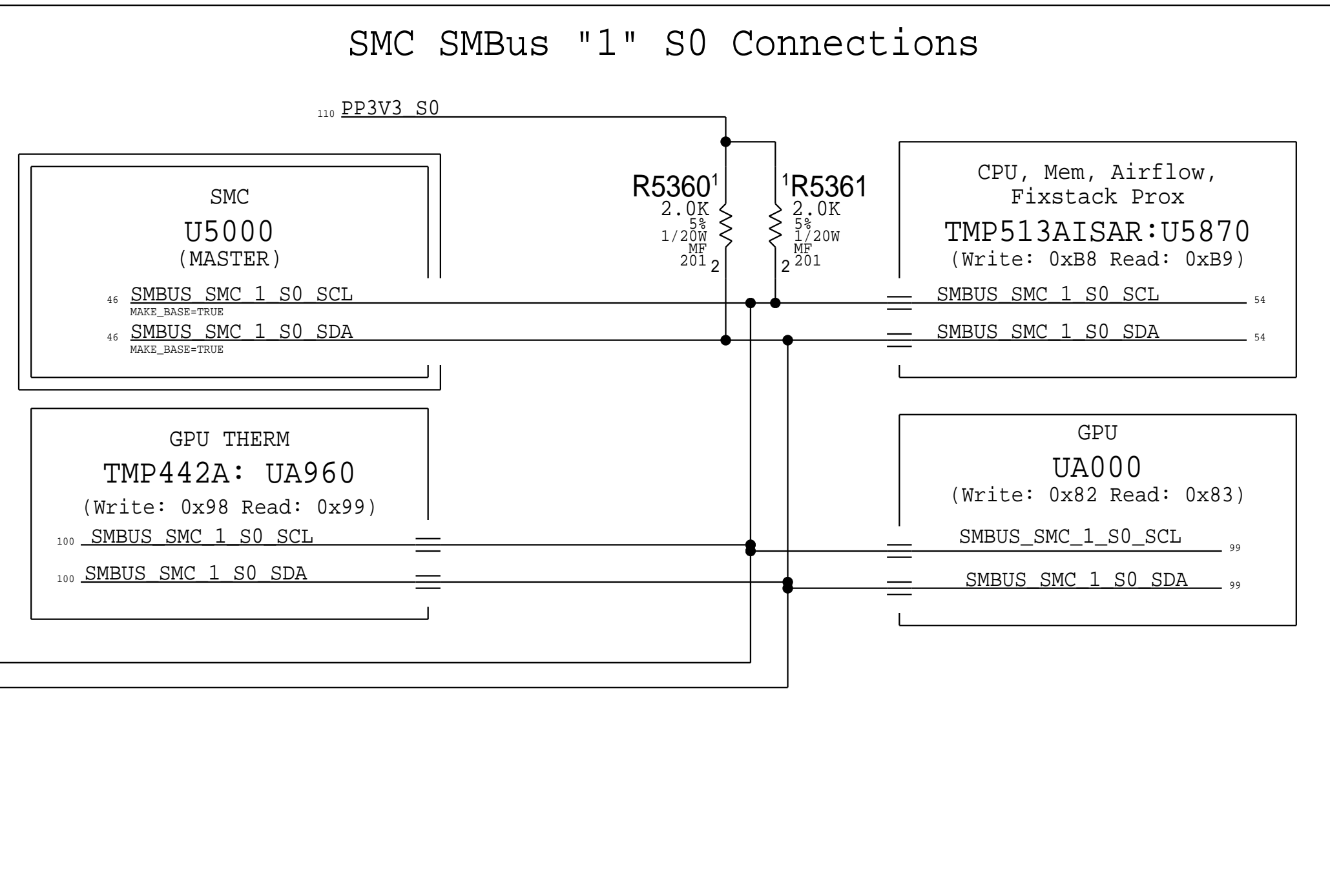
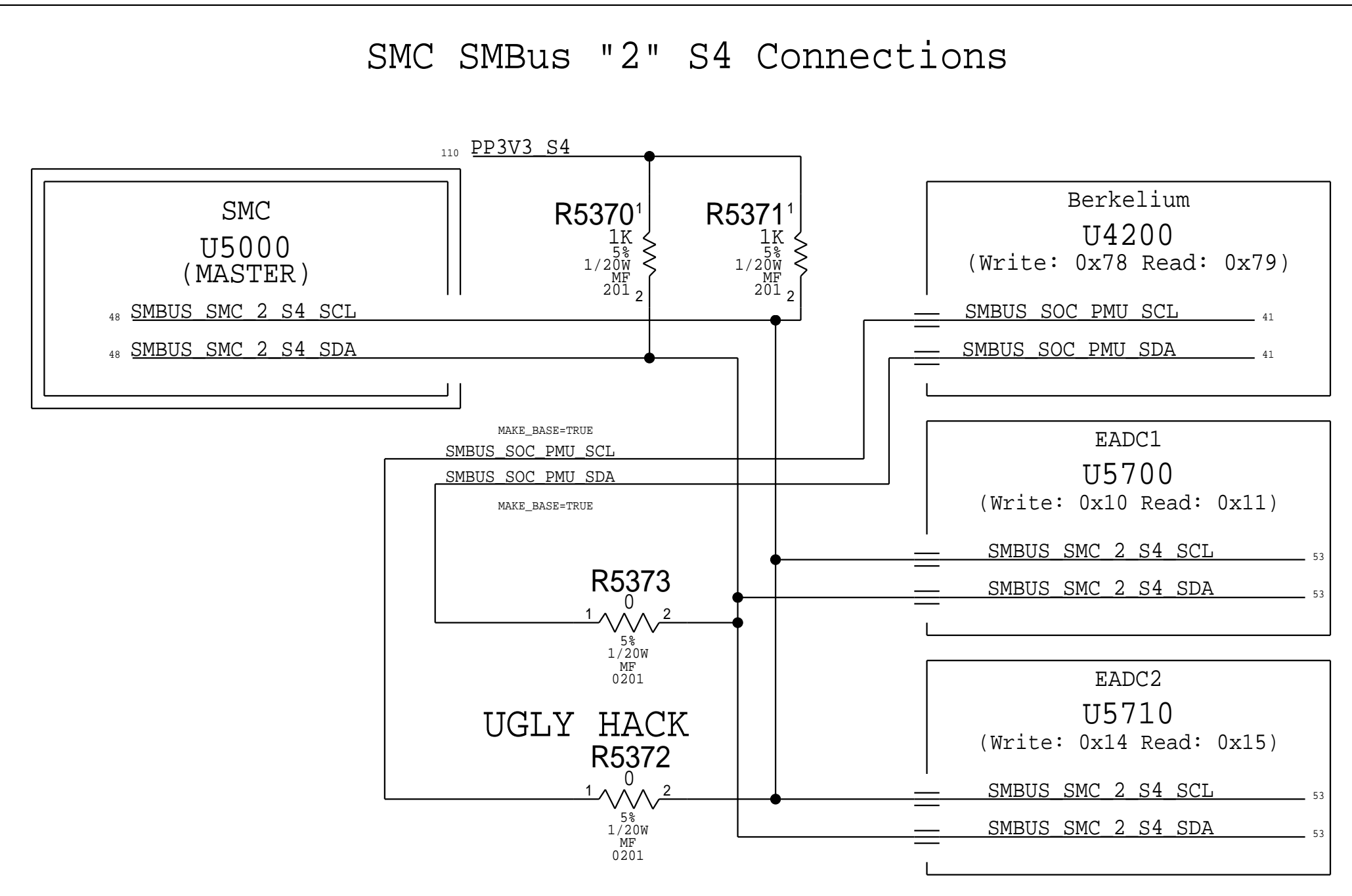
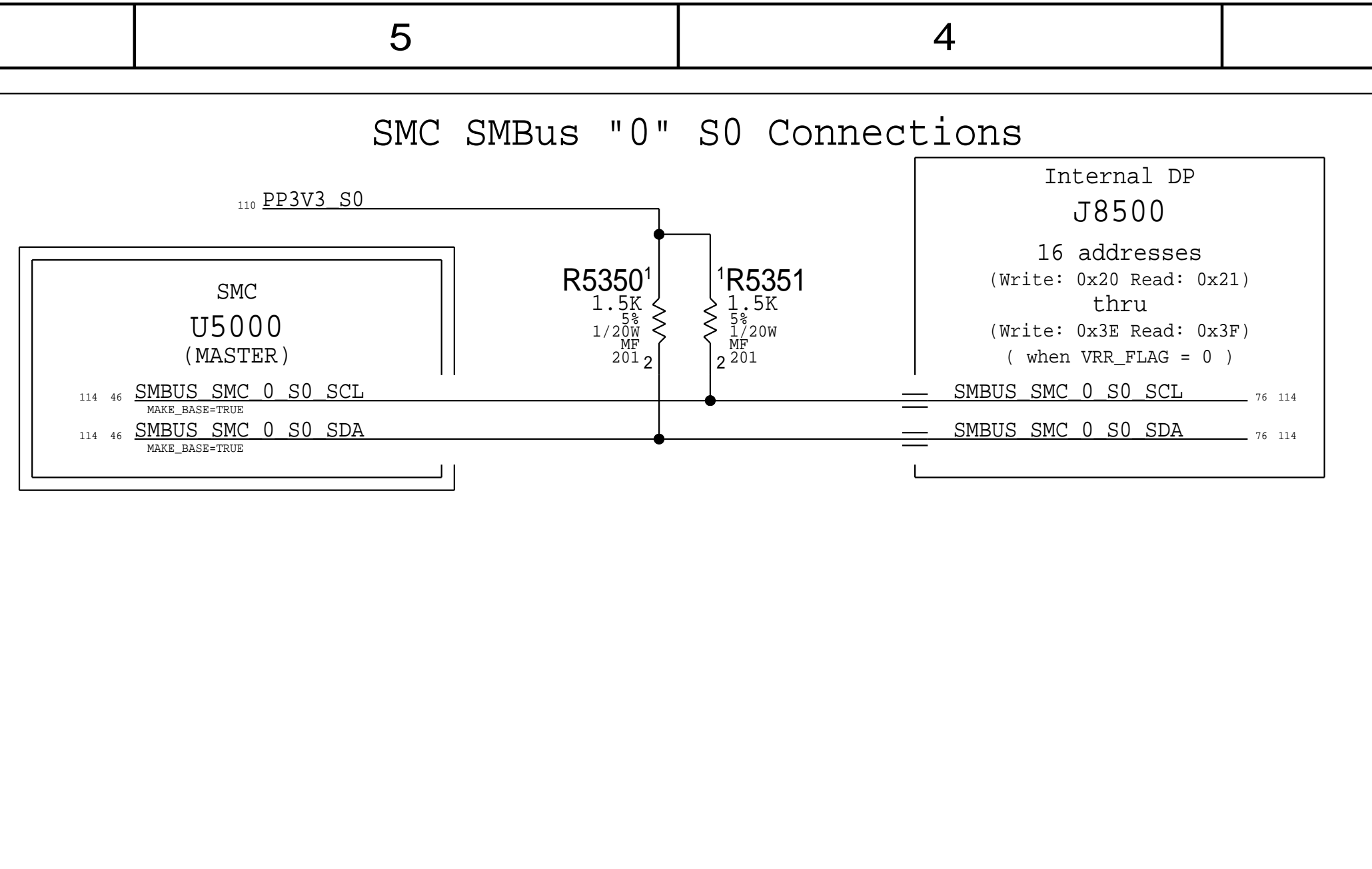
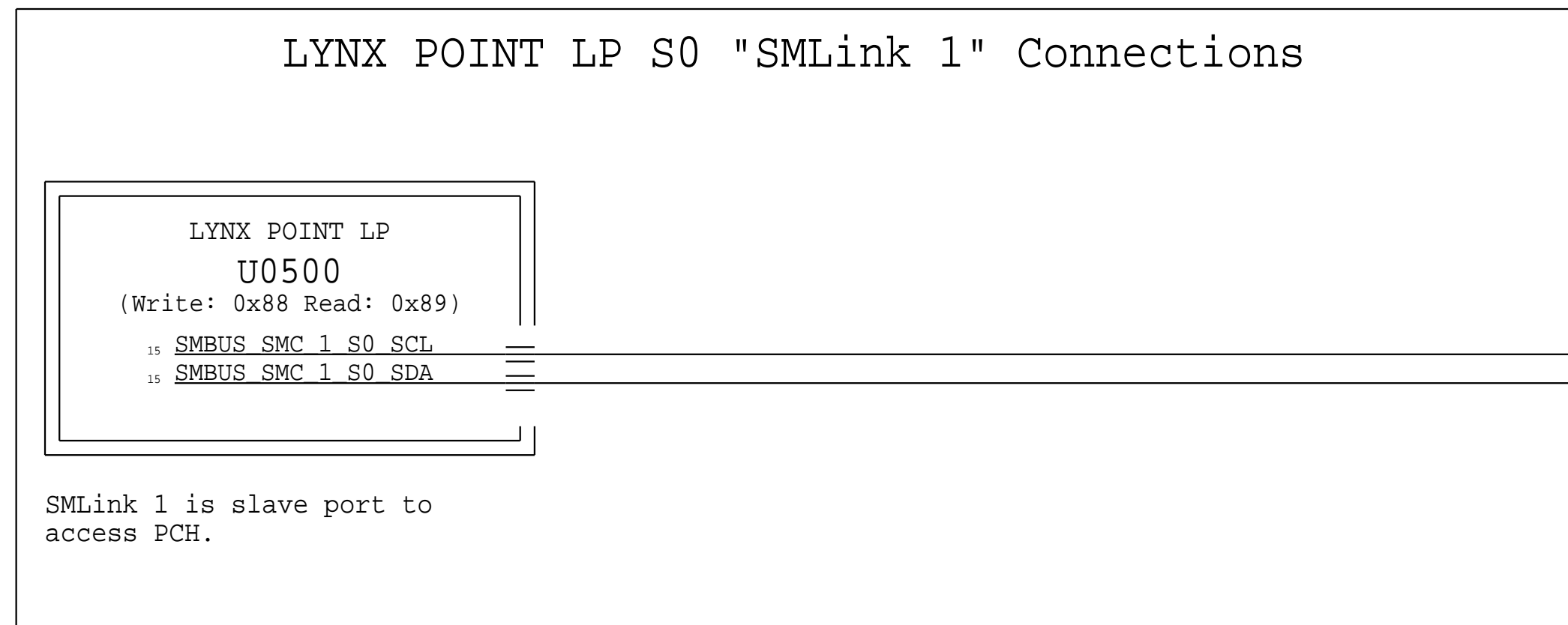
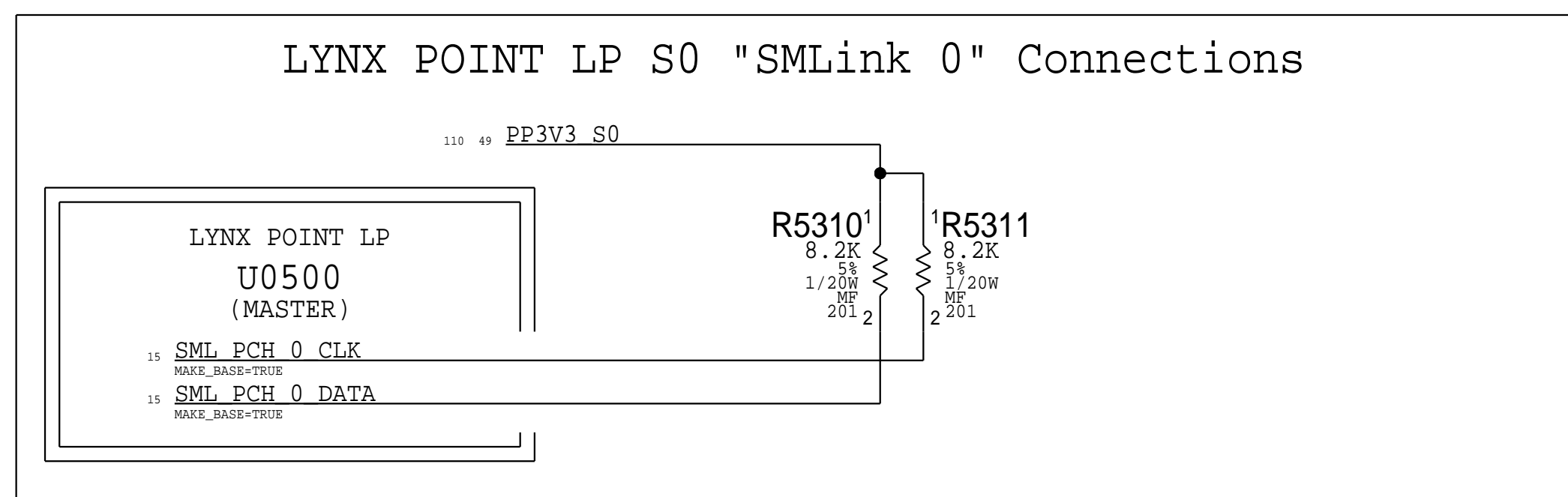
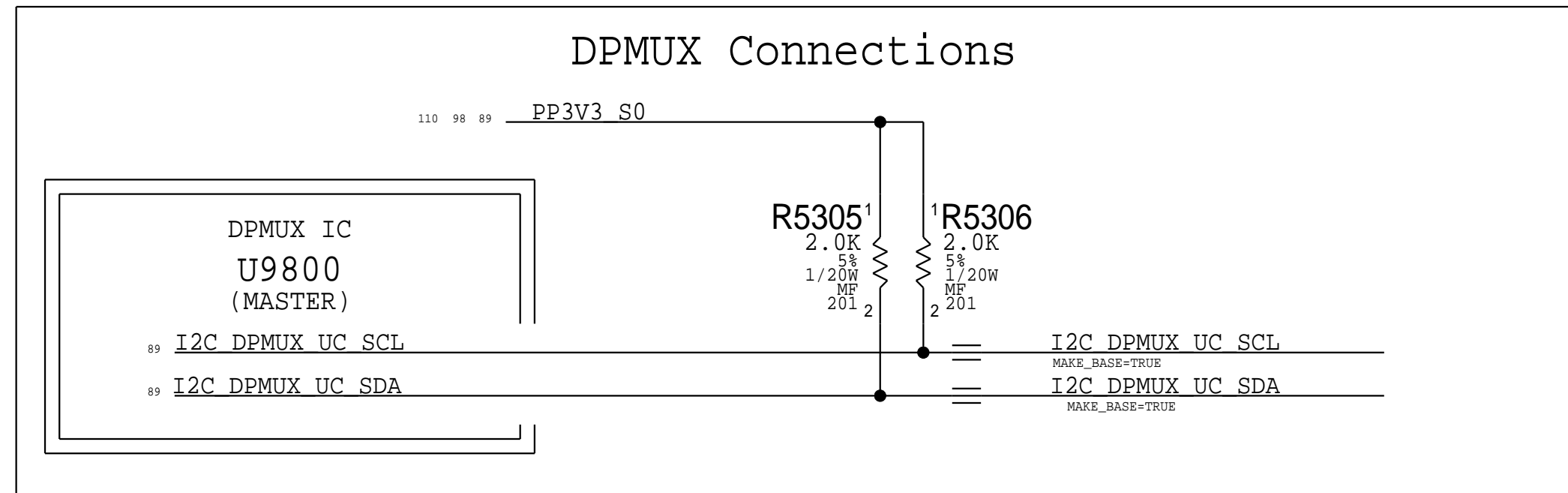
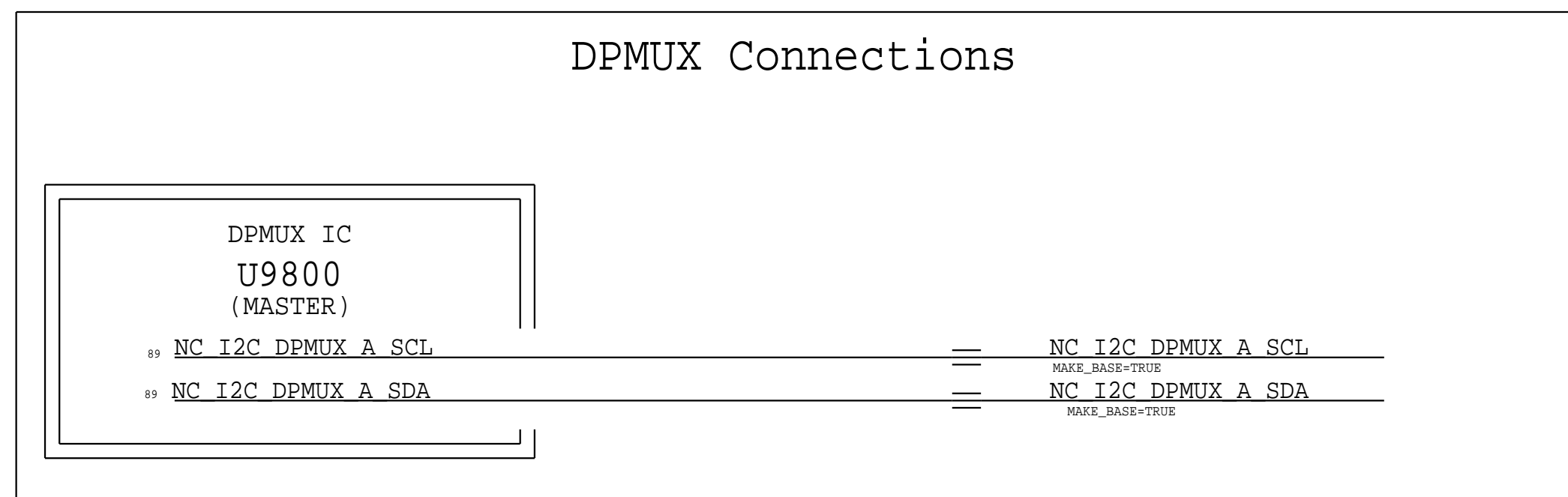
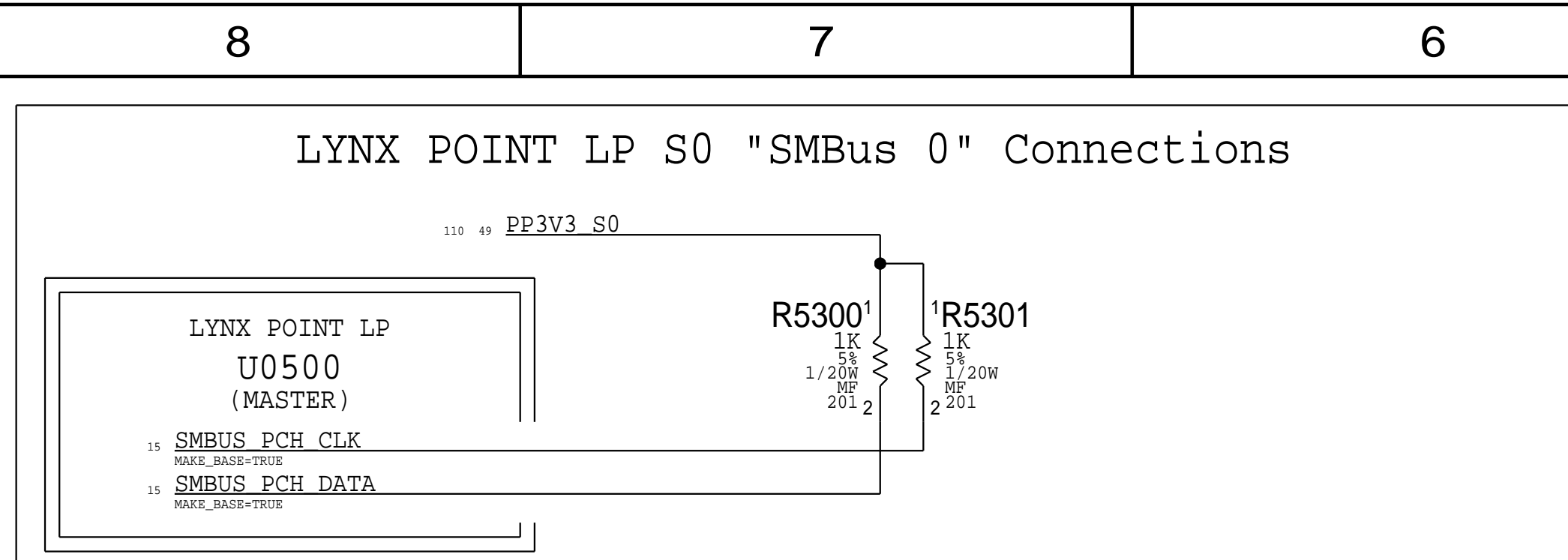


## S4 SMC Wake Sources



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BOM\_COST\_GROUP=SMC







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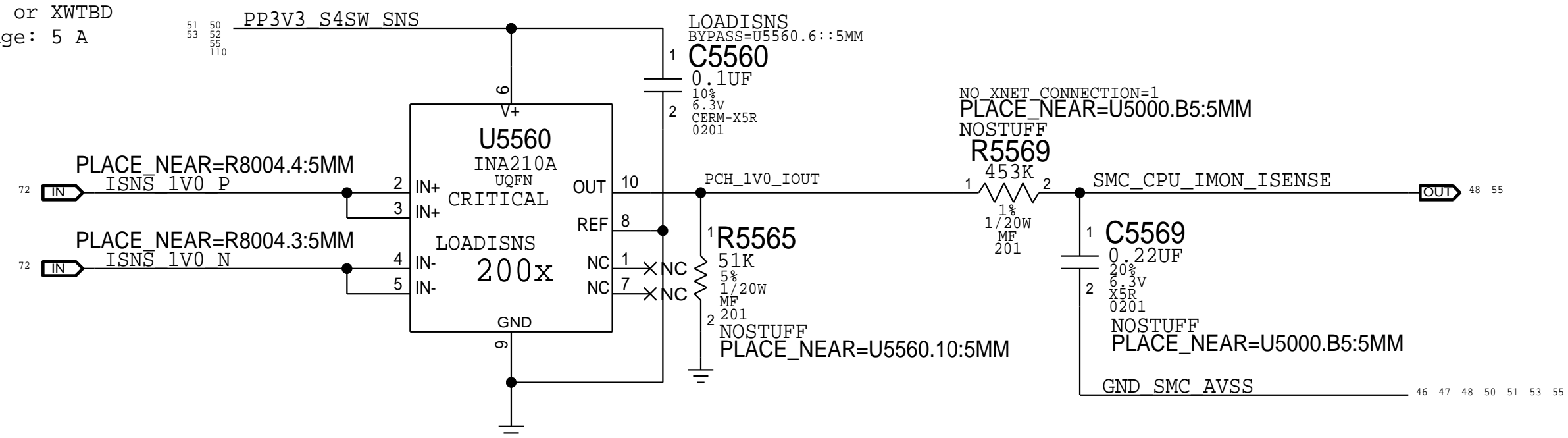
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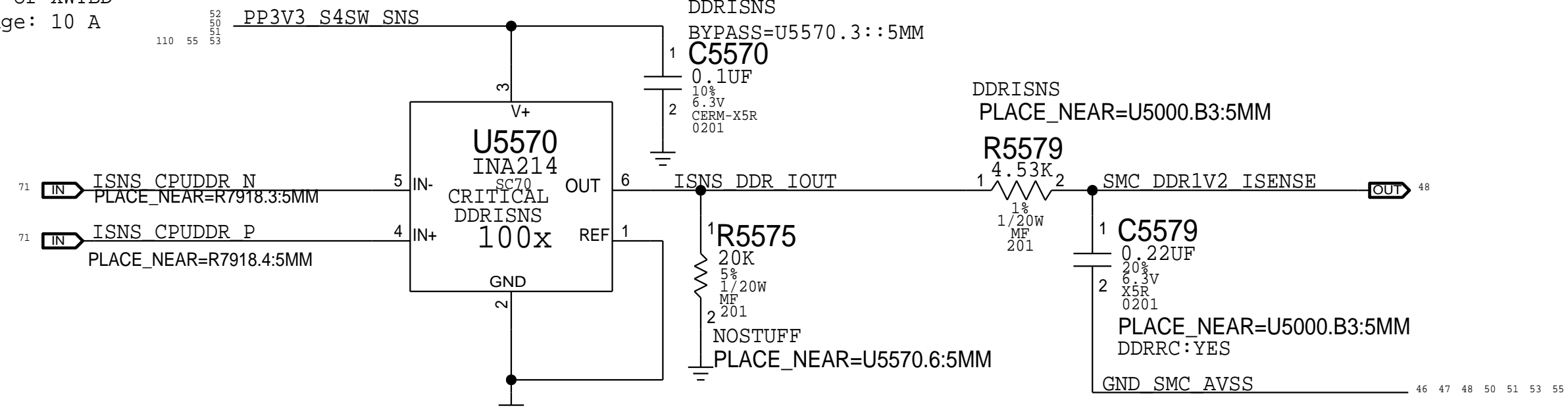
## PCH 1.0V Current Sense (ISCC)

Gain: 200x, EDP: 4.11 A  
Rsense: 0.003 (R8004) or XWTBD  
Vsense: 11.33 mV, Range: 5 A  
SMC ADC: 22



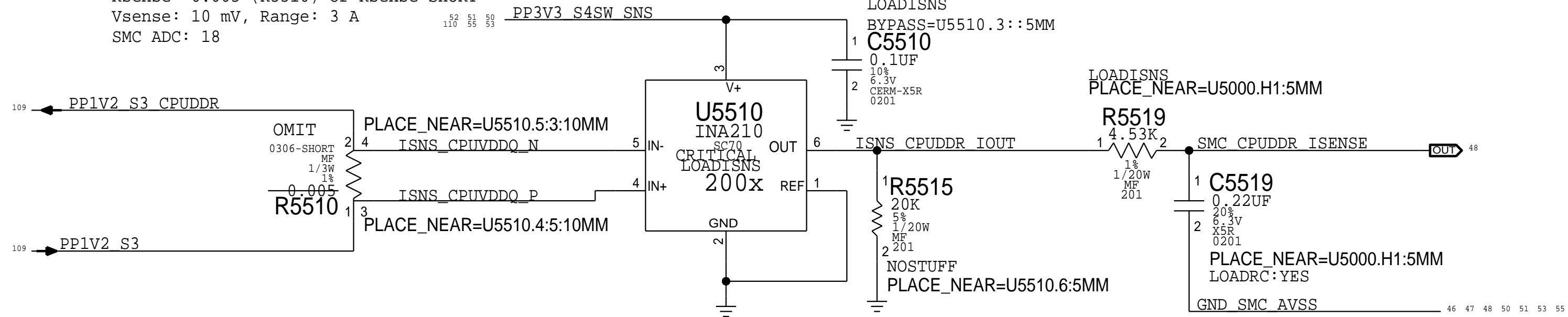
## DDR 1.2V S3 (CPU &amp; Memory) Current Sense (IMOC)

Gain: 100x, EDP: 9.01 A  
Rsense: 0.003 (R7918) or XWTBD  
Vsense: 27.03 mV, Range: 10 A  
SMC ADC: 09



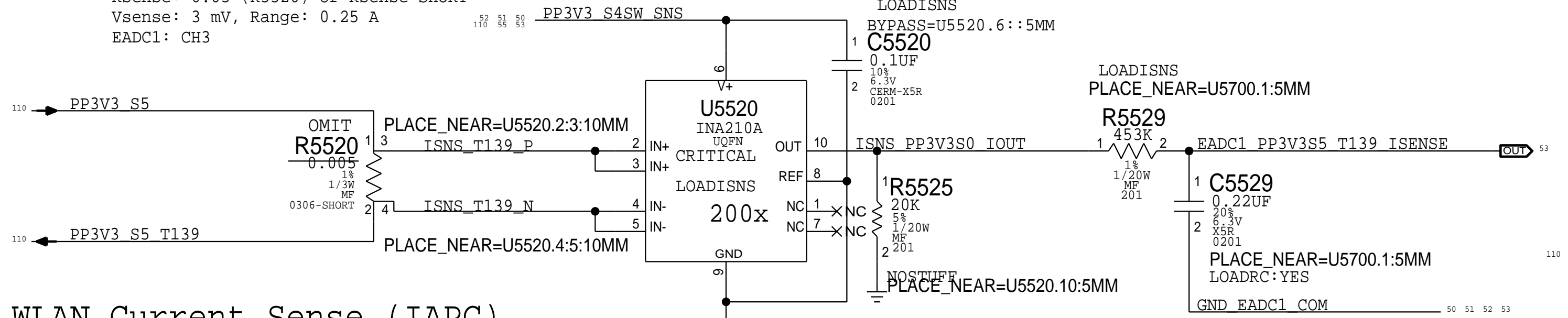
## CPU DDR 1.2V S3 (CPU Only) Current Sense (IMCC)

Gain: 200x, EDP: 2 A  
Rsense: 0.005 (R5510) or Rsense SHORT  
Vsense: 10 mV, Range: 3 A  
SMC ADC: 18



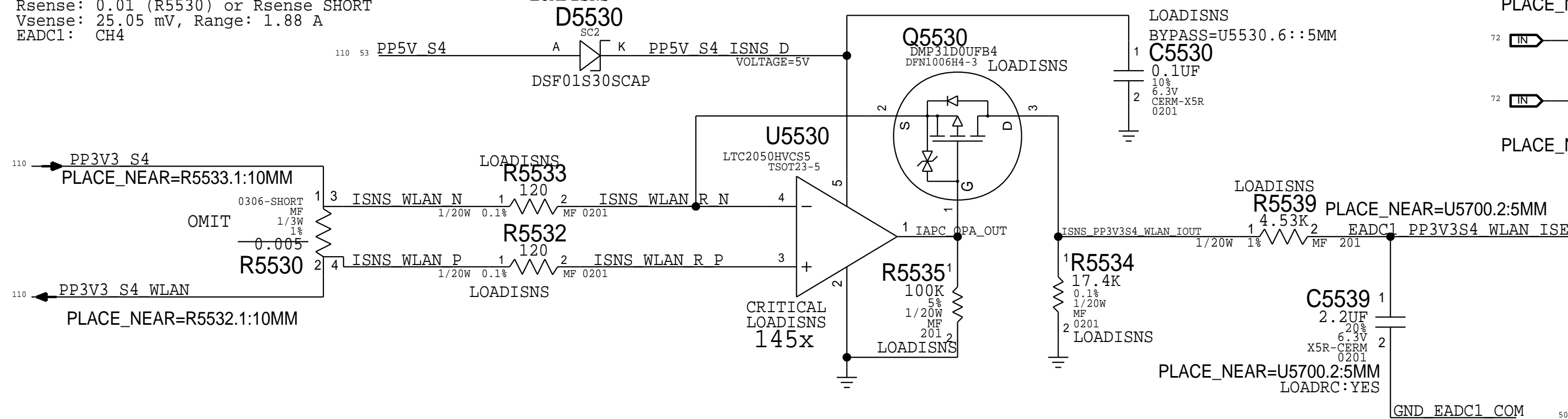
## T139 Current Sense (IF3C)

Gain: 200x, EDP: 0.06 A  
Rsense: 0.05 (R5520) or Rsense SHORT  
Vsense: 3 mV, Range: 0.25 A  
EADC1: CH3



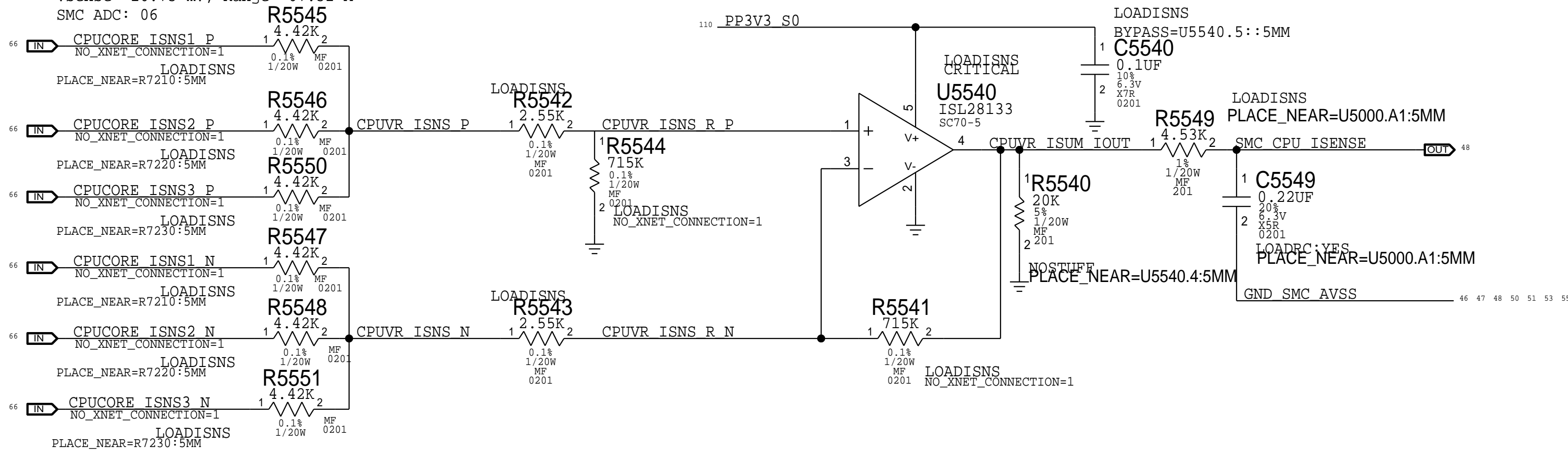
## WLAN Current Sense (IAPC)

Gain: 200x, EDP: 1.67 A  
Rsense: 0.01 (R5530) or Rsense SHORT  
Vsense: 25.05 mV, Range: 1.88 A  
EADC1: CH4



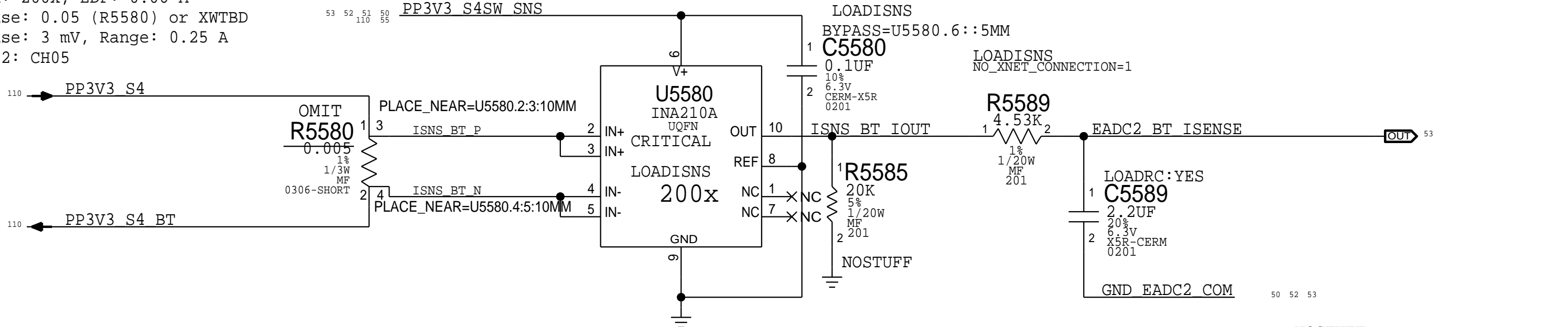
## CPU Fixed Current Sense (ICAC)

Gain: 177.71x, EDP: 67 A  
Rsense: 3x of 0.00075 (R7210, R7220, R7230), Rsum: 0.00025  
Vsense: 16.75 mV, Range: 67.52 A  
SMC ADC: 06



## BT Current Sense (IBTC)

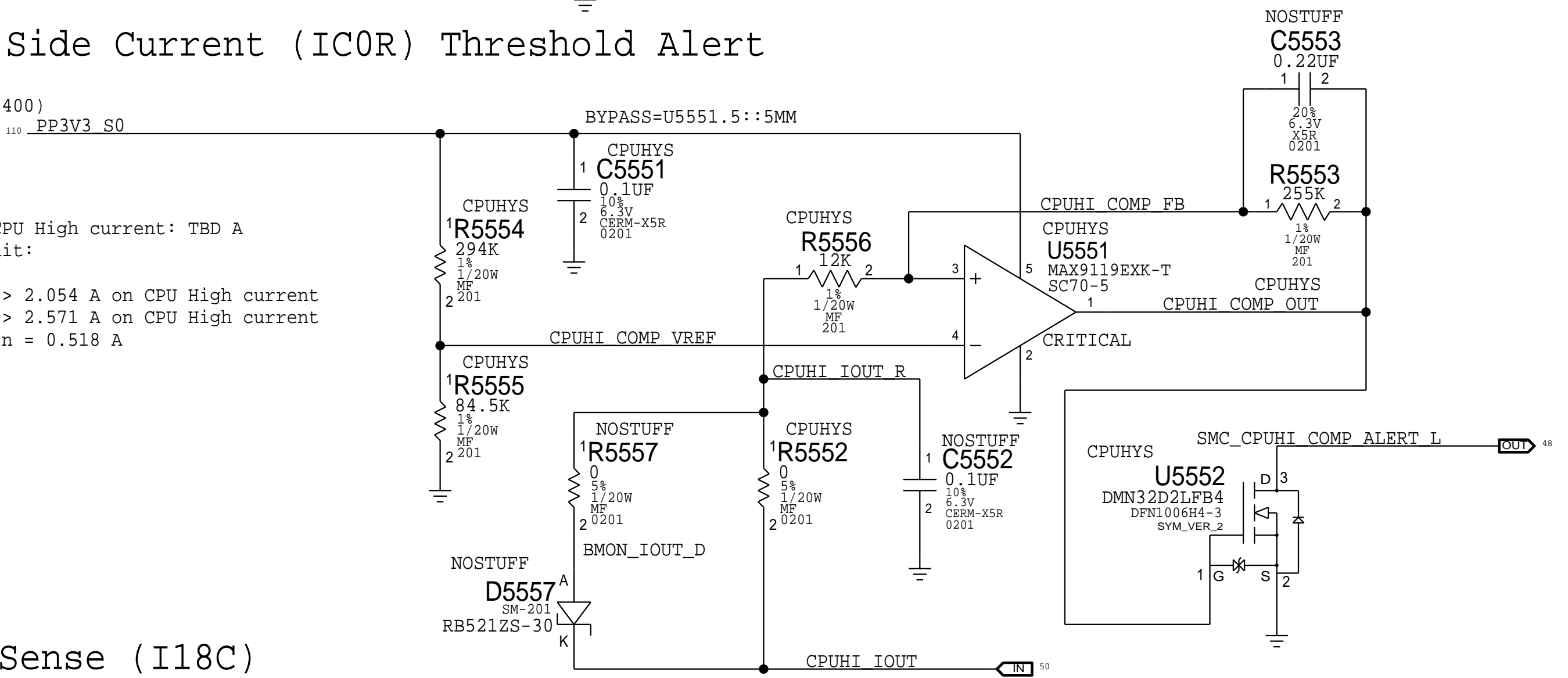
Gain: 200x, EDP: 0.06 A  
Rsense: 0.05 (R5580) or XWTBD  
Vsense: 3 mV, Range: 0.25 A  
EADC2: CH05



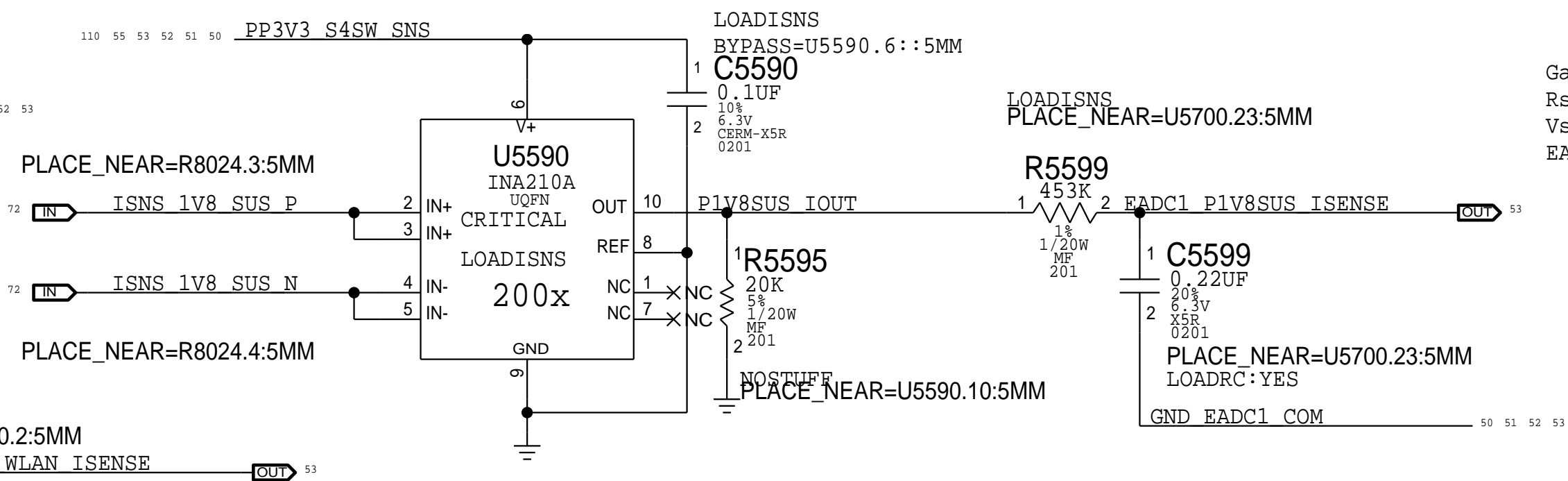
## CPU High Side Current (IC0R) Threshold Alert

Gain: 100x  
Rsense: 0.001 (R5400)

Trip Target on CPU High current: TBD A  
Hysteresis Circuit:  
Vref = 0.737 V  
Vth = 0.616 V -> 2.054 A on CPU High current  
Vtl = 0.771 V -> 2.571 A on CPU High current  
Hysteresis Margin = 0.518 A

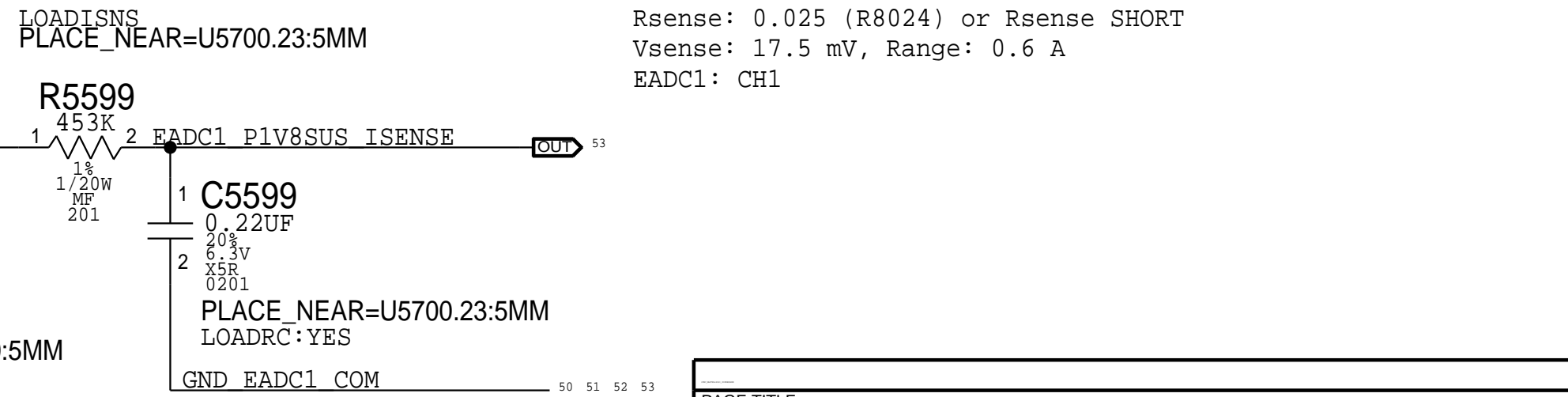


## 1.8V Current Sense (I18C)



PART NUMBER	QTY	DESCRIPTION	REFERENCE DES	CRITICAL	BOM OPTION
117S0008	6	RES,MTL FLIM,100K,1/16W,0201,SMD,LF	C5513,C5529,C5539,C5549,C5589,C5599		LOADRC:NO
117S0008	1	RES,MTL FLIM,100K,1/16W,0201,SMD,LF	C5579		DDRRC:NO

Gain: 200x, EDP: 0.7 A  
Rsense: 0.025 (R8024) or Rsense SHORT  
Vsense: 17.5 mV, Range: 0.6 A  
EADC1: CH1



PAGE TITLE			
Power Sensors: Load Side			
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BOM\_COST\_GROUP=SENSORS

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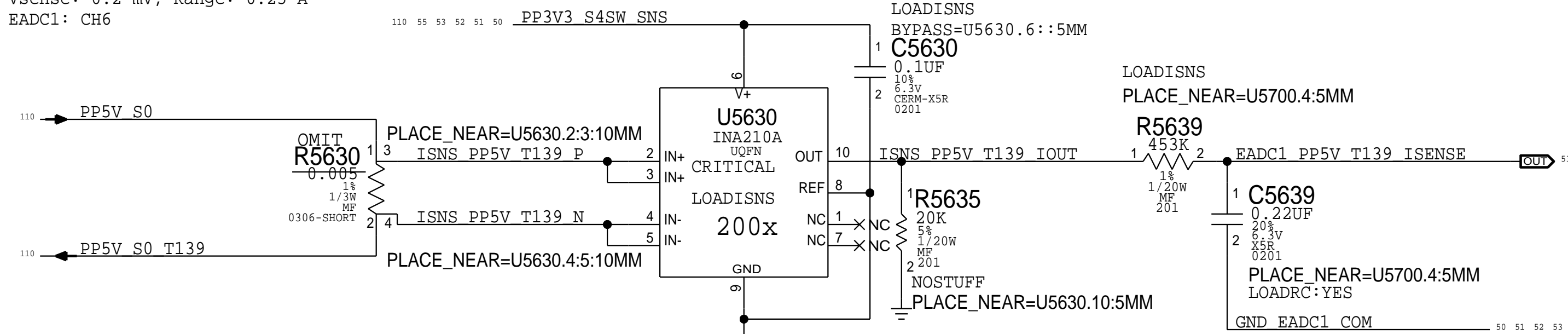
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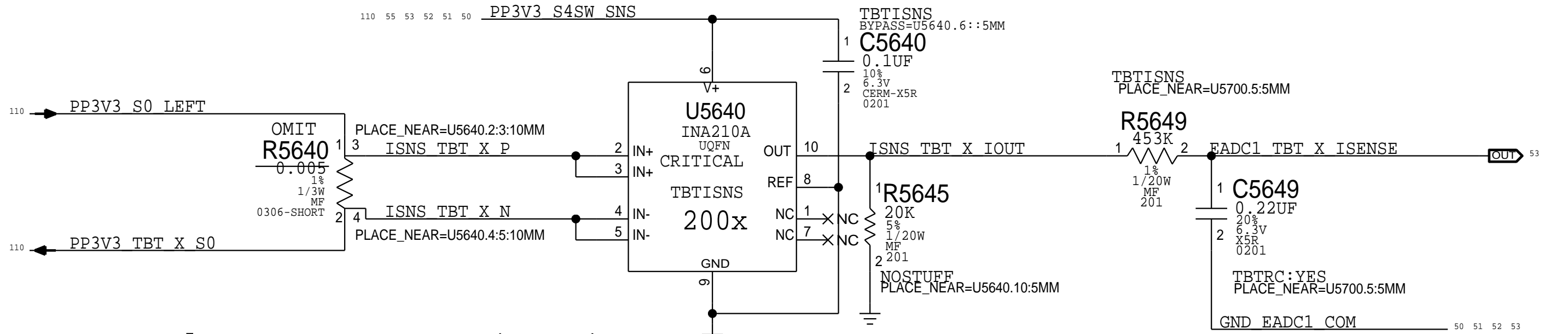
### T139 5V Current Sense (IF5C)

Gain: 200x, EDP: 0.004 A  
Rsense: 0.05 (R5630) or Rsense SHORT  
Vsense: 0.2 mV, Range: 0.25 A  
EADC1: CH6



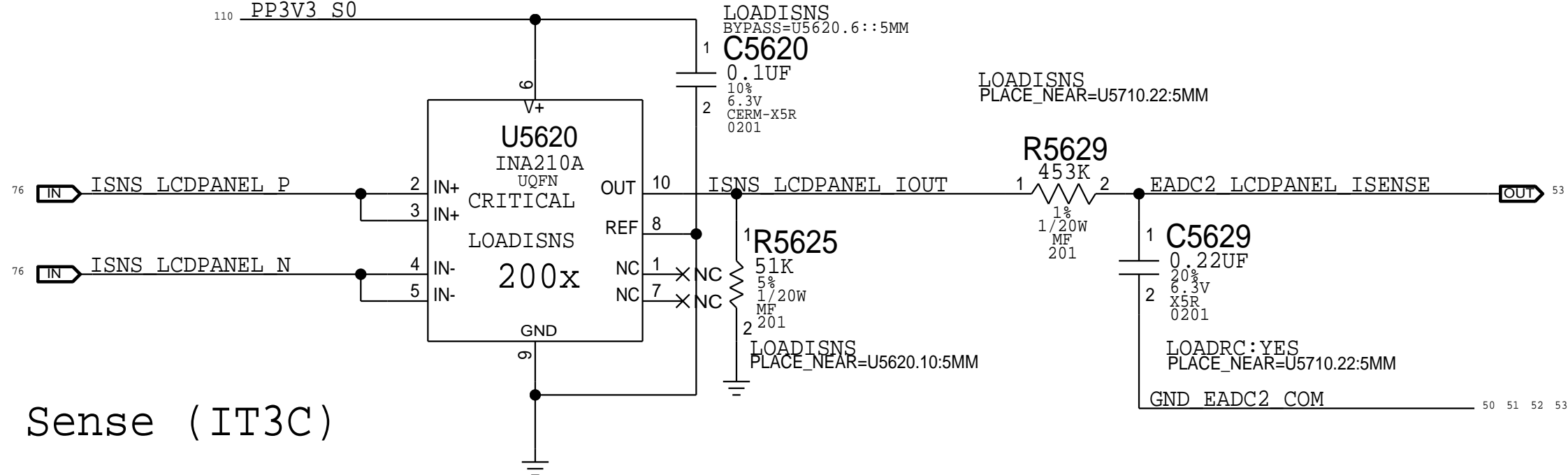
### Thunderbolt TBT LEFT Current Sense (ITLC)

Gain: 200x, EDP: 0.5 A  
Rsense: 0.025 (R5640) or Rsense SHORT  
Vsense: 12.5 mV, Range: 0.5 A  
EADC1: CH7



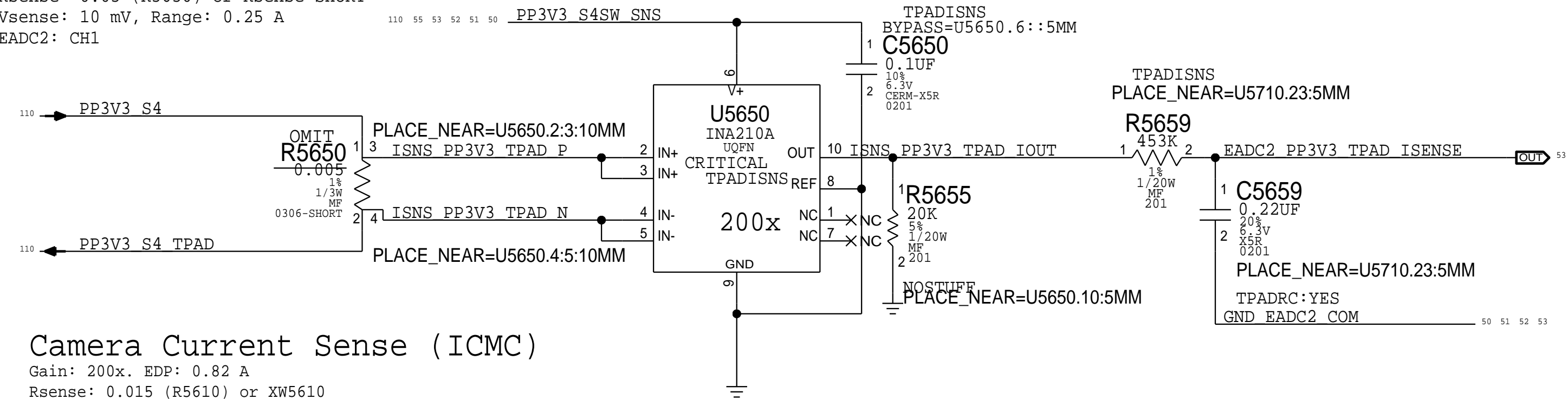
### LCD Panel Current Sense (ILDC)

Gain: 200x, EDP: 1 A  
RSENSE: 0.01 (R5620) or Rsense SHORT  
Vsense: 5 mV, Range: 1.25 A  
EADC2: CH0



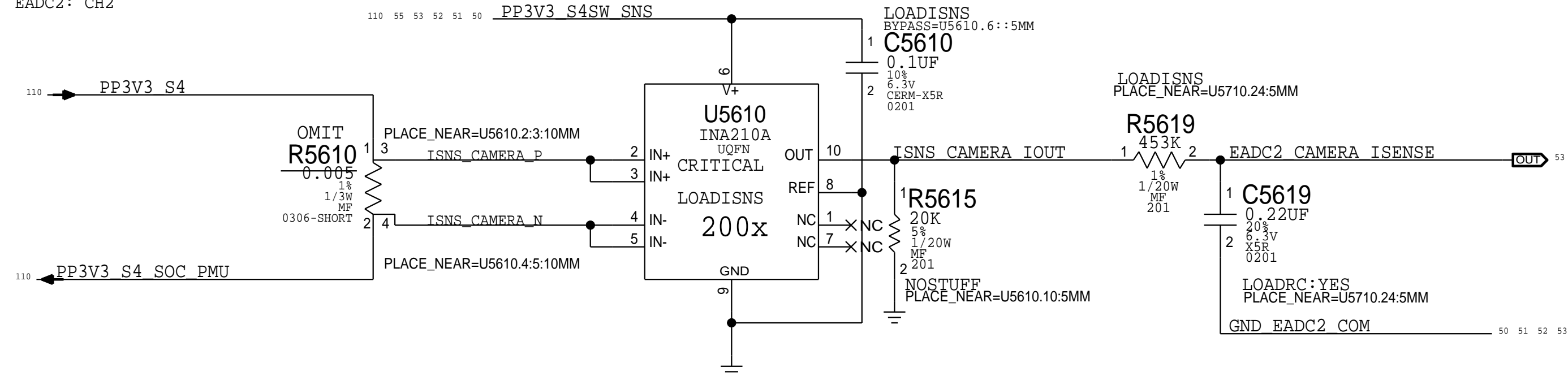
### Trackpad 3V Current Sense (IT3C)

Gain: 200x, EDP: 0.2 A  
Rsense: 0.05 (R5650) or Rsense SHORT  
Vsense: 10 mV, Range: 0.25 A  
EADC2: CH1

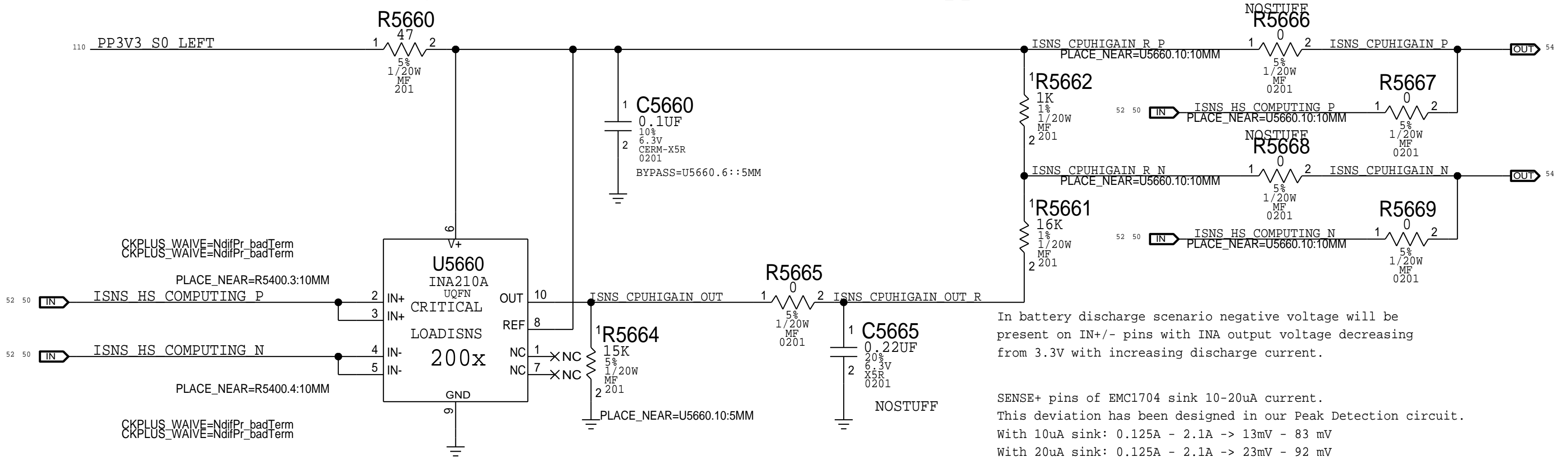


### Camera Current Sense (ICMC)

Gain: 200x, EDP: 0.82 A  
Rsense: 0.015 (R5610) or XW5610  
Vsense: 12.3 mV, Range: 0.83 A  
EADC2: CH2

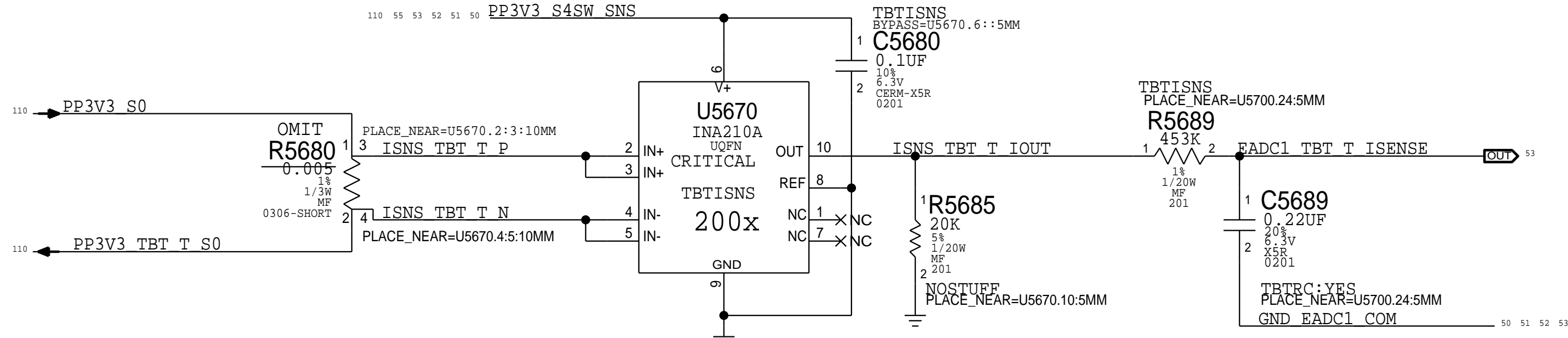


### CPU High Side (IC0R) Peak Detection Support



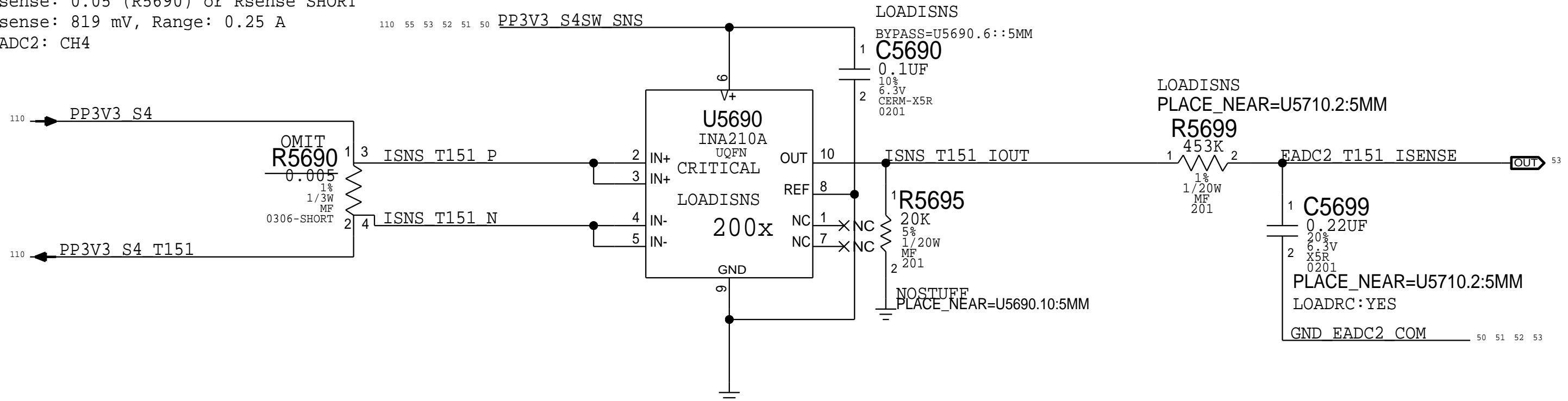
### Thunderbolt TBT RIGHT Current Sense (IURC)

Gain: 200x, EDP: 0.5 A  
Rsense: 0.025 (R5680) or Rsense SHORT  
Vsense: 12.5 mV, Range: 0.5 A  
EADC1: CH2



### T151 Current Sense (IIDC)

Gain: 200x, EDP: 0.1638 A  
Rsense: 0.05 (R5690) or Rsense SHORT  
Vsense: 819 mV, Range: 0.25 A  
EADC2: CH4



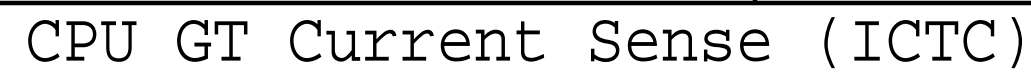
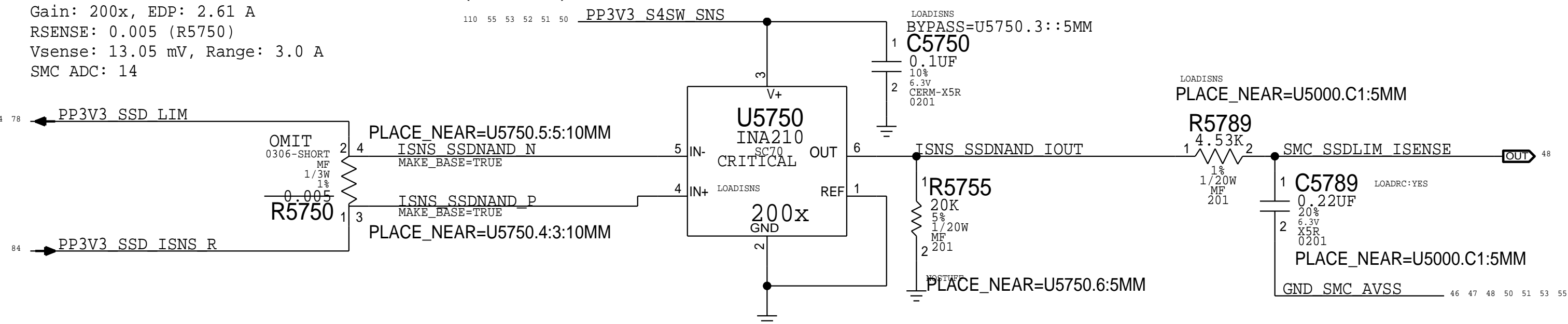
PART NUMBER	QTY	DESCRIPTION	REFERENCE DES	CRITICAL	BOM OPTION
117S0008	4	RES,MTL FILM,100K,1/16W,0201,SMD,LF	C5619,C5629,C5639,C5699		LOADRC:NO
117S0008	2	RES,MTL FILM,100K,1/16W,0201,SMD,LF	C5649,C5689		TBTRC:NO
117S0008	1	RES,MTL FLIM,100K,1/16W,0201,SMD,LF	C5659		TPADRC:NO

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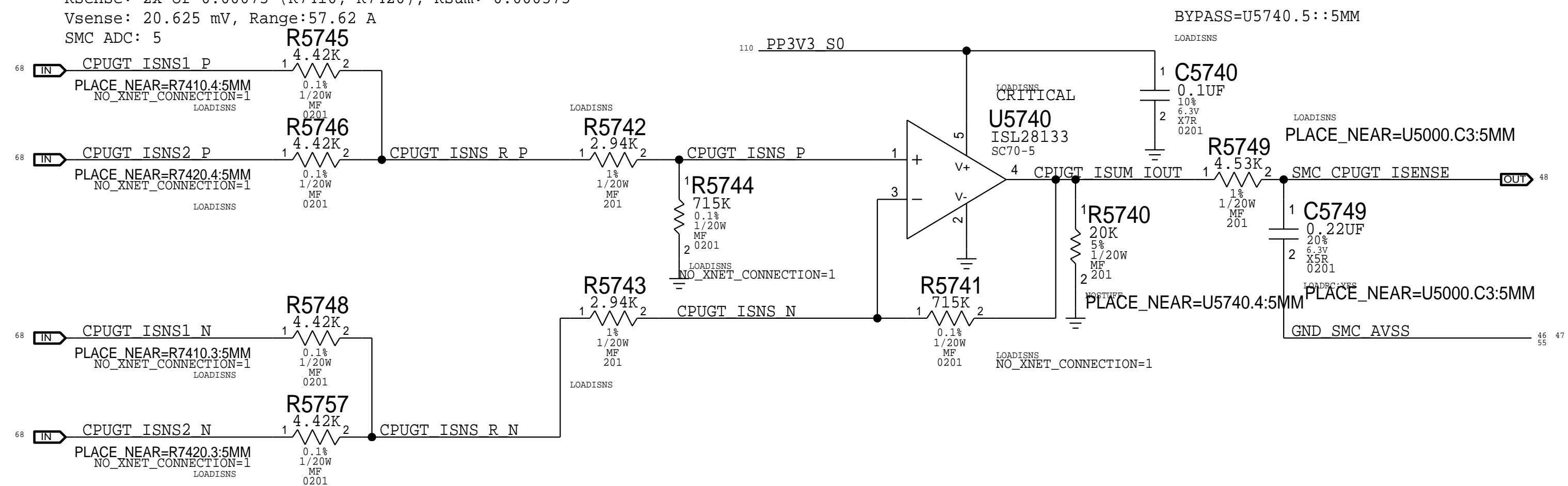




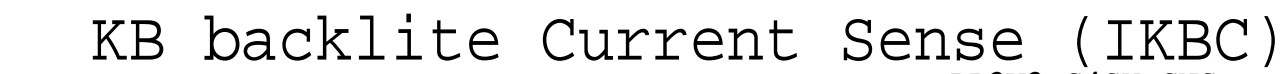
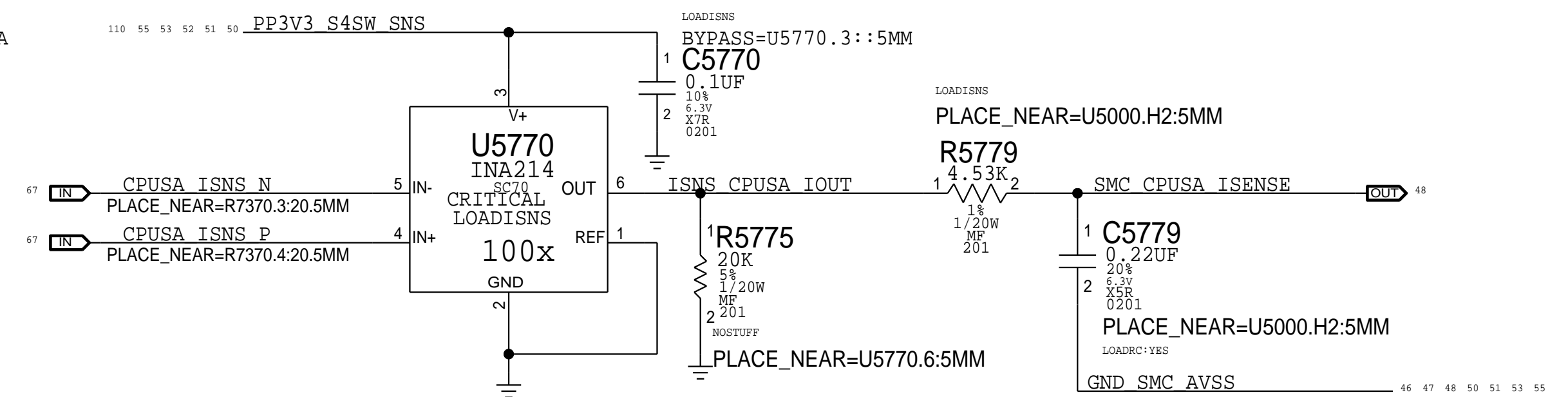
Gain: 200x, EDP: 2.61 A  
RSENSE: 0.005 (R5750)  
Vsense: 13.05 mV, Range: 3.0 A  
SMC ADC: 14



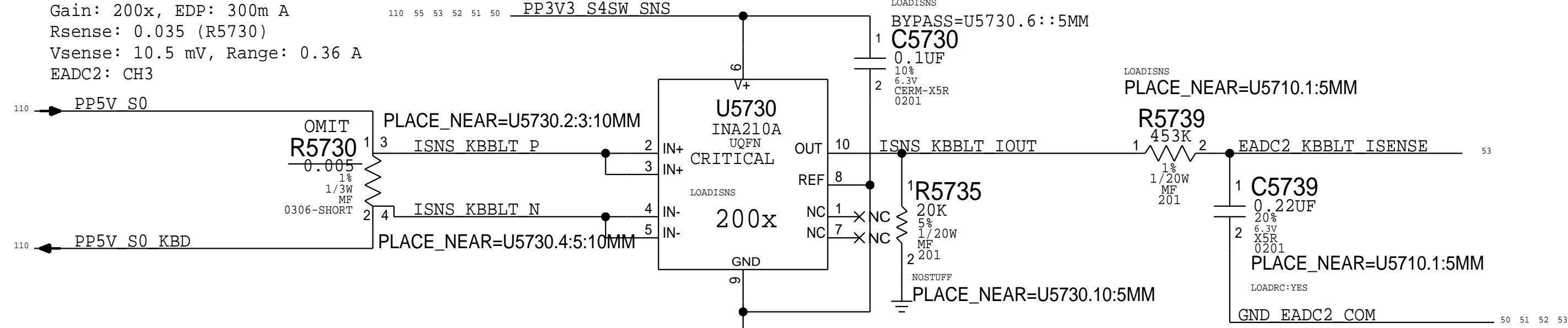
Gain: 202.93x, EDP: 55 A  
Rsense: 2x of 0.00075 (R7410, R7420), Rsum: 0.000375  
Vsense: 20.625 mV, Range: 57.62 A  
SMC ADC: 5



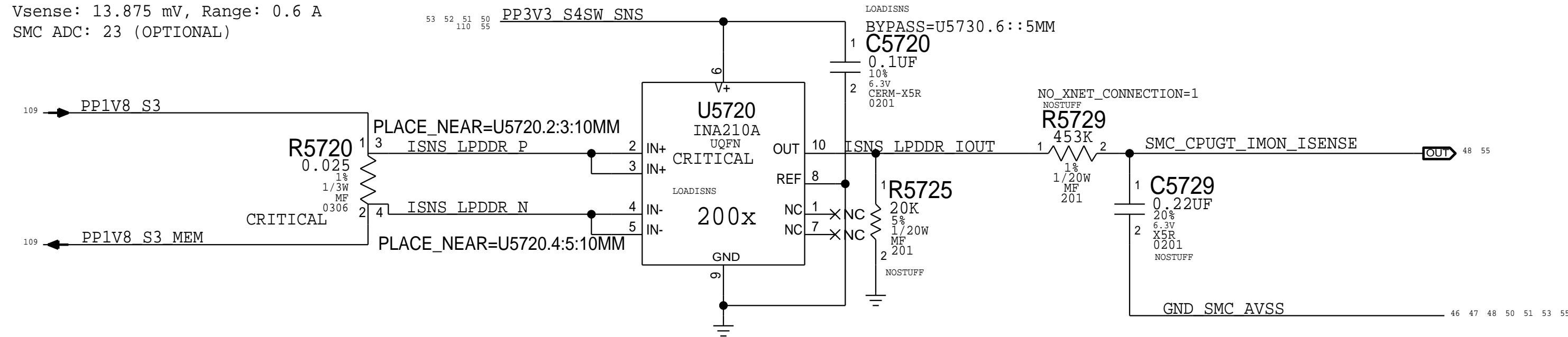
Gain: 200x, EDP: 8 A  
Rsense: 0.002 (R7570)  
Vsense: 16 mV, Range: 7.5 A  
SMC ADC: 17



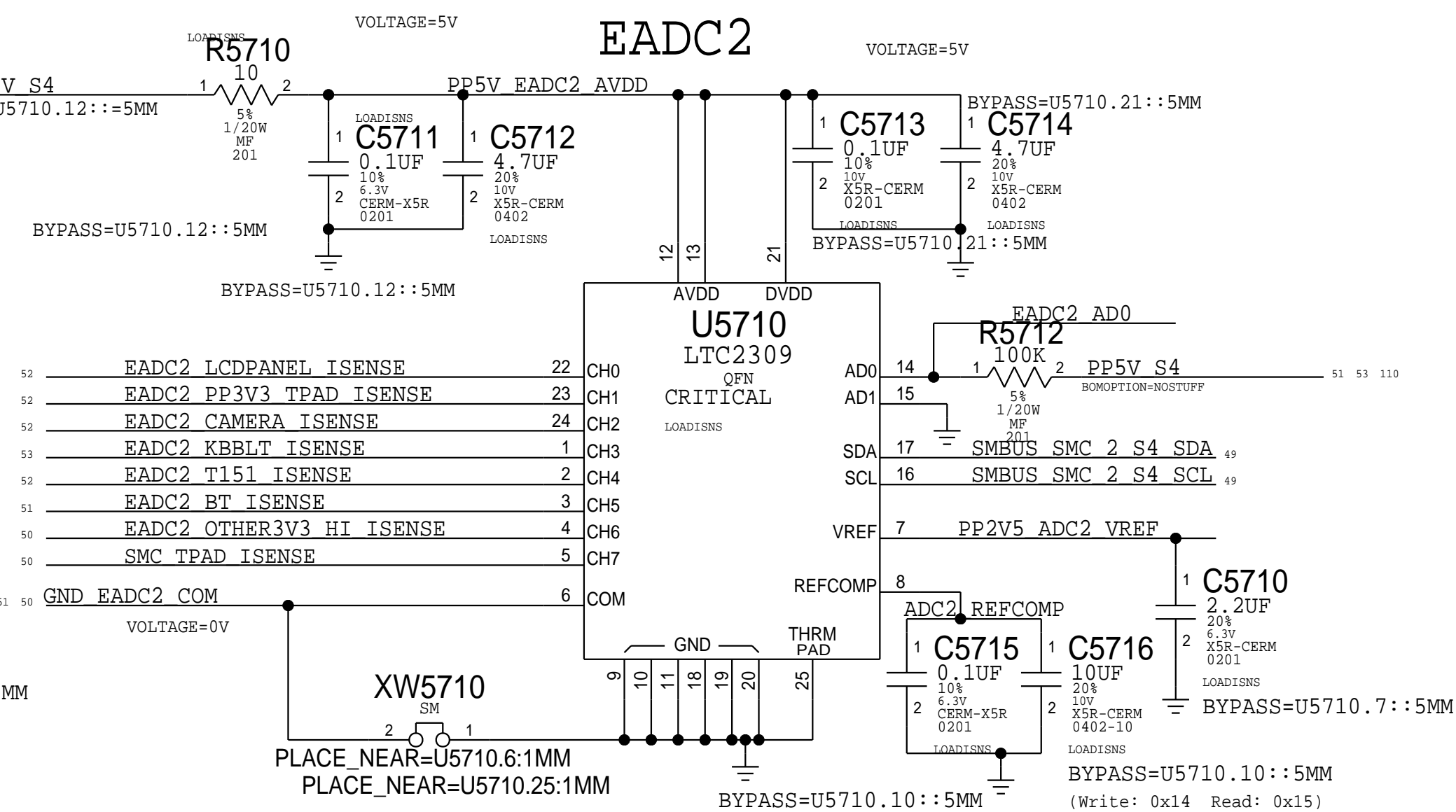
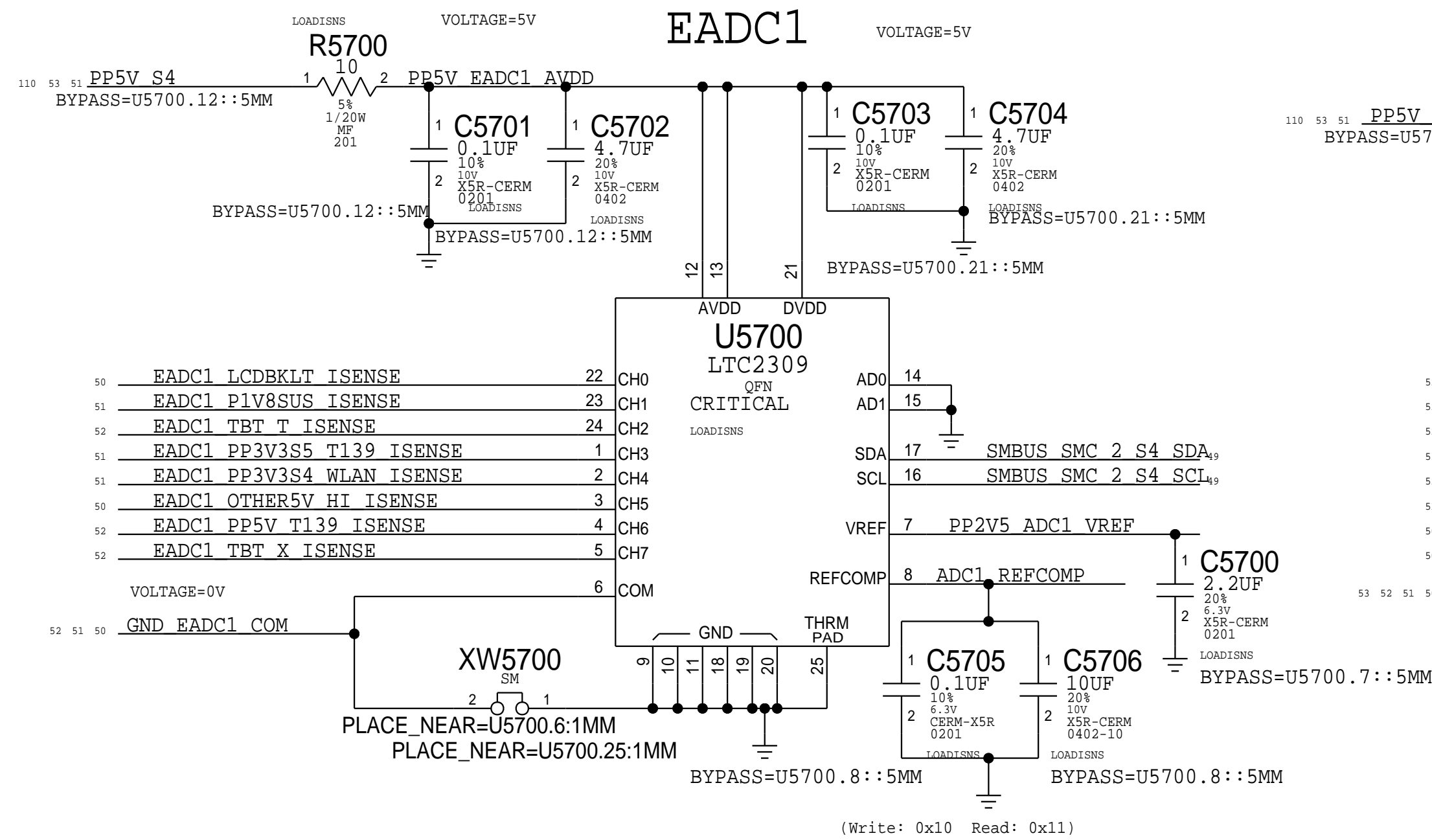
```
Gain: 200x, EDP: 300m A
Rsense: 0.035 (R5730)
Vsense: 10.5 mV, Range: 0.36 A
EADC2: CH3
```



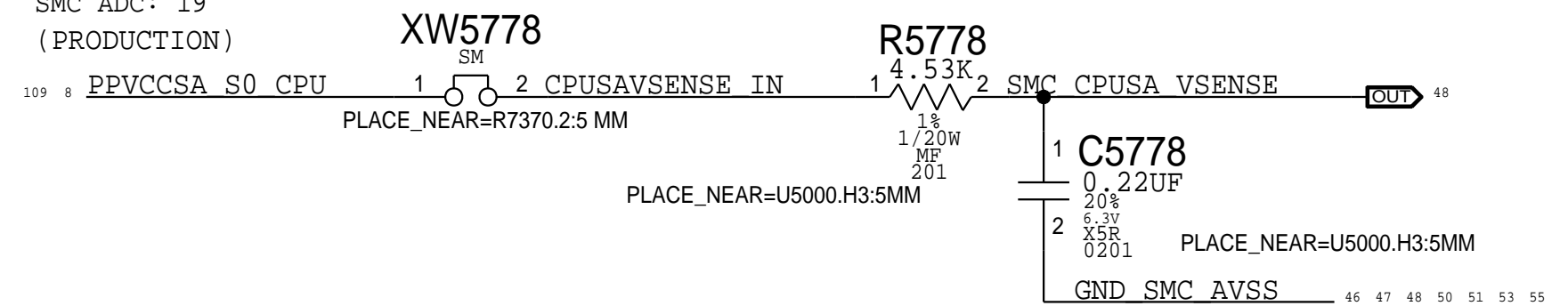
Gain: 200x, EDP: 0.555 A  
Rsense: 0.025 (R5720) or Rsense SHORT  
Vsense: 13.875 mV, Range: 0.6 A  
SMC ADC: 23 (OPTIONAL)




PART NUMBER	QTY	DESCRIPTION	REFERENCE DES	CRITICAL	BOM OPTION
117S0008	4	RES,MTL FLIM,100K,1/16W,0201,SMD,LF	C5739,C5749,C5779,C5789		LOADRC:NO



SMC ADC: 19  
(PRODUCTION

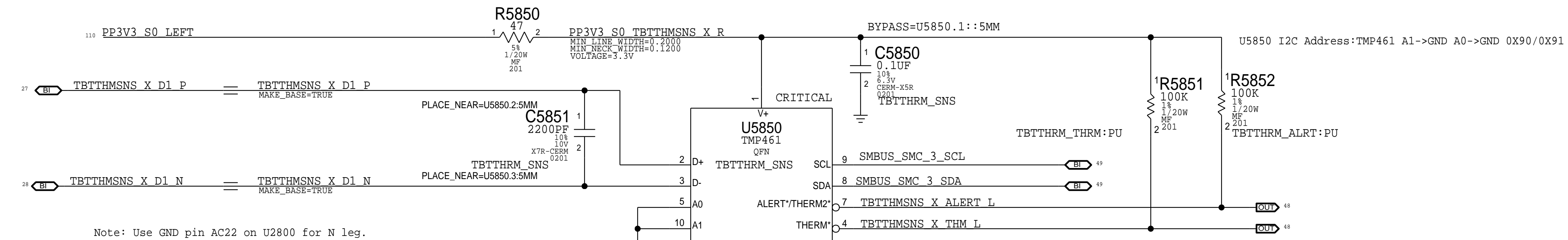


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Power Sensors: Extended 2		
 Apple Inc.	DRAWING NUMBER	SIZE
	051-00647	D
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	10.0.0	
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```
I2C Write: 0xD8, I2C Read: 0xD9
```

Thermal Diode: TBT Die (TTLD)

Placement Note:  
The P leg connects to THERMDA pin of the TBT chip, the N leg connect to pin AC22.



Thermal Diode: Airflow Left Proximity (TaLC)

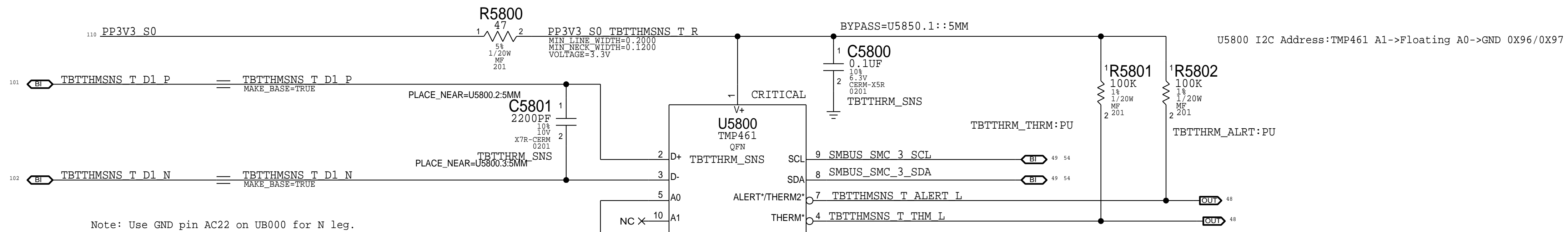
Placement Note:  
Place U5850 on the TOP side, on the left portion  
of the board, 1" to the right of USB connector.

Thermal Sensor C:  
Thunderbolt Die, Air Flow Right

```
I2C Write: 0x98, I2C Read: 0x99
```

Thermal Diode: TBT Die (TTRD)

Placement Note:  
The P leg connects to THERMDA pin of the TBT chip, the N leg connect to pin AC22.

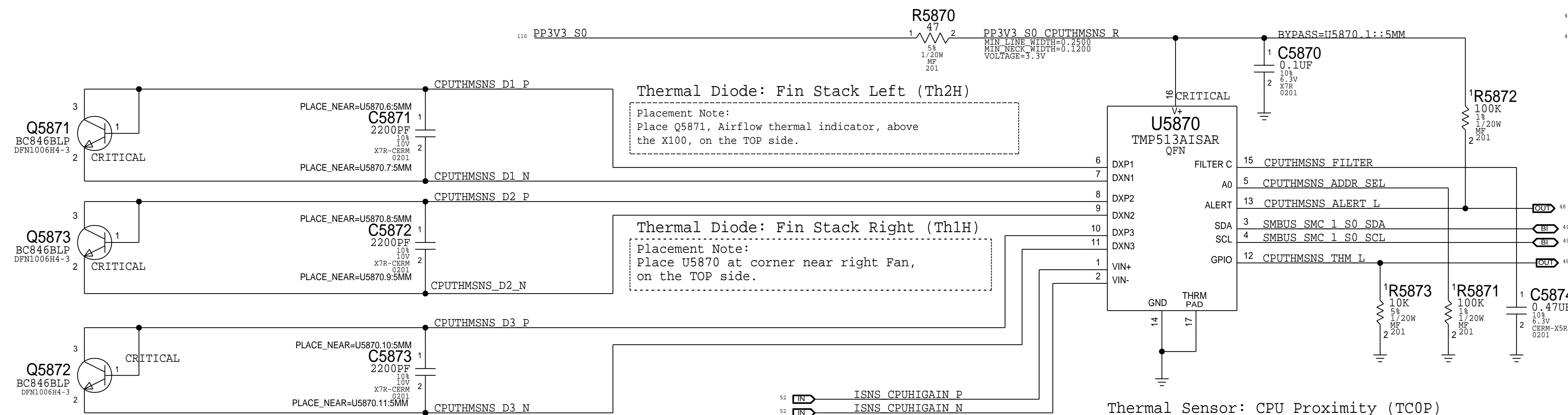


## Thermal Diode: Airflow Right Proximity (TaRC)

Placement Note:  
Place U5800 on the TOP side, on the left portion of the board, 1" to the right of USB connector.

Thermal Sensor B & CPU High Peak Detection:  
CPU Proximity, Memory Proximity, Fin Stack Left, Fin Stack Right

```
I2C Write: 0x98, I2C Read: 0x99
```



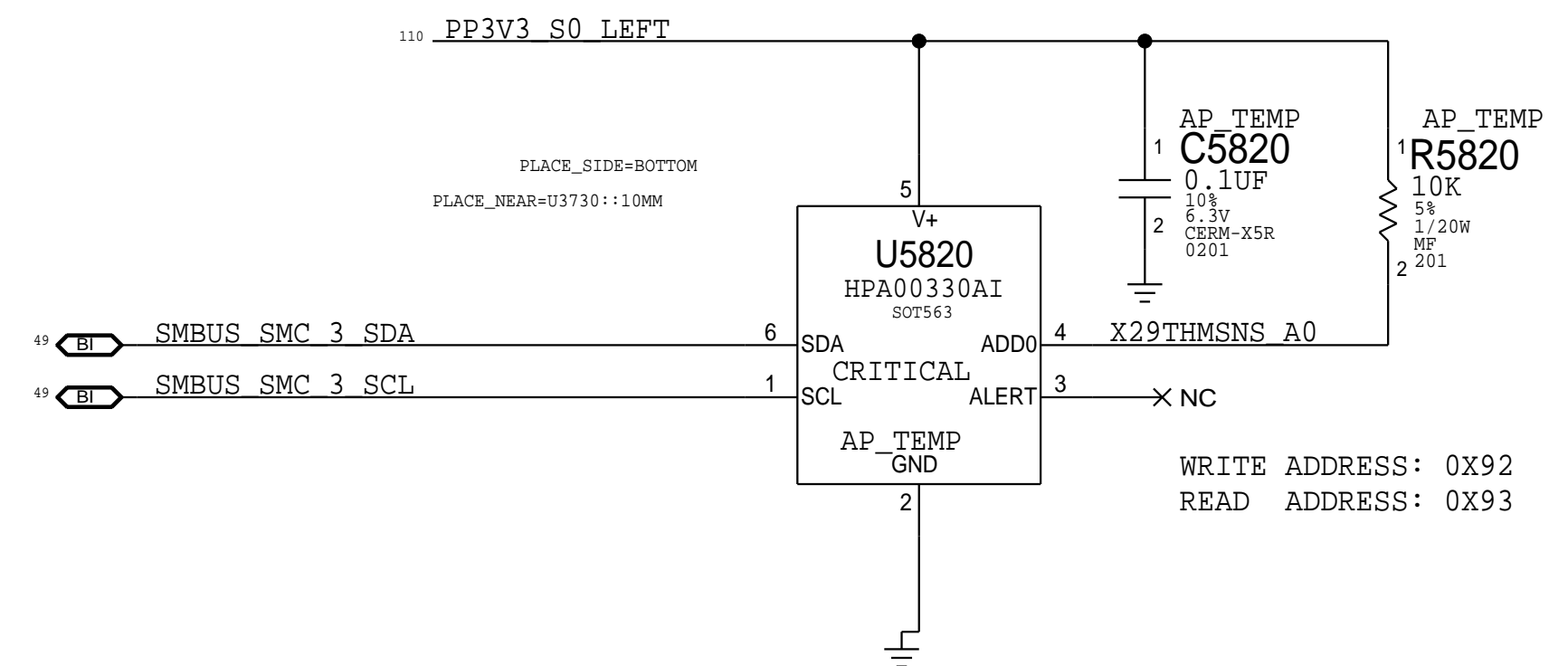
## Thermal Diode: Memory Proximity (TM0P)

Placement Note:  
Place Q5872 between two rows of Memory devices,  
between channel A and B, on the BOTTOM side.


Thermal Sensor: CPU Proximity (TC0P)

Placement Note:  
Place Q5873 under the CPU,  
on the BOTTOM side.

I2C ADDRESS (U5870): 0XB8/0XB9



Placement note:  
PLACE U5820 ON BOTTOM NEAR X100

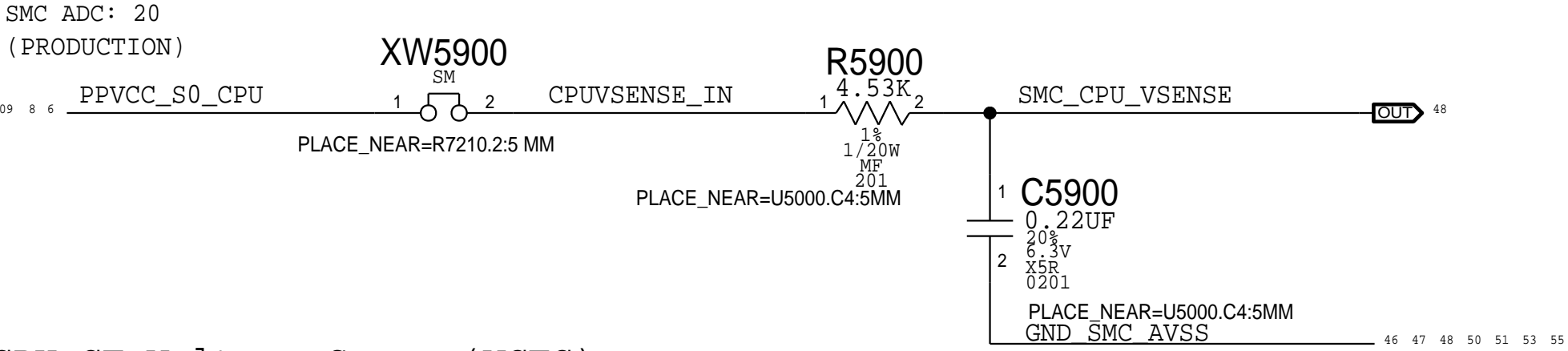
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10.0.0		
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BOM\_COST\_GROUP=SENSORS

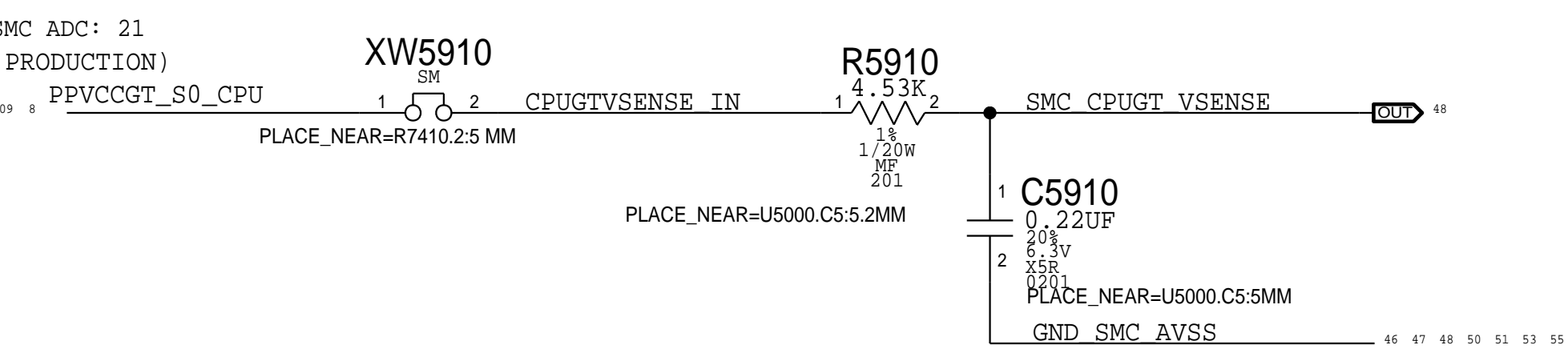


SENSORS: EXTENDER 3

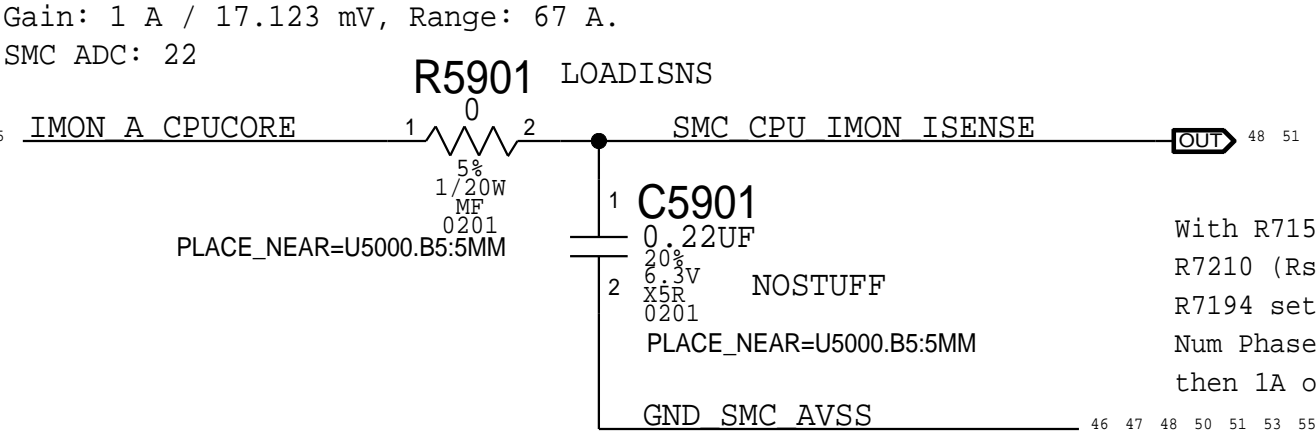
CPU Core Voltage Sense (VCAC)



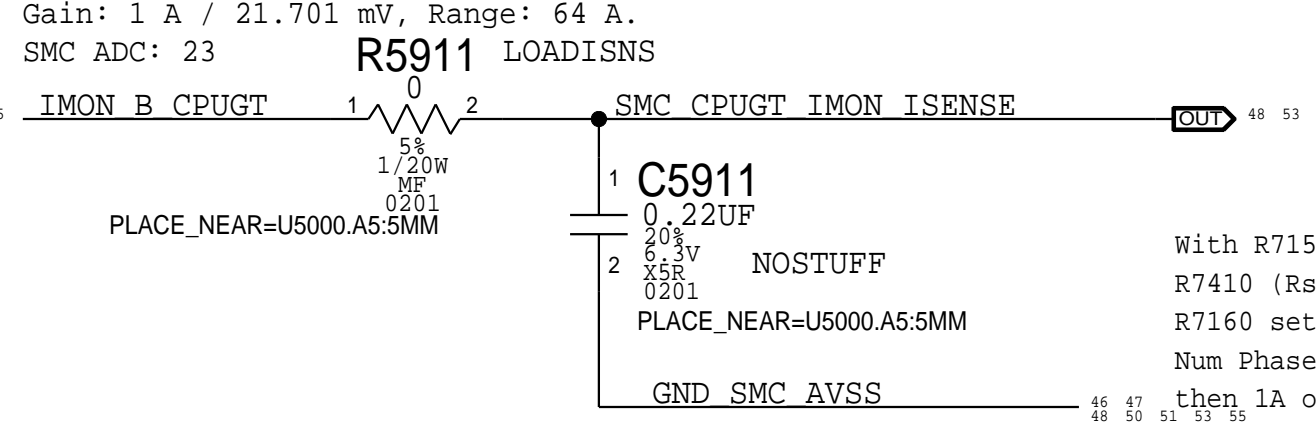
CPU GT Voltage Sense (VCTC)



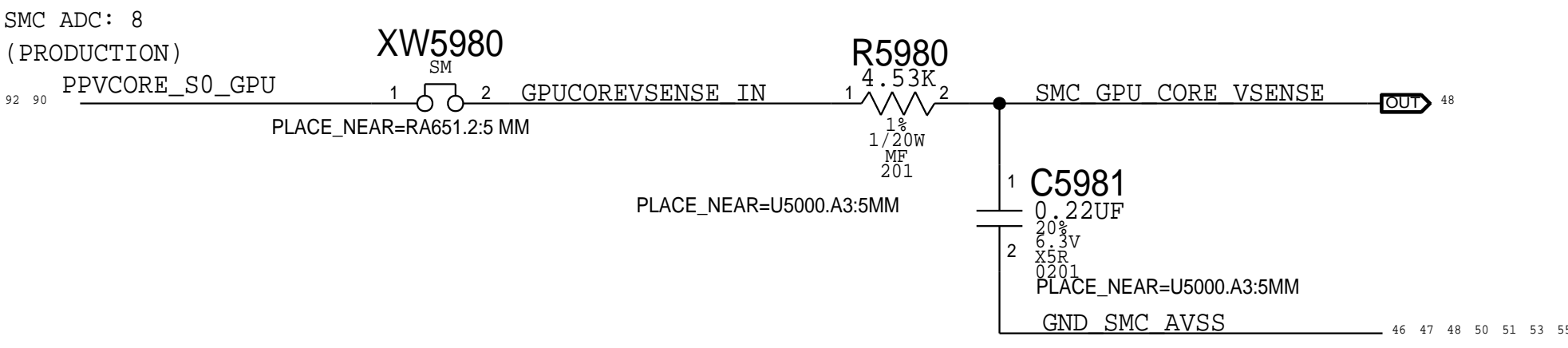
CPU Core IMON Current Sense (ICAM)



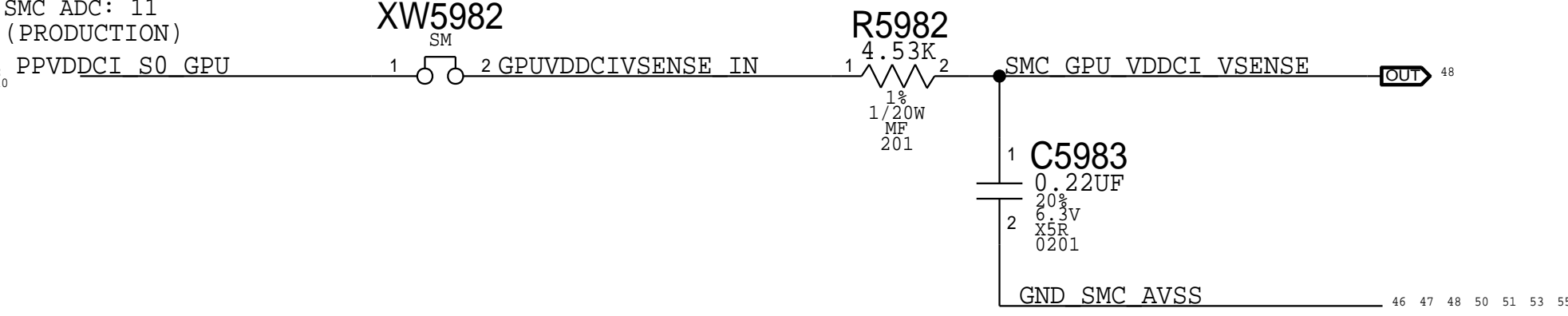
CPU GT IMON Current Sense (ICTM)



GPU CORE Voltage Sense (VG0C)

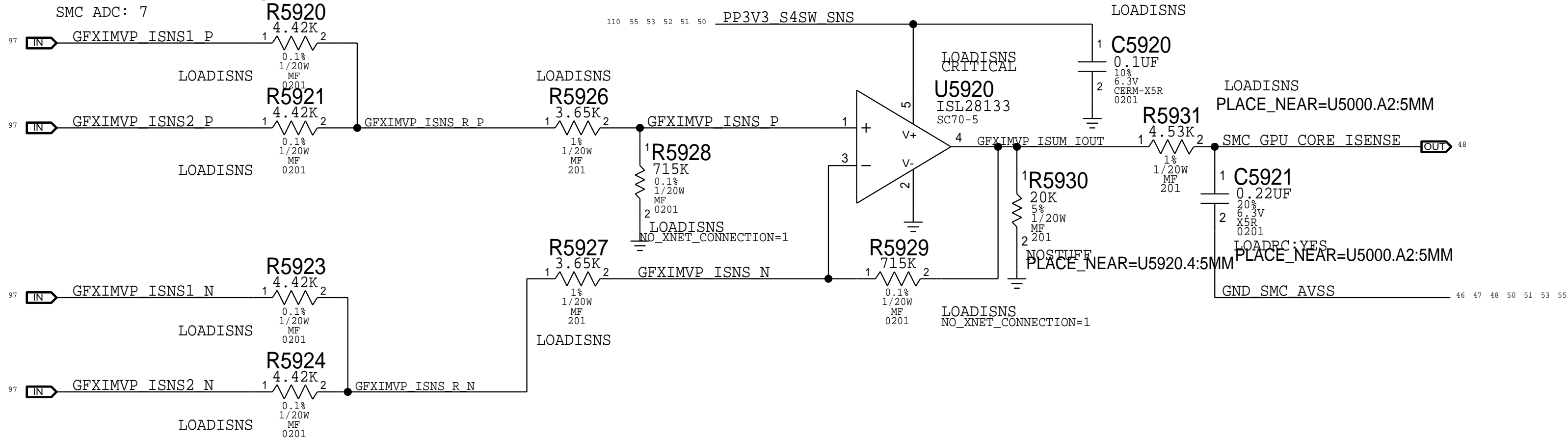


GPU VDDCI Voltage Sense (VG2C)



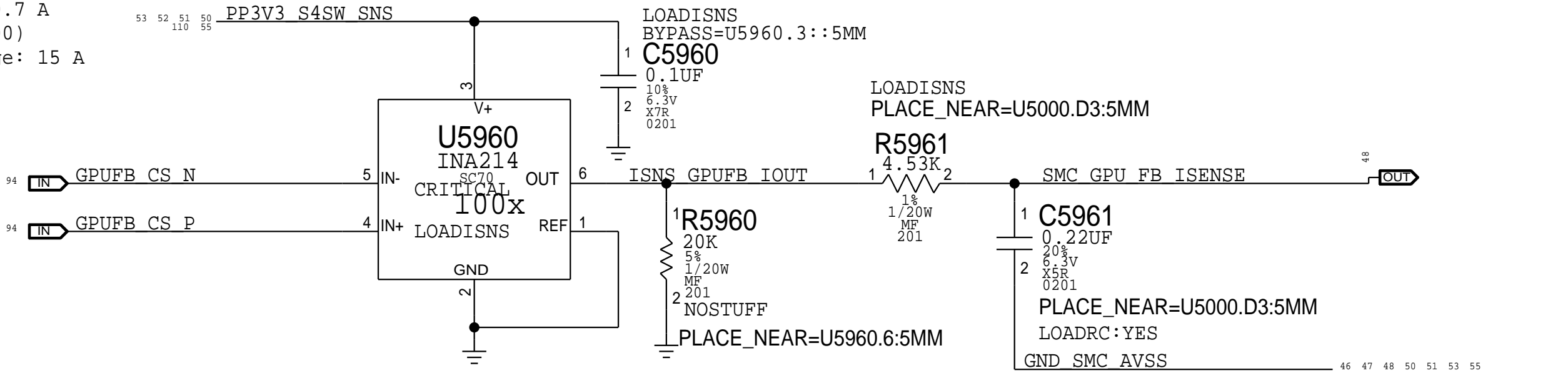
GPU CORE Current Sense (IG0C)

Gain: 122.01x, EDP: 64.2 A  
Rsense: 2x of 0.00075 (RA651, RA641), Rsum: 0.000375  
Vsense: 22.875 mV, Range: 65.57 A  
SMC ADC: 7



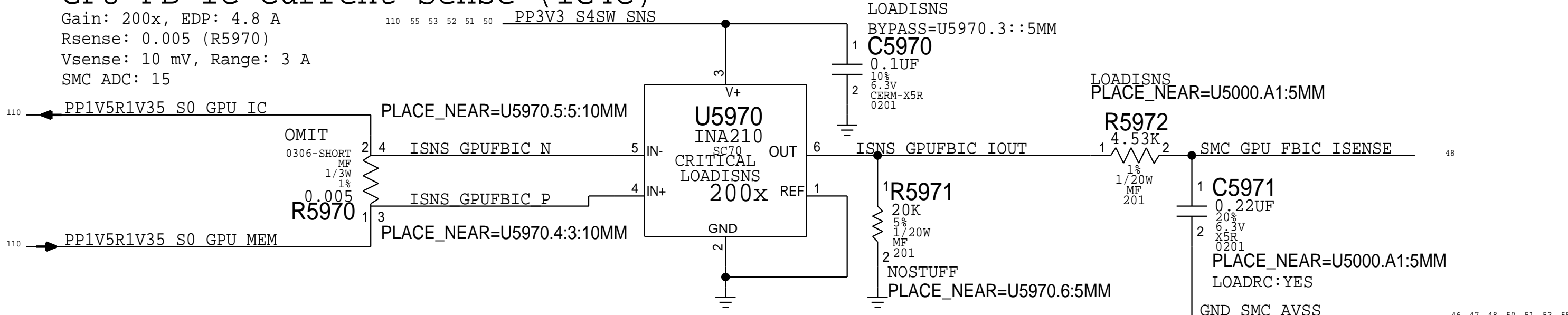
GPU FB Current Sense (IG1C)

Gain: 100x, EDP: 10.7 A  
Rsense: 0.002 (RA300)  
Vsense: 16 mV, Range: 15 A  
SMC ADC: 13



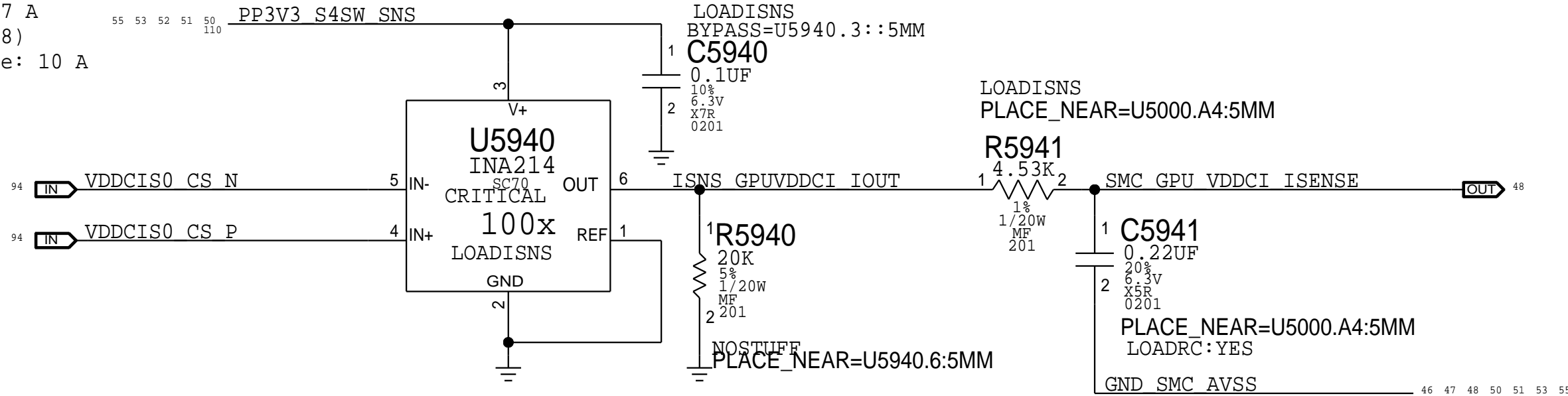
GPU FB IC Current Sense (IG4C)

Gain: 200x, EDP: 4.8 A  
Rsense: 0.005 (R5970)  
Vsense: 10 mV, Range: 3 A  
SMC ADC: 15



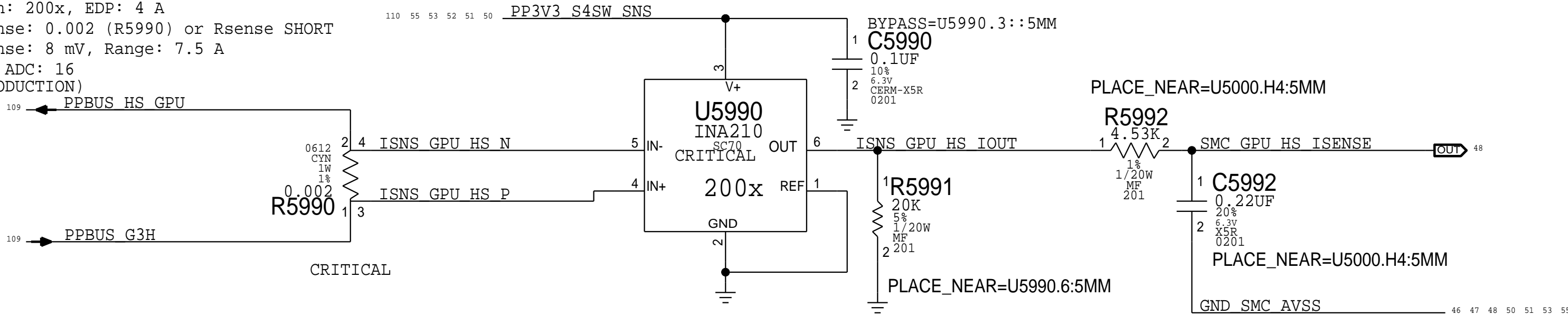
GPU VDDCI Current Sense (IG2C)

Gain: 100x, EDP: 9.7 A  
Rsense: 0.003 (RA368)  
Vsense: 24 mV, Range: 10 A  
SMC ADC: 10



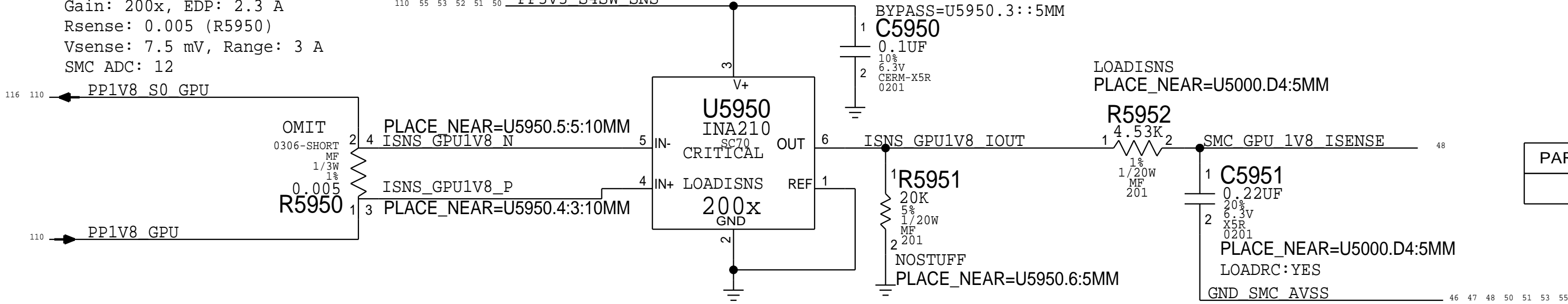
GPU HIGH SIDE Current Sense (IG0R)

Gain: 200x, EDP: 4 A  
Rsense: 0.002 (R5990) or Rsense SHORT  
Vsense: 8 mV, Range: 7.5 A  
SMC ADC: 16  
(PRODUCTION)




GPU 1V8 Current Sense (IG3C)

Gain: 200x, EDP: 2.3 A  
Rsense: 0.005 (R5950)  
Vsense: 7.5 mV, Range: 3 A  
SMC ADC: 12



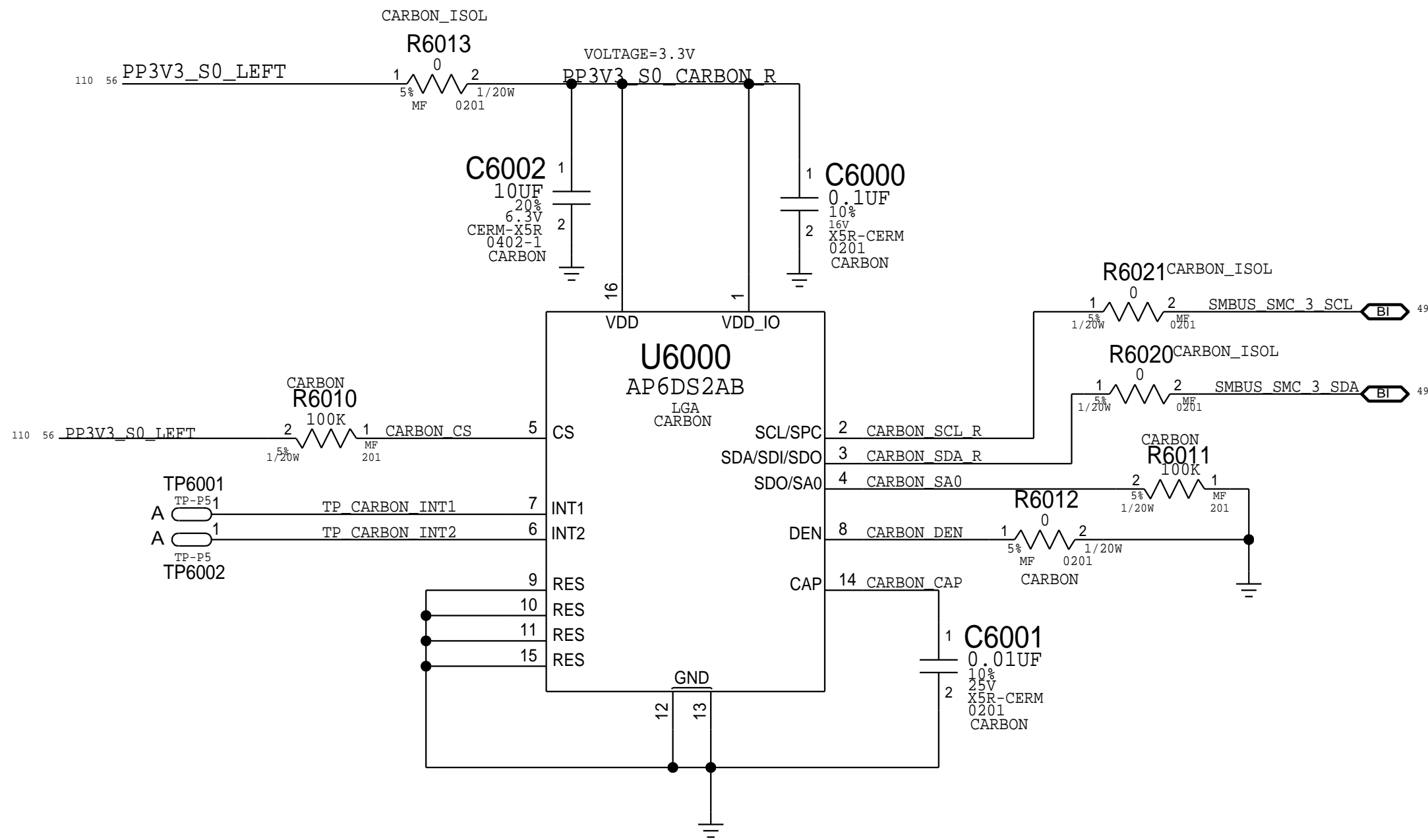
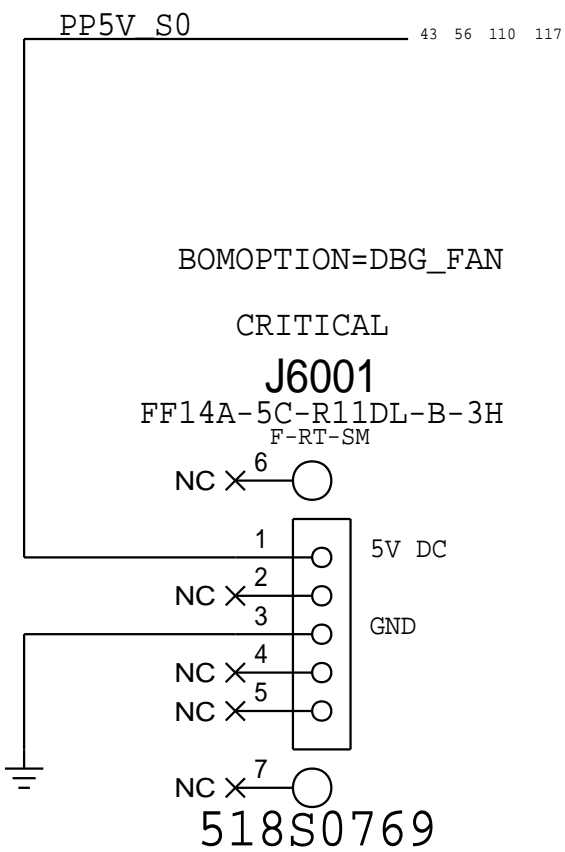
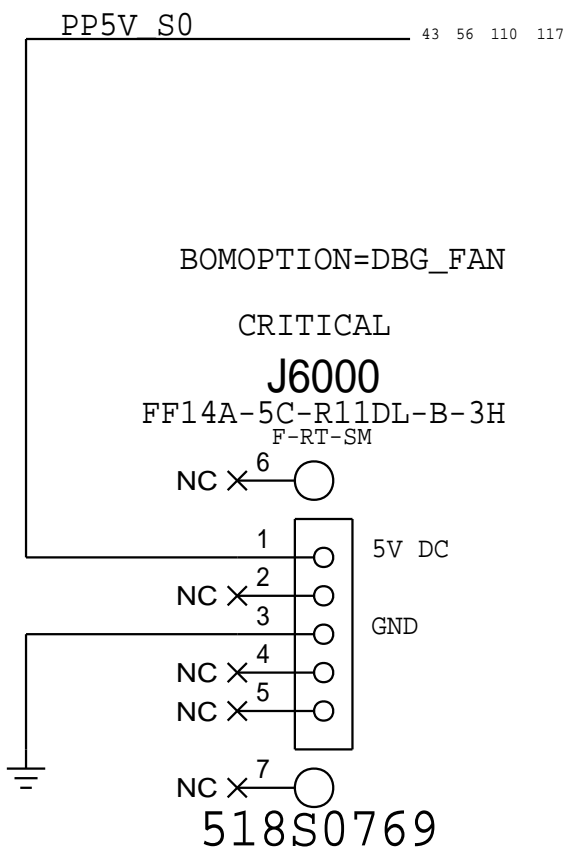
PART NUMBER	QTY	DESCRIPTION	REFERENCE DES	CRITICAL	BOM OPTION
117S0008	5	RES,MTL,FLIM,100K,1/16W,0201,SMD,LF	C5921,C5941,C5951,C5961,C5971		LOADRC:NO

BOM\_COST\_GROUP=SENSORS


Sensor Extended 3		
 Apple Inc.	DRAWING NUMBER	051-00647
	REVISION	10.0.0
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FAN CONNECTOR

KEEP THE 5 PIN CONNECTOR FROM D1



BOM\_COST\_GROUP=FAN

PAGE TITLE			
Fans			
 Apple Inc.	DRAWING NUMBER	051-00647	SIZE
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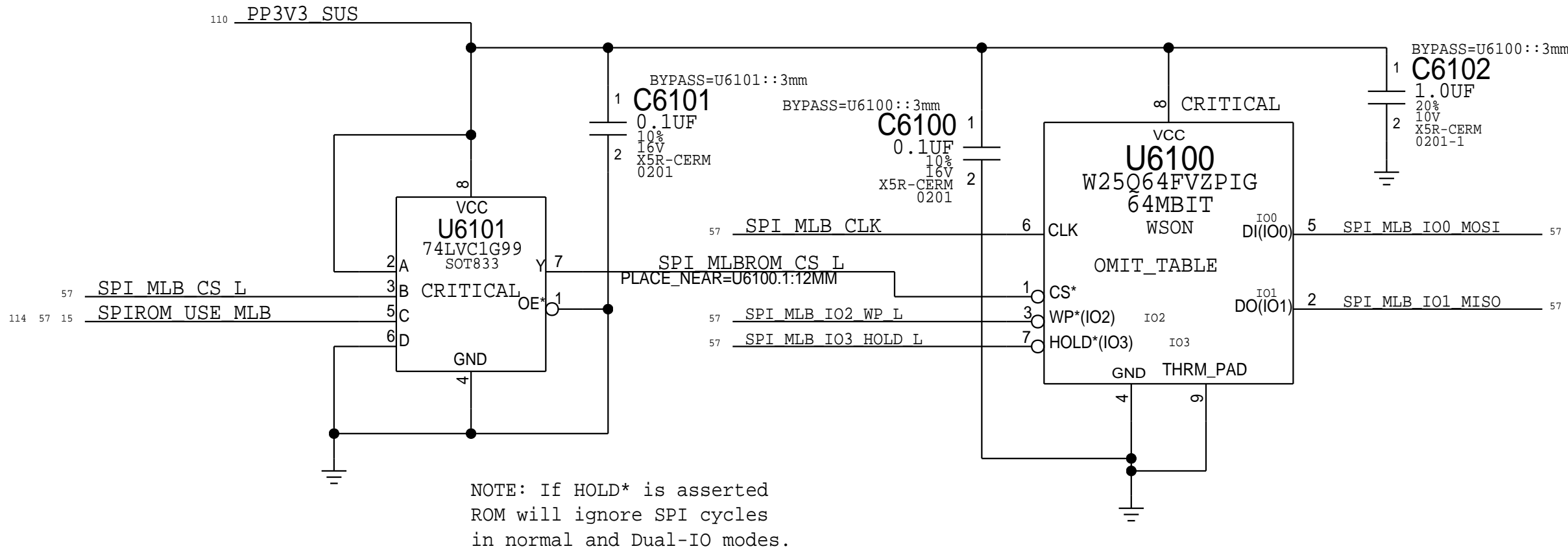
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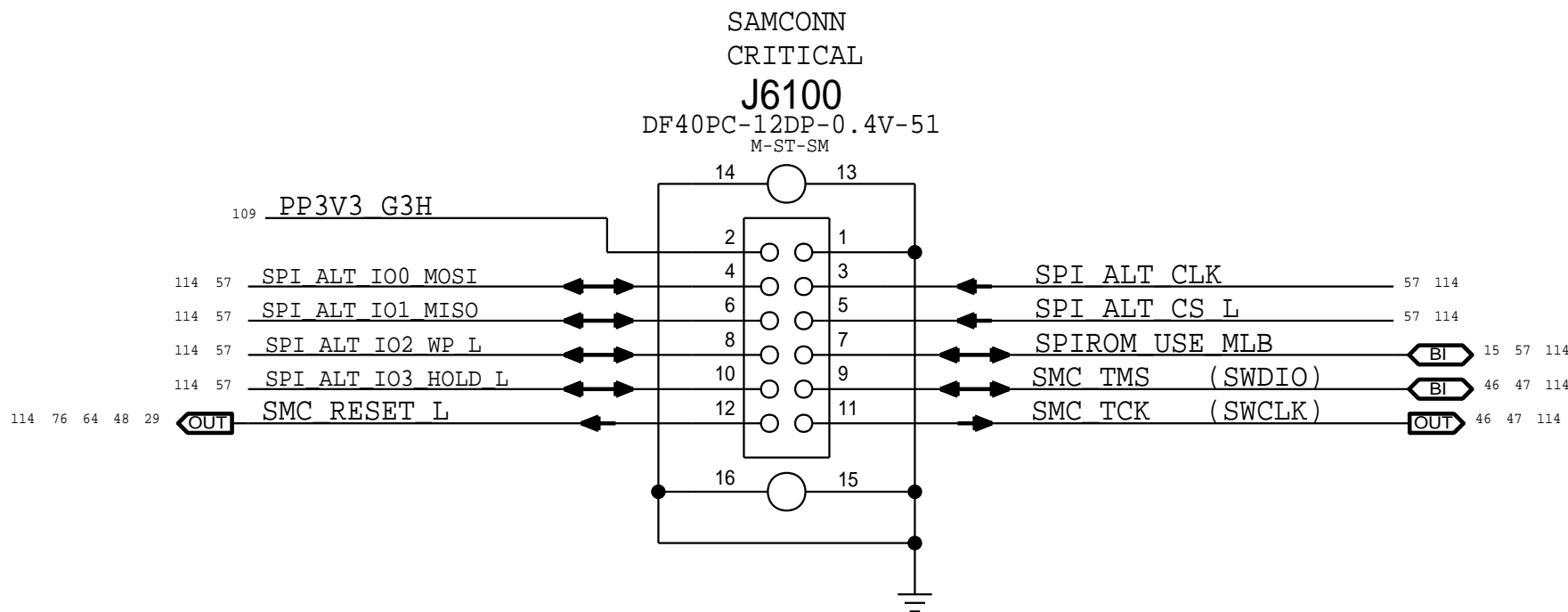
SPI ROM

Quad-I/O Mode (Mode 0 & 3) supported.  
SPI Frequency: 50MHz for CPU, 20MHz for SMC.

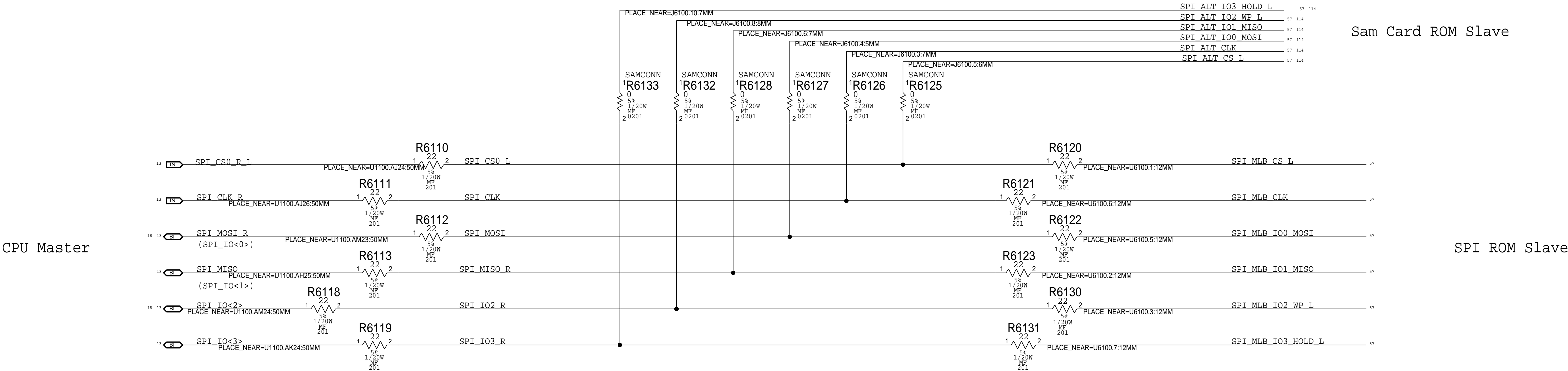


Quad SPI and QPI instructions require the non-volatile Quad Enable bit (QE) in Status Register-2 to be set. When QE=1, the /WP pin becomes IO2 and /HOLD pin becomes IO3.

SPI+SWD SAM Connector

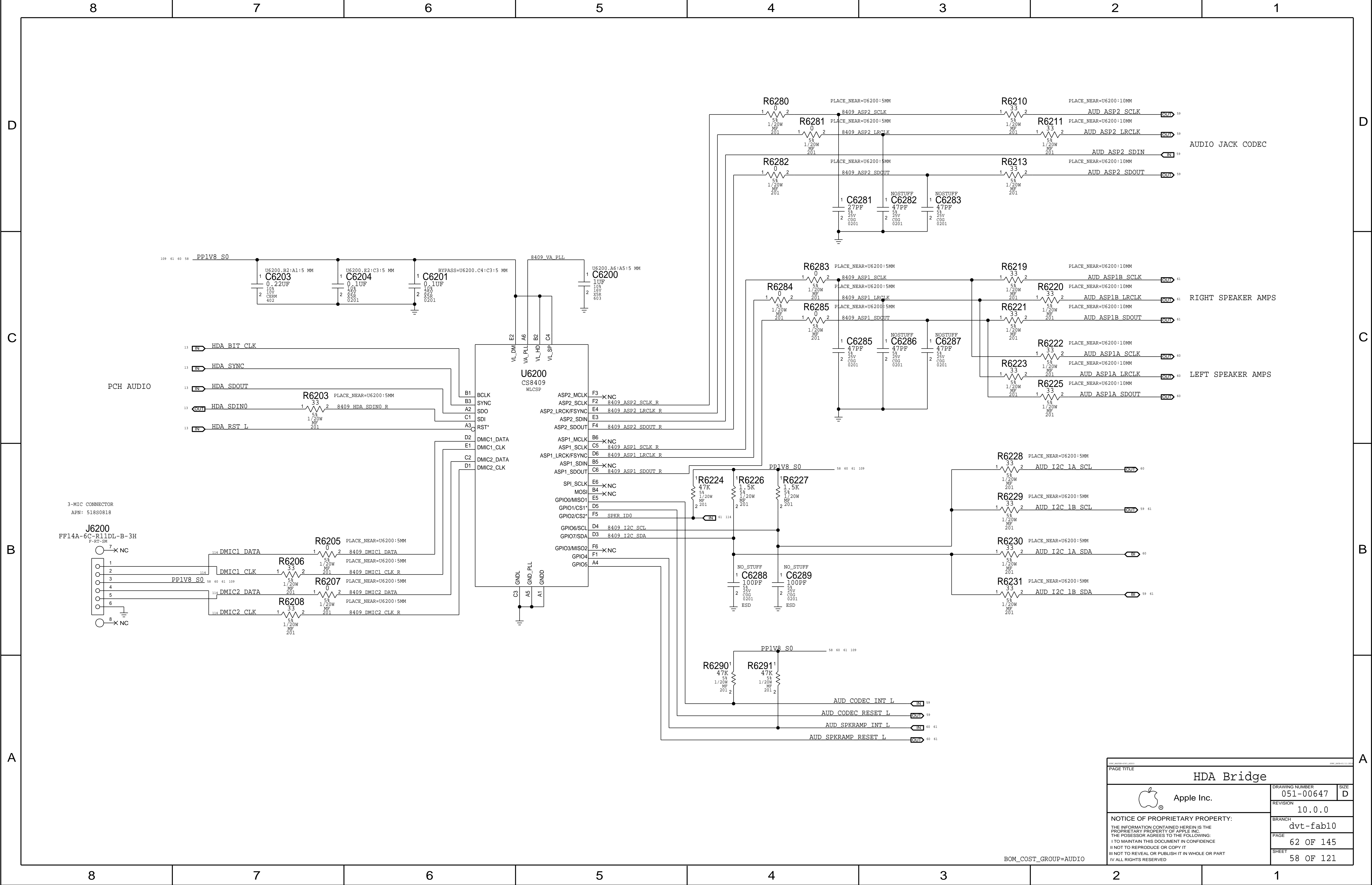



SPI Bus Series Termination (Modified per PDG)



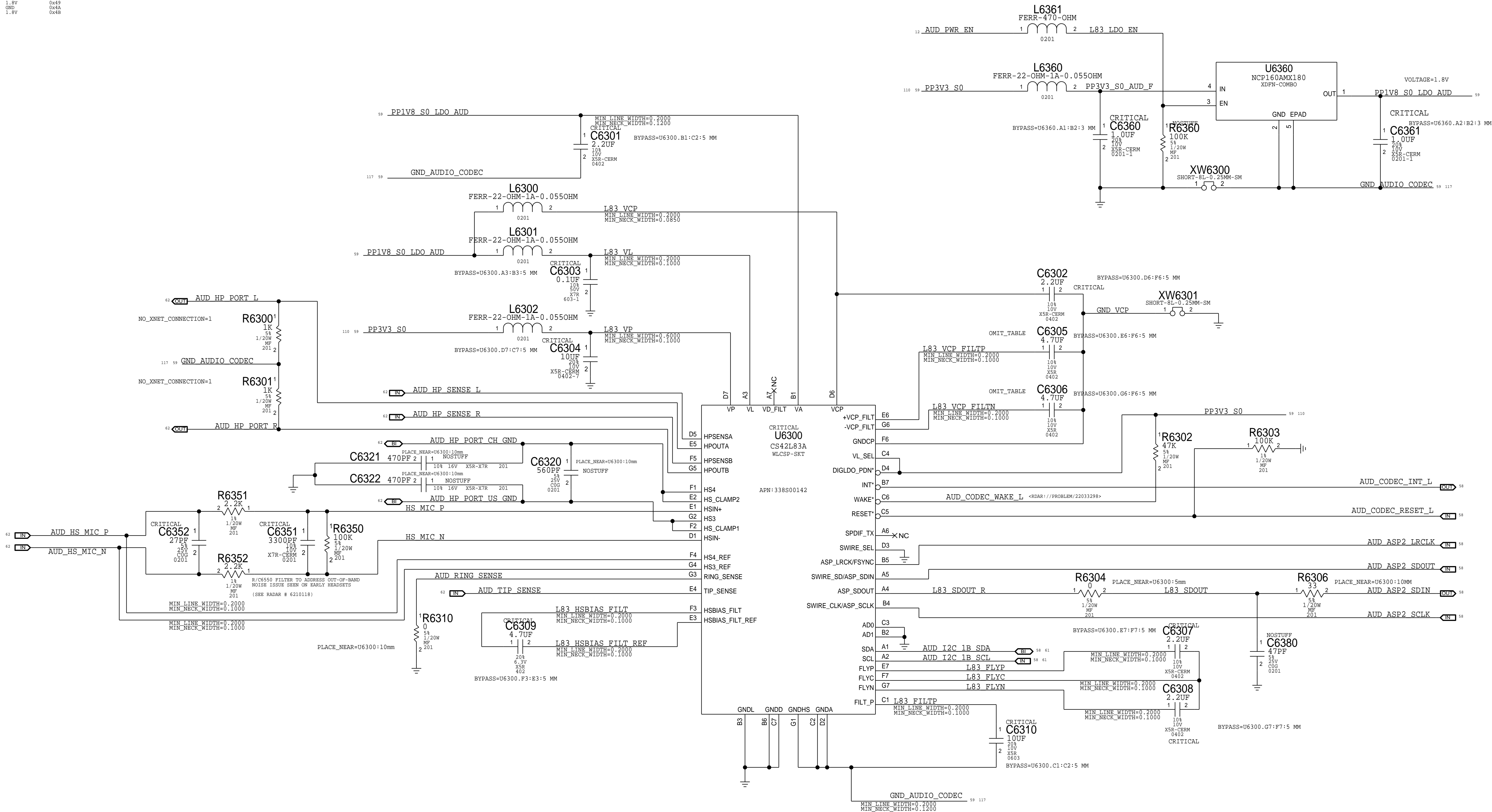
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SPI Debug Connector					
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BOM\_COST\_GROUP=CPU & CHIPSET




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HDA Bridge			
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AUDIO JACK CODEC I2C ADDRESS  
ADI ADO ADDRESS  
GND GND 0x48 <--  
GND 1.8V 0x49  
1.8V GND 0x4A  
1.8V 1.8V 0x4B



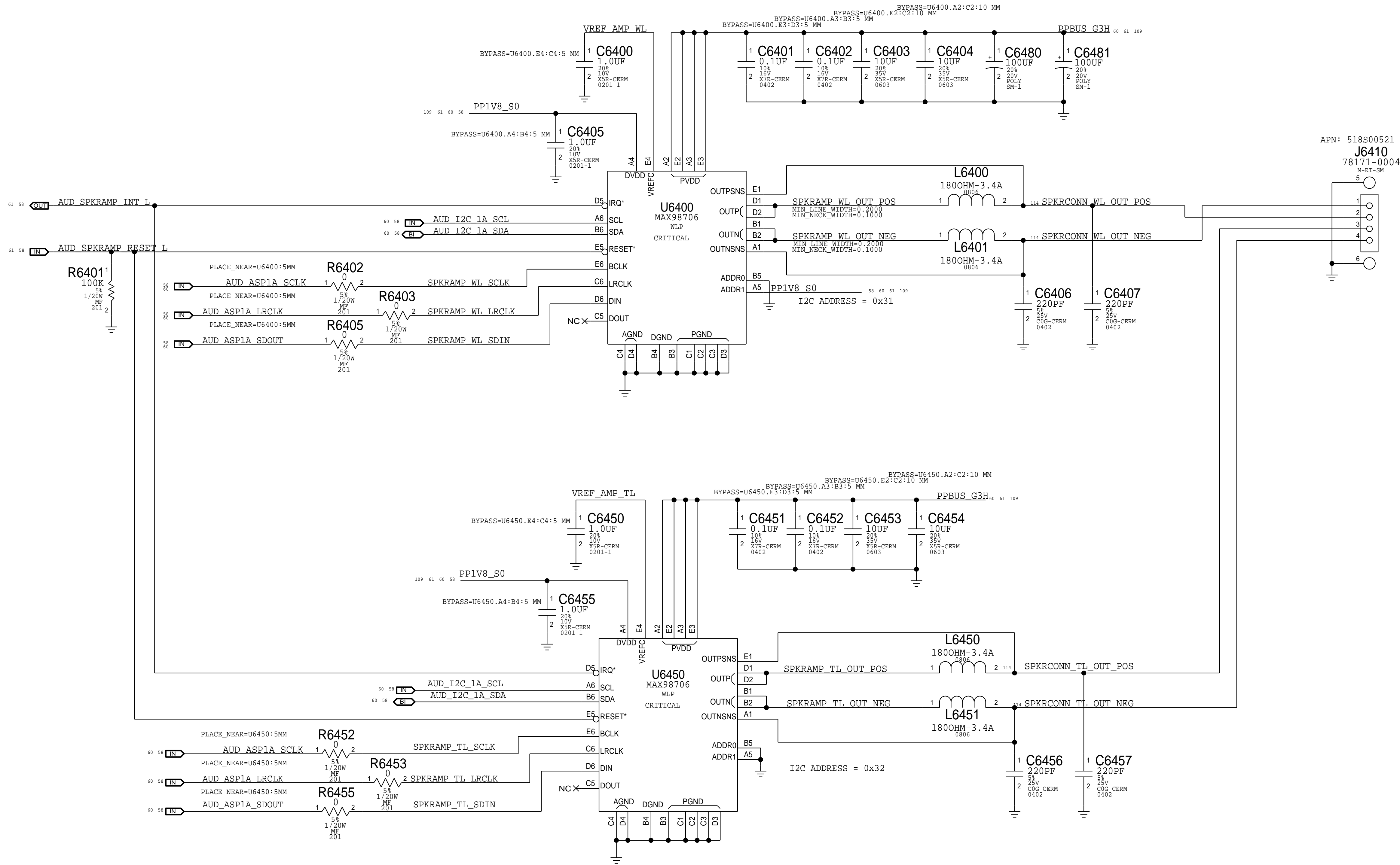
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138S0719	2	CAP, CER, 4.7UF, 20%, 10V, XSR, 0402, MURATA	C6305, C6306	CRITICAL	

BOM\_COST\_GROUP=AUDIO

PAGE TITLE			AUDIO JACK CODEC	
 Apple Inc.		DRAWING NUMBER	051-00647	SIZE D
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2X MONO SPEAKER AMPLIFIER  
APN: 353800604  
0dBFS = 9VPK



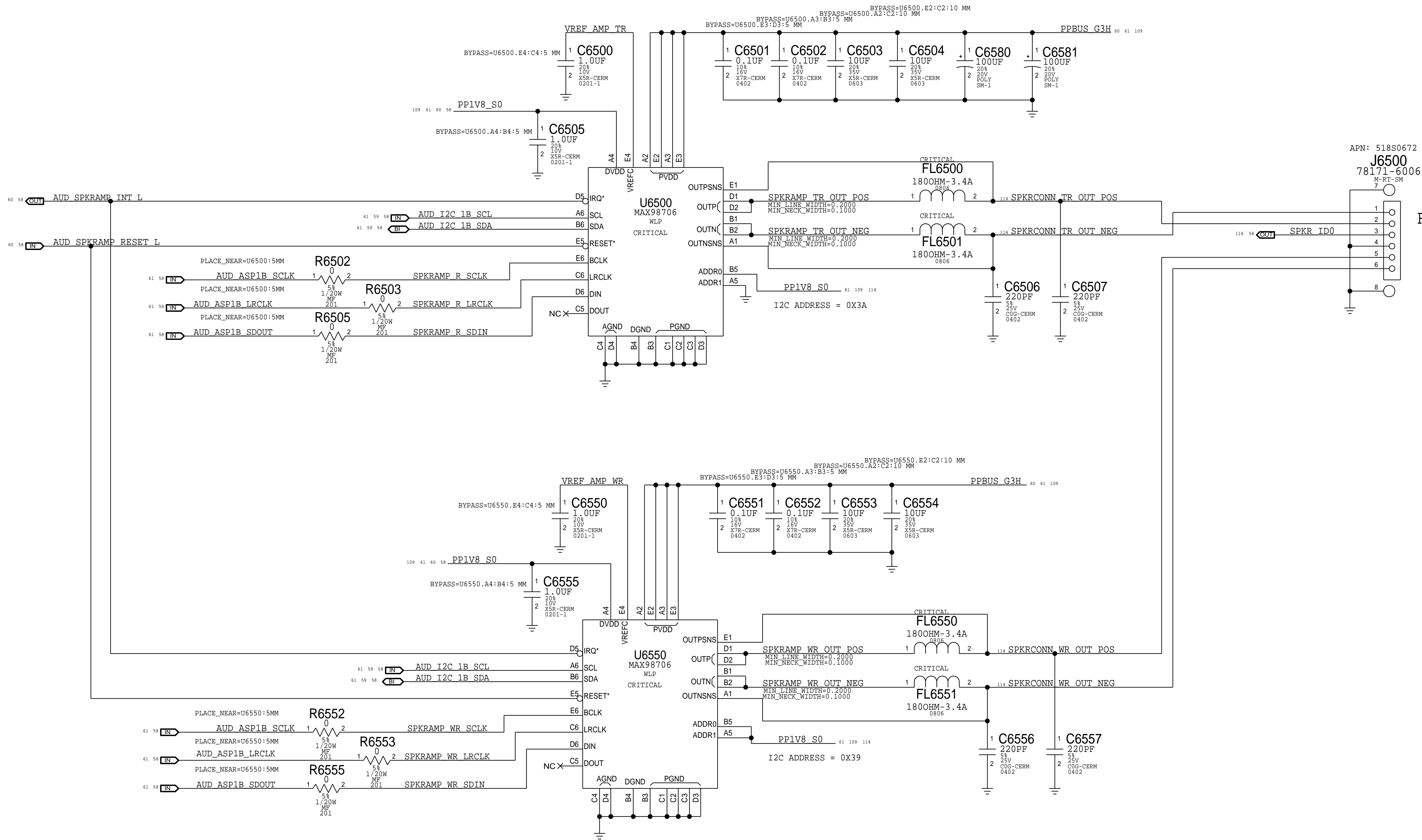
LEFT SPEAKER CONNECTOR

APN: 518S00521  
J6410  
78171-0004  
M-RT-SM


PAGE TITLE			
AUDIO Speaker Amps & Conn			
 Apple Inc.	DRAWING NUMBER	051-00647	SIZE D
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BOM\_COST\_GROUP=AUDIO

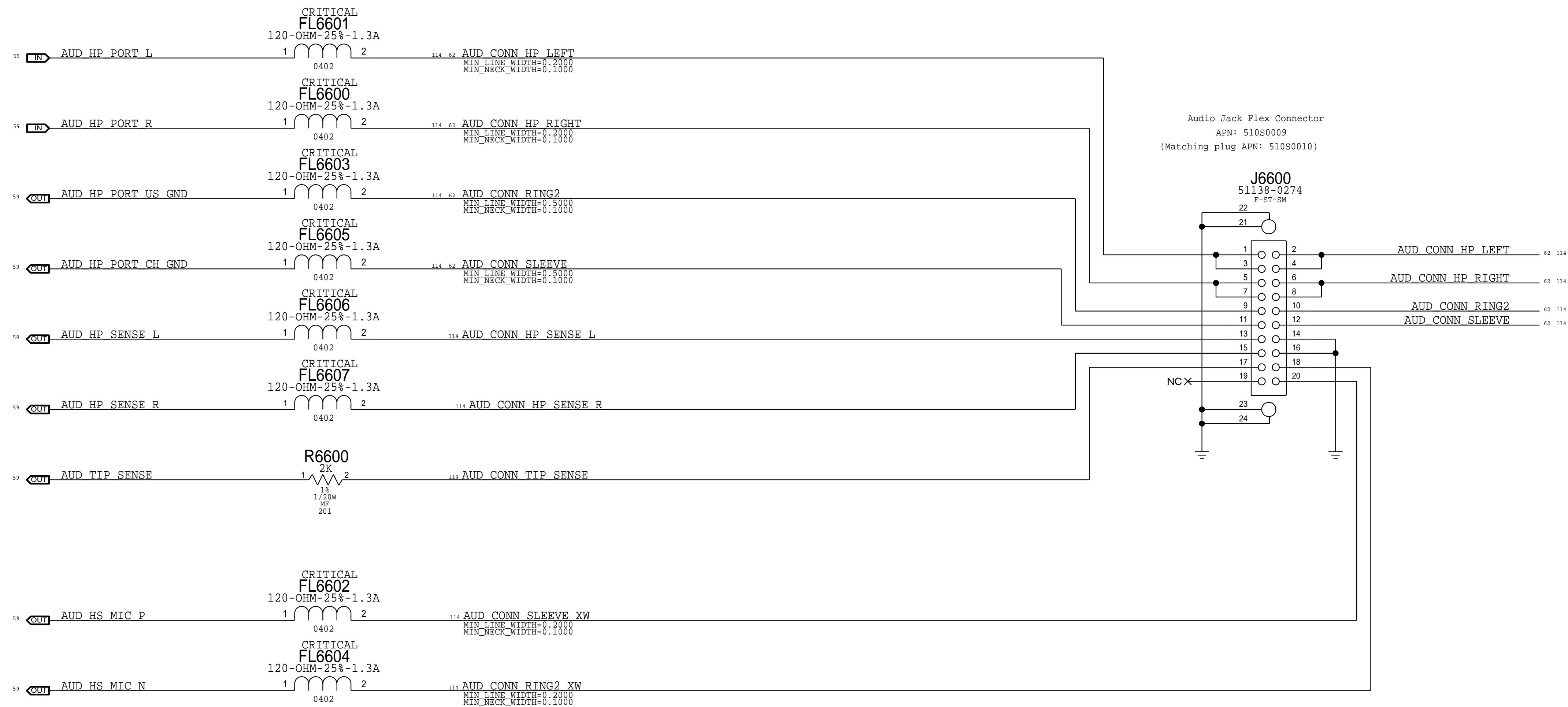
2K MONO SPEAKER AMPLIFIER  
APN: 353800604  
0dBFS = 9VPK



APN: 518S0672  
J6500  
78171-6006  
M-RT-SM  
7  
RIGHT SPEAKER CONNECTOR

PAGE TITLE			
AUDIO Speaker Amps & Conn			
 Apple Inc.	DRAWING NUMBER	051-00647	SIZE D
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BOM\_COST\_GROUP=AUDIO



DATE: 01/01/2000

PAGE TITLE

AUDIO JACK CONNECTOR

Apple Inc.

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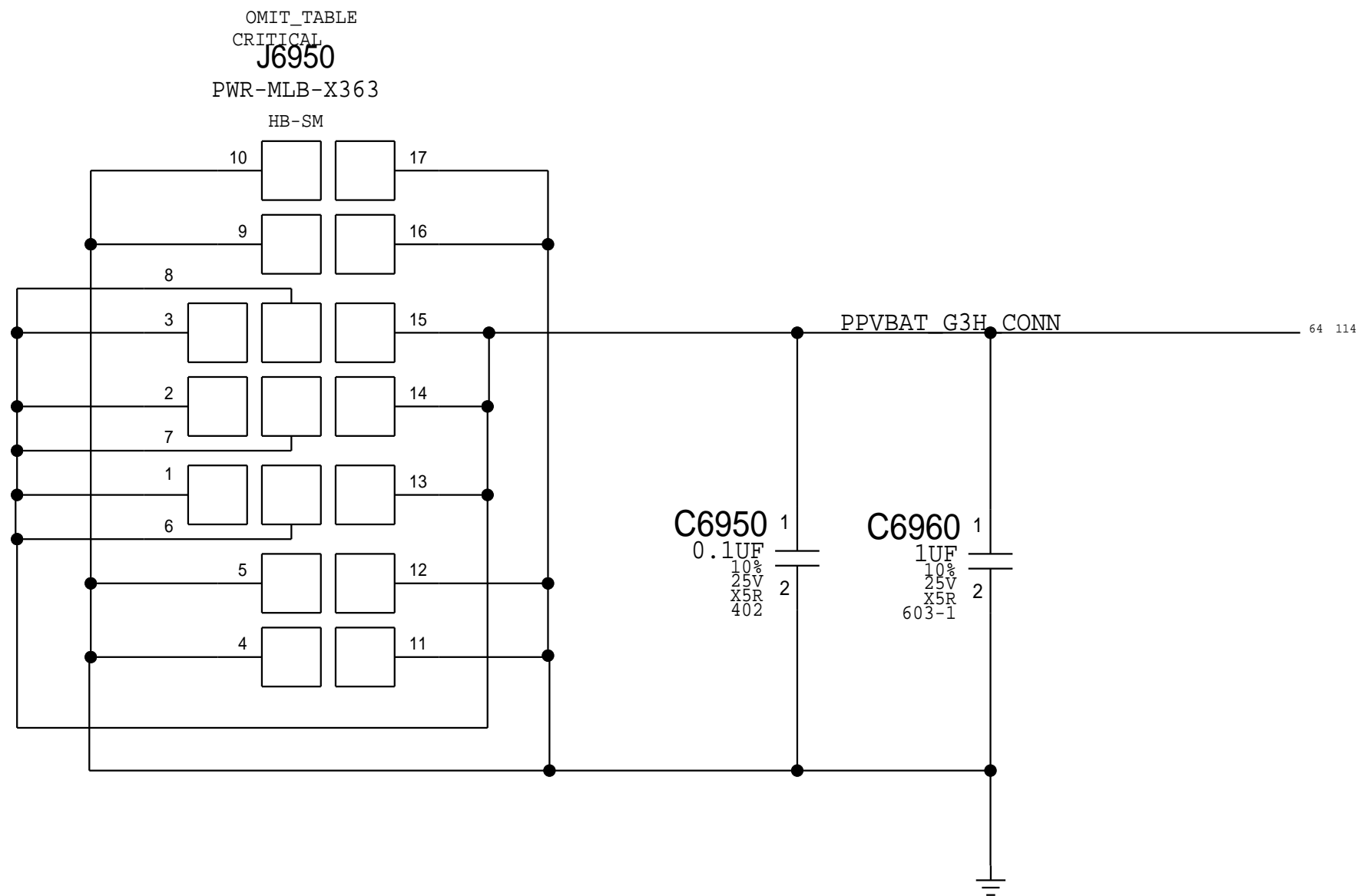
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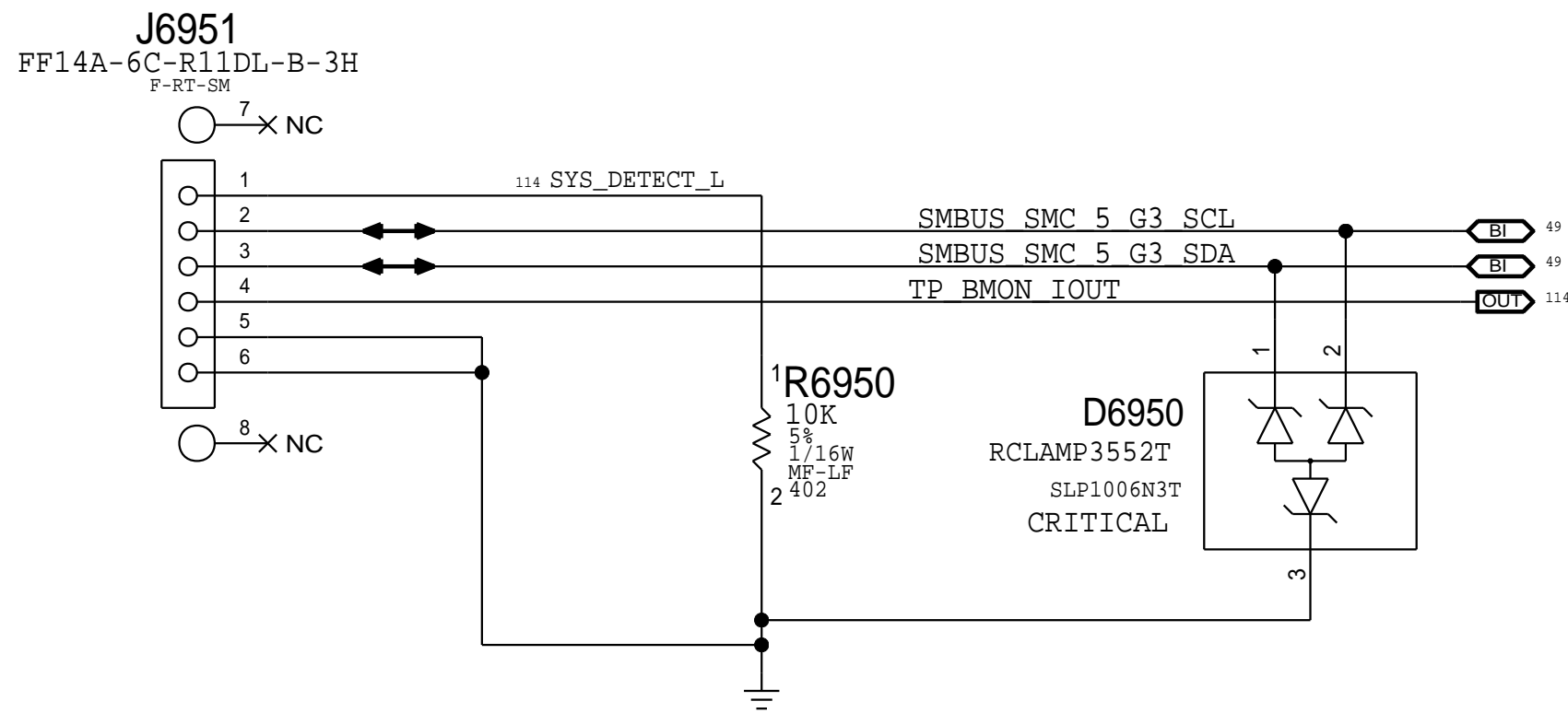
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J80 Battery Hotbar Flex Pads 998-03902  
Flex Pad TO MLB 998-03780.

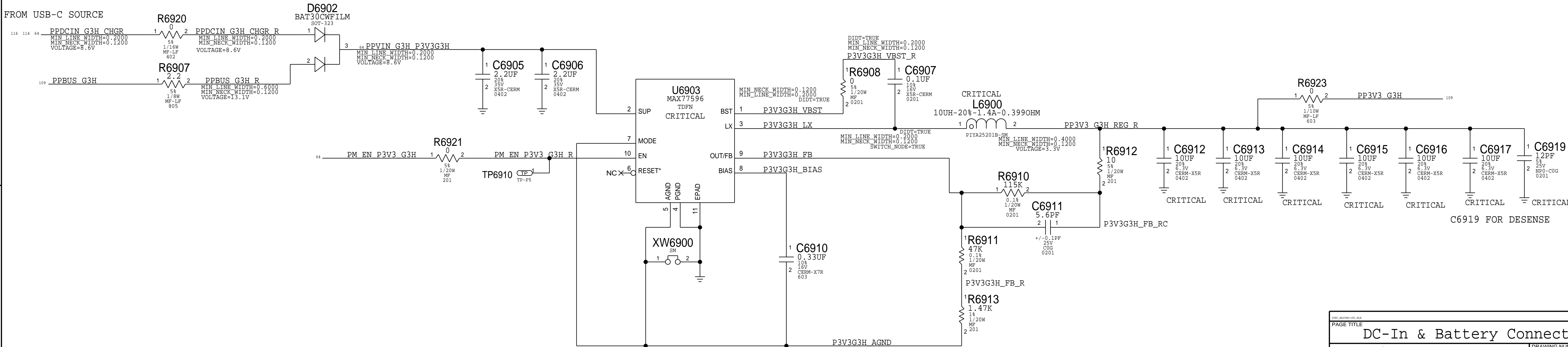


APN:518S0818



BMU POWER FLEX HOTBAR'd TO THE MLB:

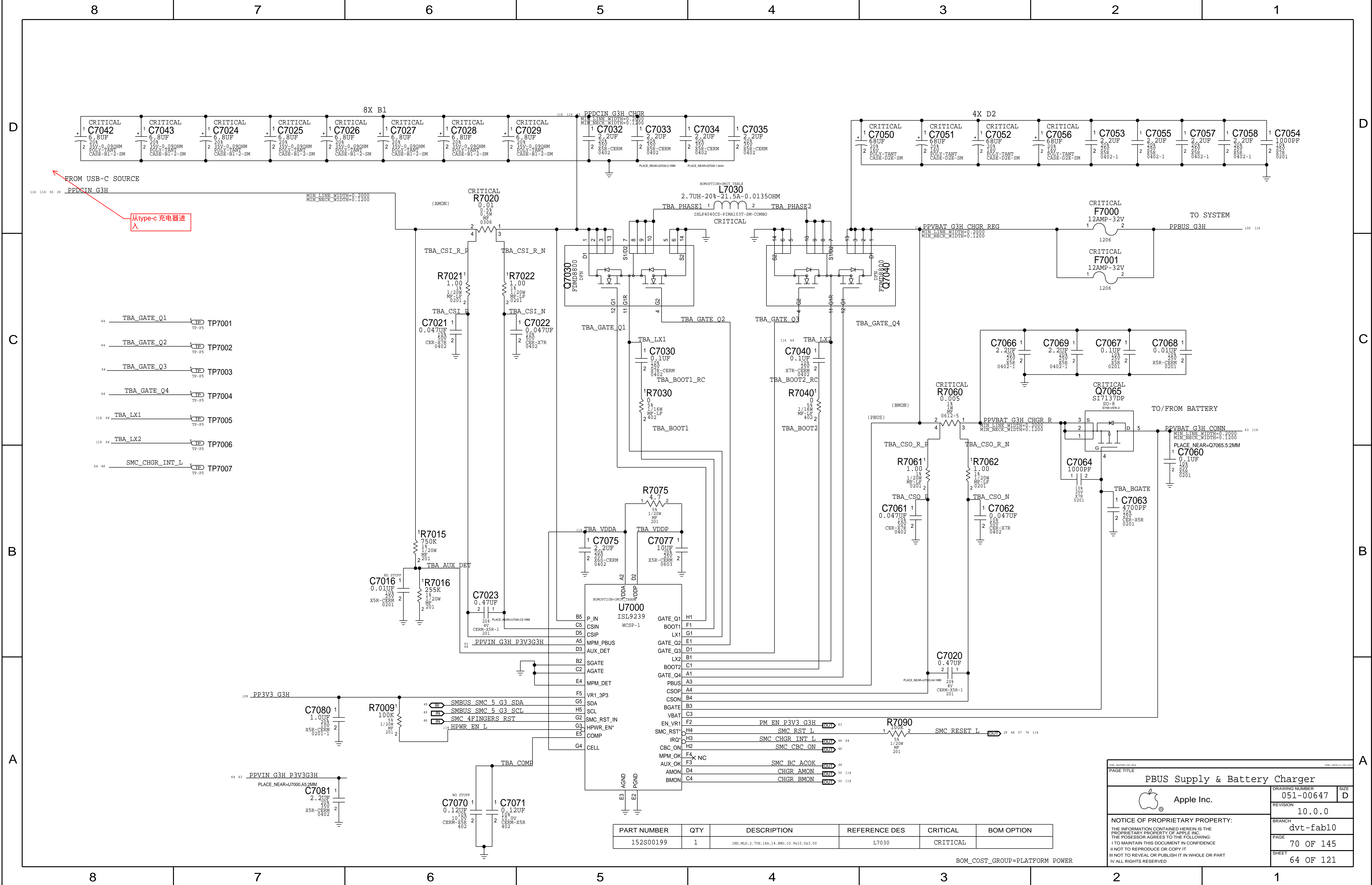
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632-00862	1	PCBA,FLEX,BMU PWR,X363	J6950	CRITICAL	

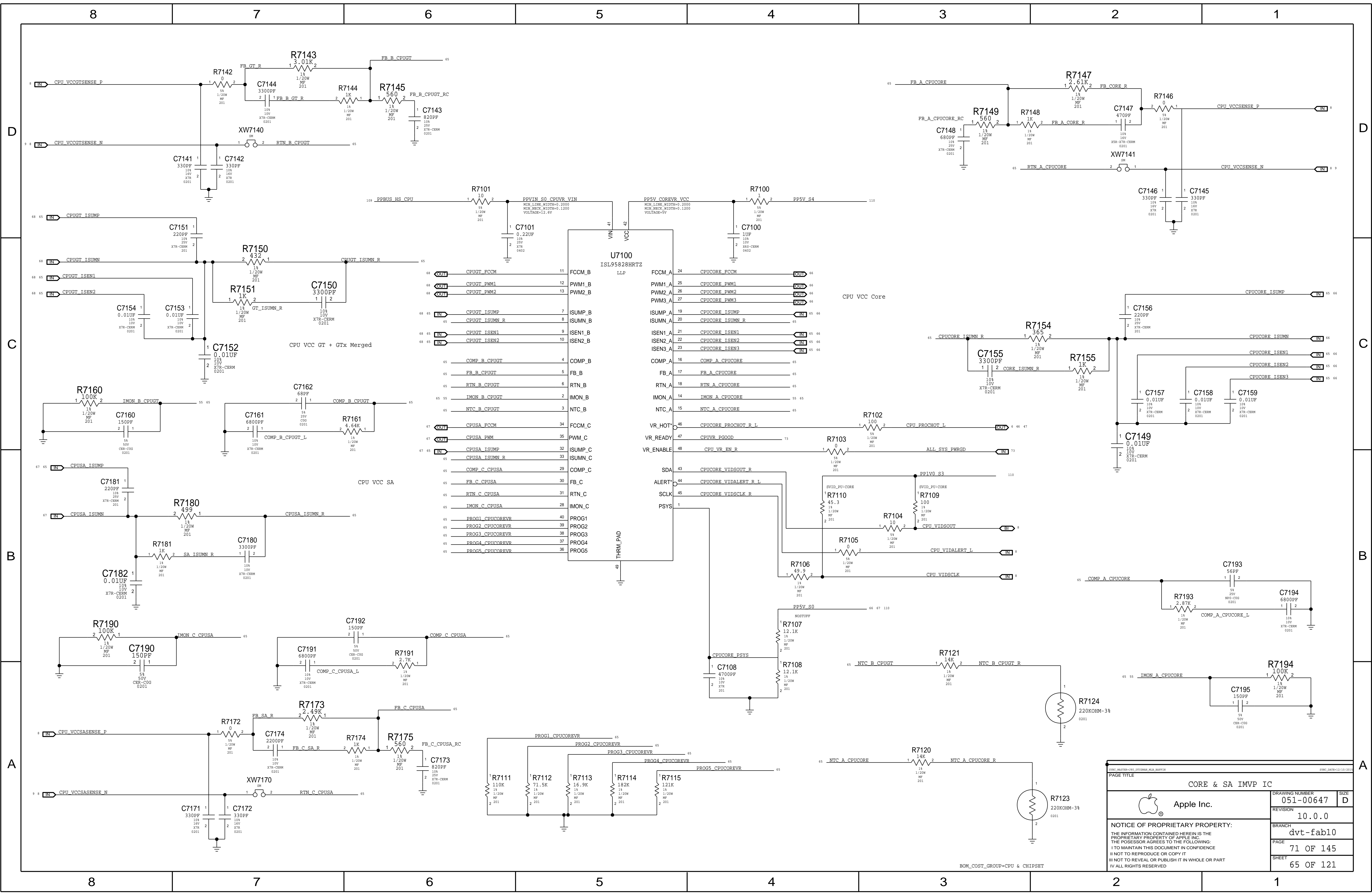


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BOM\_COST\_GROUP=PLATFORM POWER







PAGE TITLE			
CORE & SA IMVP IC			
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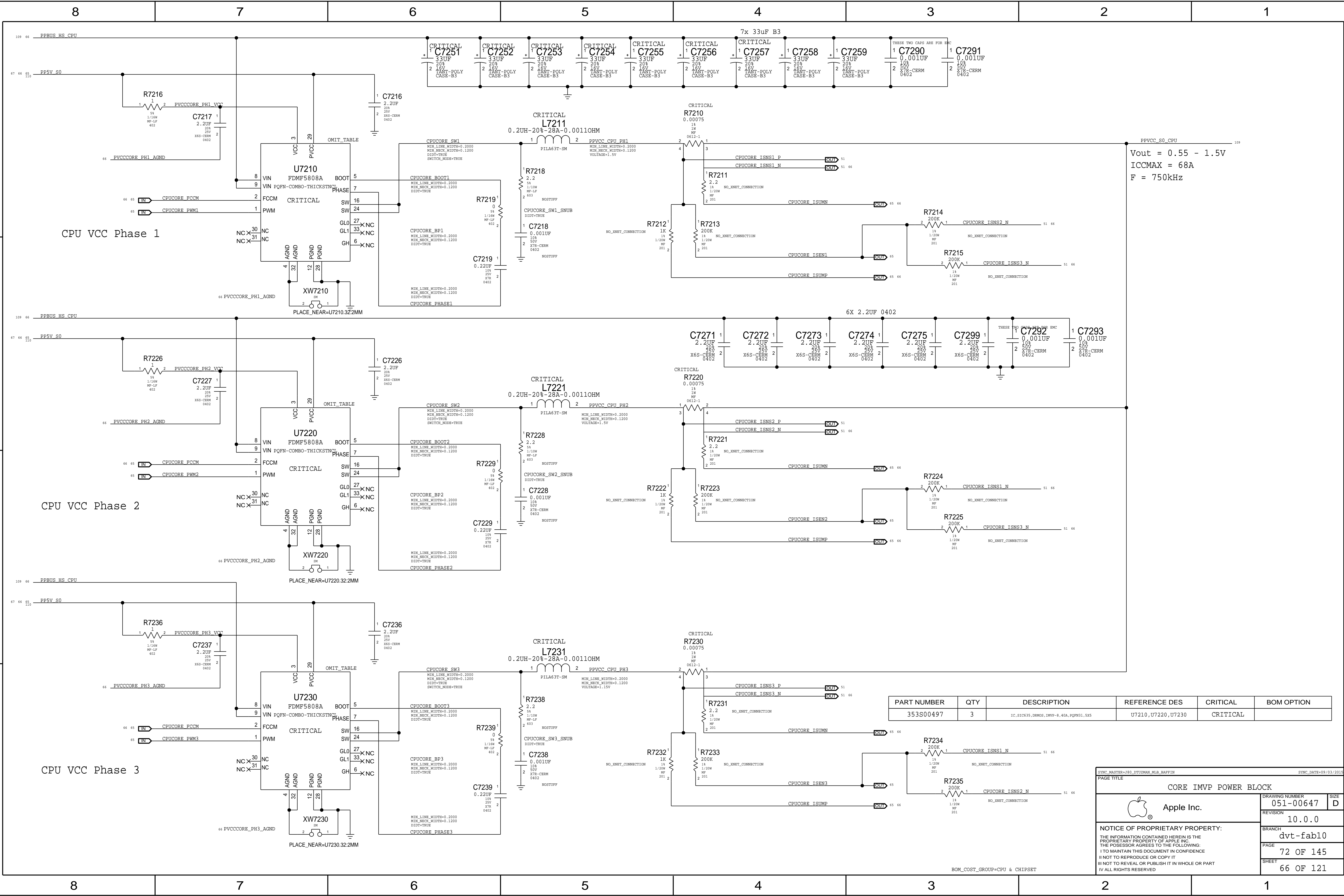
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PART NUMBER	QTY	DESCRIPTION	REFERENCE DES	CRITICAL	BOM OPTION
353S00497	3	IC, SiC635, DEMOS, 1MVP-8, 40A, PQFN31, 5X5	U7210, U7220, U7230	CRITICAL	

CORE IMVP POWER BLOCK			
	DRAWING NUMBER	051-00647	SIZE
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BOM\_COST\_GROUP=CPU & CHIPSET

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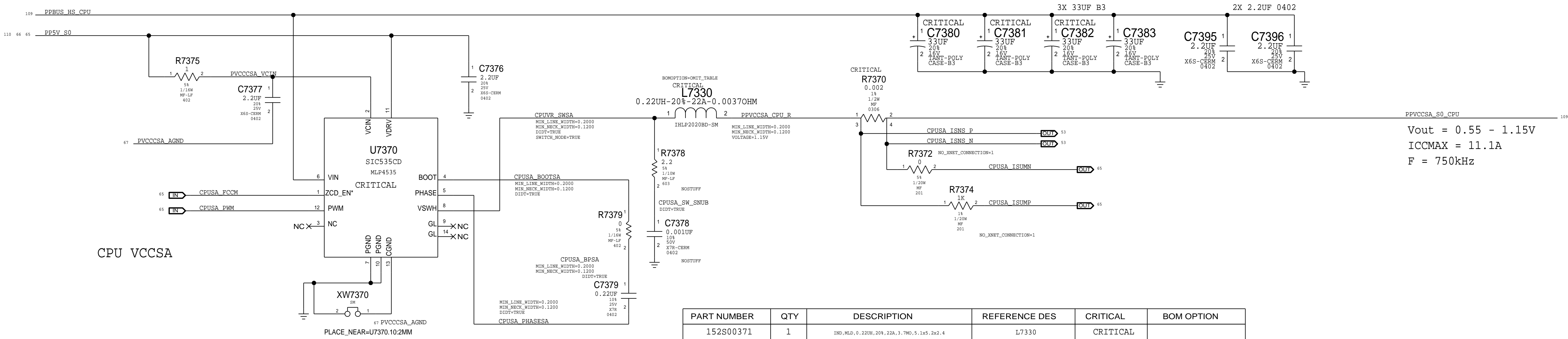
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BOM\_COST\_GROUP=CPU & CHIPSET

PAGE TITLE			SA IMVP IC	
 Apple Inc.		DRAWING NUMBER	051-00647	SIZE
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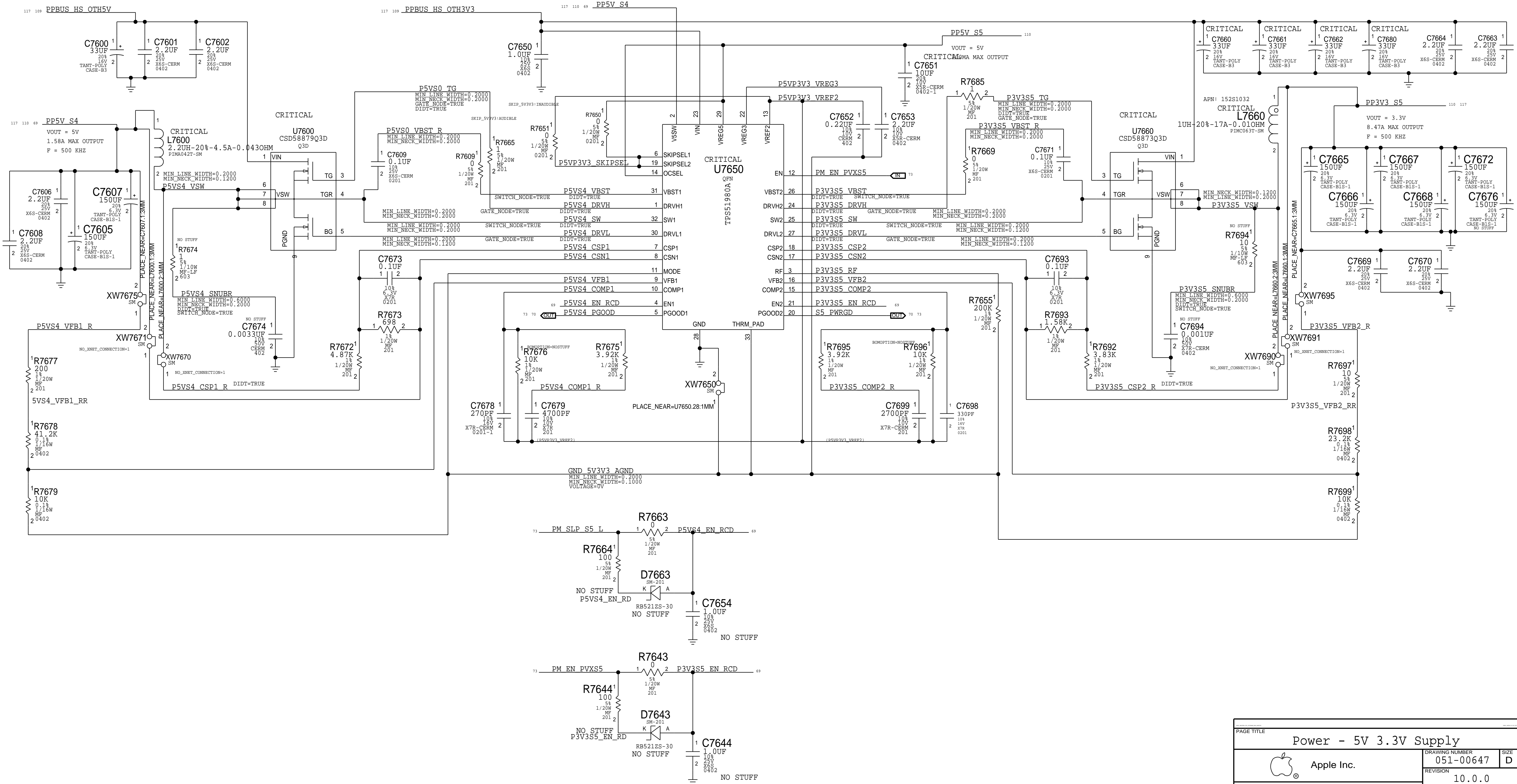
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5V S0 - V5

3.3V DSW - V6



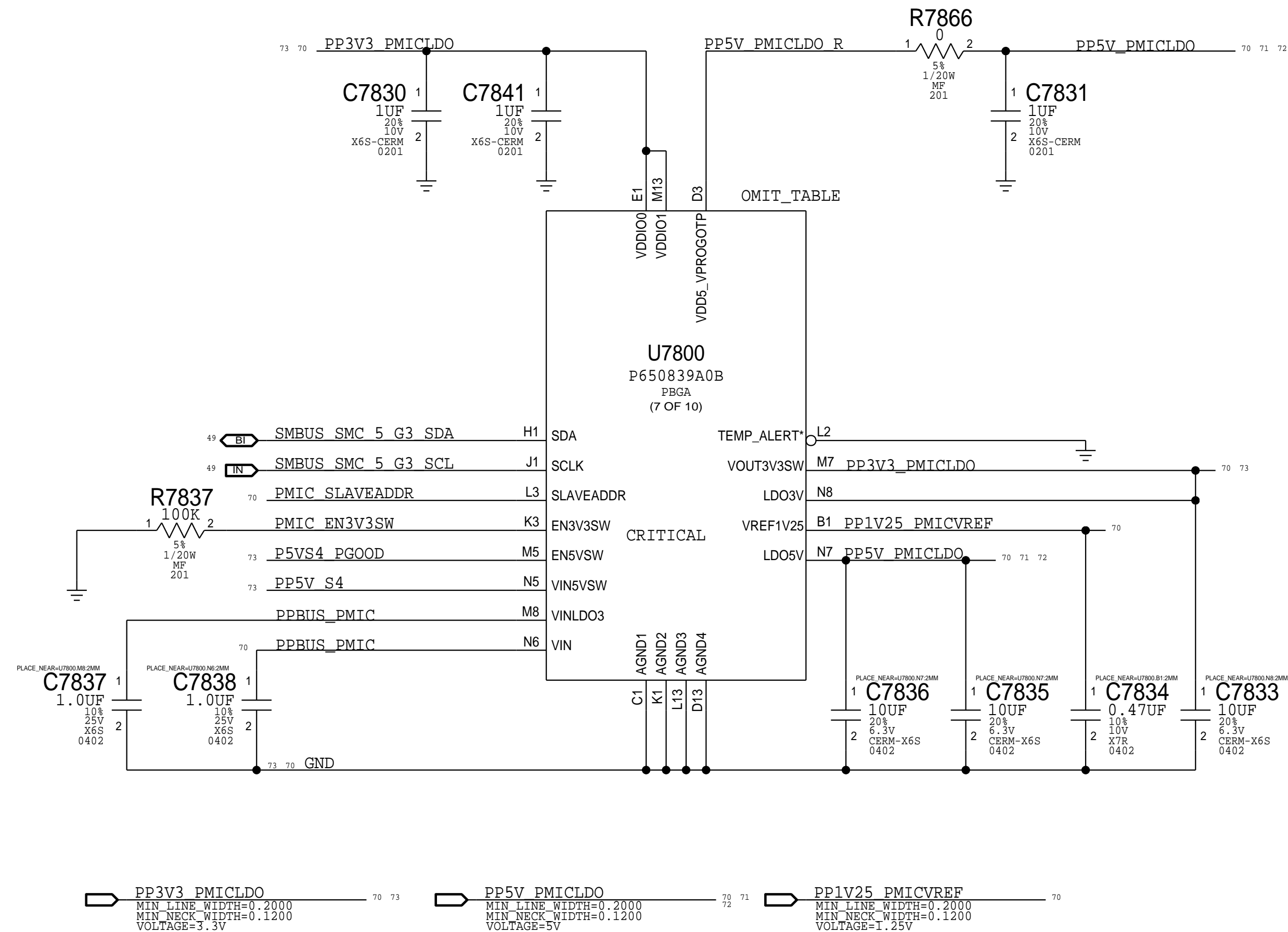
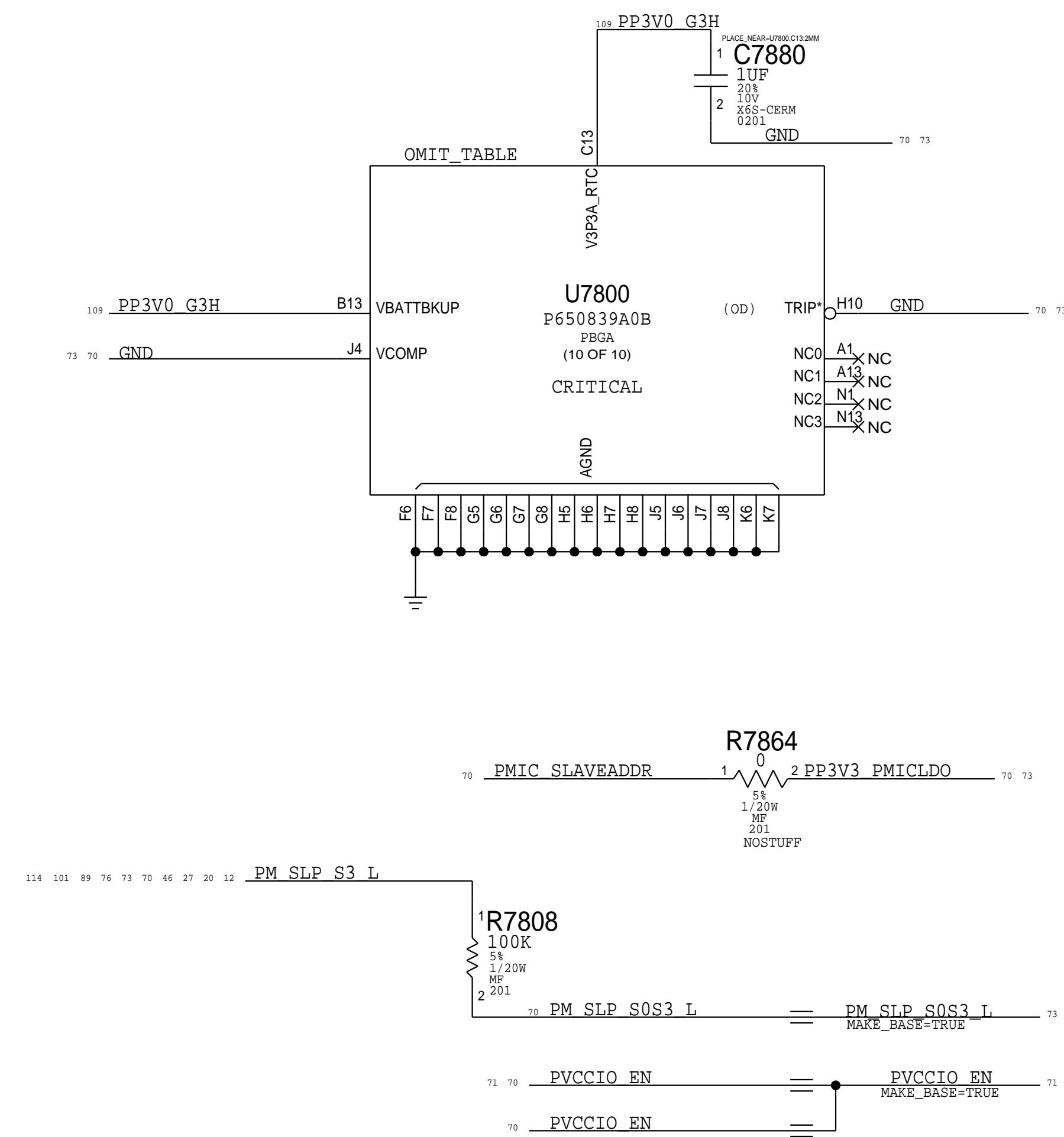
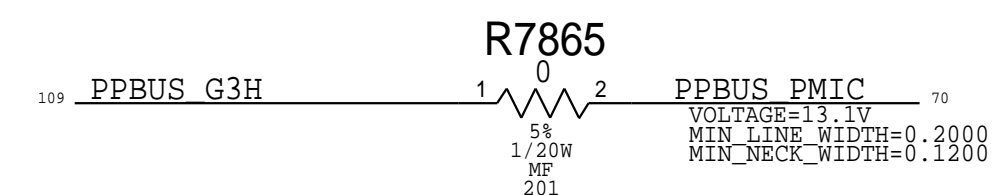
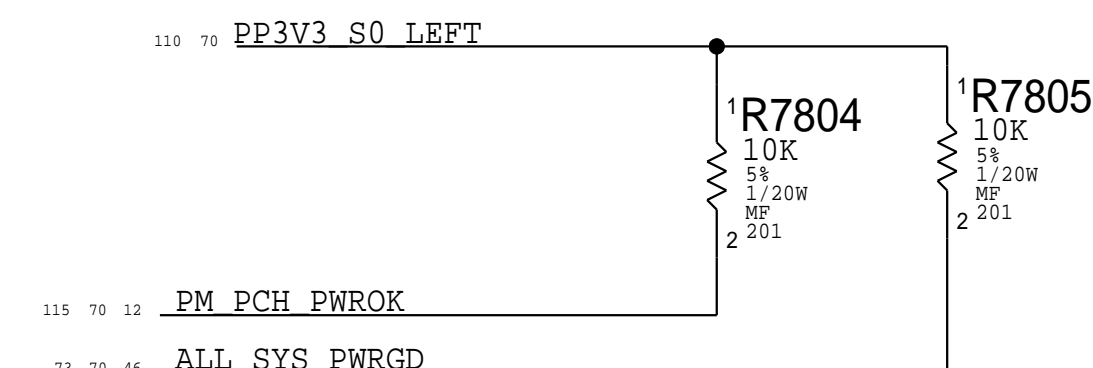
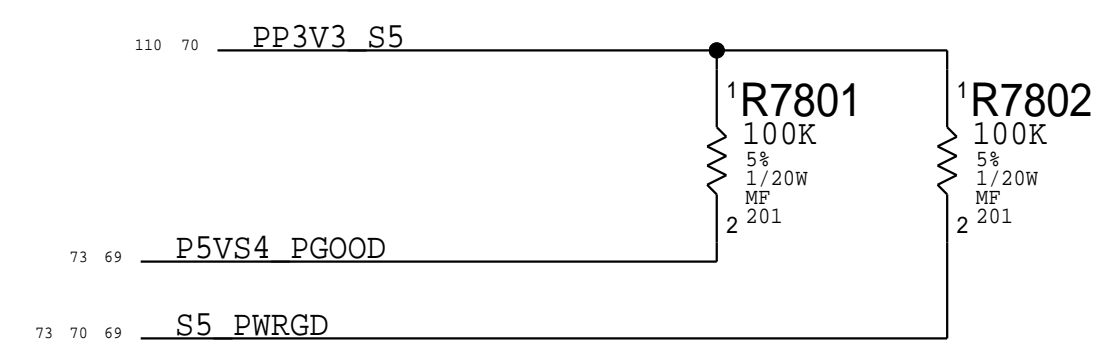
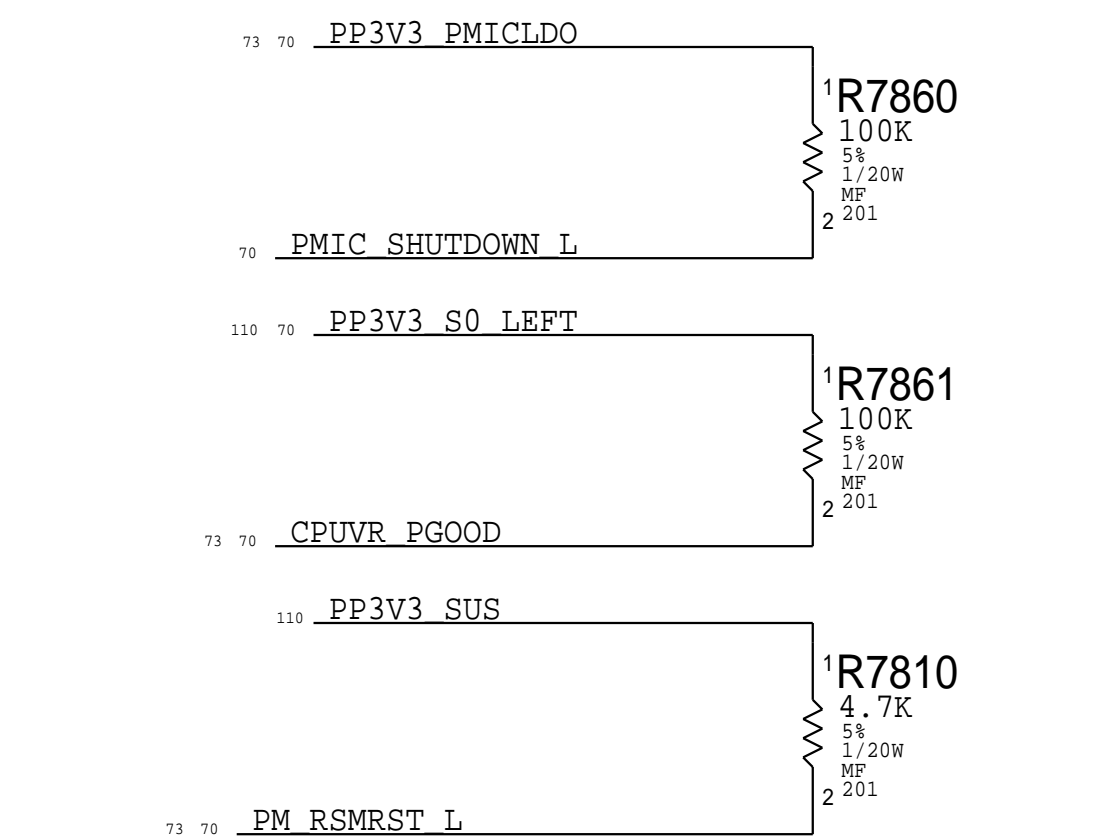
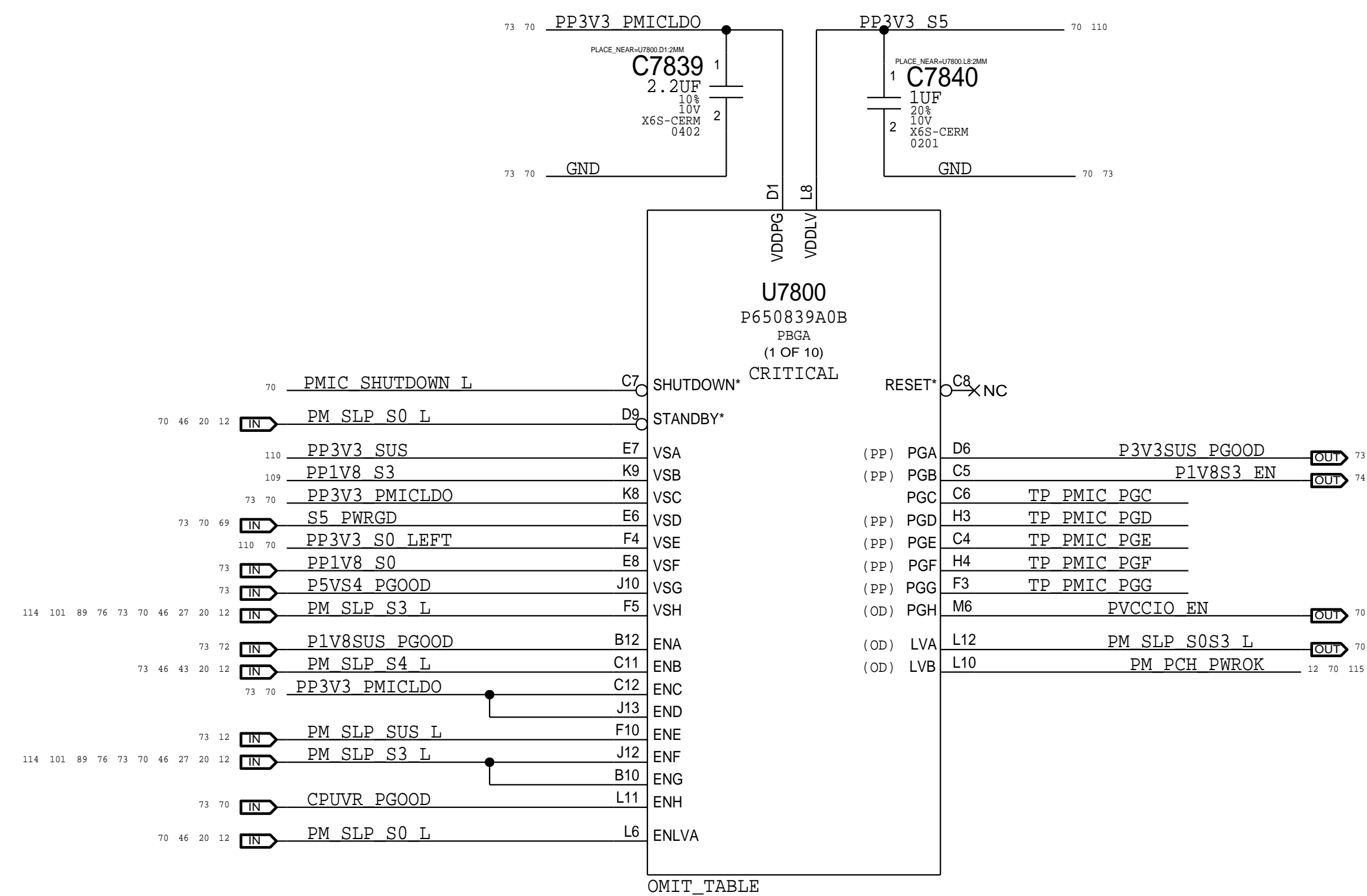
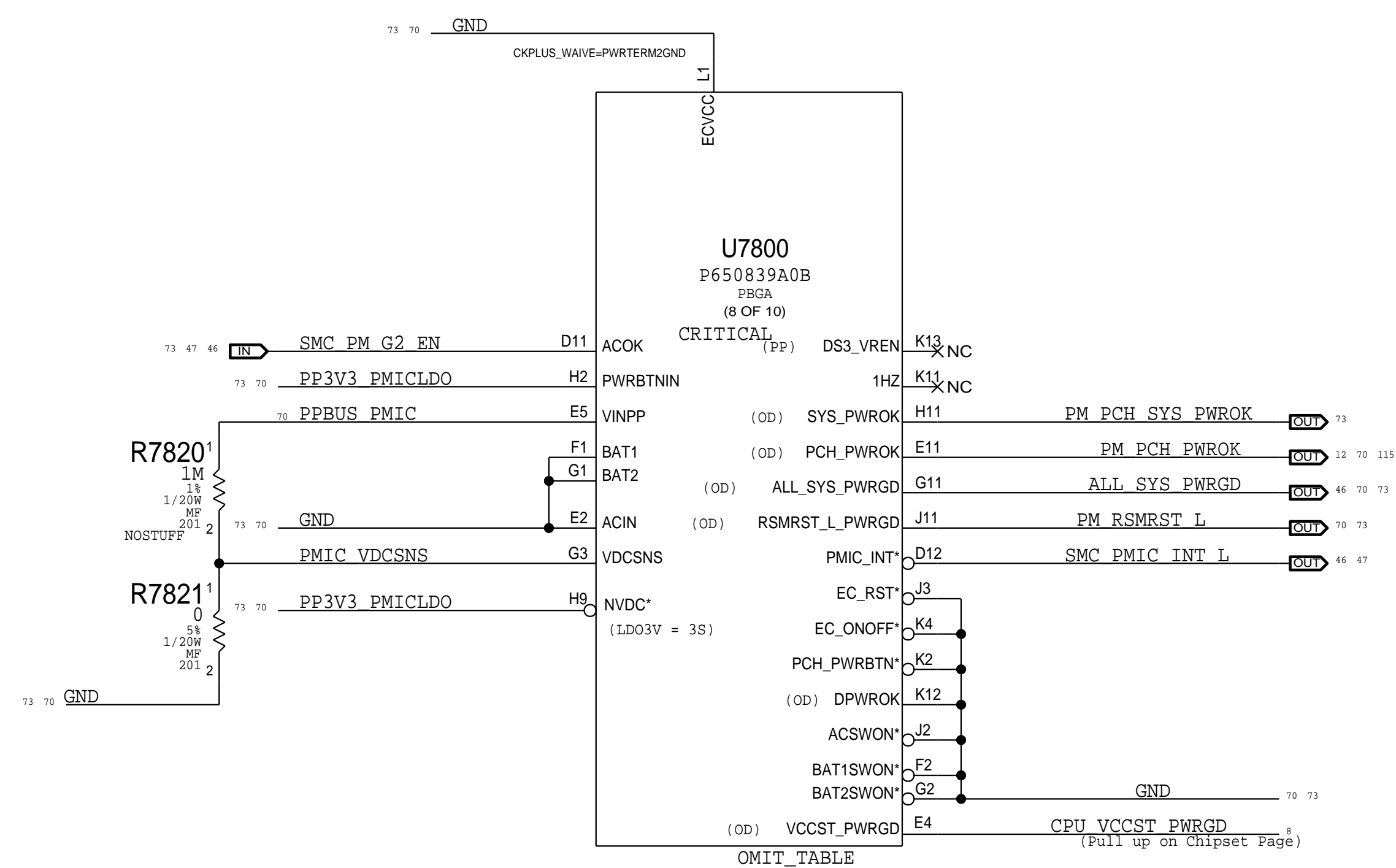
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## BANJO - PMIC Control



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		SHEET	70 OF 121

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## C



## B



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BOM\_COST\_GROUP=PLATFORM POWER



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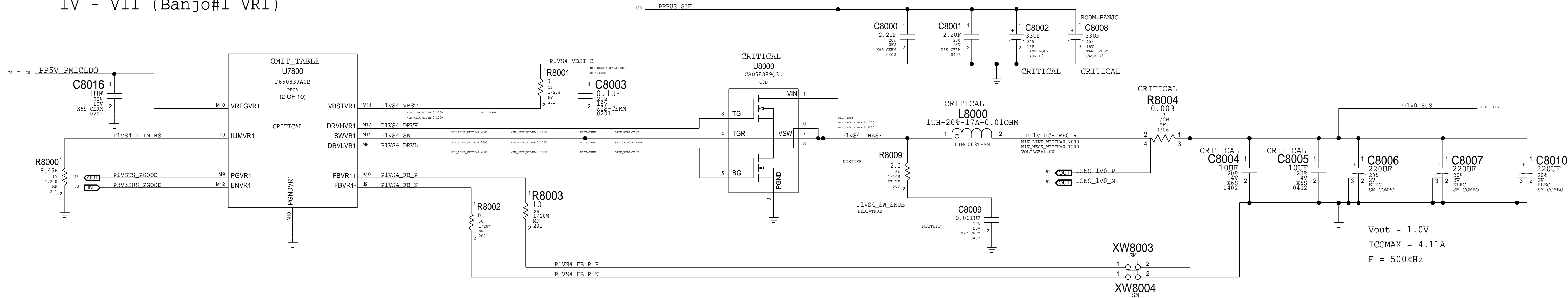
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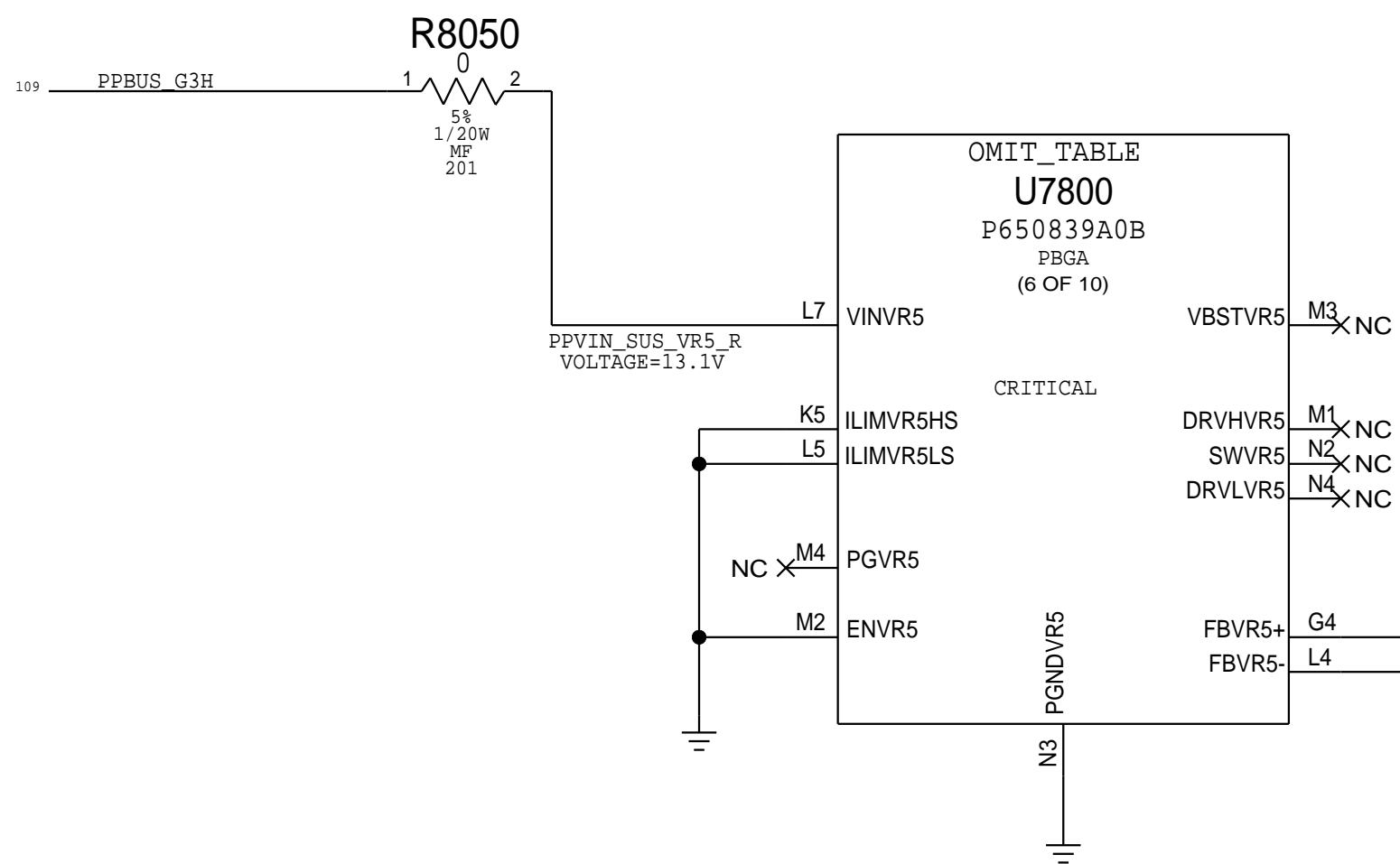
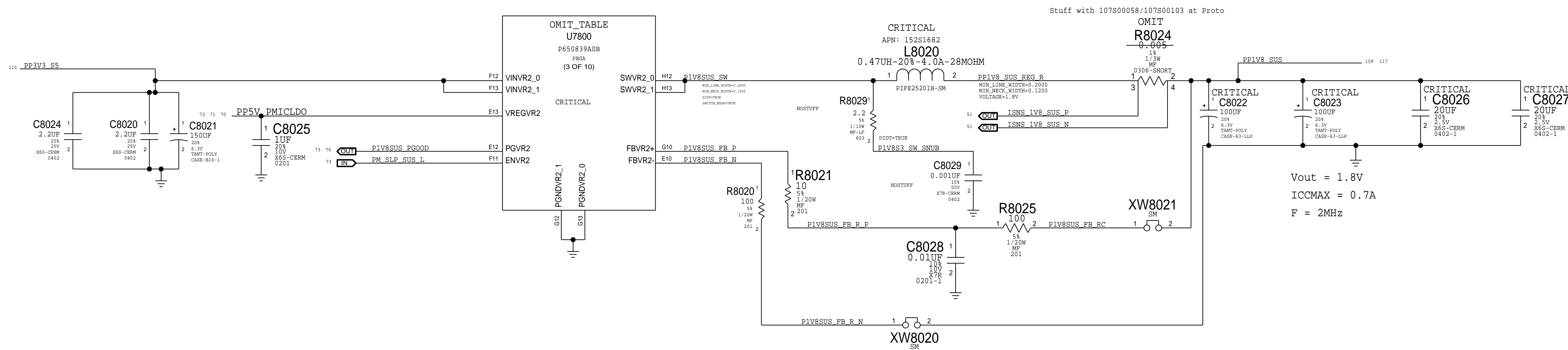
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## 1V - V11 (Banjo#1 VR1)



## 1.8V - V8 (Banjo#1 VR2)



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BOM\_COST\_GROUP=PLATFORM POWER

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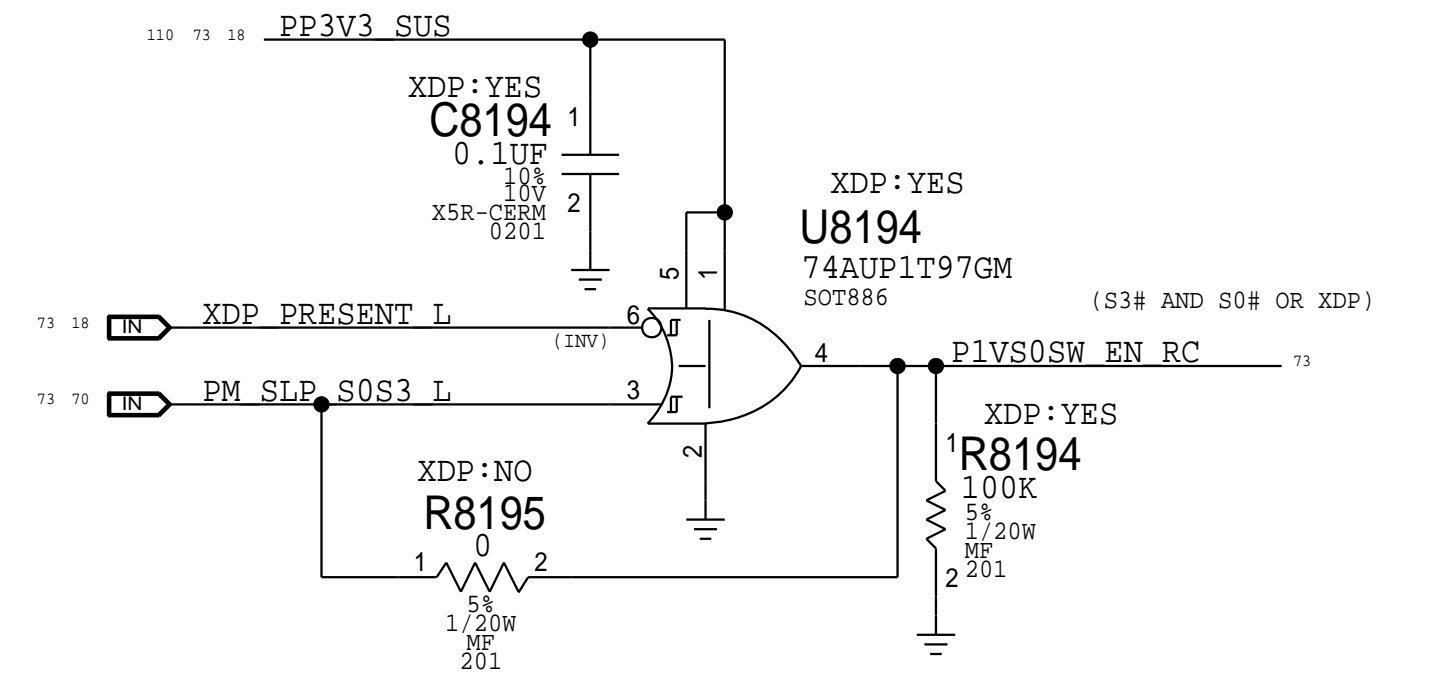
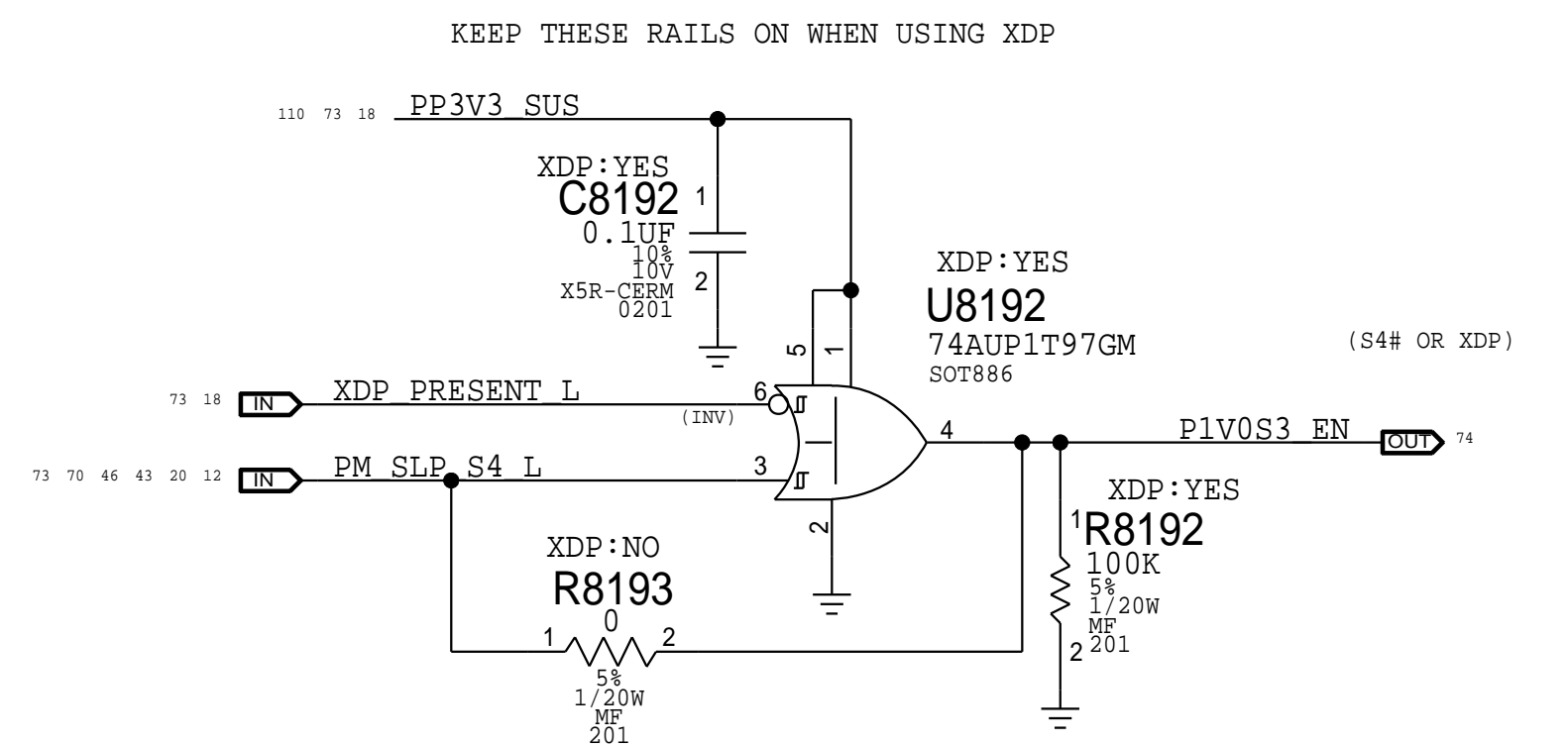
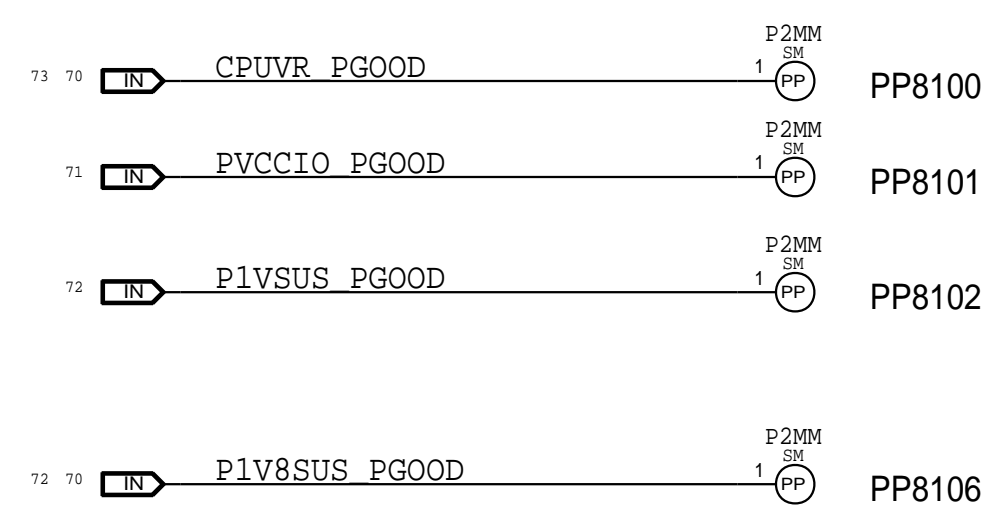
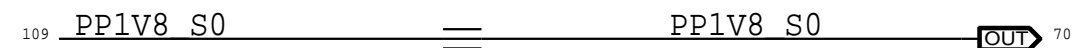
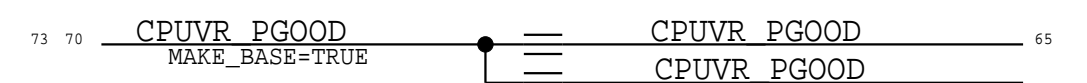
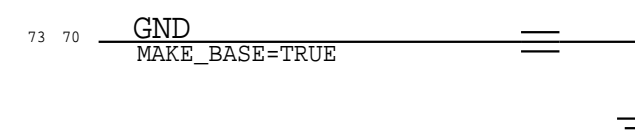
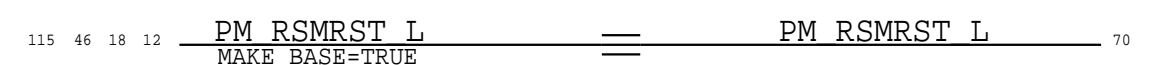
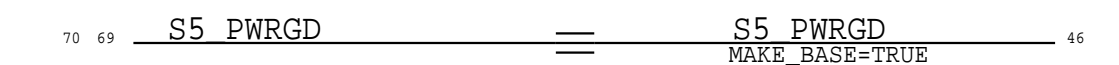
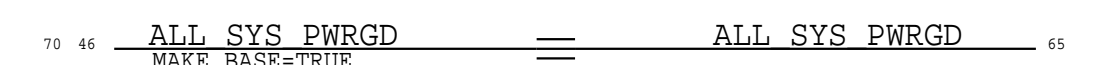
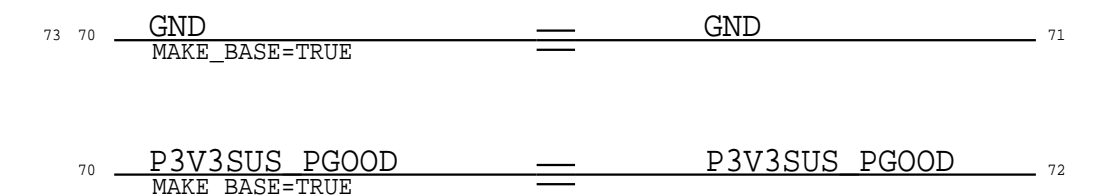
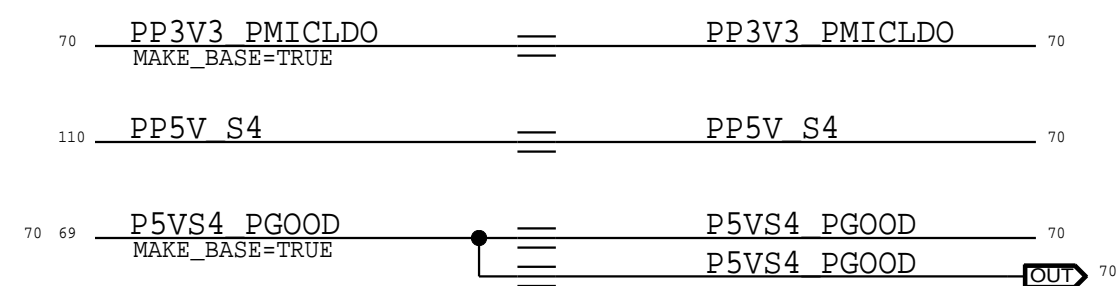
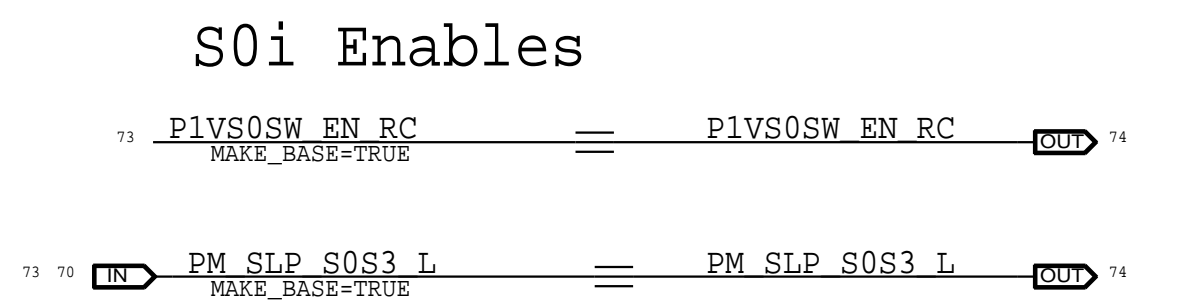
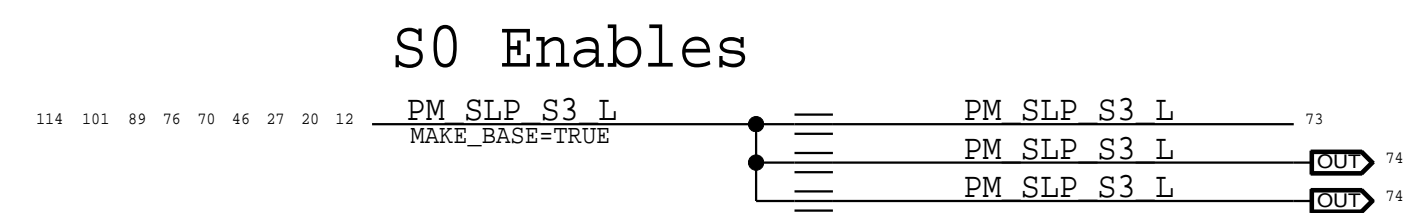
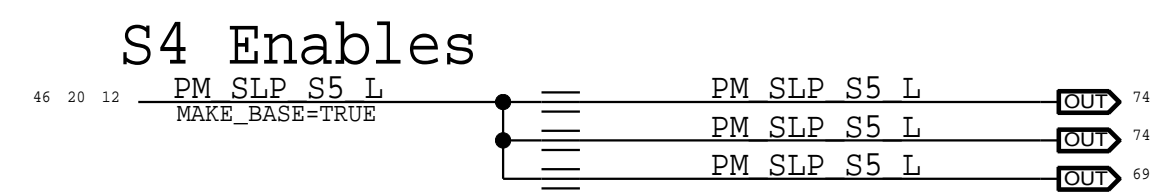
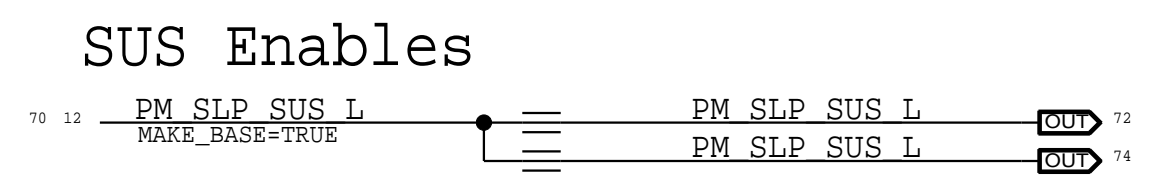
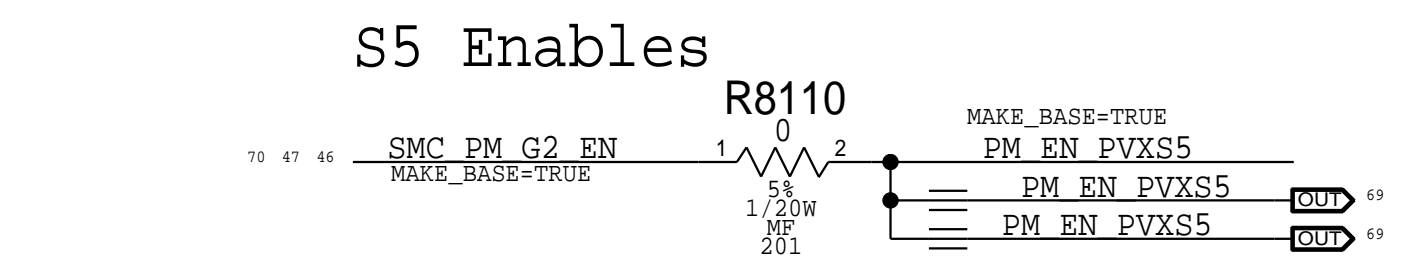
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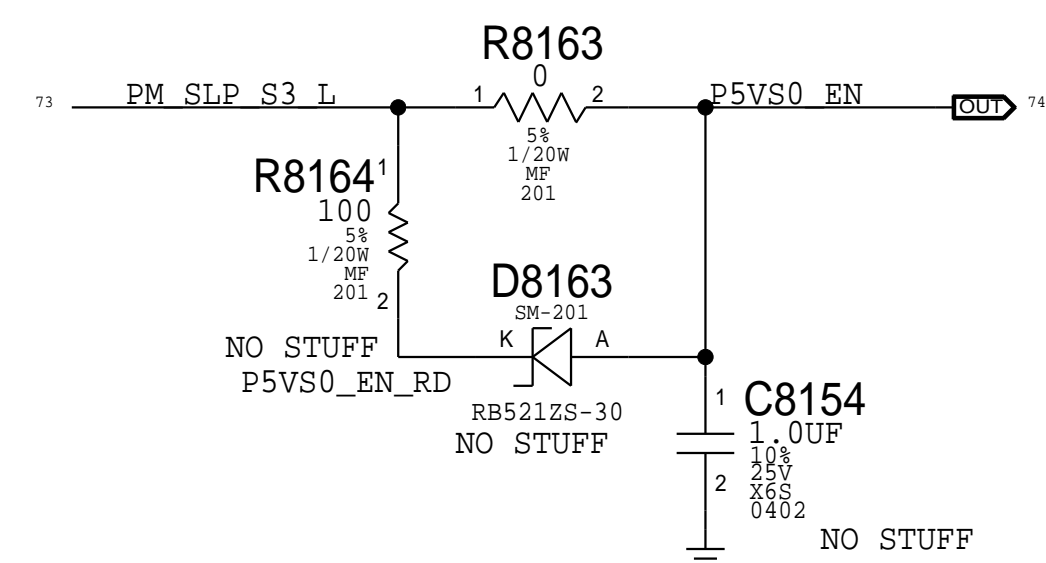
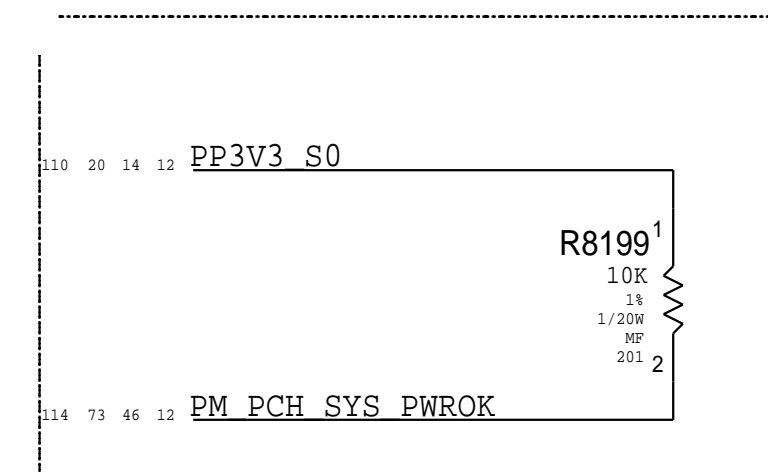
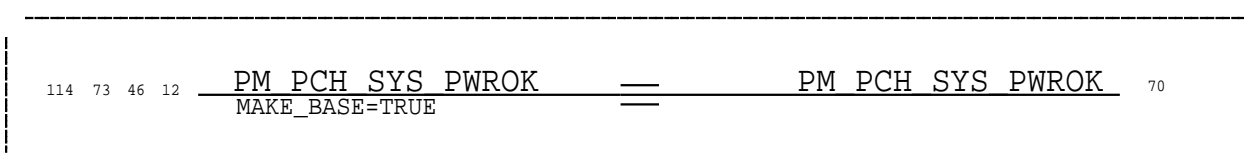
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J80G specific



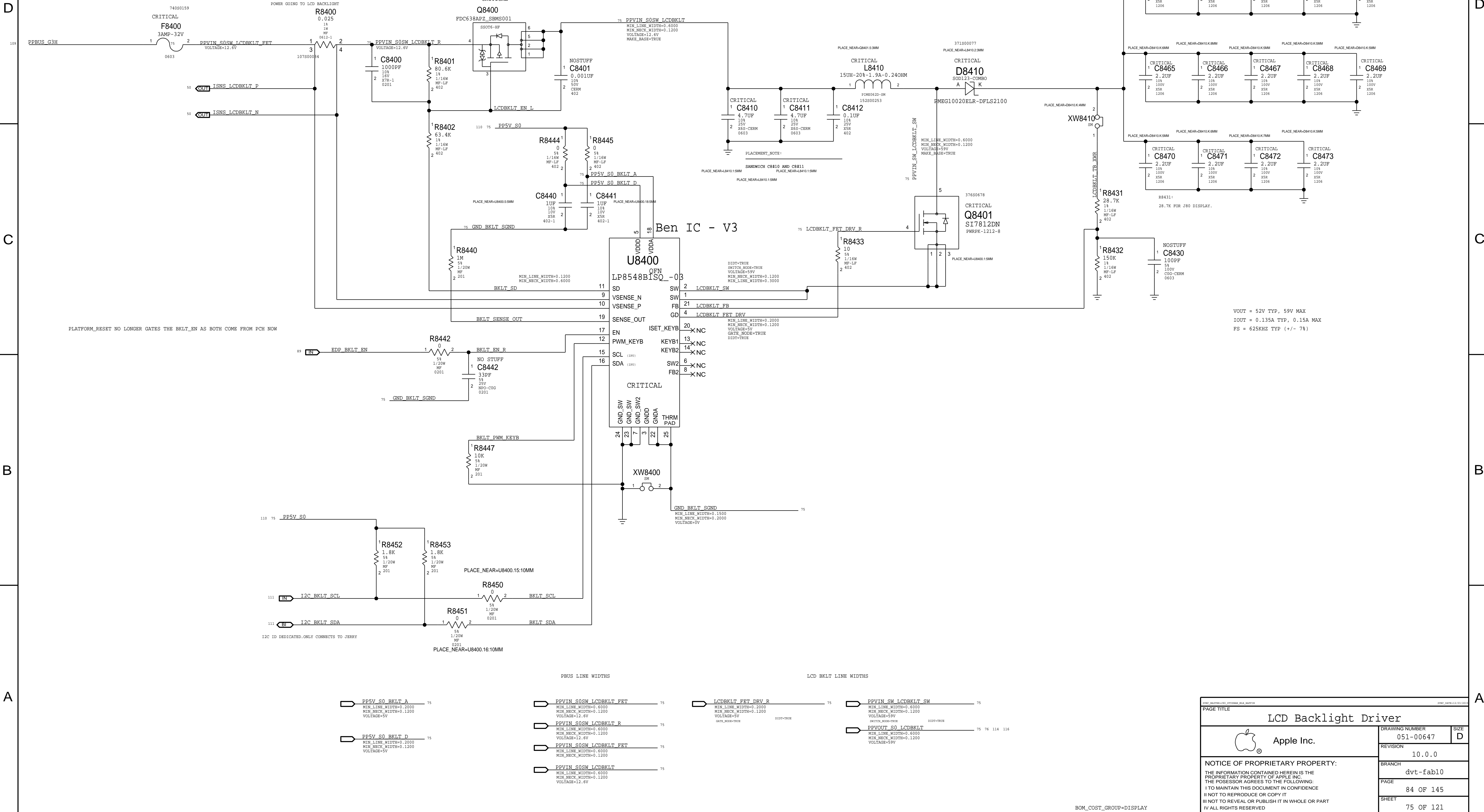
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BOM\_COST\_GROUP=PLATFORM POWER



```
Power aliases required by this page:

- =PPVIN_S0GM_LCDCLKTFET    (9-12.6V LCD BACKLIGHT INPUT)
- =PP5V_S0_BKLT             (5V BACKLIGHT DRIVER INPUT)
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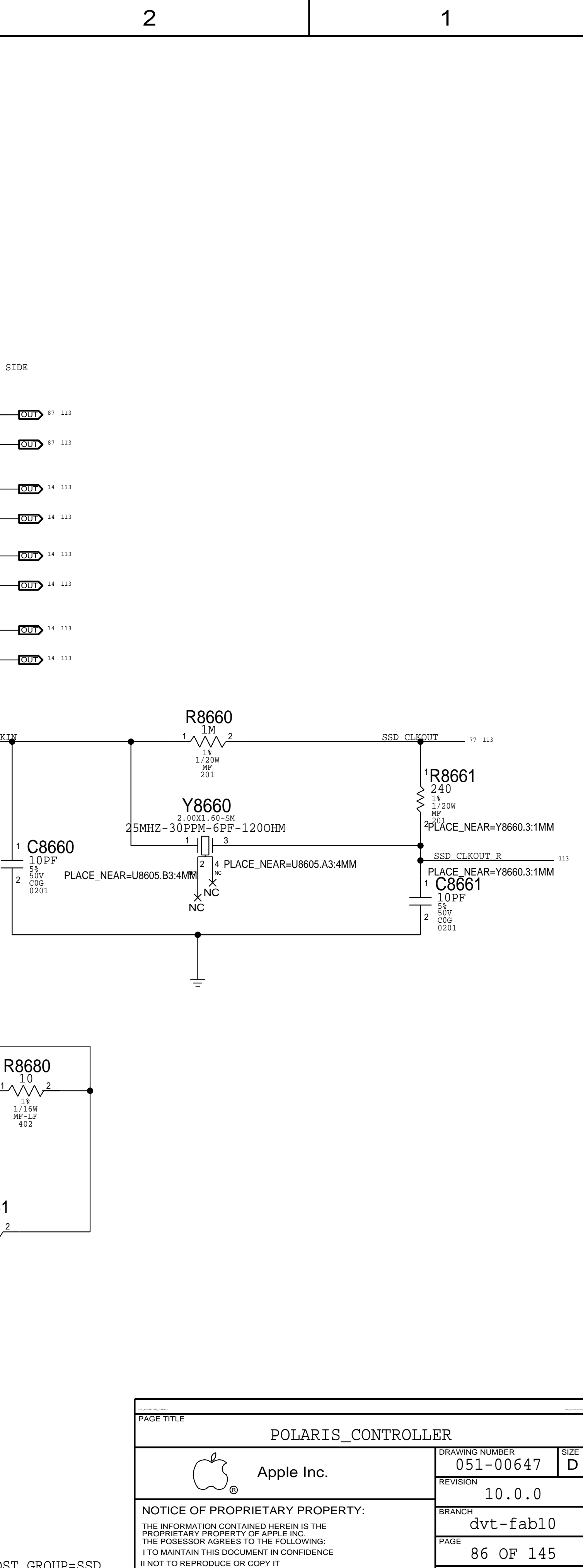
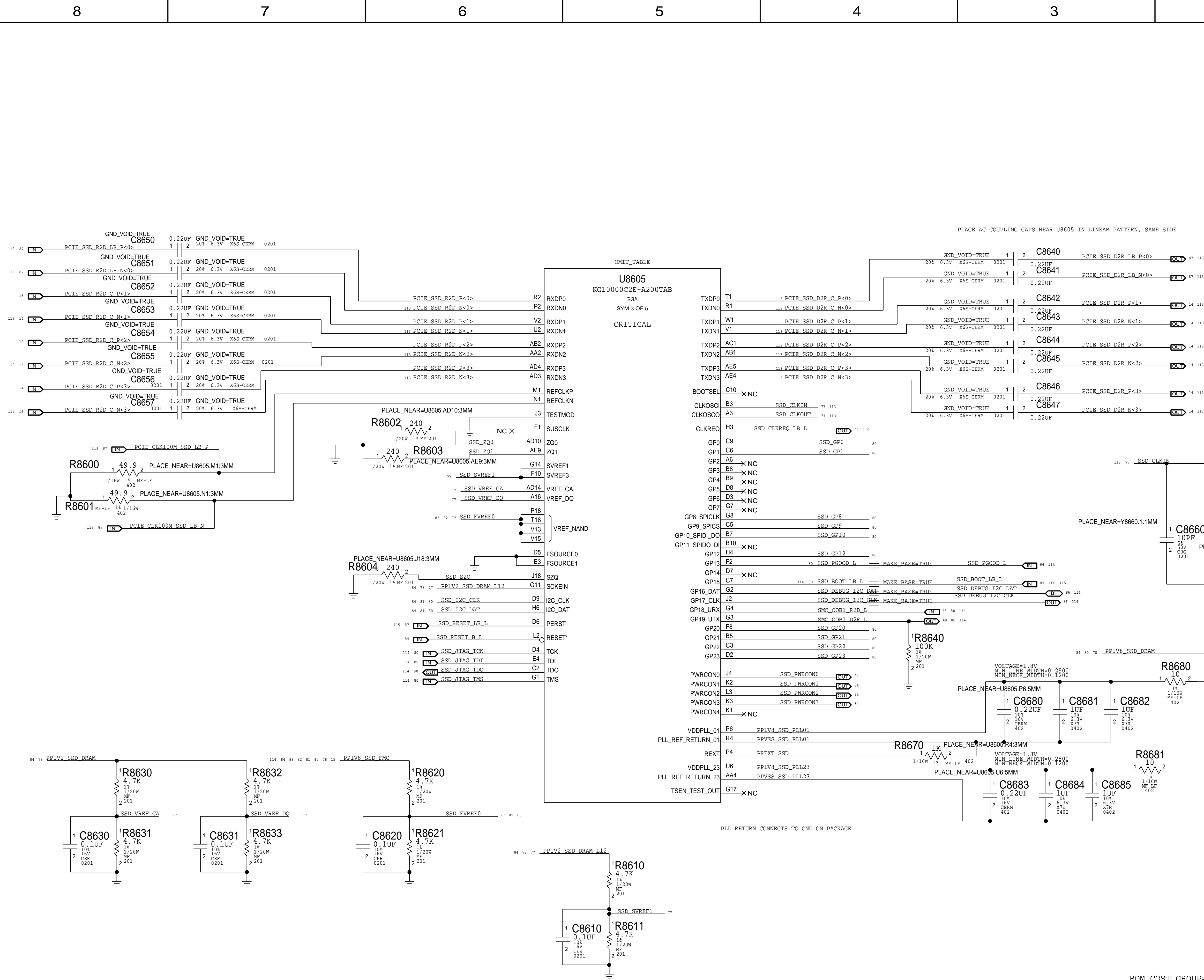



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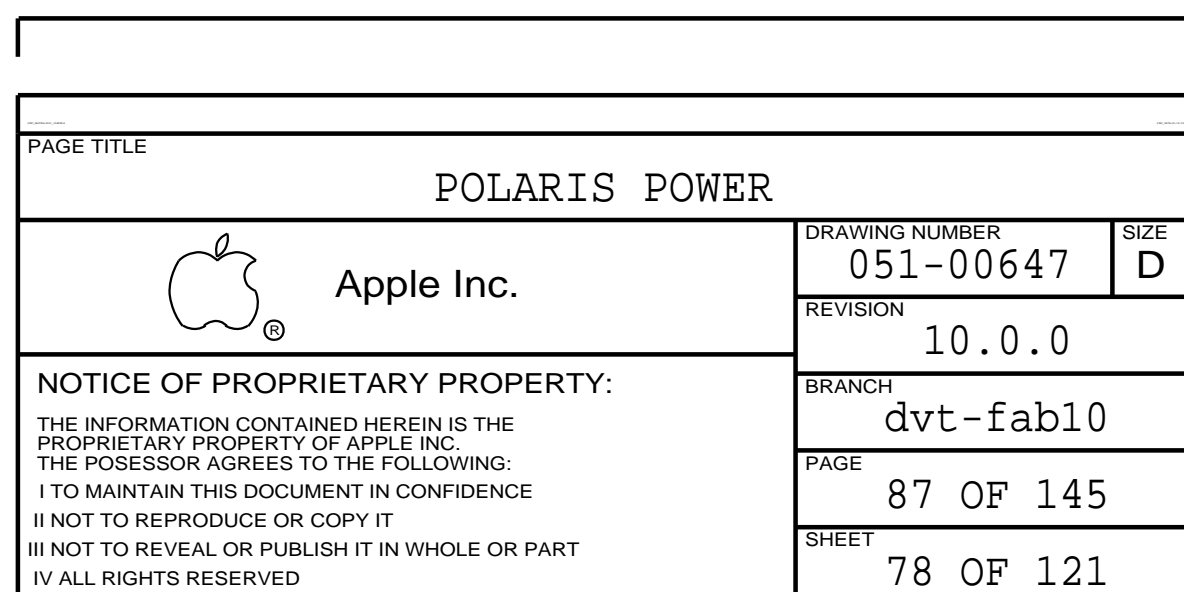
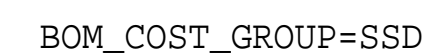


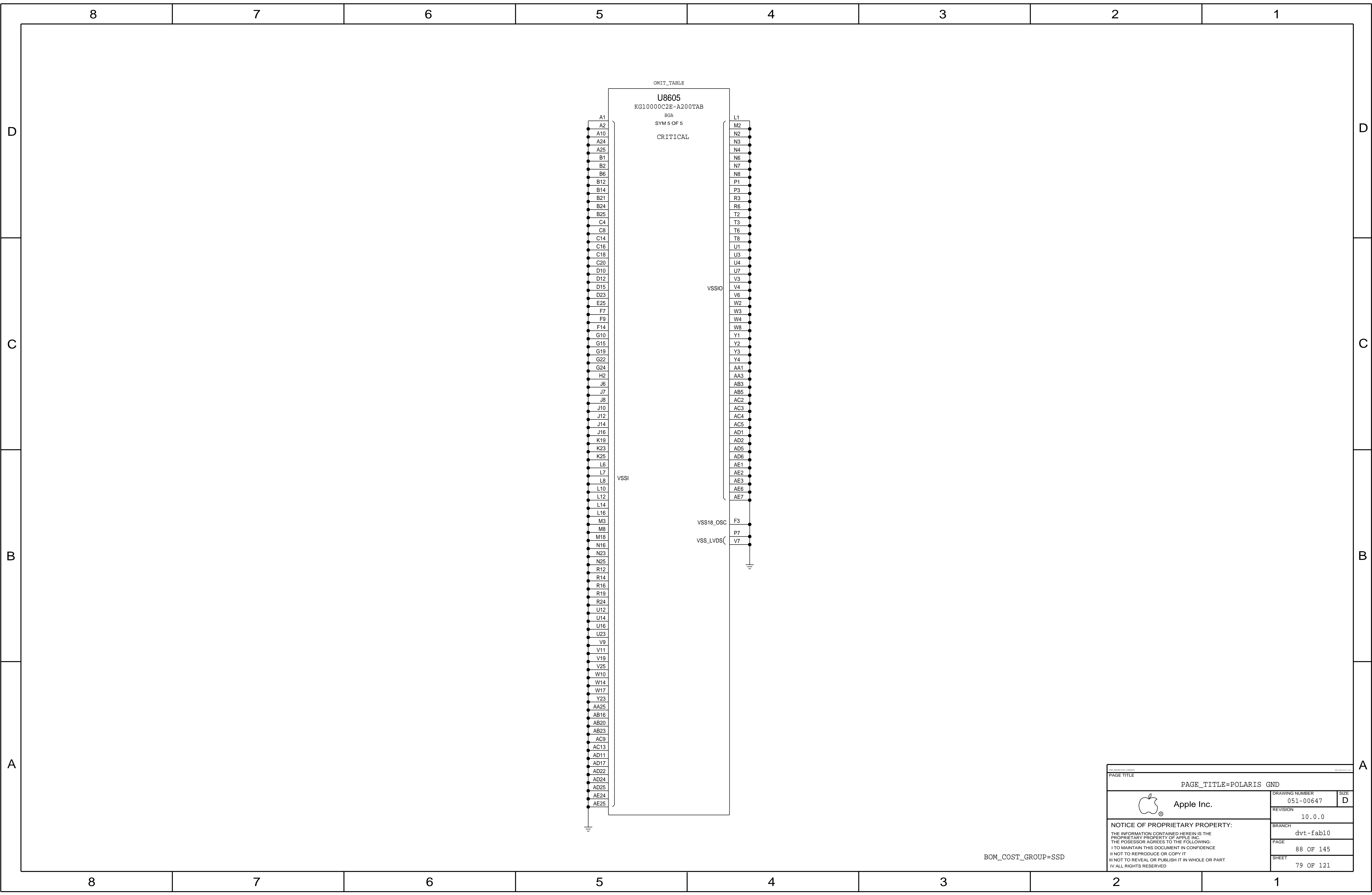
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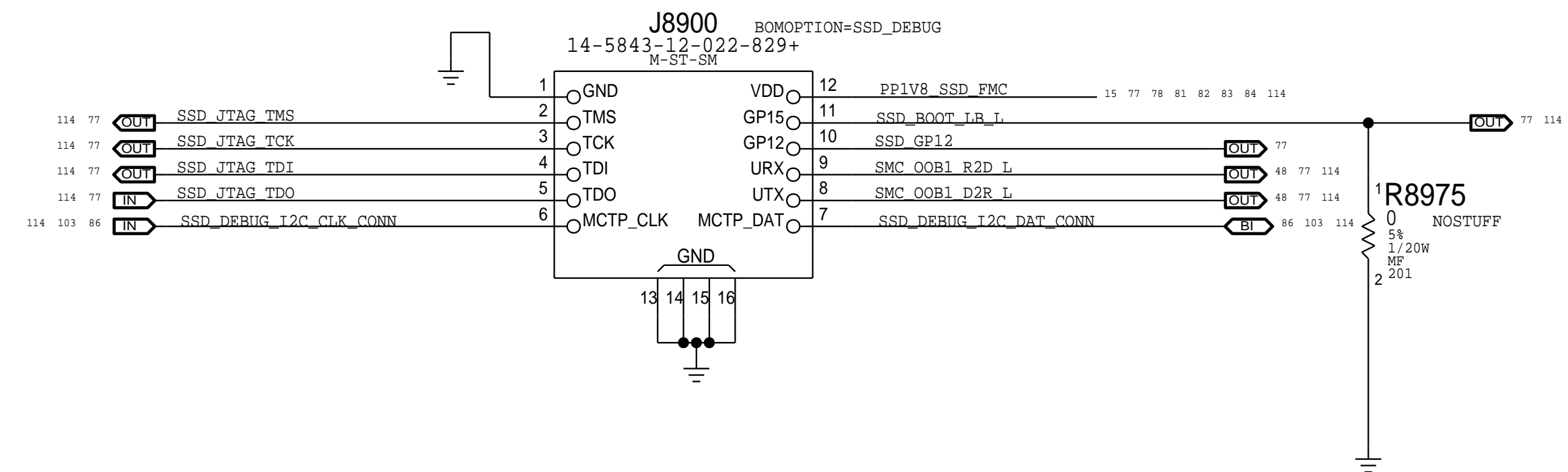
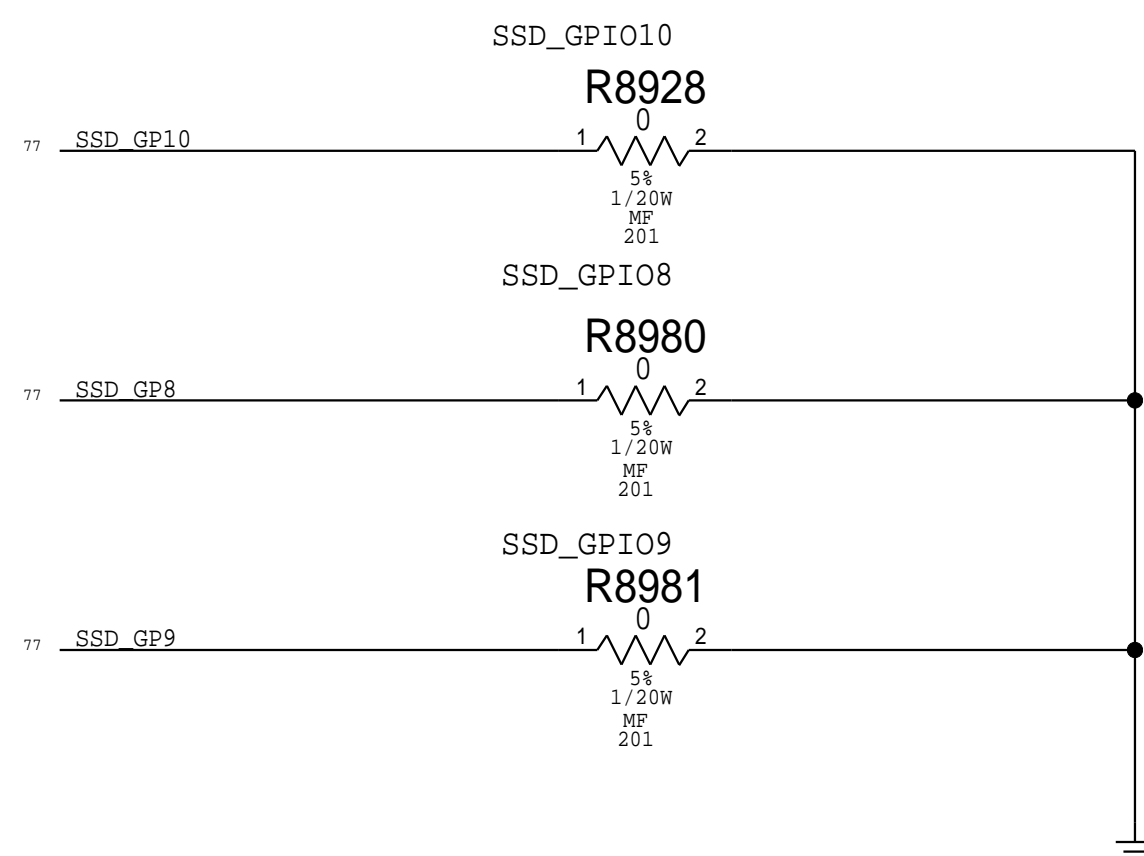
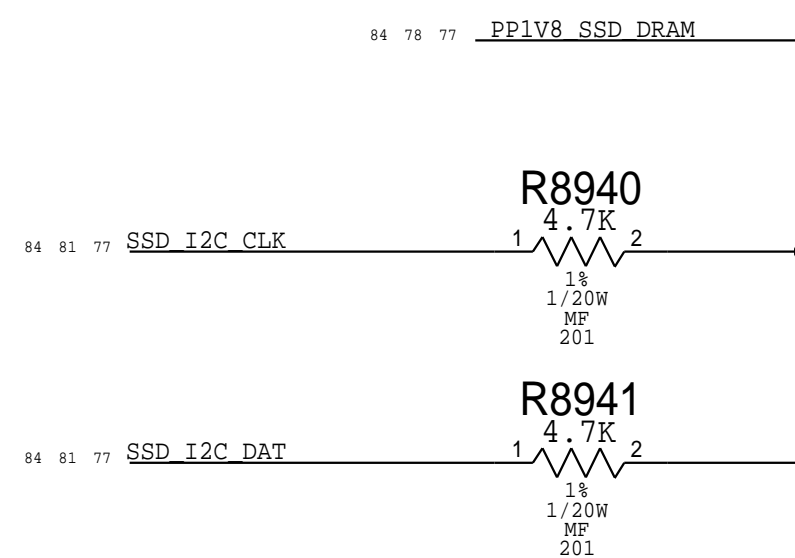
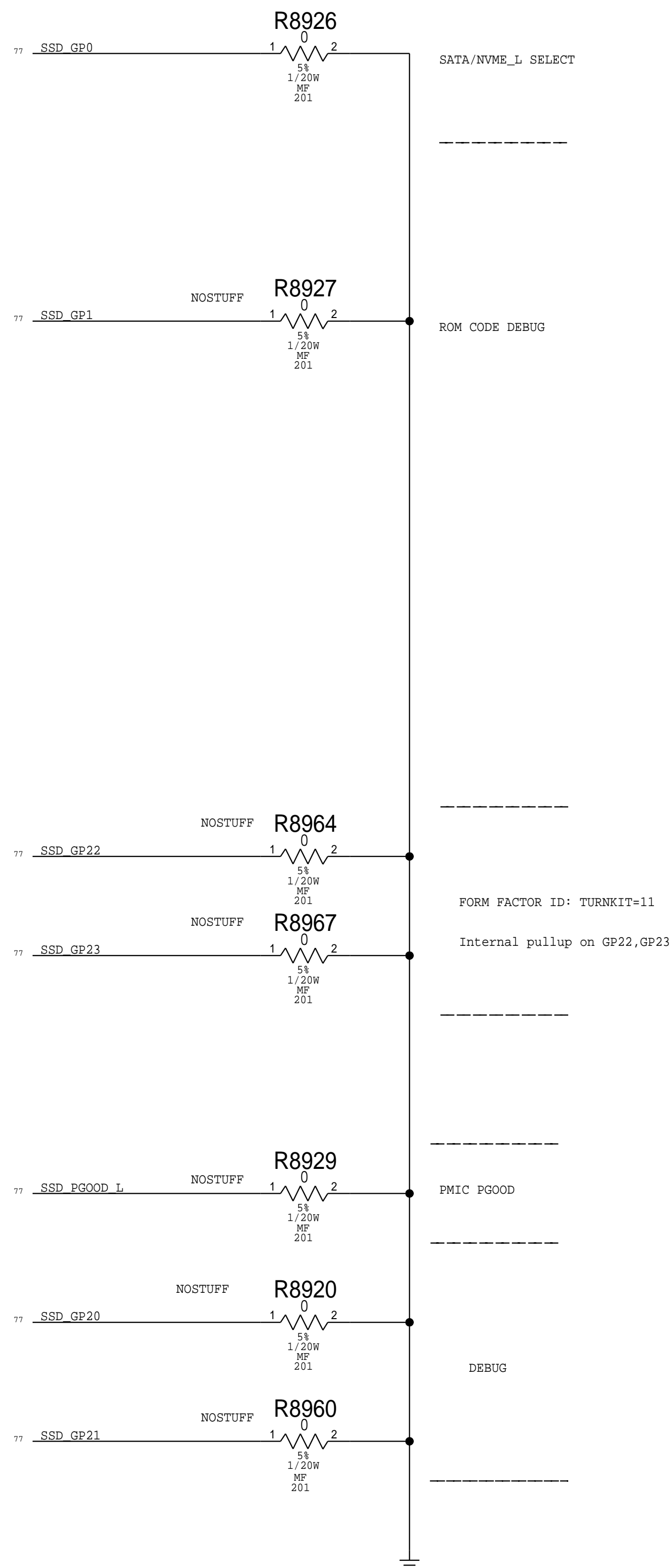
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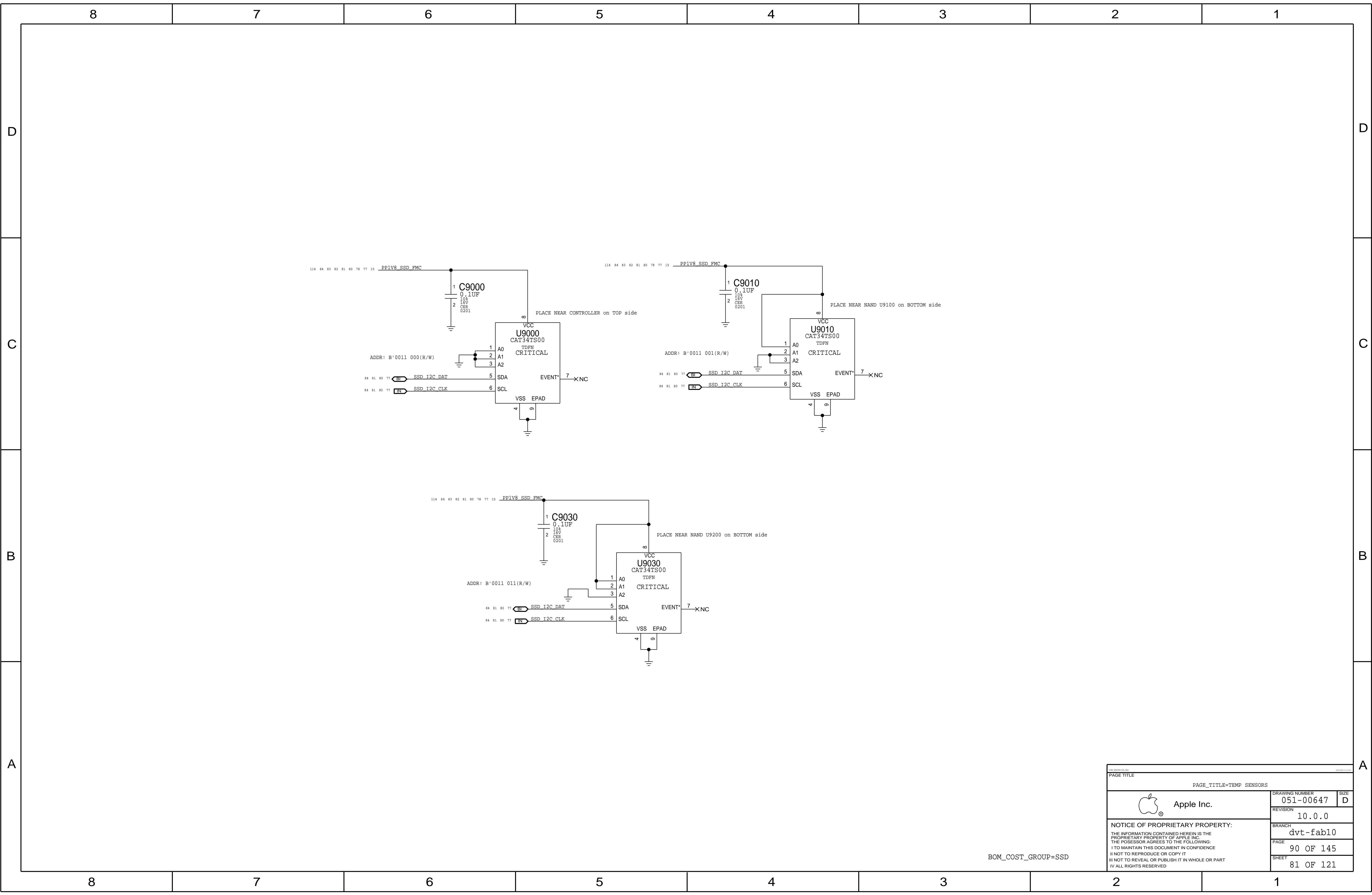


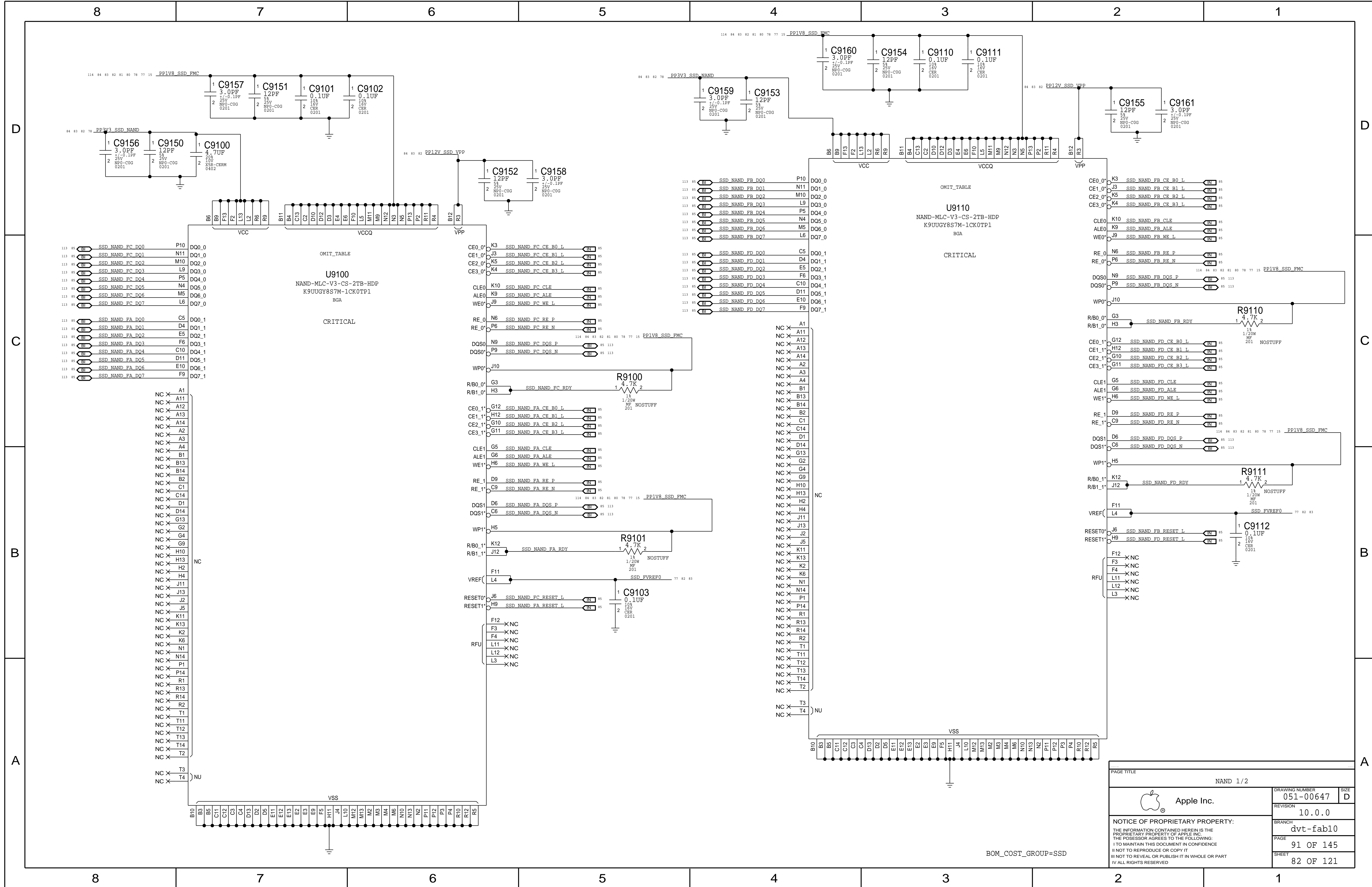
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SSD_CONFIG:512GB	SSD_GPIO8,NAND_TYPE:512GB,SSD_CTRL_TYPE:4GBIT
SSD_CONFIG:1TB	NAND_TYPE:1TB,SSD_CTRL_TYPE:8GBIT
SSD_CONFIG:2TB	SSD_GPIO10,NAND_TYPE:2TB,SSD_CTRL_TYPE:8GBIT

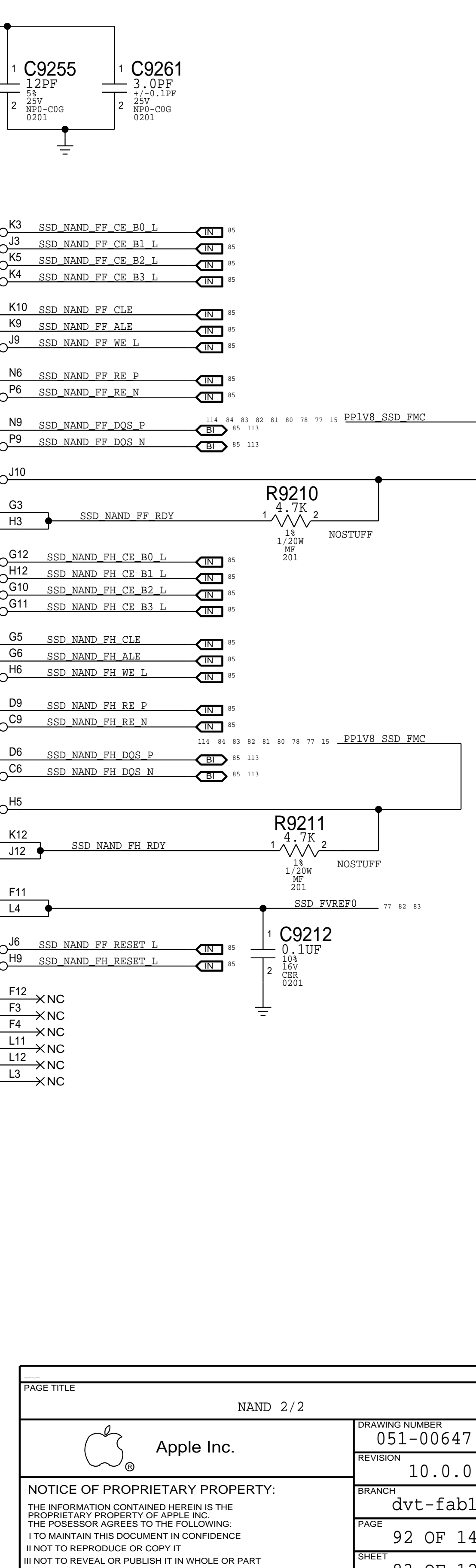
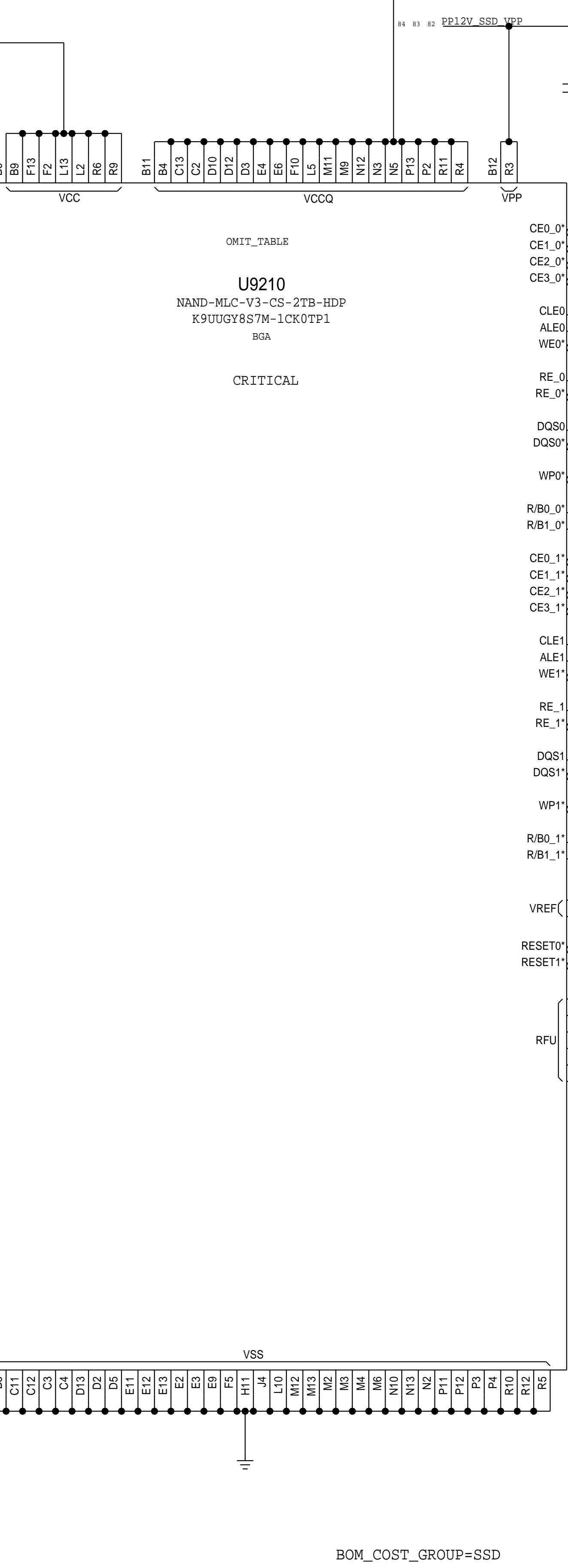
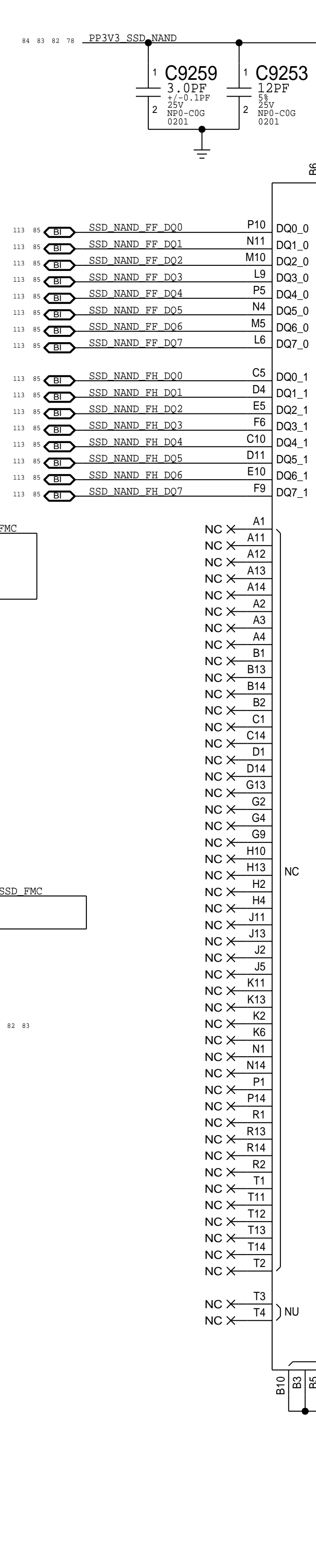
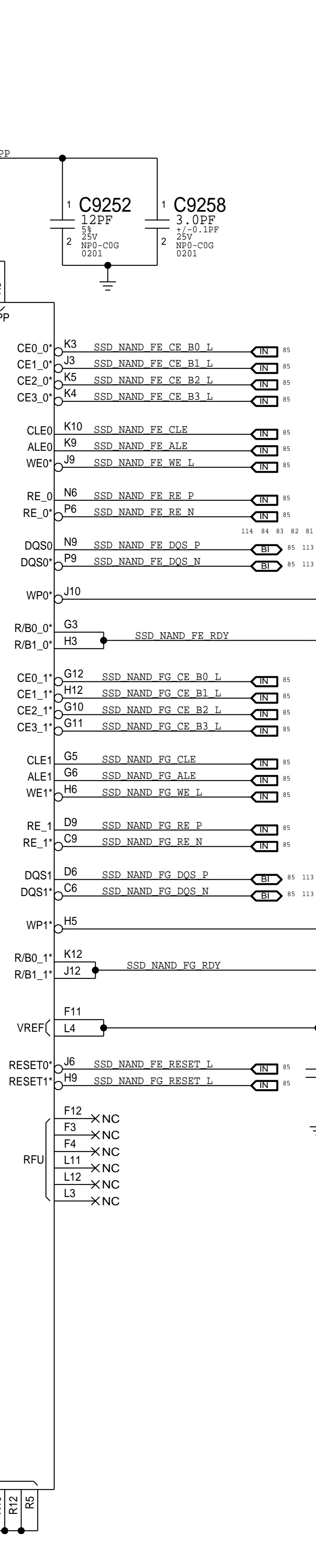
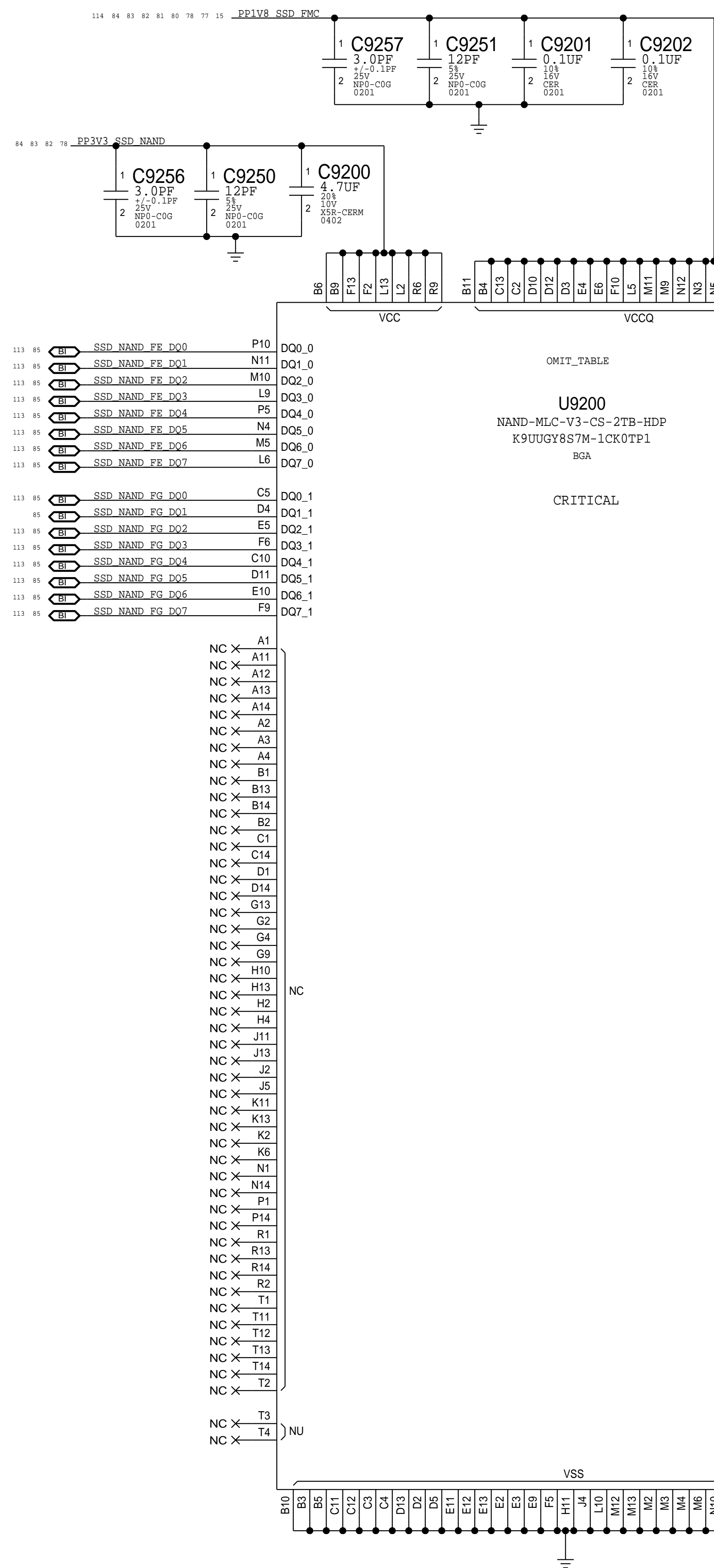
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335S00204	4	NAND,V3,128GBM,TOGO DDR2,2560,SS8GB,168	U9100,U9110,U9200,U9210	CRITICAL	NAND_TYPE:512GB
335S00205	4	NAND,V3,256GBM,TOGO DDR2,2560,SS,BGA 168	U9100,U9110,U9200,U9210	CRITICAL	NAND_TYPE:1TB
335S00219	4	NAND,V3,512GBM,TOGO DDR2,2560,SS,BGA 168	U9100,U9110,U9200,U9210	CRITICAL	NAND_TYPE:2TB

PART NUMBER	QTY	DESCRIPTION	REFERENCE DES	CRITICAL	BOM OPTION
339S00154	1	POP, POLARIS+4GBIT, SSD_CTRL, A2, 8GA516	U8605	CRITICAL	SSD_CTRL_TYPE=4GBIT
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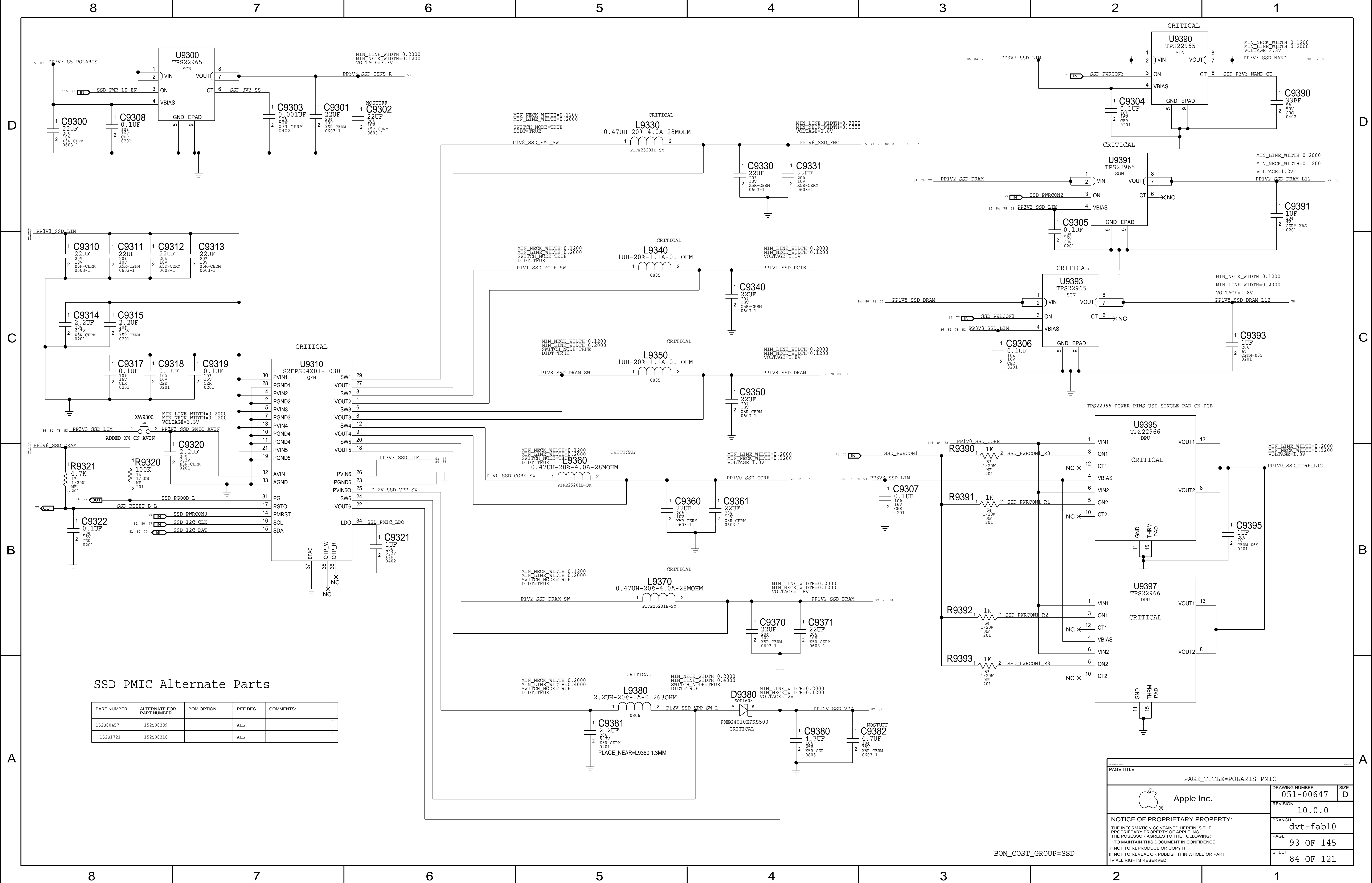
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256 GB	335S00149	339S00154 (A2 4GB DRAM)	NOSTUFF-1	STUFF-0	NOSTUFF-1
512 GB	335S00204	339S00154 (A2 4GB DRAM)	STUFF-0	NOSTUFF-1	NOSTUFF-1
1 TB	335S00205	339S00155 (A2 8GB DRAM)	NOSTUFF-1	NOSTUFF-1	NOSTUFF-1
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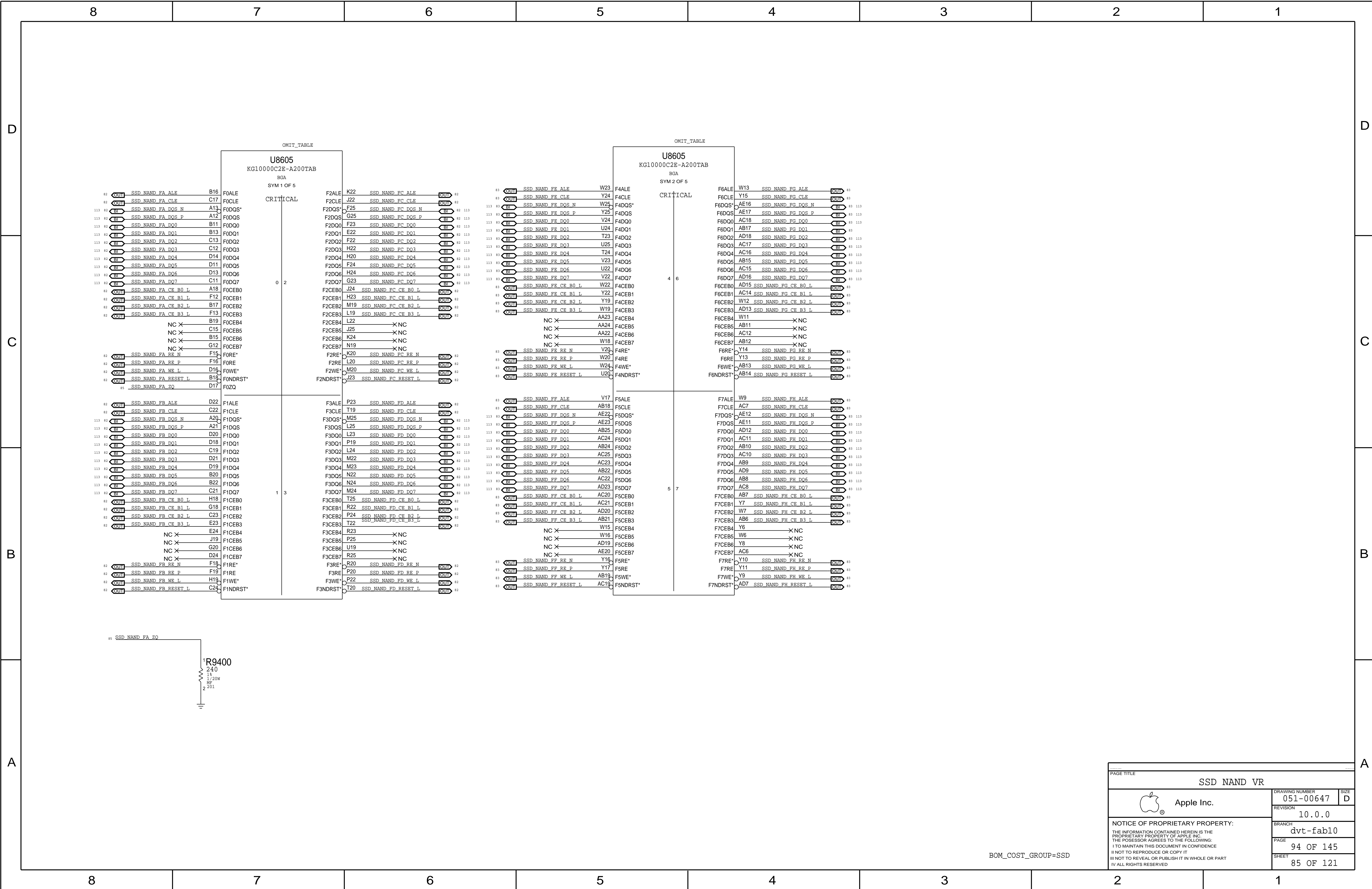




SSD PMIC Alternate Parts

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152S1721	152S00310		ALL	

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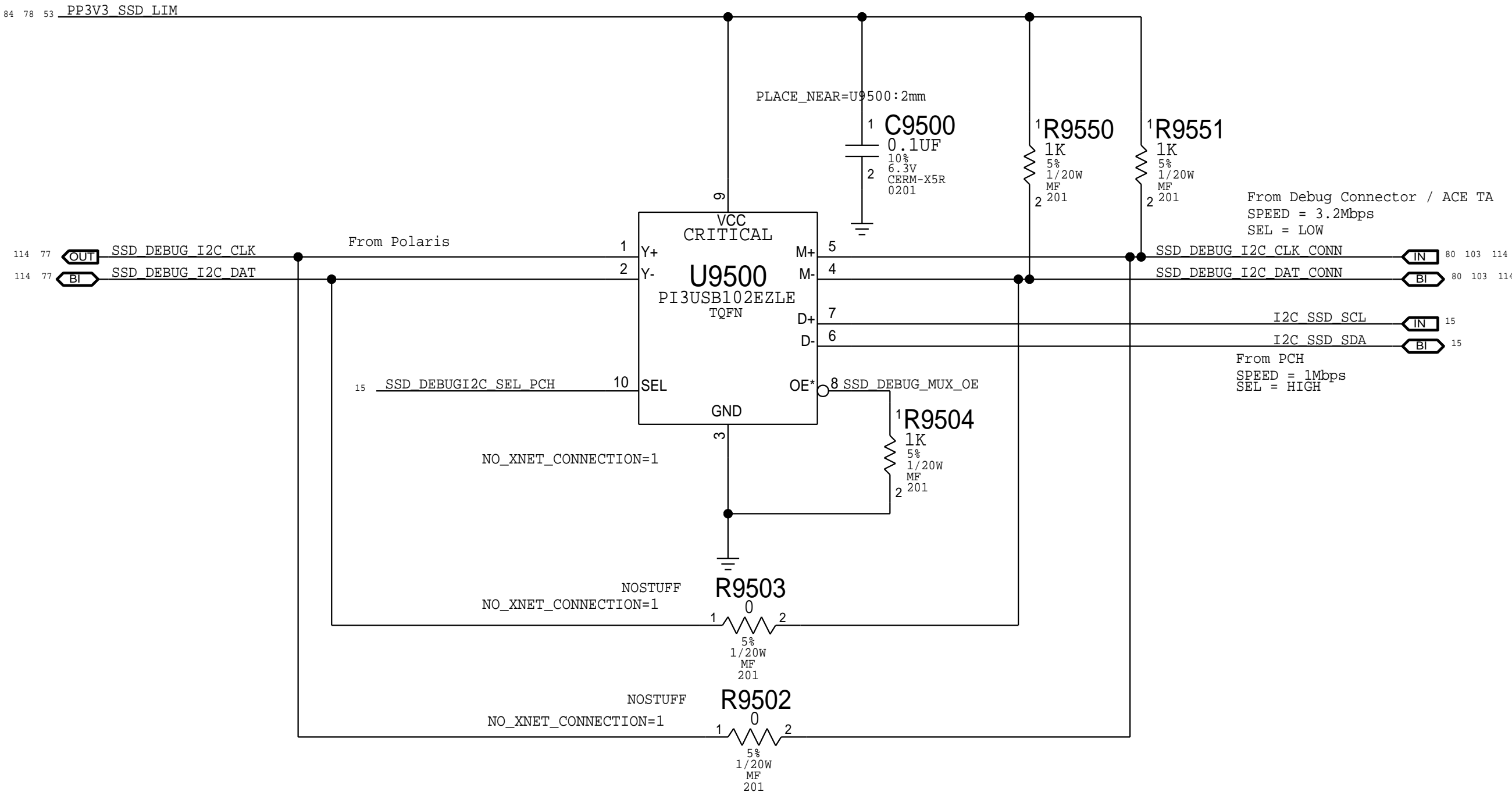
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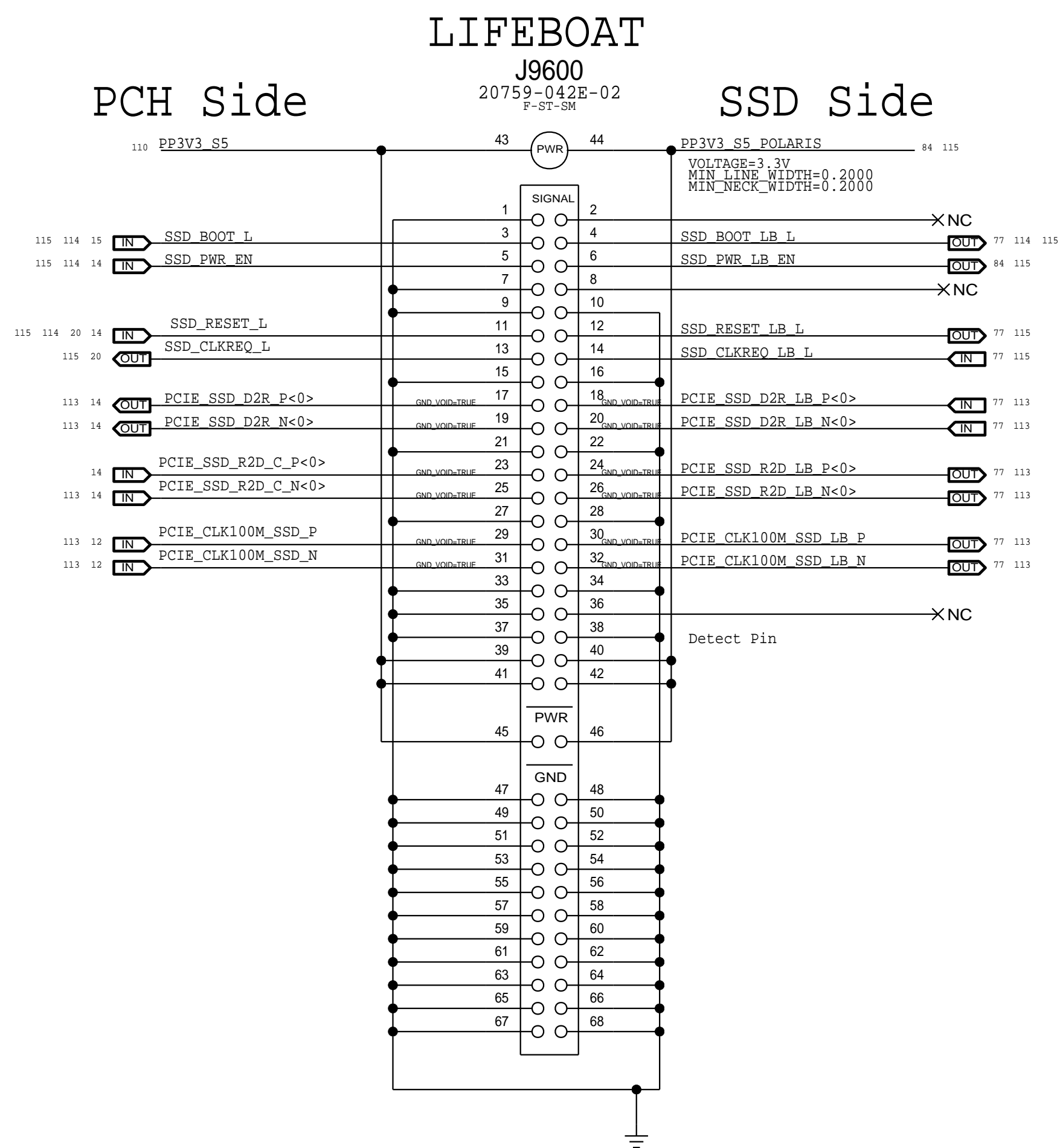
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BOM\_COST\_GROUP=SSD


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BOM\_COST\_GROUP=SSD



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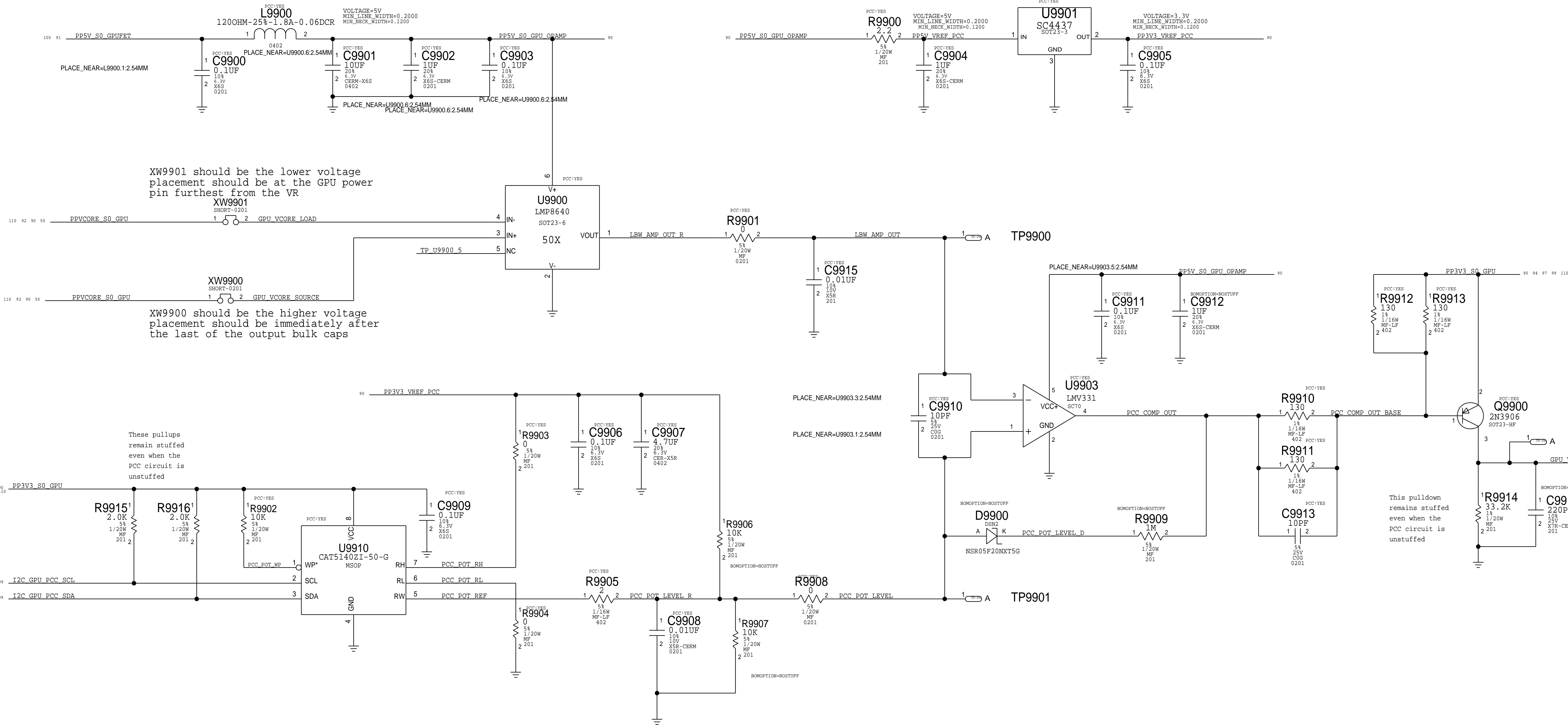
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GPU PCC		
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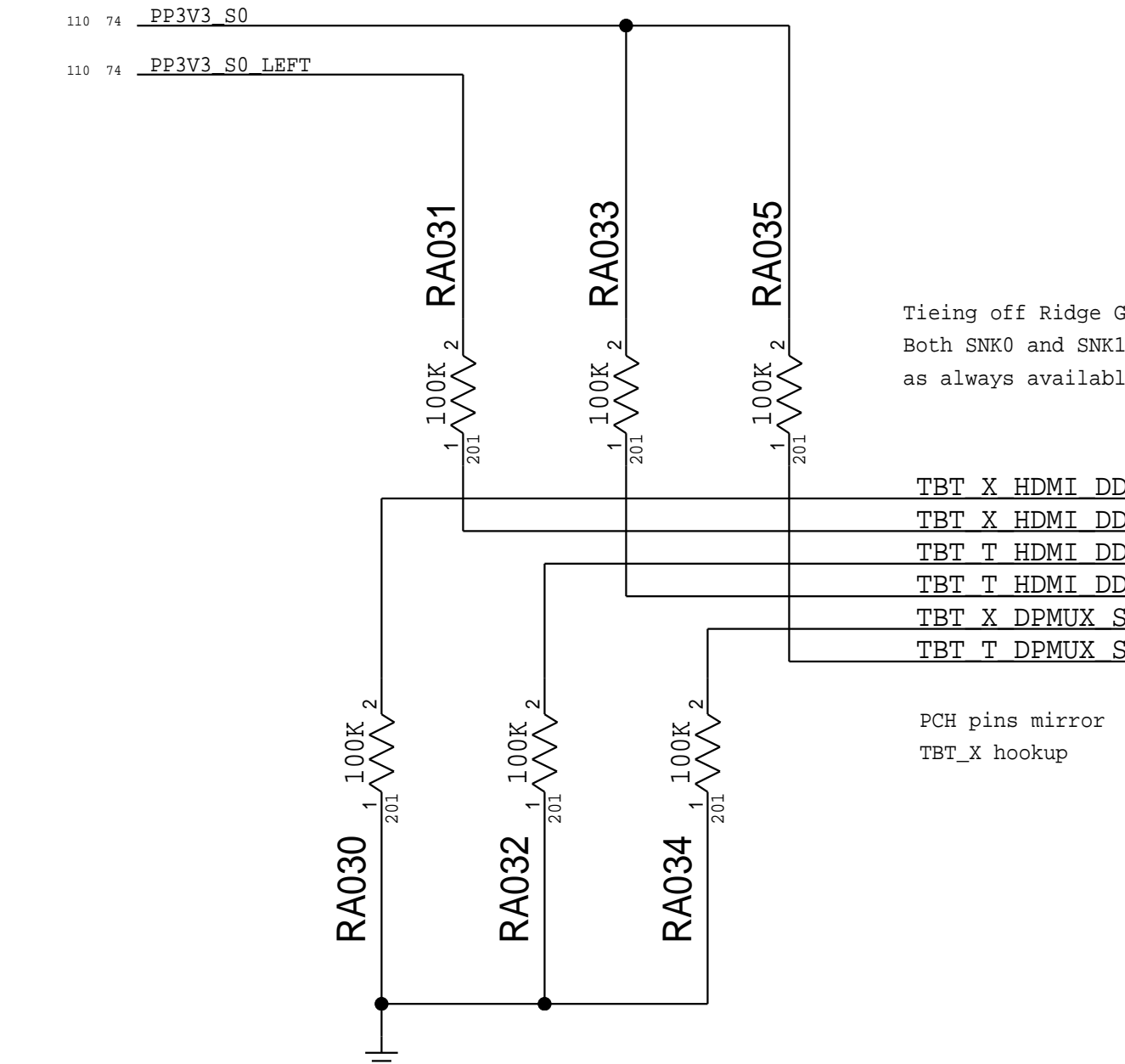
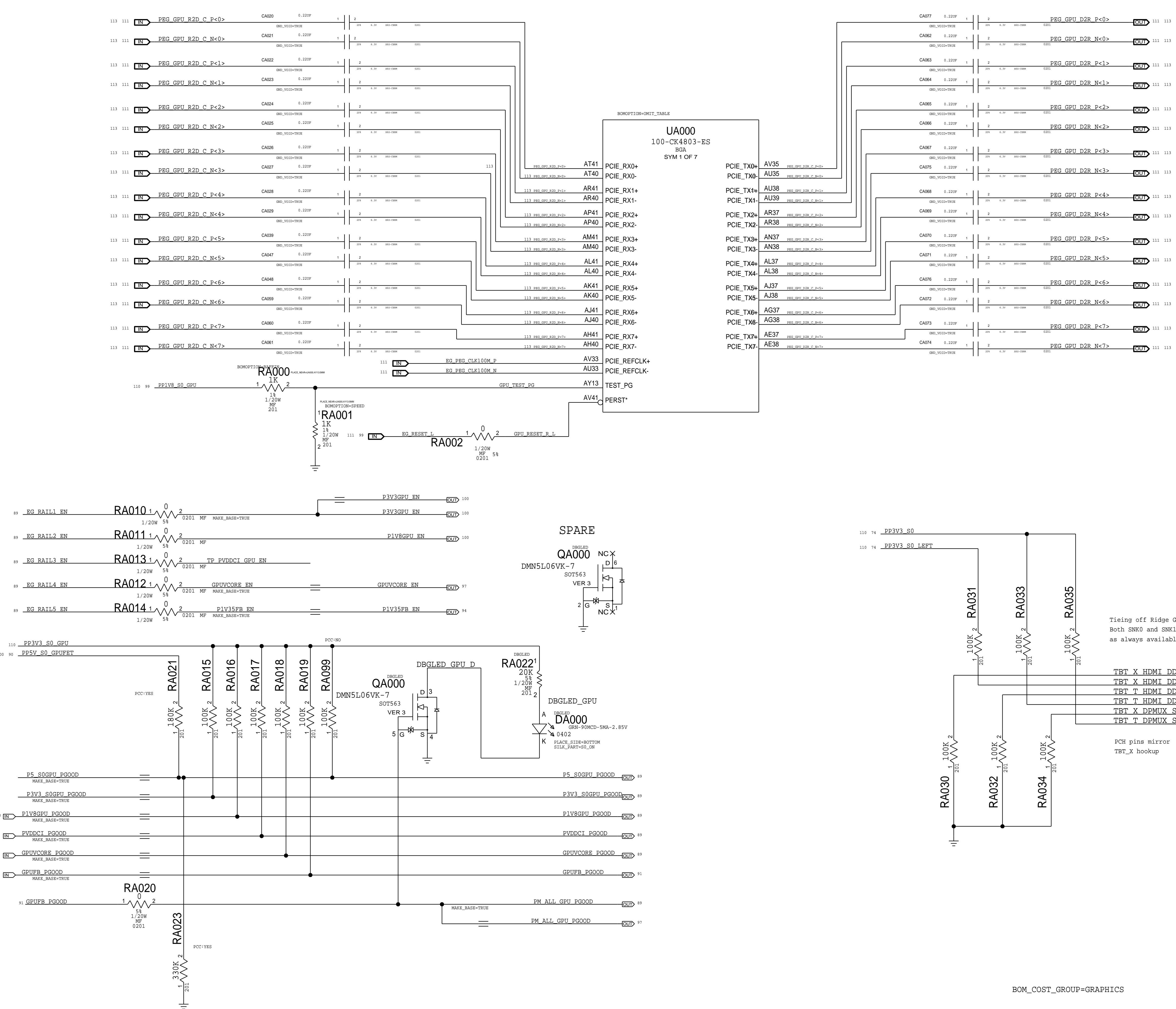
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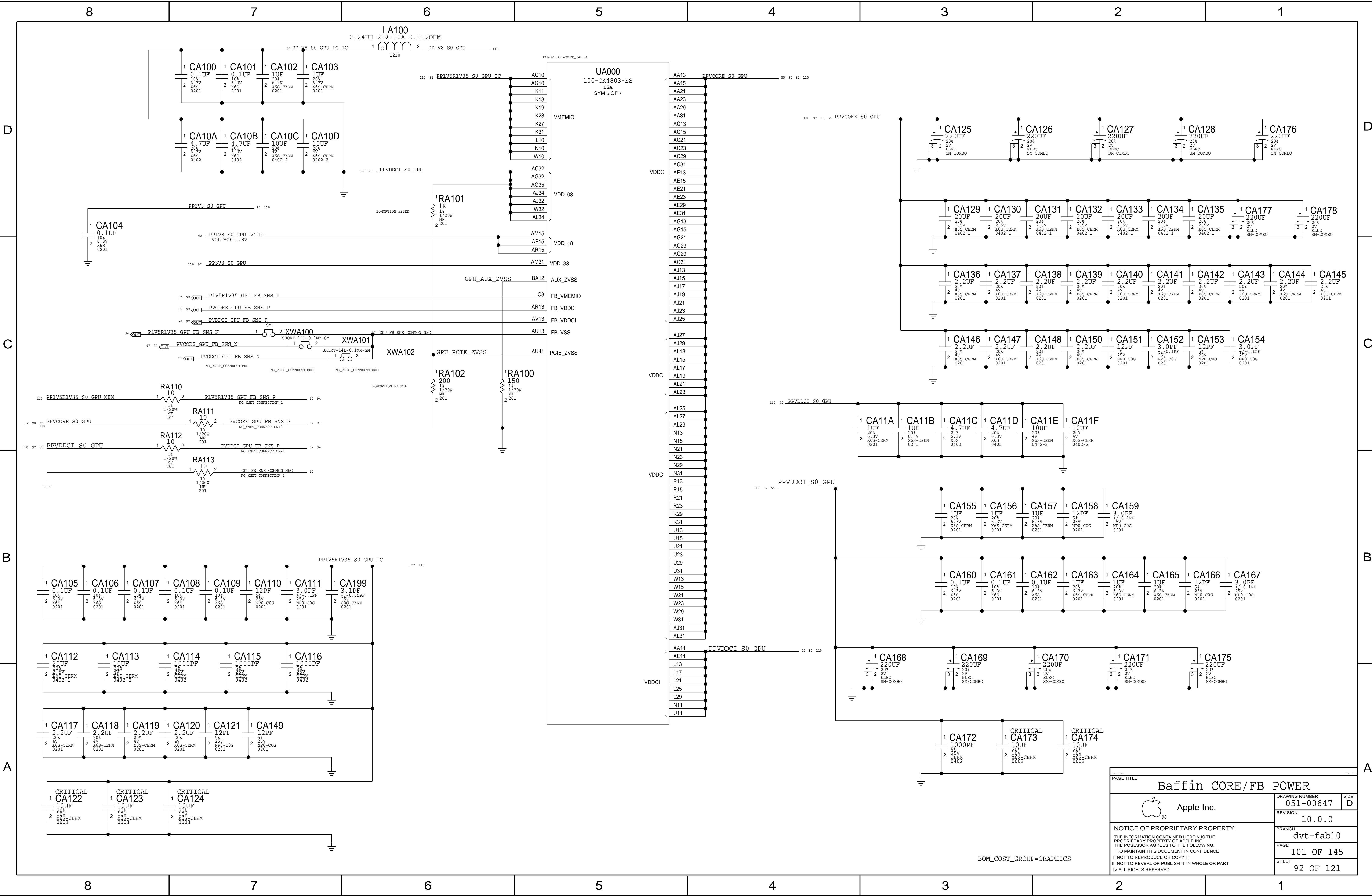
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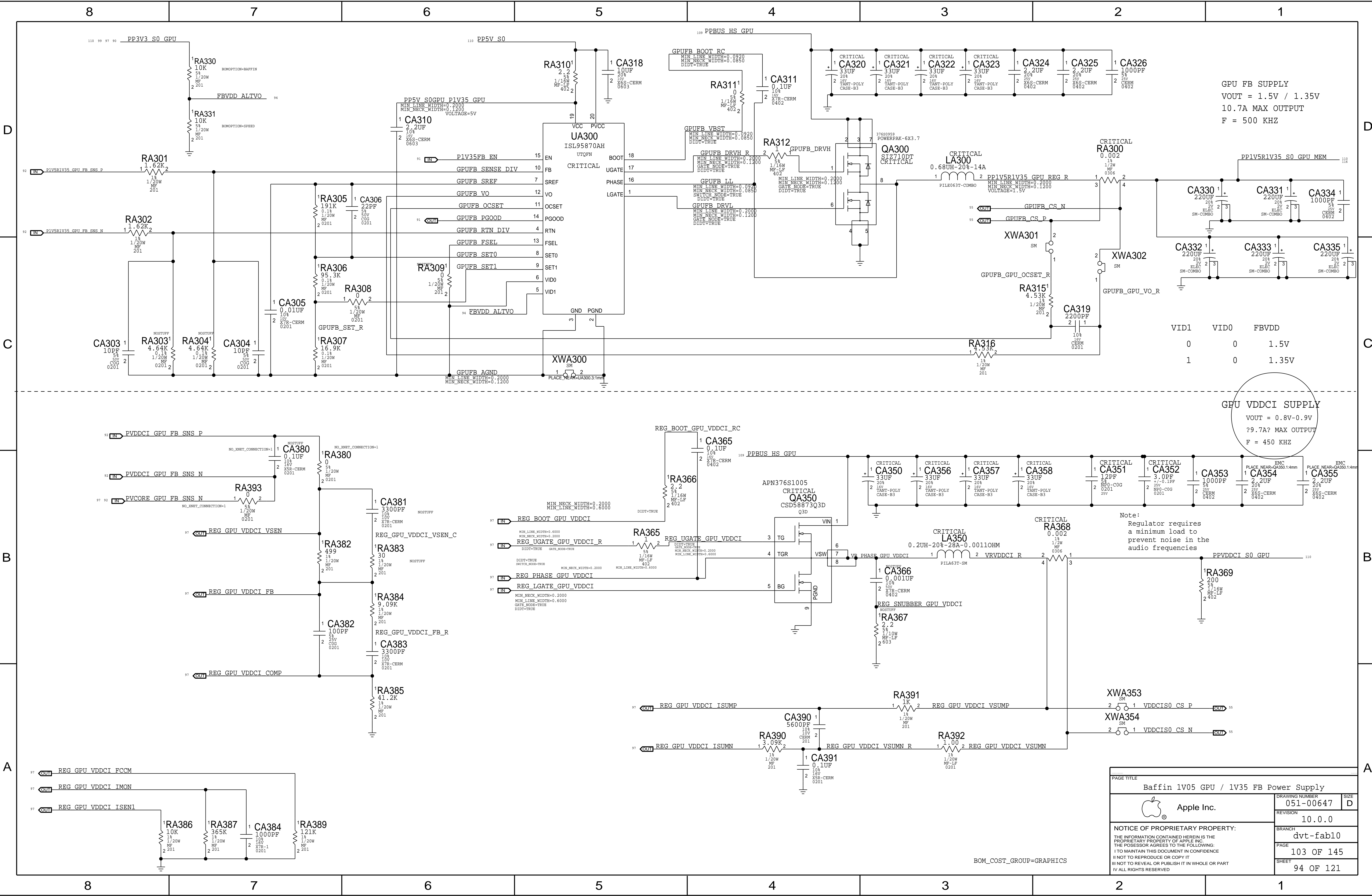
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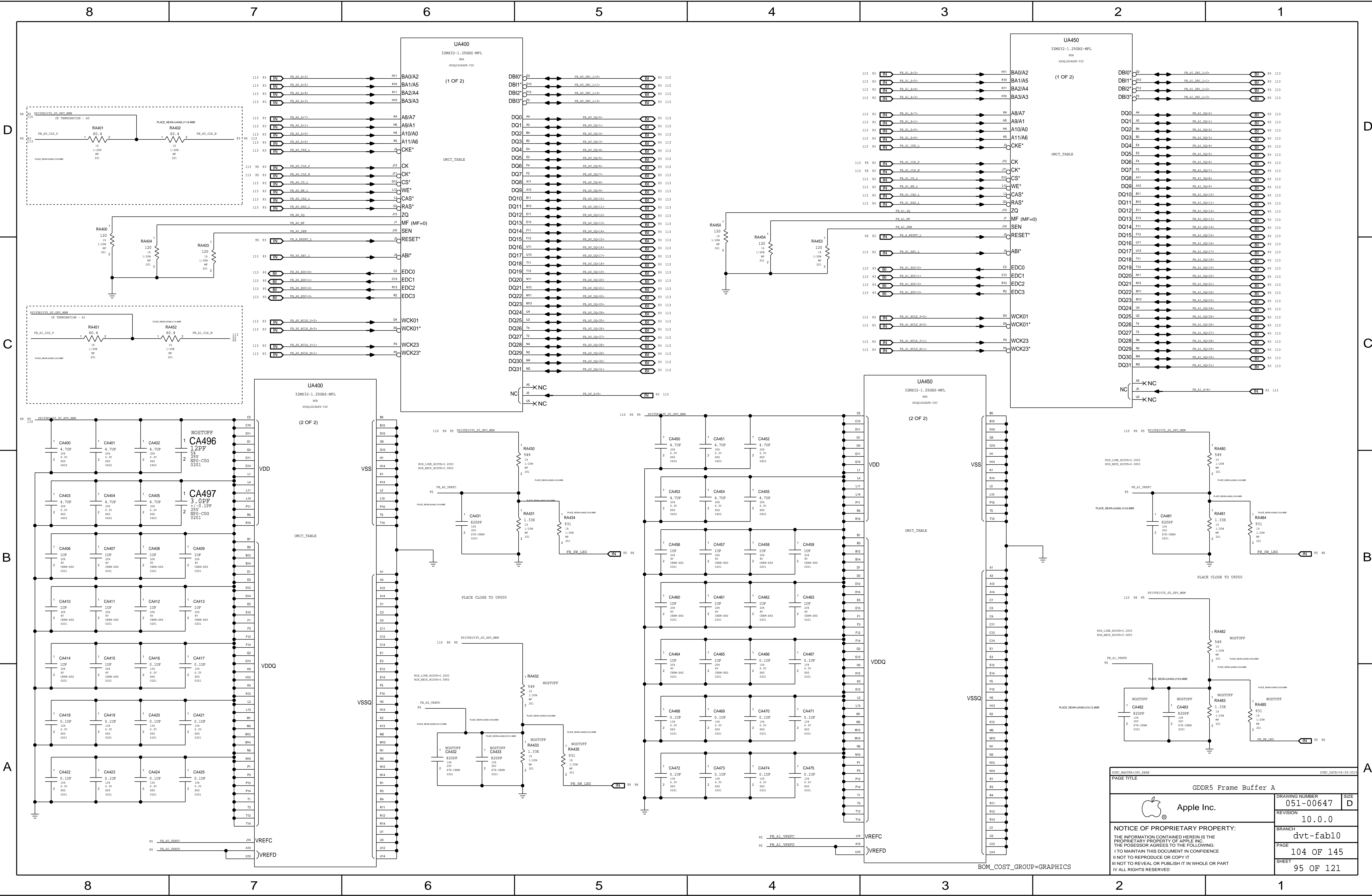




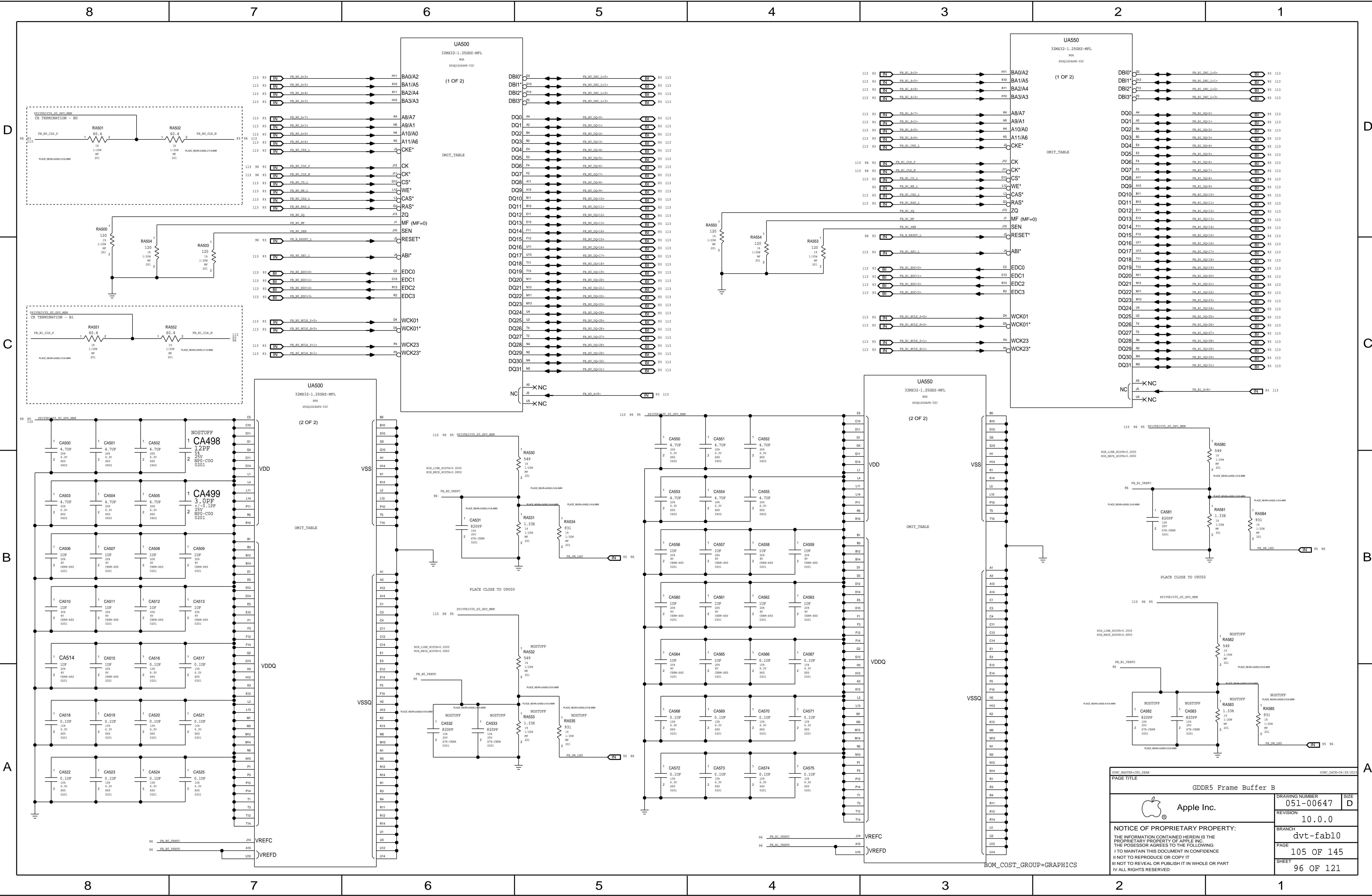




PAGE TITLE		
Baffin 1V05 GPU / 1V35 FB Power Supply		
 Apple Inc.	DRAWING NUMBER	051-00647
	REVISION	10.0.0
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	SHEET	94 OF 121








SYNCHMASTER=880\_SEAN

SYNCHDATE=04/29/2015

PAGE TITLE

GDDR5 Frame Buffer B

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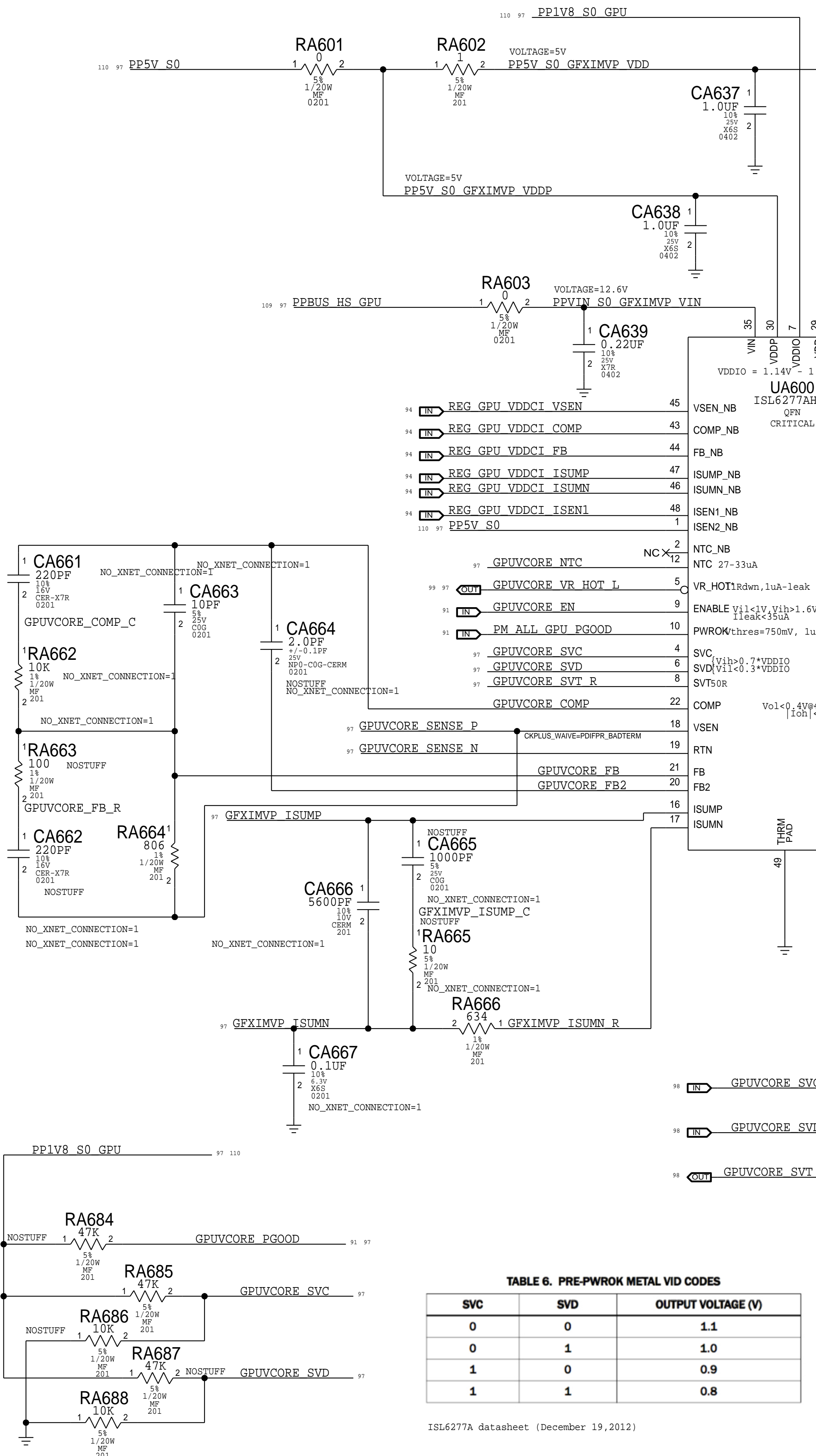
REVISION  
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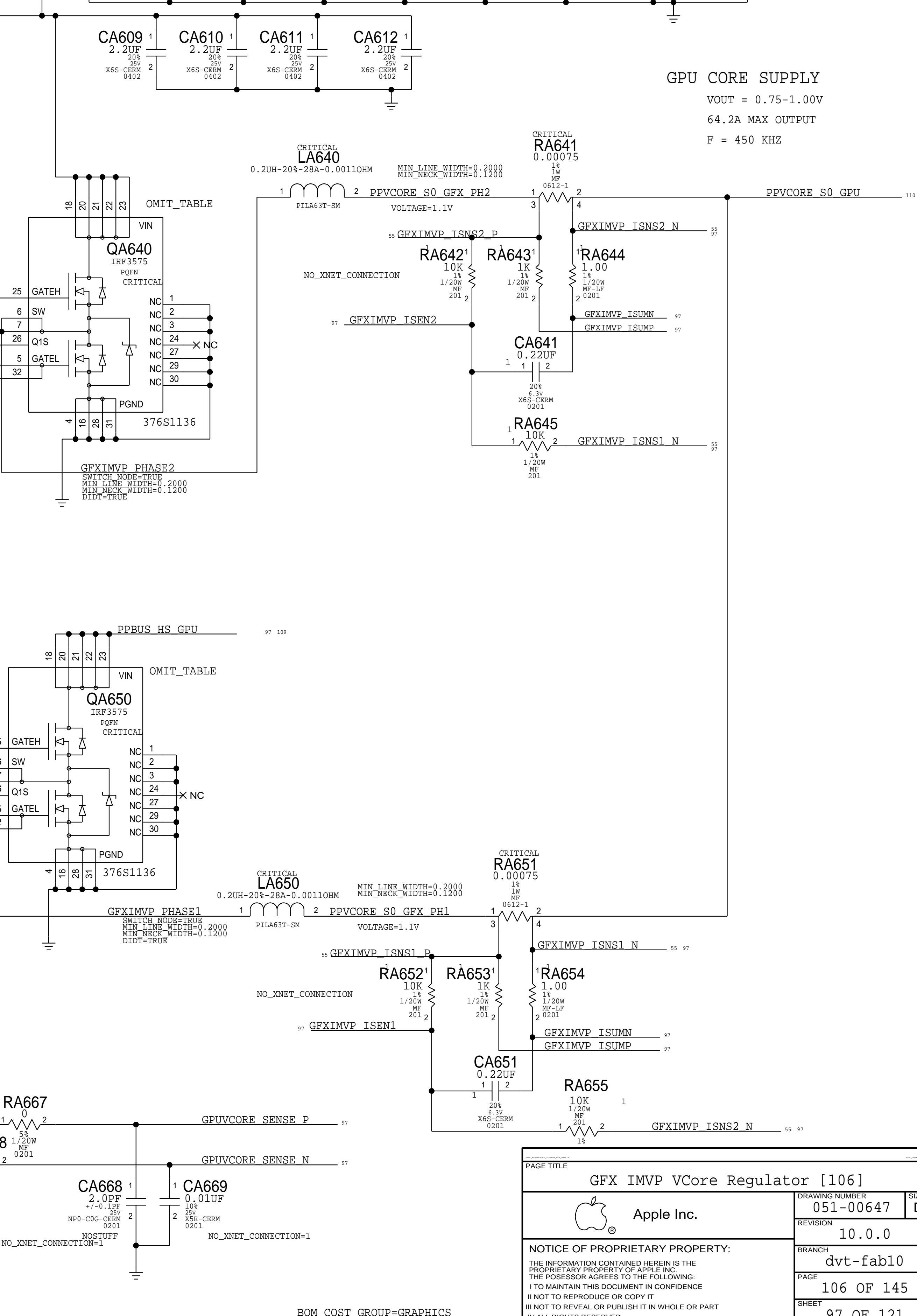
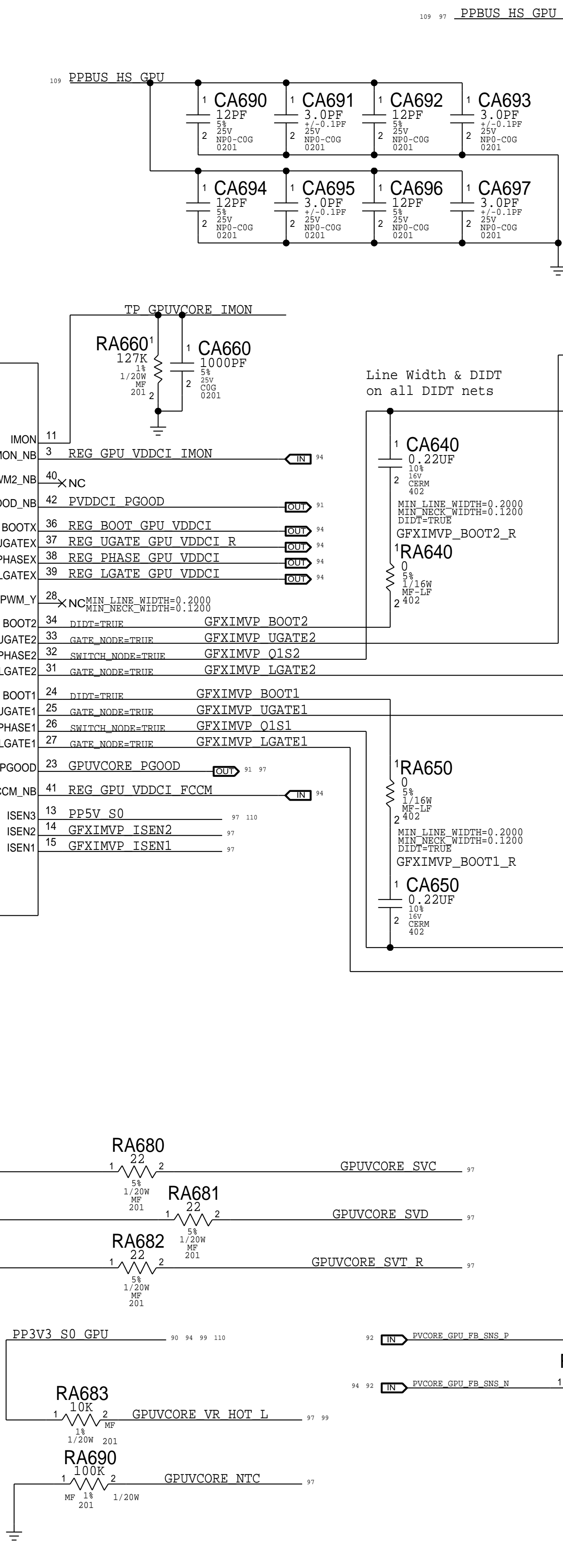
SHEET  
96 OF 121


PART NUMBER	QTY	DESCRIPTION	REFERENCE DES	CRITICAL	BOM OPTION
376S00174	2	MOSFET, CTRL+SYNC, 25V, 4..1/1..4MO, QFN32, 6x6	Q8640, Q8650	CRITICAL	



SVC	SVD	OUTPUT VOLTAGE (V)
0	0	1.1
0	1	1.0
1	0	0.9
1	1	0.8

ISL6277A datasheet (December 19, 2012)



PAGE TITLE		DRAWING NUMBER		SIZE	
GFX APPLE VCore Regulator [106]		051-00647		D	
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		SHEET		97 OF 121	

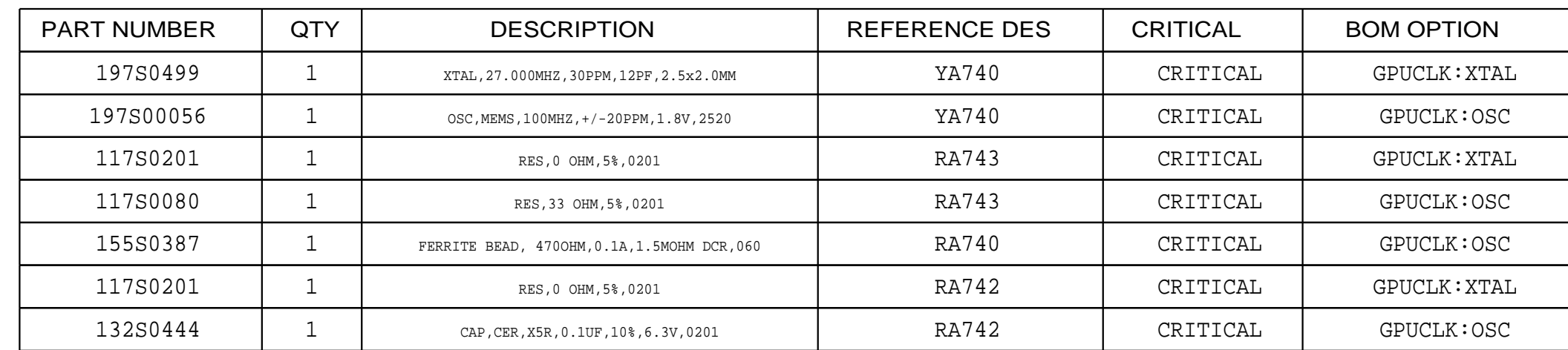


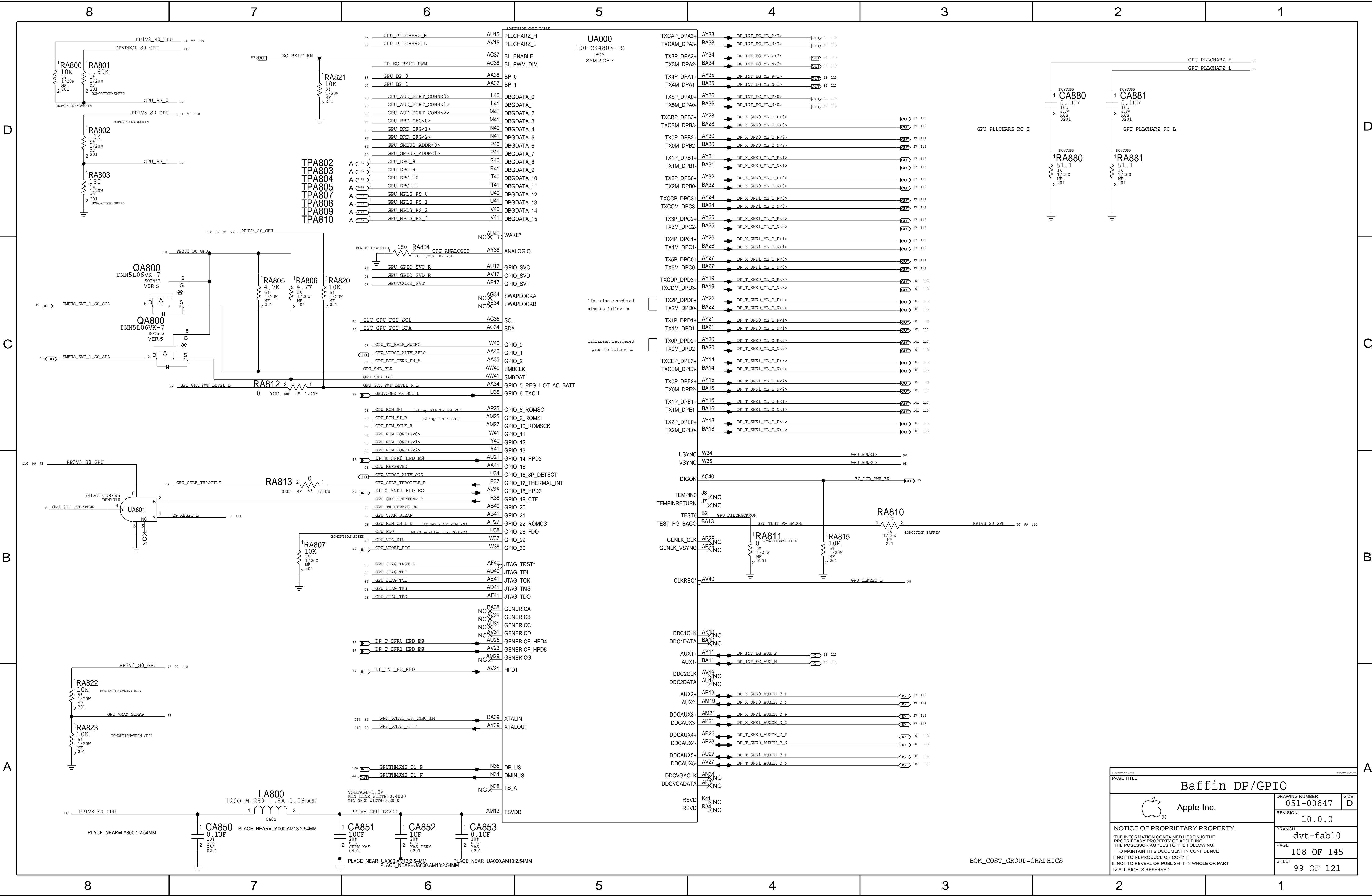
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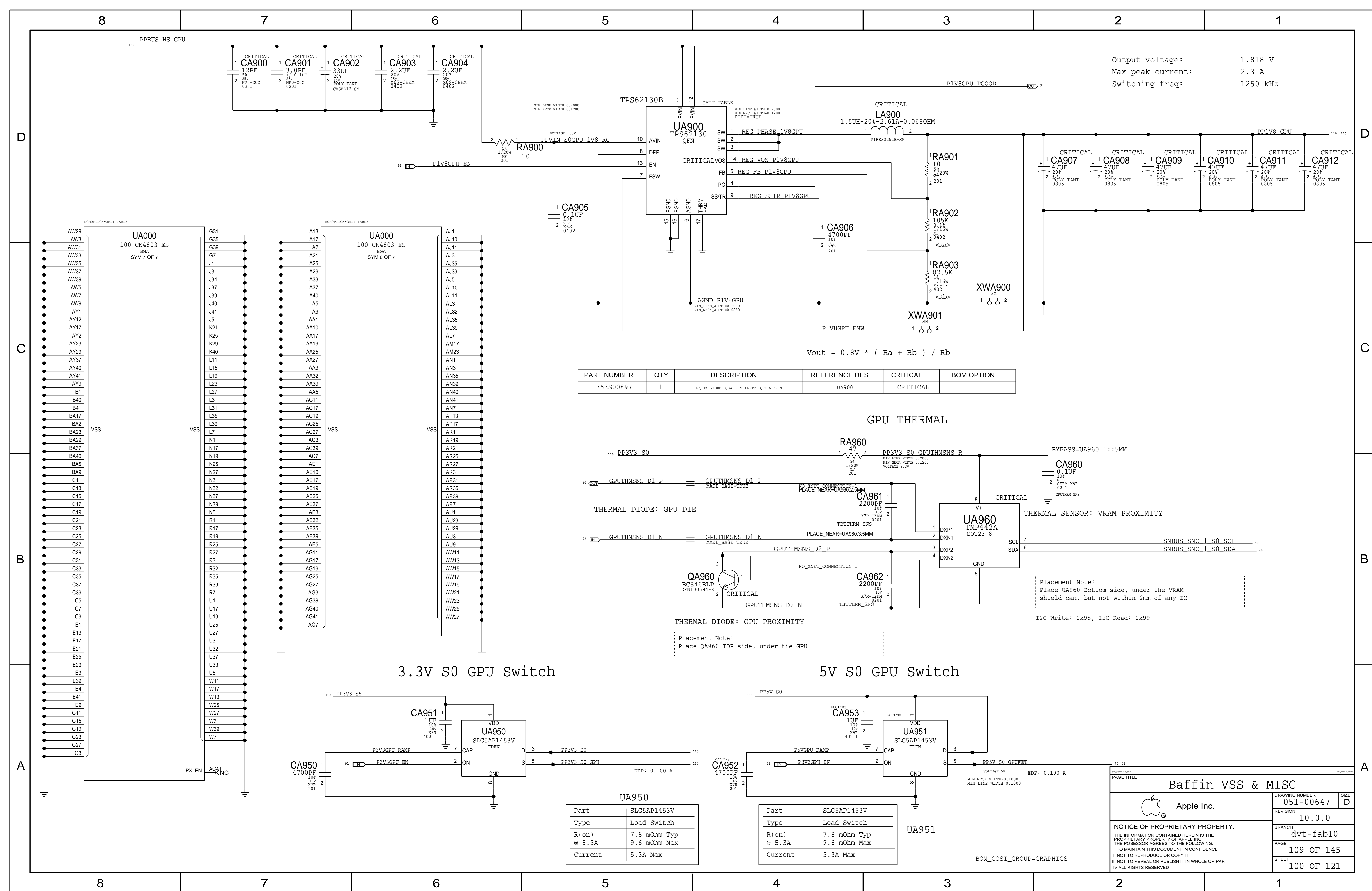
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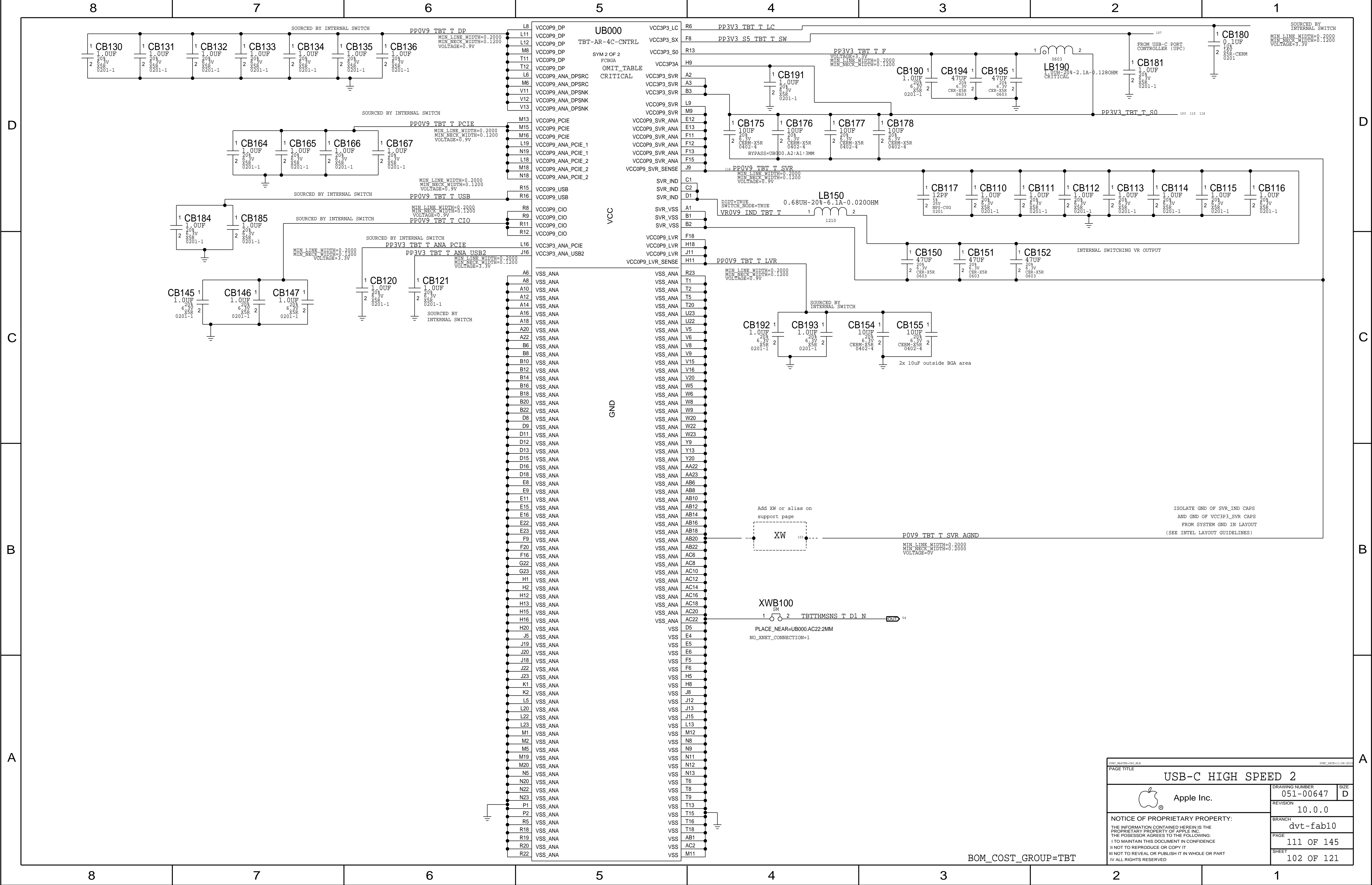
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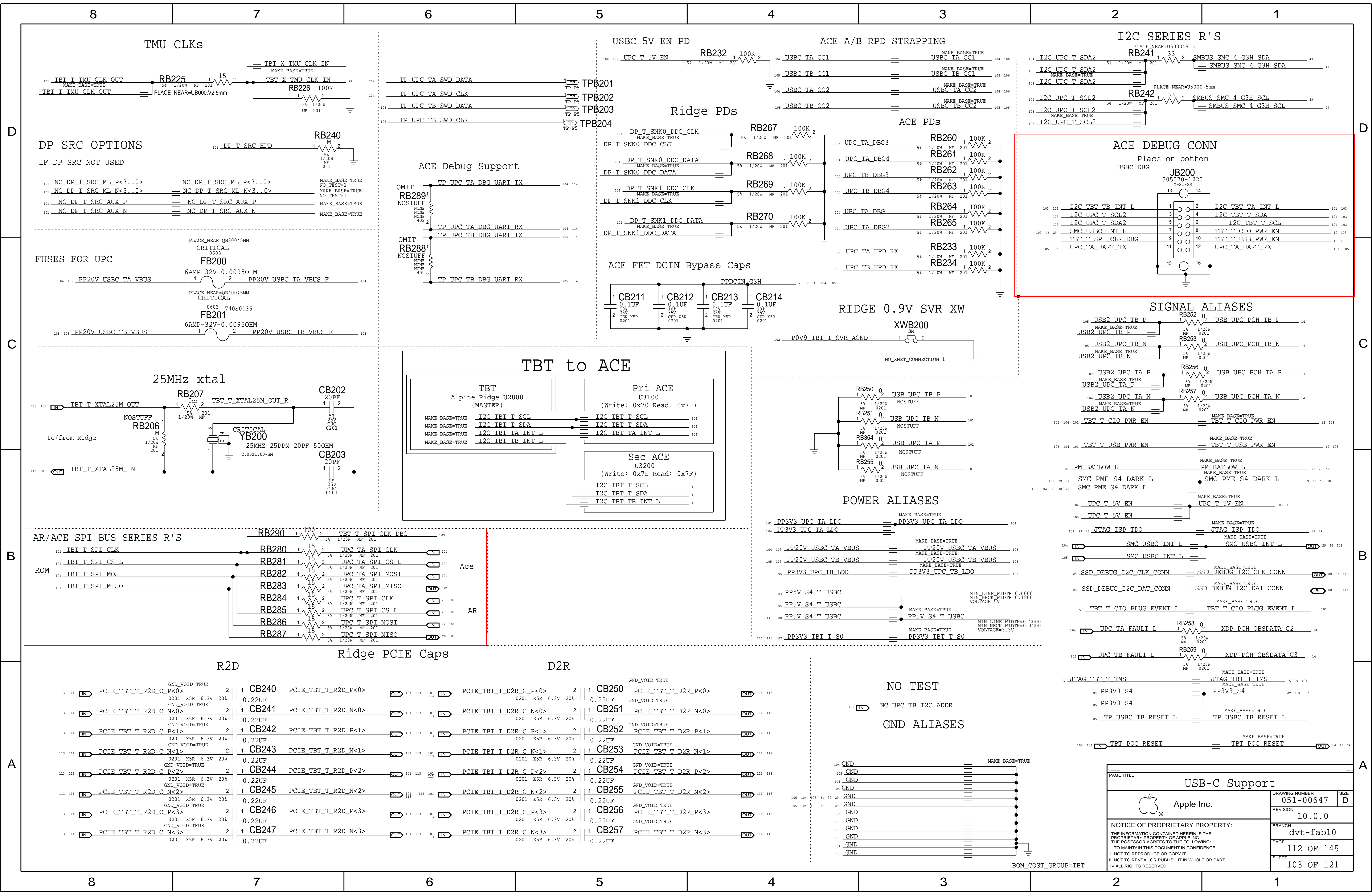






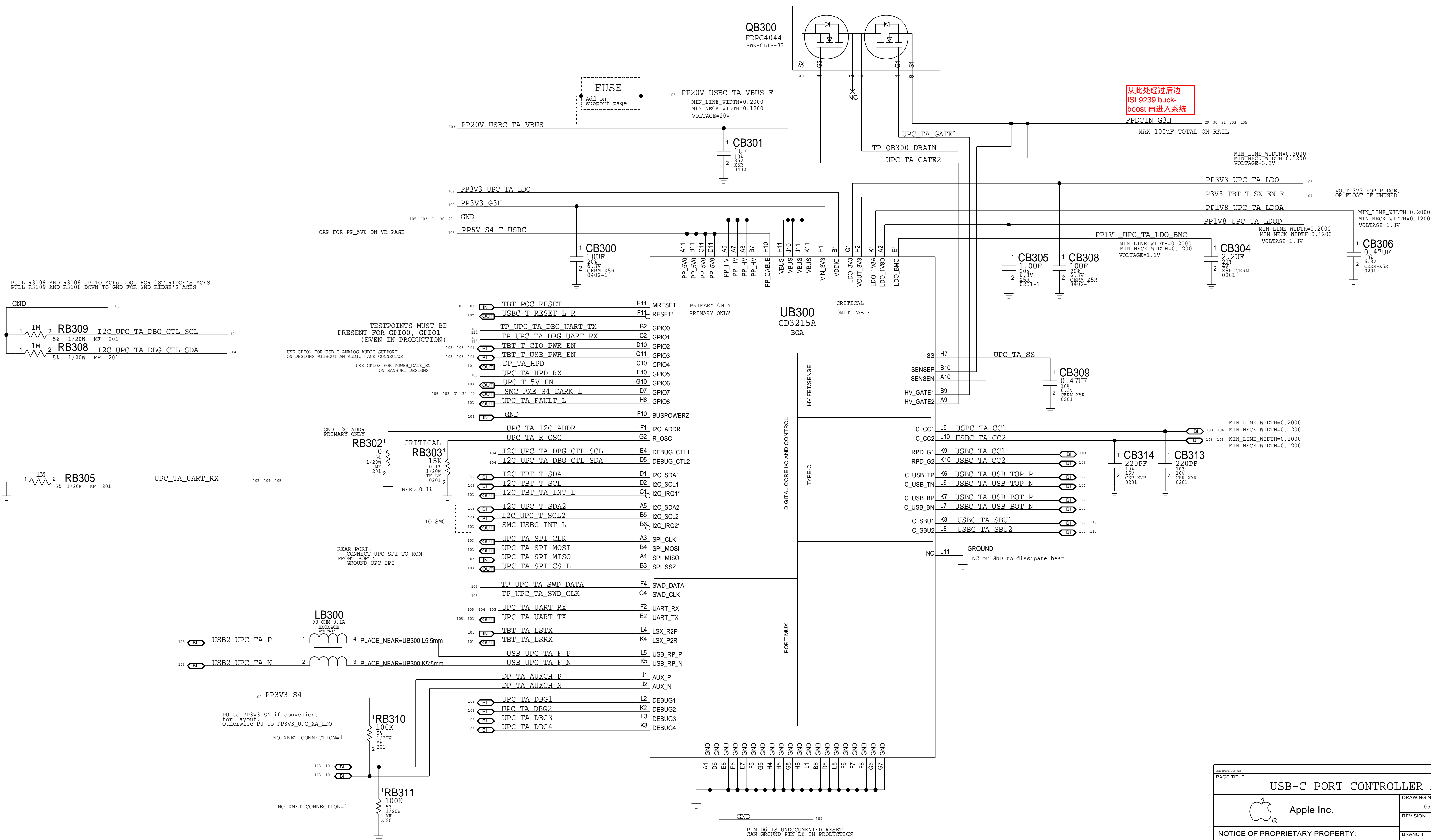
DRAWING NUMBER		051-00647	SIZE	D
REVISION		10.0.0		
BRANCH		dvt-fab10		
PAGE		111 OF 145		
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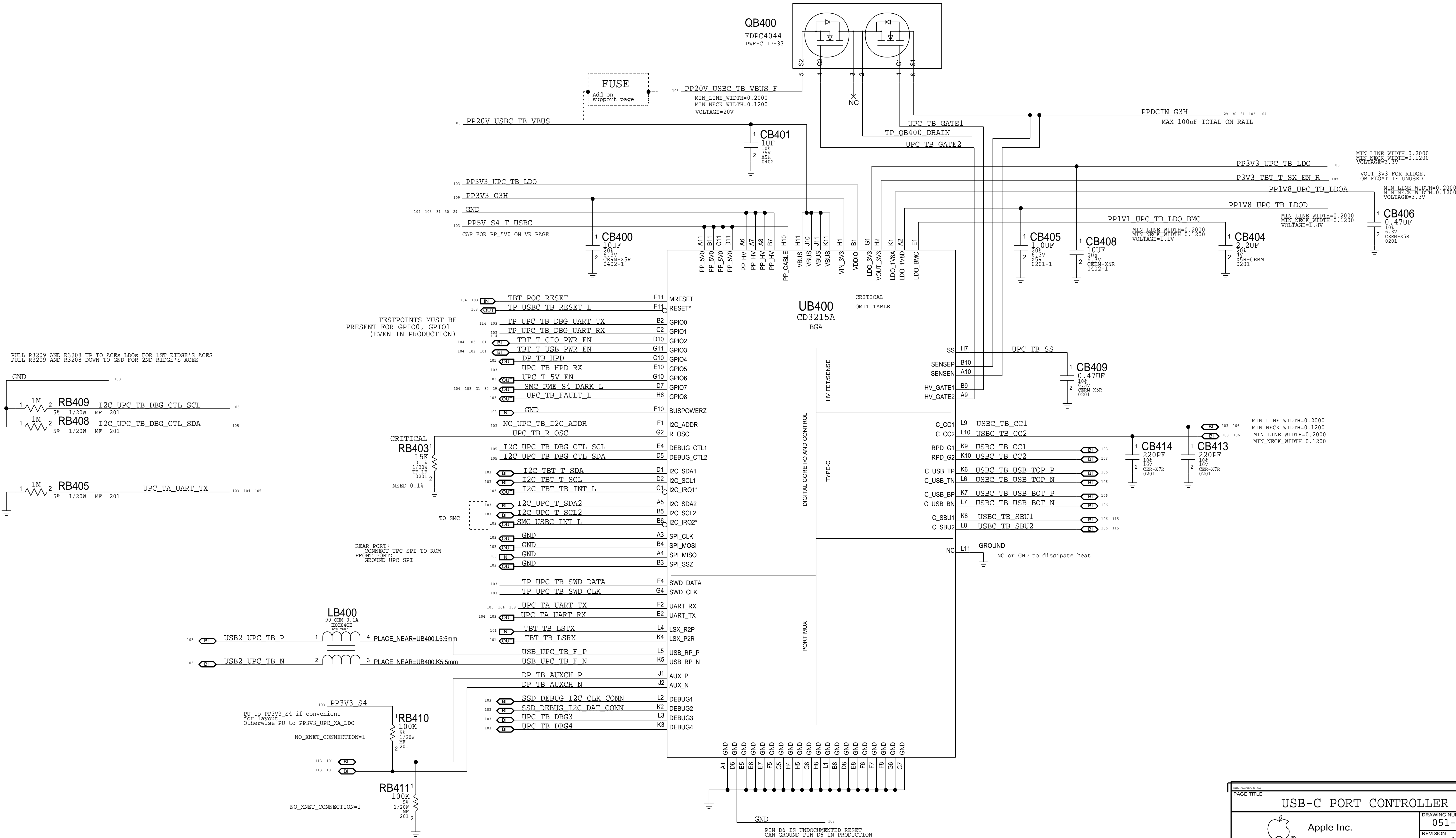
PRIMARY ACE USB-C PORT CONTROLLER (UPC)



PAGE TITLE		
USB-C PORT CONTROLLER A		
 Apple Inc.	DRAWING NUMBER	051-00647
	REVISION	10.0.0
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	SHEET	104 OF 121

BOM\_COST\_GROUP=USB-C

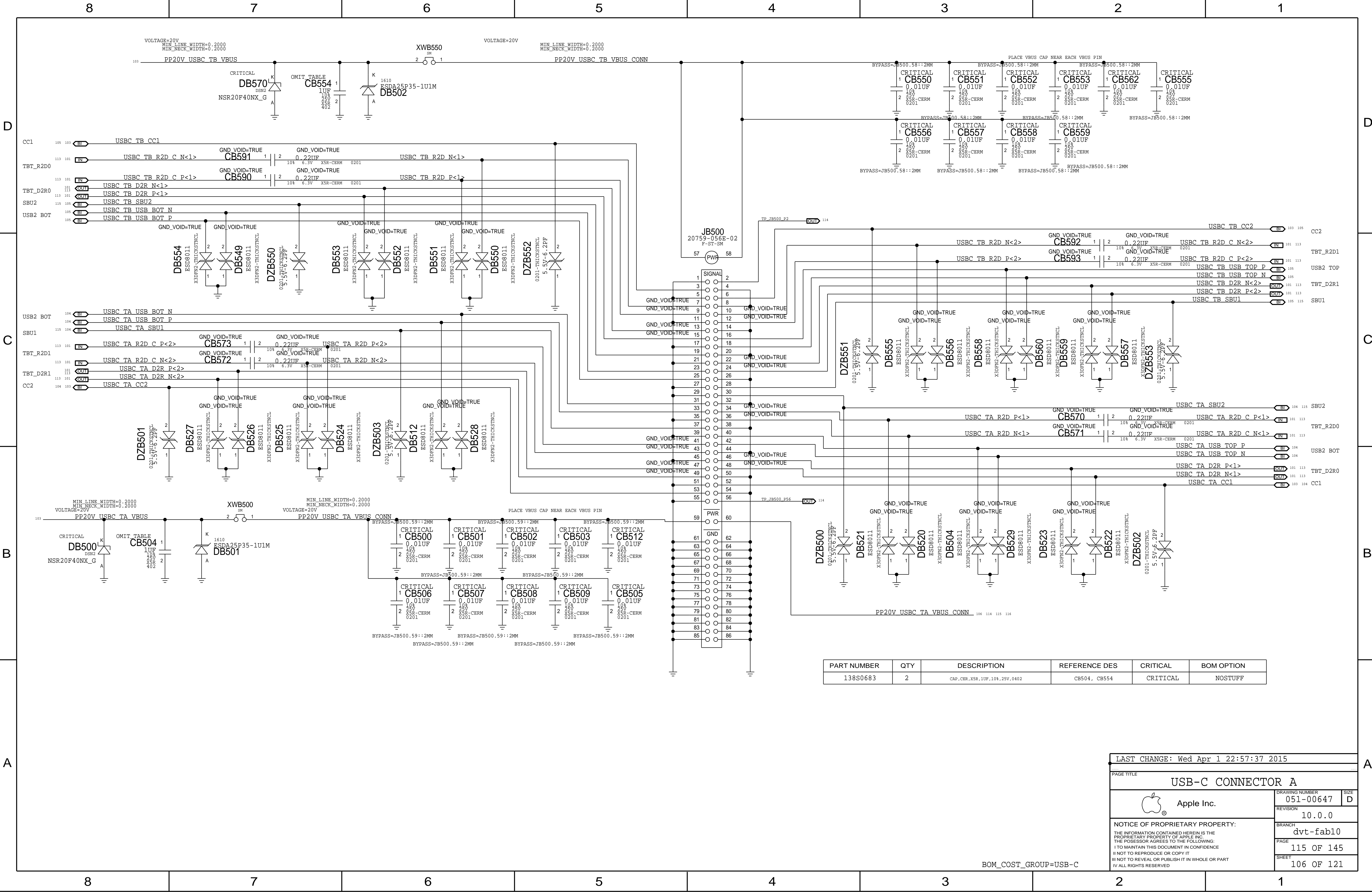
# SECONDARY ACE USB-C PORT CONTROLLER (UPC)




PAGE TITLE			
USB-C PORT CONTROLLER B			
	DRAWING NUMBER	051-00647	SIZE
	REVISION	10.0.0	D
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		PAGE	114 OF 145
		SHEET	105 OF 121

BOM\_COST\_GROUP=USB-C





PART NUMBER	QTY	DESCRIPTION	REFERENCE DES	CRITICAL	BOM OPTION
138S0683	2	CAP,CER,XSR,1UF,10%,25V,0402	CB504, CB554	CRITICAL	NOSTUFF

LAST CHANGE: Wed Apr 1 22:57:37 2015			
PAGE TITLE			
USB-C CONNECTOR A			
 Apple Inc.		DRAWING NUMBER	051-00647
		REVISION	10.0.0
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		PAGE	115 OF 145
		SHEET	106 OF 121

BOM\_COST\_GROUP=USB-C

D

C

B

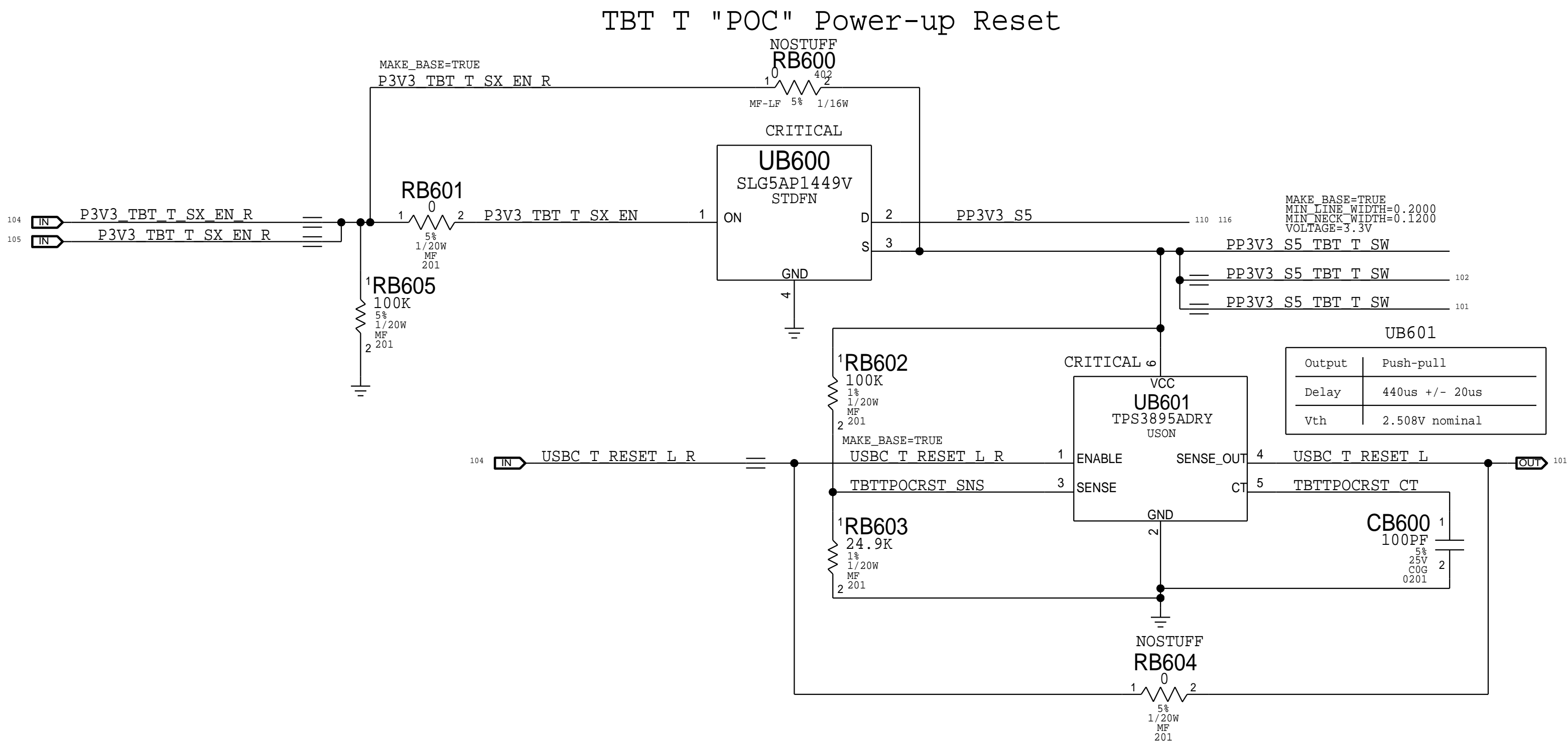
A

D


C

B

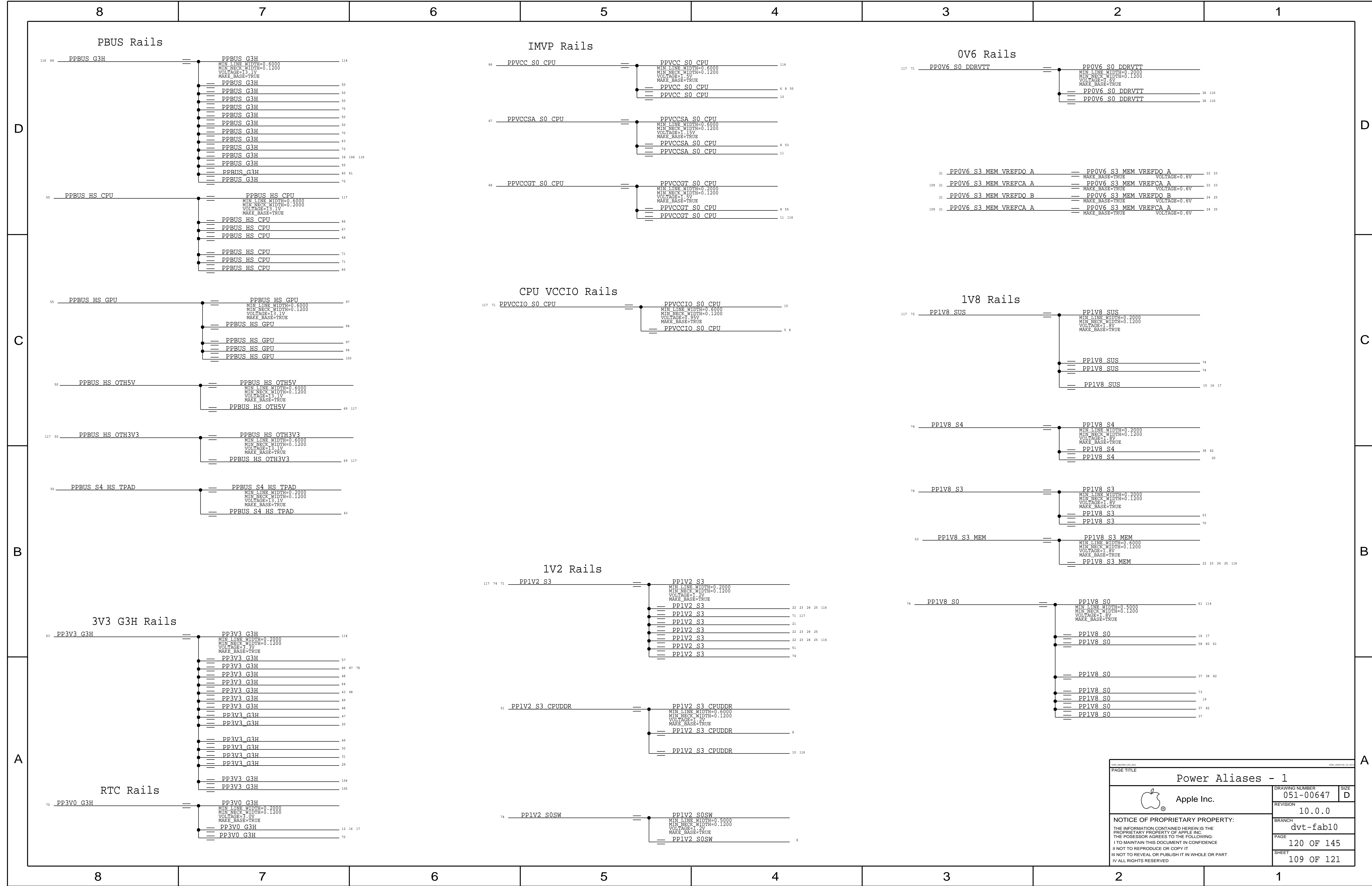
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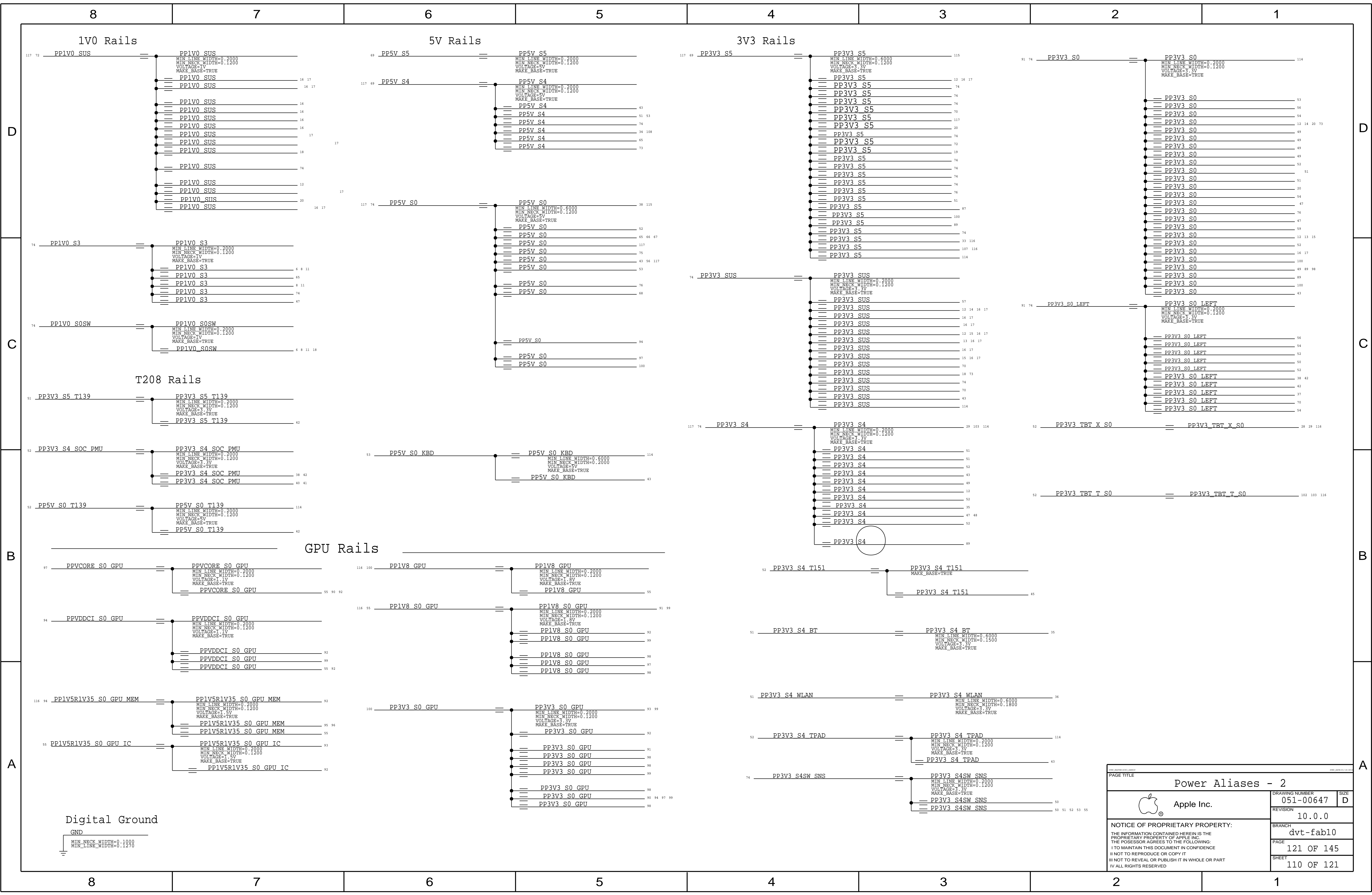


BOM\_COST\_GROUP=USB-C

DESIGN: j130/dev_mlb_u		
LAST CHANGE: Wed Apr 1 22:57:37 2015		
PAGE TITLE		
USB-C CONNECTOR B		
 Apple Inc.	DRAWING NUMBER	051-00647
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	8	7	6	5	4	3	2	1	
D	<div>SIGNAL ALIAS</div> <div>GPU PEG Lanes</div> <div>Thunderbolt Signals Through PEG</div> <div>GPU ALIAS</div> <div>CPU Display Aliases</div>								D
C									C
B									B
A	<div>EPD PANEL</div> <div>UNUSED SIGNALS</div>								A
	8	7	6	5	4	3	2	1	

8		7		6		5		4		3		2		1											
D	Memory Bit/Byte Swizzle														D										
	LPDDR3 COMMAND/ADDRESS							Memory Bit/Byte Swizzle																	
C															C										
B															B										
A															A										
8		7		6		5		4		3		2		1											

LPDDR3 COMMAND/ADDRESS

MAKE_BASE			
113	7	TRUE	MEM A DQS P<0>
113	7	TRUE	MEM A DQS N<0>
113	7	TRUE	MEM A DQS P<1>
113	7	TRUE	MEM A DQS N<1>
113	7	TRUE	MEM A DQS P<2>
113	7	TRUE	MEM A DQS N<2>
113	7	TRUE	MEM A DQS P<3>
113	7	TRUE	MEM A DQS N<3>
113	7	TRUE	MEM A DQS P<4>
113	7	TRUE	MEM A DQS N<4>
113	7	TRUE	MEM A DQS P<5>
113	7	TRUE	MEM A DQS N<5>
113	7	TRUE	MEM A DQS P<6>
113	7	TRUE	MEM A DQS N<6>
113	7	TRUE	MEM A DQS P<7>
113	7	TRUE	MEM A DQS N<7>

MAKE_BASE			
113	7	TRUE	MEM B DQS P<0>
113	7	TRUE	MEM B DQS N<0>
113	7	TRUE	MEM B DQS P<1>
113	7	TRUE	MEM B DQS N<1>
113	7	TRUE	MEM B DQS P<2>
113	7	TRUE	MEM B DQS N<2>
113	7	TRUE	MEM B DQS P<3>
113	7	TRUE	MEM B DQS N<3>
113	7	TRUE	MEM B DQS P<4>
113	7	TRUE	MEM B DQS N<4>
113	7	TRUE	MEM B DQS P<5>
113	7	TRUE	MEM B DQS N<5>
113	7	TRUE	MEM B DQS P<6>
113	7	TRUE	MEM B DQS N<6>
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113	7	TRUE	MEM B DQS N<7>

SYNC_MASTER=J80_MLB		SYNC_DATE=11/06/2015			
PAGE TITLE					
Memory Bit/Byte Swizzle					
 Apple Inc.		DRAWING NUMBER	051-00647		
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High Speed NO\_TEST

D

C

B

A

D

C

B

A

DMI		
13 5	IN	DMI_S2N_P<3..0> NO_TEST+1
13 5	IN	DMI_S2N_N<3..0> NO_TEST+1
13 5	IN	DMI_N2S_P<3..0> NO_TEST+1
13 5	IN	DMI_N2S_N<3..0> NO_TEST+1
DP - CPU/ACE		
99 27	IN	DP_X_SNK0_ML_C_N<3..0> NO_TEST+1
99 27	IN	DP_X_SNK0_ML_C_P<3..0> NO_TEST+1
99 27	IN	DP_X_SNK0_ML_N<3..0> NO_TEST+1
27	IN	DP_X_SNK0_ML_P<3..0> NO_TEST+1
27	IN	DP_X_SNK1_ML_C_N<3..0> NO_TEST+1
99 27	IN	DP_X_SNK1_ML_C_P<3..0> NO_TEST+1
27	IN	DP_X_SNK1_ML_N<3..0> NO_TEST+1
27	IN	DP_X_SNK1_ML_P<3..0> NO_TEST+1
101 99	IN	DP_T_SNK0_ML_C_N<3..0> NO_TEST+1
101 99	IN	DP_T_SNK0_ML_C_P<3..0> NO_TEST+1
101	IN	DP_T_SNK0_ML_N<3..0> NO_TEST+1
101	IN	DP_T_SNK0_ML_P<3..0> NO_TEST+1
101 99	IN	DP_T_SNK1_ML_C_N<3..0> NO_TEST+1
101 99	IN	DP_T_SNK1_ML_C_P<3..0> NO_TEST+1
101	IN	DP_T_SNK1_ML_N<3..0> NO_TEST+1
101	IN	DP_T_SNK1_ML_P<3..0> NO_TEST+1
99 27	IN	DP_X_SNK0_AUXCH_C_P NO_TEST+1
99 27	IN	DP_X_SNK0_AUXCH_C_N NO_TEST+1
101 99	IN	DP_T_SNK0_AUXCH_C_P NO_TEST+1
101 99	IN	DP_T_SNK0_AUXCH_C_N NO_TEST+1
27	IN	DP_X_SNK0_AUXCH_N NO_TEST+1
101	IN	DP_T_SNK0_AUXCH_P NO_TEST+1
101	IN	DP_T_SNK0_AUXCH_N NO_TEST+1
99 27	IN	DP_X_SNK1_AUXCH_C_P NO_TEST+1
99 27	IN	DP_X_SNK1_AUXCH_C_N NO_TEST+1
101 99	IN	DP_T_SNK1_AUXCH_C_P NO_TEST+1
101 99	IN	DP_T_SNK1_AUXCH_C_N NO_TEST+1
27	IN	DP_X_SNK1_AUXCH_P NO_TEST+1
101	IN	DP_T_SNK1_AUXCH_N NO_TEST+1
101	IN	DP_T_SNK1_AUXCH_P NO_TEST+1
CPU/EDP		
113 76	IN	EDP_AUXCH_C_N NO_TEST+1
113 76	IN	EDP_AUXCH_C_P NO_TEST+1
PCH/AR		
35 14	IN	PCIE_AP_D2R_P NO_TEST+1
35 14	IN	PCIE_AP_D2R_N NO_TEST+1
35	IN	PCIE_AP_R2D_P NO_TEST+1
35	IN	PCIE_AP_R2D_N NO_TEST+1
PCH/SSD		
87 77 14	IN	PCIE_SSD_D2R_N<3..0> NO_TEST+1
87 77 14	IN	PCIE_SSD_D2R_P<3..0> NO_TEST+1
113 77	IN	PCIE_SSD_R2D_N<3..0> NO_TEST+1
77	IN	PCIE_SSD_R2D_P<3..0> NO_TEST+1
113 87 77 14	IN	PCIE_SSD_D2R_C_N<3..0> NO_TEST+1
14	IN	PCIE_SSD_D2R_C_P<0> NO_TEST+1
14	IN	PCIE_SSD_D2R_P<0> NO_TEST+1
77	IN	PCIE_SSD_D2R_C_P<3..0> NO_TEST+1
77 14	IN	PCIE_SSD_R2D_C_N<3..0> NO_TEST+1
87 77	IN	PCIE_SSD_D2R_LB_P<0> NO_TEST+1
87 77	IN	PCIE_SSD_R2D_LB_N<0> NO_TEST+1
14	IN	PCIE_SSD_D2R_P<3> NO_TEST+1
87 77	IN	PCIE_SSD_D2R_LB_N<0> NO_TEST+1
14	IN	PCIE_SSD_D2R_N<3> NO_TEST+1
87 77	IN	PCIE_SSD_R2D_LB_P<0> NO_TEST+1
USB-C X		
32 27	IN	USBC_XB_D2R_N<2..1> NO_TEST+1
32 27	IN	USBC_XB_D2R_P<2..1> NO_TEST+1
32 27	IN	USBC_XA_D2R_P<2..1> NO_TEST+1
32 27	IN	USBC_XB_R2D_C_P<2..1> NO_TEST+1
32 27	IN	DP_XA_AUXCH_P NO_TEST+1
32 27	IN	USBC_XA_D2R_N<2..1> NO_TEST+1
32 27	IN	USBC_XB_R2D_C_N<2..1> NO_TEST+1
32 27	IN	USBC_XA_R2D_C_P<2..1> NO_TEST+1
32 27	IN	DP_XB_AUXCH_P NO_TEST+1
32 27	IN	USBC_XA_R2D_C_N<2..1> NO_TEST+1
32 27	IN	DP_XB_AUXCH_N NO_TEST+1
30 27	IN	DP_XA_AUXCH_N NO_TEST+1
27	IN	DP_XA_AUXCH_C_N NO_TEST+1
27	IN	DP_XA_AUXCH_C_P NO_TEST+1
27	IN	DP_XB_AUXCH_C_P NO_TEST+1
27	IN	DP_XB_AUXCH_C_N NO_TEST+1

PEG		
111 91	IN	PEG_GPU_D2R_N<7..0> NO_TEST+1
111 91	IN	PEG_GPU_D2R_P<7..0> NO_TEST+1
111 91	IN	PEG_GPU_R2D_C_N<7..0> NO_TEST+1
111 91	IN	PEG_GPU_R2D_C_P<7..0> NO_TEST+1
111 29	IN	PCIE_TBT_X_D2R_N<3..0> NO_TEST+1
111 29	IN	PCIE_TBT_X_D2R_P<3..0> NO_TEST+1
111 29	IN	PCIE_TBT_X_R2D_C_N<3..0> NO_TEST+1
111 29	IN	PCIE_TBT_X_R2D_C_P<3..0> NO_TEST+1
111 103	IN	PCIE_TBT_T_D2R_P<3..0> NO_TEST+1
111 103	IN	PCIE_TBT_T_D2R_N<3..0> NO_TEST+1
103 101	IN	PCIE_TBT_T_D2R_C_P<3..0> NO_TEST+1
103 101	IN	PCIE_TBT_T_D2R_C_N<3..0> NO_TEST+1
29 27	IN	PCIE_TBT_X_D2R_C_P<3..0> NO_TEST+1
29 27	IN	PCIE_TBT_X_D2R_C_N<3..0> NO_TEST+1
29 27	IN	PCIE_TBT_X_R2D_P<3..0> NO_TEST+1
29 27	IN	PCIE_TBT_X_R2D_N<3..0> NO_TEST+1
103 101	IN	PCIE_TBT_T_R2D_P<3..0> NO_TEST+1
103 101	IN	PCIE_TBT_T_R2D_C_P<3..0> NO_TEST+1
111 103	IN	PCIE_TBT_T_R2D_C_N<3..0> NO_TEST+1
91	IN	PEG_GPU_D2R_C_N<7..0> NO_TEST+1
91	IN	PEG_GPU_D2R_C_P<7..0> NO_TEST+1
91	IN	PEG_GPU_R2D_N<7..0> NO_TEST+1
91	IN	PEG_GPU_R2D_P<7..0> NO_TEST+1
PCH/DFR		
38 14	IN	USB_CAMERA_DFR_N NO_TEST+1
38 14	IN	USB_CAMERA_DFR_P NO_TEST+1
BAFFIN FRAME BUFFER		
95 93	IN	FB_A1_CS_L NO_TEST+1
95 93	IN	FB_A0_CKE_L NO_TEST+1
95 93	IN	FB_A1_CKE_L NO_TEST+1
95 93	IN	FB_A0_WE_L NO_TEST+1
95 93	IN	FB_A1_WE_L NO_TEST+1
95 93	IN	FB_B1_CS_L NO_TEST+1
95 93	IN	FB_B0_CKE_L NO_TEST+1
95 93	IN	FB_B1_CKE_L NO_TEST+1
95 93	IN	FB_B0_WE_L NO_TEST+1
95 93	IN	FB_B0_WE_L NO_TEST+1
95 93	IN	FB_B0_CLK_P NO_TEST+1
95 93	IN	FB_B1_CLK_P NO_TEST+1
95 93	IN	FB_B1_CLK_N NO_TEST+1
95 93	IN	FB_B0_RAS_L NO_TEST+1
95 93	IN	FB_B1_RAS_L NO_TEST+1
95 93	IN	FB_B0_CAS_L NO_TEST+1
95 93	IN	FB_B1_CAS_L NO_TEST+1
95 93	IN	FB_B0_CS_L NO_TEST+1
95 93	IN	FB_A0_DQ<31..0> NO_TEST+1
95 93	IN	FB_A1_DQ<31..0> NO_TEST+1
95 93	IN	FB_A0_A<8..0> NO_TEST+1
95 93	IN	FB_A1_A<8..0> NO_TEST+1
95 93	IN	FB_A0_WCLK_N<1..0> NO_TEST+1
95 93	IN	FB_A0_WCLK_P<1..0> NO_TEST+1
95 93	IN	FB_A1_WCLK_N<1..0> NO_TEST+1
95 93	IN	FB_A1_WCLK_P<1..0> NO_TEST+1
95 93	IN	FB_A0_EDC<3..0> NO_TEST+1
95 93	IN	FB_A1_EDC<3..0> NO_TEST+1
95 93	IN	FB_A0_DBI_L<3..0> NO_TEST+1
95 93	IN	FB_A1_DBI_L<3..0> NO_TEST+1
95 93	IN	FB_A0_ABI_L NO_TEST+1
95 93	IN	FB_A1_ABI_L NO_TEST+1
95 93	IN	FB_A0_CLK_N NO_TEST+1
95 93	IN	FB_A0_CLK_P NO_TEST+1
95 93	IN	FB_A1_CLK_N NO_TEST+1
95 93	IN	FB_A1_CLK_P NO_TEST+1
95 93	IN	FB_A0_RAS_L NO_TEST+1
95 93	IN	FB_A1_RAS_L NO_TEST+1
95 93	IN	FB_A0_CAS_L NO_TEST+1
95 93	IN	FB_A1_CAS_L NO_TEST+1
95 93	IN	FB_A0_CS_L NO_TEST+1
95 93	IN	FB_B0_CLK_N NO_TEST+1
95 93	IN	FB_B0_DQ<31..0> NO_TEST+1
95 93	IN	FB_B1_DQ<31..0> NO_TEST+1
95 93	IN	FB_B0_A<8..0> NO_TEST+1
95 93	IN	FB_B1_A<8..0> NO_TEST+1
95 93	IN	FB_B0_WCLK_N<1..0> NO_TEST+1
95 93	IN	FB_B0_WCLK_P<1..0> NO_TEST+1
95 93	IN	FB_B1_WCLK_N<1..0> NO_TEST+1
95 93	IN	FB_B1_WCLK_P<1..0> NO_TEST+1
95 93	IN	FB_B0_EDC<3..0> NO_TEST+1
95 93	IN	FB_B1_EDC<3..0> NO_TEST+1
95 93	IN	FB_B0_DBI_L<3..0> NO_TEST+1
95 93	IN	FB_B1_DBI_L<3..0> NO_TEST+1
95 93	IN	FB_B0_ABI_L NO_TEST+1
95 93	IN	FB_B1_ABI_L NO_TEST+1


CPU/PCH CLK		
12 6	IN	CPU_CLK24M_NSSC_CLK_N NO_TEST+1
12 6	IN	CPU_CLK24M_NSSC_CLK_P NO_TEST+1
12 6	IN	CPU_CLK100M_PCIBCLK_N NO_TEST+1
12 6	IN	CPU_CLK100M_PCIBCLK_P NO_TEST+1
12 6	IN	CPU_CLK100M_BCLK_N NO_TEST+1
12 6	IN	CPU_CLK100M_BCLK_P NO_TEST+1
87 14	IN	PCIE_CLK100M_SSD_N NO_TEST+1
87 14	IN	PCIE_CLK100M_SSD_P NO_TEST+1
87 77	IN	PCIE_CLK100M_SSD_LB_N NO_TEST+1
87 77	IN	PCIE_CLK100M_SSD_LB_P NO_TEST+1
115 18 14	IN	NC_ITPDXP_CLK100MN NO_TEST+1
115 18 14	IN	NC_ITPDXP_CLK100MP NO_TEST+1
35 14	IN	PCIE_CLK100M_AP_P NO_TEST+1
35 14	IN	PCIE_CLK100M_AP_N NO_TEST+1
MUX		
89 5	IN	DP_INT_IG_ML_N<3..0> NO_TEST+1
89 5	IN	DP_INT_IG_ML_P<3..0> NO_TEST+1
89 5	IN	DP_INT_IG_AUX_N NO_TEST+1
89 5	IN	DP_INT_IG_AUX_P NO_TEST+1
89 5	IN	DP_INT_EG_ML_N<3..0> NO_TEST+1
89 5	IN	DP_INT_EG_ML_P<3..0> NO_TEST+1
89 5	IN	DP_INT_EG_AUX_N NO_TEST+1
89 5	IN	DP_INT_EG_AUX_P NO_TEST+1
DP MUX CRYSTAL		
89	IN	DPMUX_UC_XTAL NO_TEST+1
89	IN	DPMUX_UC_EXTAL NO_TEST+1
89	IN	DPMUX_UC_EXTAL_R NO_TEST+1
89	IN	DPMUX_UC_XTAL_R NO_TEST+1

XTAL		
19	IN	GPU_XTAL_PU_OR_CAP NO_TEST+1
19	IN	NC_PCH_CLK24M_XTALOUT NO_TEST+1
19	IN	SYSCLK_CLK24M_X2 NO_TEST+1
19	IN	SYSCLK_CLK24M_X2_R NO_TEST+1
19	IN	SYSCLK_CLK24M_X1 NO_TEST+1
NAND		
85 84	IN	SSD_NAND_FA_DQ0 NO_TEST+1
85 84	IN	SSD_NAND_FA_DQ1 NO_TEST+1
85 84	IN	SSD_NAND_FA_DQ2 NO_TEST+1
85 84	IN	SSD_NAND_FA_DQ3 NO_TEST+1
85 84	IN	SSD_NAND_FA_DQ4 NO_TEST+1
85 84	IN	SSD_NAND_FA_DQ5 NO_TEST+1
85 84	IN	SSD_NAND_FA_DQ6 NO_TEST+1
85 84	IN	SSD_NAND_FA_DQ7 NO_TEST+1
85 84	IN	SSD_NAND_FA_DQS_N NO_TEST+1
85 84	IN	SSD_NAND_FA_DQS_P NO_TEST+1
85 84	IN	SSD_NAND_FB_DQ0 NO_TEST+1
85 84	IN	SSD_NAND_FB_DQ1 NO_TEST+1
85 84	IN	SSD_NAND_FB_DQ2 NO_TEST+1
85 84	IN	SSD_NAND_FB_DQ3 NO_TEST+1
85 84	IN	SSD_NAND_FB_DQ4 NO_TEST+1
85 84	IN	SSD_NAND_FB_DQ5 NO_TEST+1
85 84	IN	SSD_NAND_FB_DQ6 NO_TEST+1
85 84	IN	SSD_NAND_FB_DQ7 NO_TEST+1
85 84	IN	SSD_NAND_FB_DQS_N NO_TEST+1
85 84	IN	SSD_NAND_FB_DQS_P NO_TEST+1
85 84	IN	SSD_NAND_FC_DQ0 NO_TEST+1
85 84	IN	SSD_NAND_FC_DQ1 NO_TEST+1
85 84	IN	SSD_NAND_FC_DQ2 NO_TEST+1
85 84	IN	SSD_NAND_FC_DQ3 NO_TEST+1
85 84	IN	SSD_NAND_FC_DQ4 NO_TEST+1
85 84	IN	SSD_NAND_FC_DQ5 NO_TEST+1
85 84	IN	SSD_NAND_FC_DQ6 NO_TEST+1
85 84	IN	SSD_NAND_FC_DQ7 NO_TEST+1
85 84	IN	SSD_NAND_FC_DQS_N NO_TEST+1
85 84	IN	SSD_NAND_FC_DQS_P NO_TEST+1
85 84	IN	SSD_NAND_FD_DQ0 NO_TEST+1
85 84	IN	SSD_NAND_FD_DQ1 NO_TEST+1
85 84	IN	SSD_NAND_FD_DQ2 NO_TEST+1
85 84	IN	SSD_NAND_FD_DQ3 NO_TEST+1
85 84	IN	SSD_NAND_FD_DQ4 NO_TEST+1
85 84	IN	SSD_NAND_FD_DQ5 NO_TEST+1
85 84	IN	SSD_NAND_FD_DQ6 NO_TEST+1
85 84	IN	SSD_NAND_FD_DQ7 NO_TEST+1
85 84	IN	SSD_NAND_FD_DQS_N NO_TEST+1
85 84	IN	SSD_NAND_FD_DQS_P NO_TEST+1
85 84	IN	SSD_NAND_FE_DQ0 NO_TEST+1
85 84	IN	SSD_NAND_FE_DQ1 NO_TEST+1
85 84	IN	SSD_NAND_FE_DQ2 NO_TEST+1
85 84	IN	SSD_NAND_FE_DQ3 NO_TEST+1
85 84	IN	SSD_NAND_FE_DQ4 NO_TEST+1
85 84	IN	SSD_NAND_FE_DQ5 NO_TEST+1
85 84	IN	SSD_NAND_FE_DQ6 NO_TEST+1
85 84	IN	SSD_NAND_FE_DQ7 NO_TEST+1
85 84	IN	SSD_NAND_FE_DQS_N NO_TEST+1
85 84	IN	SSD_NAND_FE_DQS_P NO_TEST+1
85 84	IN	SSD_NAND_FF_DQ0 NO_TEST+1
85 84	IN	SSD_NAND_FF_DQ1 NO_TEST+1
85 84	IN	SSD_NAND_FF_DQ2 NO_TEST+1
85 84	IN	SSD_NAND_FF_DQ3 NO_TEST+1
85 84	IN	SSD_NAND_FF_DQ4 NO_TEST+1
85 84	IN	SSD_NAND_FF_DQ5 NO_TEST+1
85 84	IN	SSD_NAND_FF_DQ6 NO_TEST+1
85 84	IN	SSD_NAND_FF_DQ7 NO_TEST+1
85 84	IN	SSD_NAND_FF_DQS_N NO_TEST+1
85 84	IN	SSD_NAND_FF_DQS_P NO_TEST+1
WIFI		
36	IN	50_0_ANT NO_TEST+1
36	IN	50_1_ANT NO_TEST+1
36	IN	50_2_ANT NO_TEST+1
36	IN	50_0_COM NO_TEST+1
36	IN	50_1_COM NO_TEST+1
36	IN	50_2_COM NO_TEST+1
36	IN	50_A_0_DIPLEXER NO_TEST+1
36	IN	50_A_0_MATCH NO_TEST+1
36	IN	50_G_0_DIPLEXER NO_TEST+1
36	IN	50_G_0_MATCH NO_TEST+1
36	IN	50_A_1_DIPLEXER NO_TEST+1
36	IN	50_A_1_MATCH NO_TEST+1
36	IN	50_G_1_DIPLEXER NO_TEST+1
36	IN	50_G_1_MATCH NO_TEST+1
36	IN	50_A_2_DIPLEXER NO_TEST+1
36	IN	50_A_2_MATCH NO_TEST+1
36	IN	50_G_2_DIPLEXER NO_TEST+1
36	IN	50_G_2_MATCH NO_TEST+1
USB-C T		
106 101	IN	USBC_TA_D2R_P<2..1> NO_TEST+1
106 101	IN	USBC_TA_D2R_N<2..1> NO_TEST+1
106 101	IN	USBC_TA_R2D_C_P<2..1> NO_TEST+1
106 101	IN	USBC_TA_R2D_C_N<2..1> NO_TEST+1
104 101	IN	DP_TA_AUXCH_P NO_TEST+1
104 101	IN	DP_TA_AUXCH_N NO_TEST+1
101	IN	DP_TA_AUXCH_C_P NO_TEST+1
101	IN	DP_TA_AUXCH_C_N NO_TEST+1
106 101	IN	USBC_TB_D2R_P<2..1> NO_TEST+1
106 101	IN	USBC_TB_D2R_N<2..1> NO_TEST+1
106 101	IN	USBC_TB_R2D_C_P<2..1> NO_TEST+1
106 101	IN	USBC_TB_R2D_C_N<2..1> NO_TEST+1
104 101	IN	DP_TB_AUXCH_P NO_TEST+1
104 101	IN	DP_TB_AUXCH_N NO_TEST+1
101	IN	DP_TB_AUXCH_C_P NO_TEST+1
101	IN	DP_TB_AUXCH_C_N NO_TEST+1
85 83	IN	SSD_NAND_FH_DQ4 NO_TEST+1
85 83	IN	SSD_NAND_FH_DQ0 NO_TEST+1
85 83	IN	SSD_NAND_FH_DQS_P NO_TEST+1
85 83	IN	SSD_NAND_FH_DQ5 NO_TEST+1
85 83	IN	SSD_NAND_FH_DQ6 NO_TEST+1
85 83	IN	SSD_NAND_FH_DQ7 NO_TEST+1
85 83	IN	SSD_NAND_FH_DQS_N NO_TEST+1
85 83	IN	SSD_NAND_FH_DQ1 NO_TEST+1
85 83	IN	SSD_NAND_FH_DQ2 NO_TEST+1
85 83	IN	SSD_NAND_FH_DQ3 NO_TEST+1

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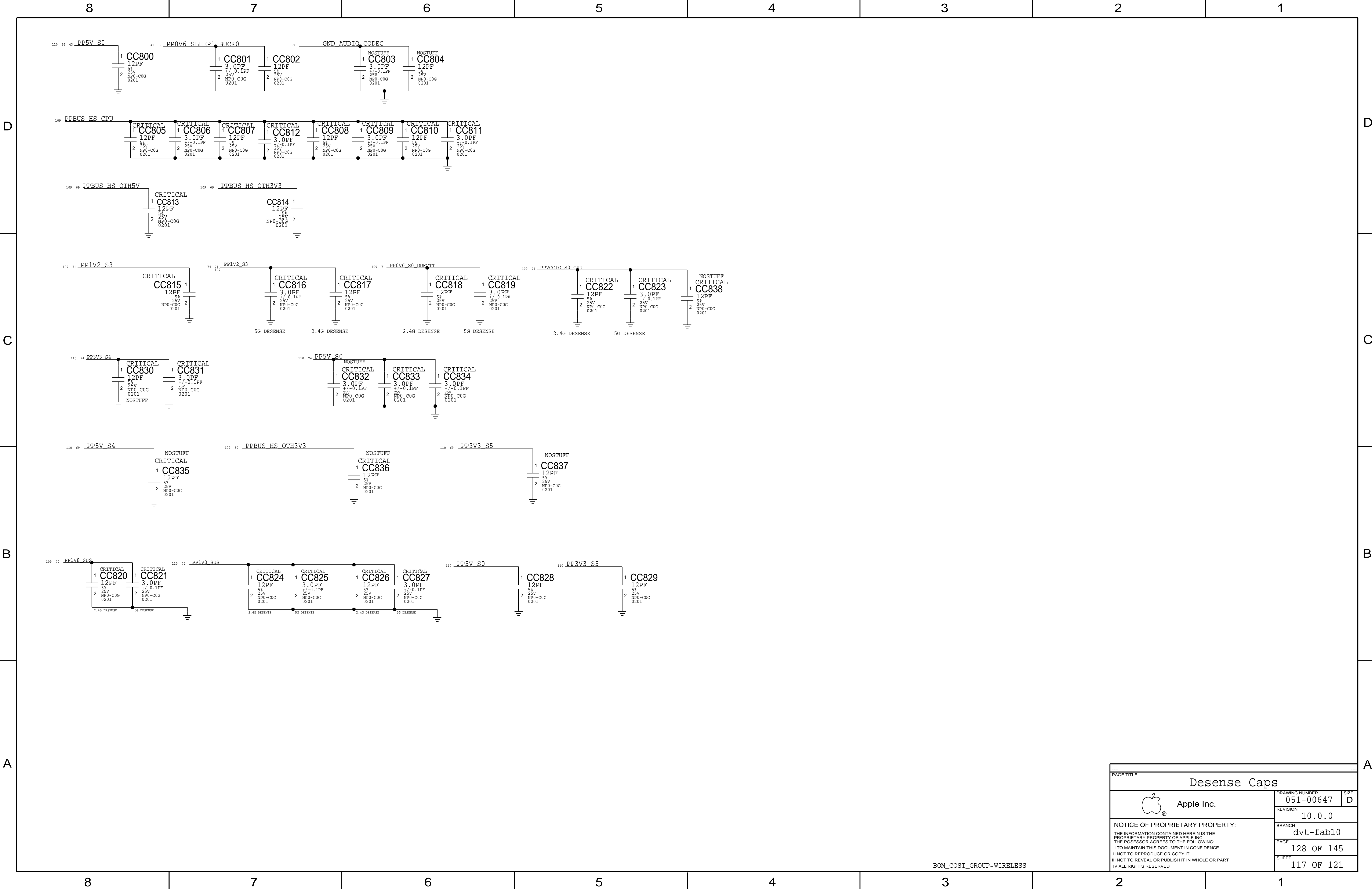















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## BOM Variants

## 44 ULA Configs


[illegible]

## 36 PROA Configs

[illegible]

## BOM Variants, Power/Socket Configs

BOM NUMBER	BOM NAME	BOM OPTIONS
639-01966	PCBA,MLB,NONE,SM-16,FB4-SM,S256,X363	BASE_BOM,DEVEL_BOM,RAM_16G,SANSUNG_2133,4GB_SM_BAPFIN,SSD_CONFIG1-256GB
639-01967	PCBA,MLB,SKT,VDDC,SM-16,FB4-SM,S256,X363	BASE_BOM,DEVEL_BOM,STANDSTAY_VDDC,RAM_16G,SANSUNG_2133,4GB_SM_BAPFIN,SSD_CONFIG1-256GB
639-01968	PCBA,MLB,SKT,MVDD,SM-16,FB4-SM,S256,X363	BASE_BOM,DEVEL_BOM,STANDSTAY_VDDC,VDDC,RAM_16G,SANSUNG_2133,4GB_SM_BAPFIN,SSD_CONFIG1-256GB
639-01969	PCBA,MLB,SKT,CPU,SM-16,FB4-SM,S256,X363	BASE_BOM,DEVEL_BOM,CPU_REL_SOCKET,RAM_16G,SANSUNG_2133,4GB_SM_BAPFIN,SSD_CONFIG1-256GB

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C	<table><tr><th>BOM NUMBER</th><th>BOM NAME</th><th>BOM OPTIONS</th></tr><tr><td>639-02621</td><td>MLB, 2.6G, MC-16, LEA-HY, SSD-1TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB</td></tr><tr><td>639-02618</td><td>MLB, 2.6G, MC-16, LEA-HY, SSD-256, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB</td></tr><tr><td>639-02622</td><td>MLB, 2.6G, MC-16, LEA-HY, SSD-2TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB</td></tr><tr><td>639-02620</td><td>MLB, 2.6G, MC-16, LEA-HY, SSD-512, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB</td></tr><tr><td>639-02608</td><td>MLB, 2.6G, SM-16, LEA-HY, SSD-1TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB</td></tr><tr><td>639-02602</td><td>MLB, 2.6G, SM-16, LEA-HY, SSD-256, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB</td></tr><tr><td>639-02611</td><td>MLB, 2.6G, SM-16, LEA-HY, SSD-2TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB</td></tr><tr><td>639-02605</td><td>MLB, 2.6G, SM-16, LEA-HY, SSD-512, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB</td></tr><tr><td>639-02645</td><td>MLB, 2.9G, MC-16, LEA-HY, SSD-1TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB</td></tr><tr><td>639-02643</td><td>MLB, 2.9G, MC-16, LEA-HY, SSD-256, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB</td></tr><tr><td>639-02646</td><td>MLB, 2.9G, MC-16, LEA-HY, SSD-2TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB</td></tr><tr><td>639-02644</td><td>MLB, 2.9G, MC-16, LEA-HY, SSD-512, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB</td></tr><tr><td>639-02633</td><td>MLB, 2.9G, SM-16, LEA-HY, SSD-1TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB</td></tr><tr><td>639-02631</td><td>MLB, 2.9G, SM-16, LEA-HY, SSD-256, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB</td></tr><tr><td>639-02634</td><td>MLB, 2.9G, SM-16, LEA-HY, SSD-2TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB</td></tr><tr><td>639-02632</td><td>MLB, 2.9G, SM-16, LEA-HY, SSD-512, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB</td></tr><tr><td>639-02647</td><td>MLB, 2.6G, MC-16, LEA-MC, SSD-1TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB</td></tr><tr><td>639-02616</td><td>MLB, 2.6G, MC-16, LEA-MC, SSD-256, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB</td></tr><tr><td>639-02619</td><td>MLB, 2.6G, MC-16, LEA-MC, SSD-2TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB</td></tr><tr><td>639-02617</td><td>MLB, 2.6G, MC-16, LEA-MC, SSD-512, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB</td></tr><tr><td>639-02607</td><td>MLB, 2.6G, SM-16, LEA-MC, SSD-1TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB</td></tr><tr><td>639-02601</td><td>MLB, 2.6G, SM-16, LEA-MC, SSD-256, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB</td></tr><tr><td>639-02610</td><td>MLB, 2.6G, SM-16, LEA-MC, SSD-2TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB</td></tr><tr><td>639-02604</td><td>MLB, 2.6G, SM-16, LEA-MC, SSD-512, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB</td></tr><tr><td>639-02641</td><td>MLB, 2.9G, MC-16, LEA-MC, SSD-1TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB</td></tr><tr><td>639-02639</td><td>MLB, 2.9G, MC-16, LEA-MC, SSD-256, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB</td></tr><tr><td>639-02642</td><td>MLB, 2.9G, MC-16, LEA-MC, SSD-2TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB</td></tr><tr><td>639-02640</td><td>MLB, 2.9G, MC-16, LEA-MC, SSD-512, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB</td></tr><tr><td>639-02629</td><td>MLB, 2.9G, SM-16, LEA-MC, SSD-1TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB</td></tr><tr><td>639-02627</td><td>MLB, 2.9G, SM-16, LEA-MC, SSD-256, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB</td></tr><tr><td>639-02630</td><td>MLB, 2.9G, SM-16, LEA-MC, SSD-2TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB</td></tr><tr><td>639-02628</td><td>MLB, 2.9G, SM-16, LEA-MC, SSD-512, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB</td></tr><tr><td>639-02614</td><td>MLB, 2.6G, MC-16, LEA-SM, SSD-1TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB</td></tr><tr><td>639-02612</td><td>MLB, 2.6G, MC-16, LEA-SM, SSD-256, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB</td></tr><tr><td>639-02615</td><td>MLB, 2.6G, MC-16, LEA-SM, SSD-2TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB</td></tr><tr><td>639-02613</td><td>MLB, 2.6G, MC-16, LEA-SM, SSD-512, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB</td></tr><tr><td>639-02606</td><td>MLB, 2.6G, SM-16, LEA-SM, SSD-1TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB</td></tr><tr><td>639-02600</td><td>MLB, 2.6G, SM-16, LEA-SM, SSD-256, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB</td></tr><tr><td>639-02609</td><td>MLB, 2.6G, SM-16, LEA-SM, SSD-2TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB</td></tr><tr><td>639-02603</td><td>MLB, 2.6G, SM-16, LEA-SM, SSD-512, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB</td></tr><tr><td>639-02637</td><td>MLB, 2.9G, MC-16, LEA-SM, SSD-1TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB</td></tr><tr><td>639-02635</td><td>MLB, 2.9G, MC-16, LEA-SM, SSD-256, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB</td></tr><tr><td>639-02638</td><td>MLB, 2.9G, MC-16, LEA-SM, SSD-2TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB</td></tr><tr><td>639-02636</td><td>MLB, 2.9G, MC-16, LEA-SM, SSD-512, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB</td></tr><tr><td>639-02625</td><td>MLB, 2.9G, SM-16, LEA-SM, SSD-1TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB</td></tr><tr><td>639-02623</td><td>MLB, 2.9G, SM-16, LEA-SM, SSD-256, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB</td></tr><tr><td>639-02626</td><td>MLB, 2.9G, SM-16, LEA-SM, SSD-2TB, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB</td></tr><tr><td>639-02624</td><td>MLB, 2.9G, SM-16, LEA-SM, SSD-512, X363G</td><td>BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB</td></tr></table>														BOM NUMBER	BOM NAME	BOM OPTIONS	639-02621	MLB, 2.6G, MC-16, LEA-HY, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB	639-02618	MLB, 2.6G, MC-16, LEA-HY, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB	639-02622	MLB, 2.6G, MC-16, LEA-HY, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB	639-02620	MLB, 2.6G, MC-16, LEA-HY, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB	639-02608	MLB, 2.6G, SM-16, LEA-HY, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB	639-02602	MLB, 2.6G, SM-16, LEA-HY, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB	639-02611	MLB, 2.6G, SM-16, LEA-HY, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB	639-02605	MLB, 2.6G, SM-16, LEA-HY, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB	639-02645	MLB, 2.9G, MC-16, LEA-HY, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB	639-02643	MLB, 2.9G, MC-16, LEA-HY, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB	639-02646	MLB, 2.9G, MC-16, LEA-HY, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB	639-02644	MLB, 2.9G, MC-16, LEA-HY, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB	639-02633	MLB, 2.9G, SM-16, LEA-HY, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB	639-02631	MLB, 2.9G, SM-16, LEA-HY, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB	639-02634	MLB, 2.9G, SM-16, LEA-HY, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB	639-02632	MLB, 2.9G, SM-16, LEA-HY, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB	639-02647	MLB, 2.6G, MC-16, LEA-MC, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB	639-02616	MLB, 2.6G, MC-16, LEA-MC, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB	639-02619	MLB, 2.6G, MC-16, LEA-MC, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB	639-02617	MLB, 2.6G, MC-16, LEA-MC, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB	639-02607	MLB, 2.6G, SM-16, LEA-MC, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB	639-02601	MLB, 2.6G, SM-16, LEA-MC, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB	639-02610	MLB, 2.6G, SM-16, LEA-MC, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB	639-02604	MLB, 2.6G, SM-16, LEA-MC, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB	639-02641	MLB, 2.9G, MC-16, LEA-MC, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB	639-02639	MLB, 2.9G, MC-16, LEA-MC, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB	639-02642	MLB, 2.9G, MC-16, LEA-MC, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB	639-02640	MLB, 2.9G, MC-16, LEA-MC, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB	639-02629	MLB, 2.9G, SM-16, LEA-MC, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB	639-02627	MLB, 2.9G, SM-16, LEA-MC, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB	639-02630	MLB, 2.9G, SM-16, LEA-MC, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB	639-02628	MLB, 2.9G, SM-16, LEA-MC, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB	639-02614	MLB, 2.6G, MC-16, LEA-SM, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB	639-02612	MLB, 2.6G, MC-16, LEA-SM, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB	639-02615	MLB, 2.6G, MC-16, LEA-SM, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB	639-02613	MLB, 2.6G, MC-16, LEA-SM, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB	639-02606	MLB, 2.6G, SM-16, LEA-SM, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB	639-02600	MLB, 2.6G, SM-16, LEA-SM, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB	639-02609	MLB, 2.6G, SM-16, LEA-SM, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB	639-02603	MLB, 2.6G, SM-16, LEA-SM, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB	639-02637	MLB, 2.9G, MC-16, LEA-SM, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB	639-02635	MLB, 2.9G, MC-16, LEA-SM, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB	639-02638	MLB, 2.9G, MC-16, LEA-SM, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB	639-02636	MLB, 2.9G, MC-16, LEA-SM, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB	639-02625	MLB, 2.9G, SM-16, LEA-SM, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB	639-02623	MLB, 2.9G, SM-16, LEA-SM, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB	639-02626	MLB, 2.9G, SM-16, LEA-SM, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB	639-02624	MLB, 2.9G, SM-16, LEA-SM, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB	C
	BOM NUMBER	BOM NAME	BOM OPTIONS																																																																																																																																																															
	639-02621	MLB, 2.6G, MC-16, LEA-HY, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB																																																																																																																																																															
	639-02618	MLB, 2.6G, MC-16, LEA-HY, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB																																																																																																																																																															
	639-02622	MLB, 2.6G, MC-16, LEA-HY, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB																																																																																																																																																															
	639-02620	MLB, 2.6G, MC-16, LEA-HY, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB																																																																																																																																																															
	639-02608	MLB, 2.6G, SM-16, LEA-HY, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB																																																																																																																																																															
	639-02602	MLB, 2.6G, SM-16, LEA-HY, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB																																																																																																																																																															
	639-02611	MLB, 2.6G, SM-16, LEA-HY, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB																																																																																																																																																															
	639-02605	MLB, 2.6G, SM-16, LEA-HY, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB																																																																																																																																																															
	639-02645	MLB, 2.9G, MC-16, LEA-HY, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB																																																																																																																																																															
	639-02643	MLB, 2.9G, MC-16, LEA-HY, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB																																																																																																																																																															
	639-02646	MLB, 2.9G, MC-16, LEA-HY, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB																																																																																																																																																															
	639-02644	MLB, 2.9G, MC-16, LEA-HY, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB																																																																																																																																																															
	639-02633	MLB, 2.9G, SM-16, LEA-HY, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB																																																																																																																																																															
	639-02631	MLB, 2.9G, SM-16, LEA-HY, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB																																																																																																																																																															
	639-02634	MLB, 2.9G, SM-16, LEA-HY, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB																																																																																																																																																															
	639-02632	MLB, 2.9G, SM-16, LEA-HY, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_HY_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB																																																																																																																																																															
	639-02647	MLB, 2.6G, MC-16, LEA-MC, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB																																																																																																																																																															
	639-02616	MLB, 2.6G, MC-16, LEA-MC, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB																																																																																																																																																															
	639-02619	MLB, 2.6G, MC-16, LEA-MC, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB																																																																																																																																																															
	639-02617	MLB, 2.6G, MC-16, LEA-MC, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB																																																																																																																																																															
	639-02607	MLB, 2.6G, SM-16, LEA-MC, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB																																																																																																																																																															
	639-02601	MLB, 2.6G, SM-16, LEA-MC, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB																																																																																																																																																															
	639-02610	MLB, 2.6G, SM-16, LEA-MC, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB																																																																																																																																																															
	639-02604	MLB, 2.6G, SM-16, LEA-MC, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB																																																																																																																																																															
	639-02641	MLB, 2.9G, MC-16, LEA-MC, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB																																																																																																																																																															
	639-02639	MLB, 2.9G, MC-16, LEA-MC, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB																																																																																																																																																															
	639-02642	MLB, 2.9G, MC-16, LEA-MC, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB																																																																																																																																																															
	639-02640	MLB, 2.9G, MC-16, LEA-MC, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB																																																																																																																																																															
	639-02629	MLB, 2.9G, SM-16, LEA-MC, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB																																																																																																																																																															
	639-02627	MLB, 2.9G, SM-16, LEA-MC, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB																																																																																																																																																															
	639-02630	MLB, 2.9G, SM-16, LEA-MC, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB																																																																																																																																																															
	639-02628	MLB, 2.9G, SM-16, LEA-MC, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_MC_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB																																																																																																																																																															
	639-02614	MLB, 2.6G, MC-16, LEA-SM, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB																																																																																																																																																															
	639-02612	MLB, 2.6G, MC-16, LEA-SM, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB																																																																																																																																																															
	639-02615	MLB, 2.6G, MC-16, LEA-SM, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB																																																																																																																																																															
	639-02613	MLB, 2.6G, MC-16, LEA-SM, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB																																																																																																																																																															
	639-02606	MLB, 2.6G, SM-16, LEA-SM, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB																																																																																																																																																															
	639-02600	MLB, 2.6G, SM-16, LEA-SM, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB																																																																																																																																																															
	639-02609	MLB, 2.6G, SM-16, LEA-SM, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB																																																																																																																																																															
	639-02603	MLB, 2.6G, SM-16, LEA-SM, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.6, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB																																																																																																																																																															
	639-02637	MLB, 2.9G, MC-16, LEA-SM, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB																																																																																																																																																															
	639-02635	MLB, 2.9G, MC-16, LEA-SM, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB																																																																																																																																																															
	639-02638	MLB, 2.9G, MC-16, LEA-SM, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB																																																																																																																																																															
	639-02636	MLB, 2.9G, MC-16, LEA-SM, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_MICRON_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB																																																																																																																																																															
	639-02625	MLB, 2.9G, SM-16, LEA-SM, SSD-1TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 1TB																																																																																																																																																															
	639-02623	MLB, 2.9G, SM-16, LEA-SM, SSD-256, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 256GB																																																																																																																																																															
639-02626	MLB, 2.9G, SM-16, LEA-SM, SSD-2TB, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 2TB																																																																																																																																																																
639-02624	MLB, 2.9G, SM-16, LEA-SM, SSD-512, X363G	BASE_BOM, DEVEL_BOM, CPU_SKU: 2.9, RAM_16G_SAMSUNG_2133, 2GB_SM_BAFFIN, BAFFIN_LEA, SSD_CONFIG: 512GB																																																																																																																																																																
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Alternate Parts

PART NUMBER	ALTERNATE FOR PART NUMBER	BOM OPTION	REF DES	COMMENTS:
740S0144	740S0118		ALL	
740S00003	740S0135		ALL	
376S1089	376S1128		ALL	
376S1080	376S0820		ALL	
376S00086	376S0761		ALL	
376S00074	376S0855		ALL	
376S00014	376S0761		ALL	
372S0186	372S0185		ALL	
371S0713	371S0558		ALL	
311S00060	311S0273		ALL	
311S00004	311S0370		ALL	
155S0914	155S0897		ALL	
155S0694	155S0387		ALL	
155S0660	155S0513		ALL	
155S00154	155S0398		ALL	
155S00007	155S0667		ALL	
138S0863	138S0853		ALL	
138S0775	138S0860		ALL	
138S0703	138S0648		ALL	
132S00064	132S0409		ALL	
128S0325	128S0397		ALL	
128S00029	128S00007		ALL	
128S00026	128S00011		ALL	
128S00070	128S00007		ALL	
128S00009	128S00007		ALL	
107S0249	107S0251		ALL	
107S00071	107S00053		ALL	
107S00070	107S0085		ALL	
107S00033	107S00034		ALL	
107S00015	107S00011		ALL	
376S1106	376S0678		ALL	Fairchild alt to Vishay
138S0738	138S1101		ALL	Samsung alt to Murata
138S0846	138S0811		ALL	Samsung alt to Murata
376S1053	376S0604		ALL	Diodes alt to Fairchild
152S00359	152S00253		ALL	Chillisin alt to Cyttec
740S00027	740S0159		ALL	Bourns alt to Little Fuse
371S0704	371S00077		ALL	NXP alt to Diodes
138S00032	138S0831		ALL	
138S00049	138S0831		ALL	

998-04070	998-04071		OFF	Hynix alt to SS
128S00010	128S00011		ALL	
128S00031	128S00011		ALL	
138S00084	138S00060		ALL	
155S00155	155S0441		OFF	
155S00190	155S0897		ALL	
353S00107	353S3239		ALL	
353S00525	353S4471		ALL	
376S1193	376S00037		OFF	
740S00028	740S0118		ALL	
152S00369	152S00268		ALL	Cyttec w/ NEC
128S0296	128S0487		ALL	NEC w/ pana
128S00012	128S0487		ALL	NEC w/ Rohm
155S00189	155S0275		ALL	Murata w/ Taiyo
155S00018	155S0664		ALL	Murata w/ Taiyo
152S00388	152S00182		ALL	
107S0240	107S0255		ALL	
128S00062	128S00067		ALL	NEC for Panasonic
138S0660	138S0684		ALL	
155S00204	155S0731		ALL	

PART NUMBER	ALTERNATE FOR PART NUMBER	BOM OPTION	REF DES	COMMENTS:
311S0271	311S00008		ALL	NXP w/ Diodes
197S00046	197S00036		ALL	Epson w/ TXC
197S00047	197S00036		ALL	Kyocera w/ TXC
197S00048	197S00036		ALL	Murata w/ TXC
197S00053	197S00050		ALL	Kyocera w/ TXC
197S00054	197S00050		ALL	NDK w/ TXC
197S00055	197S00050		ALL	Murata w/ TXC
311S0596	311S0593		ALL	NXP w/ Diodes
107S0276	107S00020		ALL	Cyttec w/ TFT
107S00021	107S0284		ALL	TFT w/ Yageo
132S00012	132S0401		ALL	Taiyo w/ Murata&TDK
152S00343	152S1682		ALL	NXP w/ Diodes
107S00087	107S00029		ALL	TFT w/ Yageo
128S00057	128S00018		ALL	NEC w/ Vishay
128S00058	128S00018		ALL	NEC w/ Rohm
128S0364	128S0264		ALL	Kemet w/ Panasonic
138S0641	138S0700		ALL	Murata w/ SS&Taiyo
138S0739	138S0706		ALL	NEC w/ Vishay
138S0945	138S0706		ALL	NEC w/ Rohm
152S00358	152S00208		ALL	Murata w/ Chillisin
152S00389	152S00241		OFF	Cyttec w/ Vishay
152S00390	152S00265		OFF	Cyttec w/ Vishay
152S00400	152S1872		ALL	Murata w/ Cyttec
152S1872	152S00361		ALL	Murata w/ Cyntec
155S00034	155S0706		ALL	Taiyo w/ Murata

371S00082	371S00046		ALL	On-Semi w/ Diodes
376S00146	376S1061		ALL	NXP w/ Diodes
353S00711	353S2073		ALL	On Semi w/ TI

740S00019	740S00007		ALL	Bourns w/ Polytronics
155S00189	155S0342		ALL	Murata w/ Taiyo
132S0438	132S0428		ALL	Murata w/ Taiyo&TDK
138S0714	138S0713		ALL	Murata w/ Samsung
138S0715	138S0732		ALL	Murata w/ Samsung
107S00086	107S00056		ALL	TFT w/ Cyttec
138S0875	138S0678		ALL	Taiyo w/ Mur&SS
138S0786	138S0705		ALL	Murata w/ Samsung
155S0382	155S0659		ALL	Murata w/ TDK
152S2052	152S1954		ALL	Taiyo w/ Cyttec
152S2015	152S1958		ALL	Taiyo w/ Cyttec
128S00055	128S00002		ALL	Kemet w/ Panasonic
138S0748	138S0751		ALL	Murata w/ SS
138S00102	138S0773		ALL	Murata w/ Taiyo
138S0789	138S0941		ALL	Murata w/ SS
107S00101	107S00005		ALL	Cyttec w/ Yageo
107S00102	107S00017		ALL	Cyttec w/ Yageo
107S00100	107S00057		ALL	Cyttec w/ TFT
107S00103	107S00058		ALL	Cyttec w/ Yageo
107S00104	107S00061		ALL	Cyttec w/ Yageo
107S00105	107S00062		ALL	Cyttec w/ Yageo
152S00403	152S00322		ALL	Murata w/ Chillisin
353S00852	353S4262		ALL	TI w/ OnSemi

138S00104	138S0978		ALL	
128S00069	128S00067		ALL	Rohm for Panasonic
138S0759	138S0762		ALL	
377S00077	377S0183		ALL	
152S00363	152S00048		ALL	
138S00111	138S00036		ALL	
138S00097	138S0750		ALL	
155S00203	155S0894		ALL	
116S00006	116S0175		ALL	
311S00104	311S00091		ALL	

PART NUMBER	ALTERNATE FOR PART NUMBER	BOM OPTION	REF DES	COMMENTS:
311S00013	311S0508		ALL	Part will be stuffed in production
311S00118	311S0489		ALL	
311S00072	311S0657		ALL	
311S00090	311S00028		ALL	
353S00750	353S00877		ALL	
353S00878	353S00599		ALL	
311S00105	311S0233		ALL	
353S00880	353S3452		ALL	
311S00007	311S0426		ALL	
128S0445	128S0392		ALL	
152S00415	152S00140		ALL	
128S0436	128S0392		ALL	
343S00135	343S00136		ALL	T208
343S00137	343S00136		ALL	T208
343S00138	343S00136		ALL	T208
138S00105	138S00037		ALL	
152S00434	152S1829		ALL	
353S3527	353S3528		ALL	
353S3526	353S3528		ALL	
353S00135	353S00034		ALL	
353S2220	353S00034		ALL	
353S00769	353S4398		ALL	
353S00879	353S00754		ALL	
104S00012	155S0398		ALL	
353S4342	353S00854		ALL	
152S00543	152S00484		ALL	
371S00089	371S00085		ALL	
107S00111	107S00110		ALL	
335S00213	335S0988		ALL	
311S0437	311S00112		ALL	
377S0178	377S00031		ALL	
371S00091	371S00083		ALL	
197S00069	197S00068		ALL	
138S0698	138S00113		ALL	
152S00461	152S00112		ALL	
371S00074	371S0602		ALL	
197S00082	197S00081		ALL	
353S00991	353S00920		ALL	
131S00134	131S00041		ALL	

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